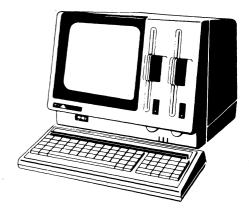
SYSTEM REFERENCE GUIDE







APC System Reference Guide

NEC NEC Information Systems, Inc.

819-000100-1003 4-83

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FEDERAL COMMUNICATIONS COMMISSION RADIO FREQUENCY INTERFERENCE STATEMENT

"WARNING: This equipment generates, uses and can radiate radio frequency energy and if not installed and used in accordance with the instructions manual, may cause interference to radio communications. It has been tested and found to comply with the limits for a Class A Computing device pursuant to Subpart J of Part 15 of FCC Rules, which are designed to provide protection against such interference. Operation of the equipment in a residential area is likely to cause interference in which case, the user will be required to take whatever measures may be required to correct the interference."

Manufacturer's Instructions and User's Responsibility to Prevent Radio Frequency Interference

Manufacturer's Instructions

The user must observe the following precautions when installing and operating this device:

- 1. Operate the equipment in strict accordance with the manufacturer's instructions for the model.
- 2. Ensure that the unit is plugged into a properly grounded wall outlet and that the power cord supplied with the unit is used and not modified.
- 3. Ensure that the unit is always operated with the factory-installed cover set on the unit.
- 4. Make no modifications to the equipment which would affect its meeting the specified limits of the Rules.
- 5. Properly maintain the equipment in a satisfactory state of repair.

User's Responsibility

The user has the ultimate responsibility to correct problems arising from harmful radio-frequency emissions from equipment under his control. If this equipment does cause interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures. All of these responsibilities and any others not mentioned are exclusively at the expense of the user.

- 1. Change in orientation of the receiving device antenna.
- 2. Change in orientation of the equipment.
- 3. Change in location of equipment.
- 4. Change in equipment power source.

If these attempts are unsuccessful, install one or all of the following devices:

- 1. Line isolation transformers
- 2. Line filters
- 3. Electro-magnetic shielding

If necessary, the user should consult the dealer, NEC, or an experienced radio/television technician for additional suggestions. The user may find the following booklet prepared by the Federal Communications Commission to be helpful: "How to Identify and Resolve Radio-TV Interference Problems." This booklet is available from the U.S. Government Printing Office, Washington, D.C. 20402, Stock No. 004-000-00345-4.

"Note: The operator of a computing device may be required to stop operating his device upon finding that the device is causing harmful interference and it is in the public interest to stop operation until the interference problem is corrected."

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Preface

This system reference guide provides hardware design and interface information for programmers, engineers, designers, and others who need to know how the APC is designed.

Chapter 1, Hardware Overview, familiarizes you with the Advanced Personal Computer and defines the principal components and devices.

Chapter 2, Processor PCB, includes descriptions and technical information for the devices contained on the Processor PCB along with programming considerations where appropriate.

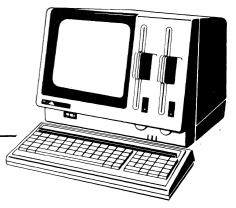
Chapter 3, Controller PCB, includes information similar to that in Chapter 2 for the devices contained on the Controller PCB.

Chapter 4, Power Supply, contains detailed specifications for the system power source.

Appendices A to F include hardware reference information such as IC data sheets, logic diagrams, and data summaries.

List of Abbreviations

А	Ampere	ISR	Read Inservice Register
ALE	Address Latch Enable	KB	Kilobyte
APC	Advanced Personal	LED	Light Emitting Diode
me	Computer	LSB	Least Significant Bit
APU	Arithmetic Processing Unit	LSI	Large-Scale Integration
AT	Abnormal Termination	MB	Megabyte
BBM	Battery-Backed Memory	MFM	Modified Frequency
CMOS	Complementary Metal		Modulation
emob	Oxide Semiconductor	MHz	Megahertz
CPU	Central Processing Unit	MOS	Metal Oxide
CRT	Cathode Ray Tube	mos	Semiconductor
CS	Code Segment	ms	Millisecond
DCH	Device Control	MSB	Most Significant Bit
DIP	Dual In-line Package	ns	Nanosecond
DMA	Direct Memory Access	NT	Normal Termination
DMC	Direct Memory Access	OCW	Operational Command
21110	Cycle		Word
DS	Data Segment	ODA	Output Device Adapter
EPROM	Erasable Programmable	PAL	Programmable Array
	Read-Only Memory		Logic
ES	Extra Segment	PCB	Printed Circuit Board
FDC	Flexible Disk Drive	POF	Power Off Control
	Controller	RAM	Random Access Memory
FDD	Flexible Disk Drive	ROM	Read-Only Memory
FIFO	First-In First-Out	rpm	Revolutions Per Minute
$\mathbf{F}\mathbf{M}$	Frequency Modulation	SS	Stack Segment
GDC	Graphic Display Controller	SW	Switch
HEX	Hexadecimal	TTL	Transistor/Transistor
Hz	Hertz	LICADT	Logic
IC	Integrated Circuit,	USART	Universal Synchronous/
	Interrupt Code, Invalid		Asynchronous Receiver/
	Command	* 7	Transmitter
ICW	Initialization Command	V	Volt
T/O	Word	VFO	Variable Frequency
I/O	Input/Output	117	Oscillator
IP	Instruction Pointer	W	Watt
IRR	Read Interrupt Register	μs	Microsecond



Chapter 1 Hardware Overview

The NEC Advanced Personal Computer (APC) has two basic components: a Main Unit and a Keyboard. The Keyboard, which cable-connects to the Main Unit, is common to all APC models. The Main Unit, which houses the Central Processing Unit (CPU), memory, visual display, sound output, and peripheral controllers, is available in three models: (1) a Monochrome Cathode Ray Tube (CRT) Display with one 8-inch Flexible Disk Drive (FDD), (2) a Monochrome CRT Display with two 8-inch FDDs, and (3) a Color CRT Display with two 8-inch FDDs. Several options and accessories are available to enhance performance or to adapt the APC for special applications.

Figure 1-1 is a block diagram of the APC. The Main Unit, the heart of the APC, has a CRT Display, one or two 8-inch FDDs, an ON/OFF switch, and several controls associated with the CRT Display. Three Input/Output (I/O) cable connectors are available at the rear of the cabinet.

The CPU, memory, and basic control logic are contained in the Main Unit on two quad-layered Printed Circuit Boards (PCB): a Processor PCB (G9PFBU) and a Controller PCB (G9PFCU). These PCBs plug into a mother board interface bus that has the space and power for up to three additional (optional) PCBs.

The Processor PCB contains as standard equipment:

- A 16-bit 8086 Microprocessor
- An 8288 Bus Controller with 20-bits of addressing, making one megabyte (MB) of memory accessible
- 128 kilobytes (KB) (standard) of Random Access Memory (RAM)
- 8 KB of Read-Only Memory (ROM)
- 4 KB of CMOS Battery-Backed Memory, which remains refreshed for at least two years without ac power
- A 4-channel Direct Memory Access (DMA) Controller

Hardware Overview

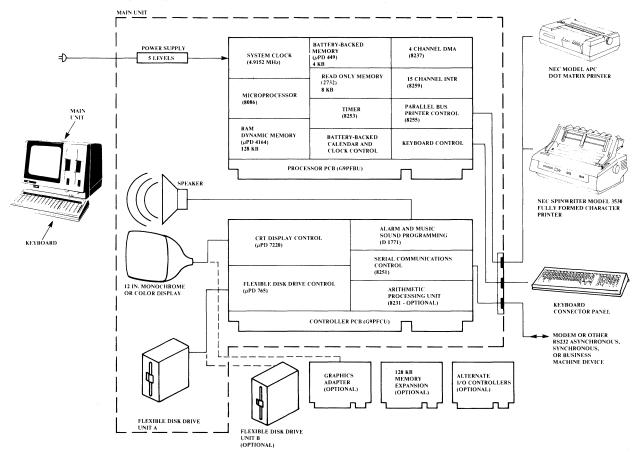


Figure 1-1 System Block Diagram

- A 15-channel Interrupt System
- Printer and Keyboard Controllers
- Calendar-and-Clock Controller, which keeps track of the month, date, day of week, hour, minute, and second, and runs on battery power when ac power is off, thus preserving the time/date setting.

The Controller PCB contains as standard equipment:

• CRT Display Control, which can generate 250 predefined characters and allows you to create and store on disk any number of sets of 256 other special characters

- Flexible Disk Drive Controller (FDC) to coordinate the reading of and the writing to one or two 8-inch flexible disks
- Alarm and Music Sound Programming System, which enables you to select alarm tones and generate music across two octaves, with selected tempos, volumes, and tone characteristics
- Serial Communications Adapter, which is a Universal Synchronous/ Asynchronous Receiver/Transmitter (USART), enabling the APC to communicate with almost any type of communications device.

The APC power supply is a 100-watt, 5-voltage-level switching regulator. It furnishes dc levels to all components — except to the CRT which has its own power unit — and has sufficient reserve capacity to handle future expansion. The power supply has a software-controlled Power-Off control (POF) circuit that enables you to turn off the system locally or remotely.

One or two 8-inch FDDs are integrated into the Main Unit. The FDC (NEC μ PD765) can read from or write to dual-sided double-density disks (which store up to 1 MB of unformatted data) or single-sided single-density flexible disks (which can store about 260 KB of unformatted data). The disk drive is a compact, high-performance, energy-efficient design featuring direct drive by a dc motor. Head loading and positioning is microprocessor-controlled for greater accuracy and minimum wear and damage to the media surface. Variable Frequency Oscillation (VFO) is employed to improve data transfer.

The APC comes equipped with a 12-inch (diagonal) green-phosphor monochrome CRT or a 12-inch 8-color CRT. Either unit has a self-contained power supply. Both have a reduced glare surface and a high resolution screen. Standard alphanumeric characters are composed from an 8-by-19 dot matrix, allowing a display of 25 lines of 80 characters. Special symbols can be designed by the user with a dot matrix of up to 8-by-16.

The CRT Display has considerable versatility and provides you with capabilities for scrolling, partitioning (and scrolling within selected partitions), overbar, vertical bar, underscore, highlighting, blinking, and reverse video. The Color CRT Display has all these attributes plus a choice from eight colors.

With the special-character generator, you can design up to 256 characters dot-bydot, which can be saved on disk as one or more special character sets. Using a dot matrix printer, these special characters can be printed and displayed, making the APC especially adaptable to users who use non-Roman alphabets or scientific symbols. The APC also offers an optional Graphics Adapter based on the NEC μ PD 7220. This self-contained single PCB plugs into the Main Unit and simplifies graphics applications, such as area shading, simulated movement, and solid or dashed lines, either straight or curved. By employing the Graphics Adapter with selected software packages, you can generate graphs, bar graphs, and three-dimensional pictures.

Also optional are two NEC printers. The Dot Matrix Printer provides rapid, high quality printing at a low cost. It prints in both directions at 100 characters per second on a 80-to-136-character column width. It prints special and graphic characters as well as standard alphanumeric characters.

The other printer is the NEC Model 3530 Spinwriter[®], which produces high quality fully-formed characters. This printer features interchangeable print elements that contain up to 128 characters and are offered in several dozen type styles and symbol sets. It prints 35 characters per second at 10, 12, and 15 characters per inch or proportional spacing. It also prints bidirectionally and offers word processor functions, such as automatic underlining, shadowing, bold face printing, as well as several paper-handling accessories.

The standard APC comes equipped with 128 KB of RAM, which resides on the Processor PCB. With the optional memory-expansion kits, RAM can be expanded to 640 KB.

The asynchronous, synchronous serial I/O communications adapter is a standard feature of the APC. The interface is supported by the NEC 8251A Communications Controller, a USART, that is used as a peripheral and is programmed by the microprocessor to communicate using virtually any serial or parallel data-transmission technique, at programmable baud rates. For communications interface requirements beyond this standard controller, NEC offers special-purpose I/O Controllers on plug-in boards.

The Keyboard is not housed in the Main Unit; it attaches to the rear of the Main Unit with a single five-foot, coiled cable. The Keyboard has 109 keys, including a numeric keypad and 22 programmable function keys that facilitate data and word processing. Each function key has two shift-modes, making available 44 userdefinable functions with one or two keystrokes.

NOTE

Only 32 of the 44 user-definable functions can be character strings.

1-4

Chapter 2 Processor PCB

The Processor PCB (G9PFBU) fits vertically in the Main Unit and is 11 inches long by $9\frac{1}{2}$ inches high (see Figure 2-1). It is composed of four sandwiched layers, including the signal, ground, and dc-power internal planes. It plugs into the third slot of the card cage with a 100-contact edge connector on the bottom of the PCB.

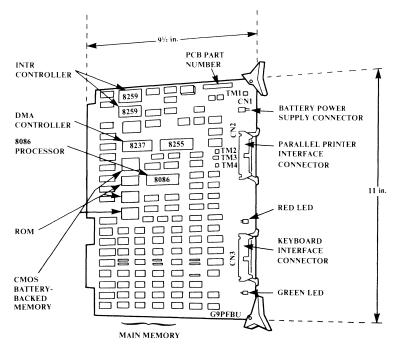


Figure 2-1 Processor PCB

As shown in Figure 2-1, three cable connectors are on the Processor PCB; two are 26-pin connectors and the third is a 2-pin header connector. The Keyboard interface uses one of the 26-pin connectors, while the other connector provides a parallel printer (or other such device) interface. Battery power is supplied by the 2-pin connector.

The principal functional components and their interrelationships are shown on the block diagram of the Processor PCB (see Figure 2-2). The major elements of the PCB consist of the following functional areas:

- An NEC μ PD8086 microprocessor, which is
 - 1) Fully compatible with the Intel 8086 microprocessor
 - 2) Capable of addressing one MB of memory
 - 3) Driven by an NEC μ PD8284 clock generator at 4.9152 MHz
- A 20-bit bidirectional address bus, 16 bits of which serve also as the data bus, and related buffers, controls, and ports
- A DMA controller to permit high speed data transmission between input/ output devices without intervention of the microprocessor

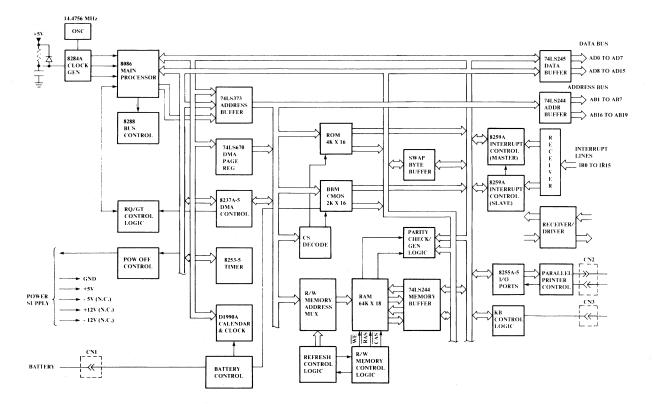


Figure 2-2 Processor PCB Block Diagram

- A 15-channel interrupt controller to govern access to the microprocessor and data bus
- 8 KB (4K x 16 bits) of ROM, which carry out self-testing and flexible-disk bootstrap loading.
- 128 KB of RAM organized into sixteen 64K x 1 dynamic-memory chips, plus two more for parity check
- 4 KB (2K x 16 bits) of CMOS Battery-Backed Memory (BBM)
- Keyboard control logic, which controls and conveys data from the Keyboard to the data bus
- Parallel printer control, which interfaces with a connector on the APC rear panel for connection of a printer or similar device
- Calendar and clock generator, supported by NEC μ PD1990AC, which is battery-protected and generates day, month, day of the week, hour, minute, and second information.

2.1 MOTHER BOARD/CARD CAGE INTERFACE

The Mother Board contains five card-edge socket connectors, each having 100 contacts, 50 on a side (see Figure 2-3). All contacts are connected as a bus to each PCB socket.

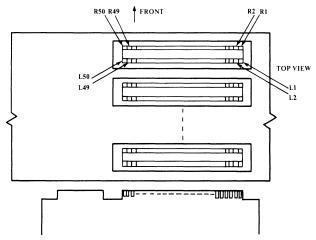


Figure 2-3 Mother Board/Card Cage Interface

Table 2-1 lists the contact assignments for each socket. All signals on these contacts are Transistor/Transistor Logic (TTL) compatible. Time relationships between various contacts in the card cage bus are shown in Figures 2-4 through 2-7. I/O equivalent circuits for the affected contacts and devices are shown in Figures 2-8 and 2-9.

PIN NUMBER	NAME	READ/ WRITE	DESCRIPTION
R1, R50 L1, L50	GND		Signal Ground
R2, R49 L2, L49	+5 V		+5 Vdc Supply
R3, R48 L3, L48	+12 V		+12 V Supply
R47, L47	-12 V		-12 V Supply
R46, L46	-5 V		-5 V Supply
R4	POF	W	Power Off Control. Goes high to command power supply off.
R5, L5 R6, L7 R8 R9, L9 R10, L10 R12	IR0 to IR14	R	Interrupt Request 0 Through 14. These 15 lines carry interrupt requests to the proces- sor. When an I/O device requires processor intervention, it signals the μ PD8259A inter- rupt controller, which activates one of the 15 interrupt lines to the processor; the interrupt- request signal is maintained until acknow- ledgement from the processor. IR0 has the highest priority and IR15 the lowest priority. These lines are active Low.
R13, R14 R15, R16	DRQ0 to DRQ3	R	DMA Request 0 Through 3. These lines trans- mit requests by I/O devices for DMA service. These signals remain active until DMA acknowledgement is active on a correspond- ing DACK line. Channel assignments are $0 =$ CRT, $1 =$ FDD, $2 =$ Graphics, $3 =$ AUX.
L13, L14 L15, L16	DACK0 to DACK3	W	DMA-Request Acknowledgement 0 Through 3. These lines signify that the DMA controller has acknowledged the DMA request on a corresponding DRQ line. DACK lines are active High.

 Table 2-1
 Card Cage Socket Contact Assignments

Table 2-1	Card Cage	Socket Contact	Assignments	(cont'd)
-----------	-----------	----------------	-------------	----------

PIN NUMBER	NAME	READ/ WRITE	DESCRIPTION
R20	ТС	W	<i>Terminal Count.</i> This line carries to the I/O device a one-clock-duration pulse indicating that the terminal count for the DMA channel has been reached. This pulse is active High.
R21	РНІО	W	System Clock. The pulse of the clock is transmitted on this line; the clock period is about 200 nsec (4.9152 MHz) and its duty cycle is 33 percent.
L21	IRST	W	<i>Initial Reset.</i> When this line goes High, every device in the system is initialized. This line is activated at power on.
R22	IOW	W	<i>I/O Write.</i> A Low on this line instructs the I/O device to receive data from the data bus. Either the DMA controller or processor can activate the line.
L22	RDY	R	<i>Ready.</i> A High on this line indicates that data has been received by an I/O device or memory, or that preparation of data is com- plete. It is pulled Low by a device to lengthen I/O memory cycles, allowing slower devices to adjust to the I/O channel.
			NOTE
			There is an <i>Interval-Ready</i> signal within the G9PFBU PCB; it acti- vates when memory access from the processor or DMA controller clashes with the memory-refresh cycle.

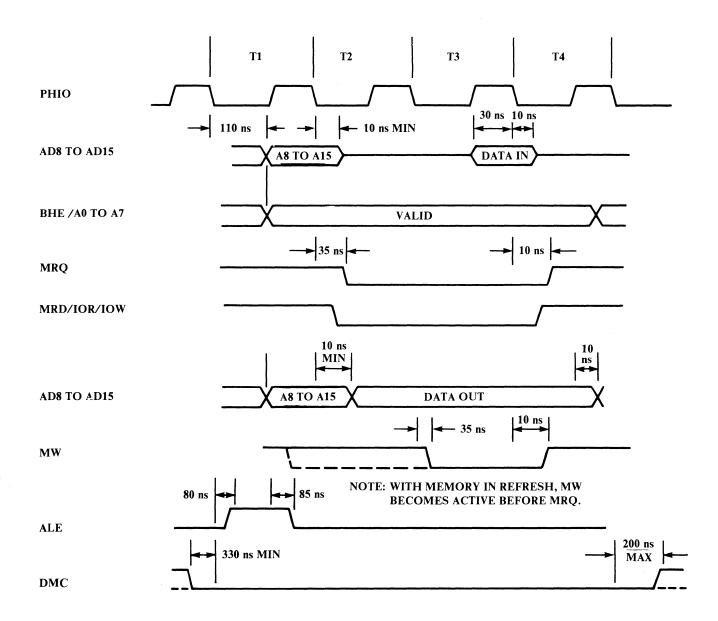
Table 2-1	Card Cage Socket	Contact Assignments (cont'd)

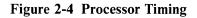
PIN NUMBER	NAME	READ/ WRITE	DESCRIPTION
R23	IOR	W	<i>I/O Read.</i> A Low on this line instructs the I/O device to transmit its data to the data bus. This instruction can come from either the DMA controller or the processor.
L23	DMC	W	<i>DMA Cycle.</i> A High on this line indicates the processor has been inhibited, thus giving system-bus control to the DMA controller.
R24	MRQ	W	<i>Memory Request.</i> When this line is Low, it indicates the memory cycle is in operation. The line is inactive (High) during memory-refresh cycles.
L24	MR	W	<i>Memory Read.</i> This line instructs the additional memory to transmit its data onto the data bus. Either the processor or DMA controller can activate this signal, which is active Low.
R25	RFSH	W	<i>Memory Refresh.</i> When this line is Low, dynamic memory is refreshed.
L25	MW	w	<i>Memory Write.</i> When Low, this line instructs the selected memory to receive the data on the data bus. It is activated by either the DMA controller or processor.
R26	вне	W	Bus High Enable. When Low, this line indi- cates that the most significant half of the data line is ready to be read. This line is not used during DMA cycles.
L26	ALE	w	Address Latch Enable. When activated by the processor or DMA control, the signal on this line latches the address on the bus.

PIN NUMBER	NAME	READ/ WRITE	DESCRIPTION
R27	DT/R	W	Data Transmit or Receive. This line indicates data transfer direction. When High, direction is processor to I/O or memory; when Low, direction is I/O or memory to processor.
L27	CLK0	W	<i>Communication Clock.</i> This line, which is energized by the 8253-5 Programmable Inter- val Timer, conveys a synchronizing variable frequency clock to the communications control.
R30	A0	W	Address Bit 0. When this line is active (High), the memory or I/O device associated with the least significant half of the data is enabled to read or transmit its data.
R31, L30 R32, L31 R33, L32 L33	Al to A7	W	Address Bits 1 Through 7. These seven lines address the memory or I/O device. These signals are latched.
R34, L34 R35, L35 R36, L36 R37, L37 R38, L38 R39, L39 R40, L40 R41, L41	AD0 to AD15	W	Address and Data Lines 0 Through 15. These 16 lines are bidirectional and time multi- plexed to convey address or data to the address or data buses.
R42, L42 R43, L43	A16 to A19	W	Address Lines 16 Through 19. These four lines, used for addressing the memory, increase the number of address lines to twenty, allowing access to one megabyte of memory.

 Table 2-1
 Card Cage Socket Contact Assignments (cont'd)

Processor PCB





2-8

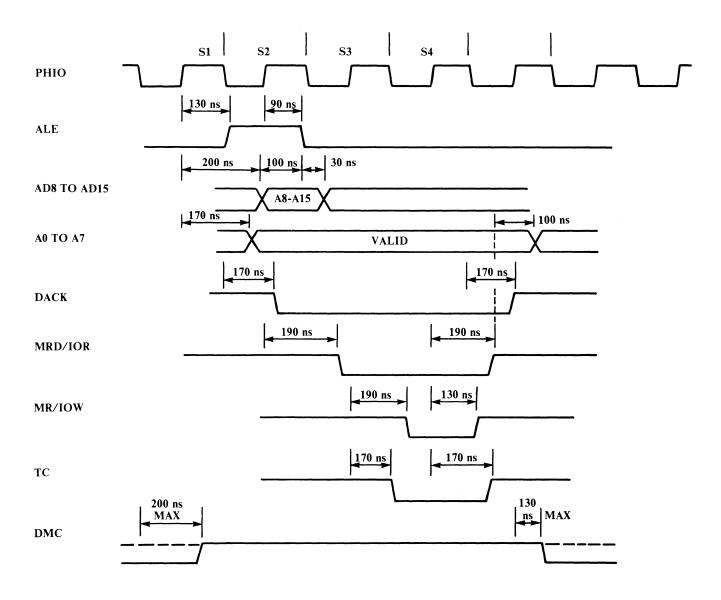
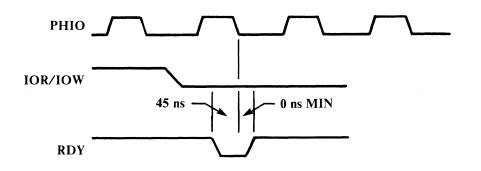
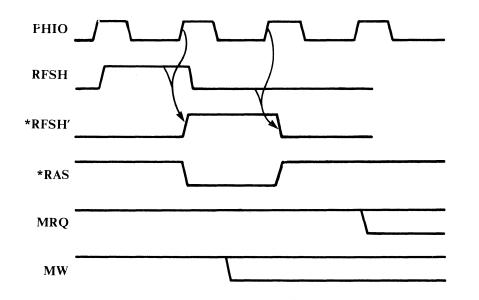


Figure 2-5 DMA Timing







NOTE: THE *RFSH' AND *RAS SIGNALS ARE GENERATED IN THE MEMORY FROM THE RFSH SIGNAL.

Figure 2-7 RFSH Signal Timing

1. A0 TO A19, IRQ, IOR, IOW, BHE, IRST, PHIO

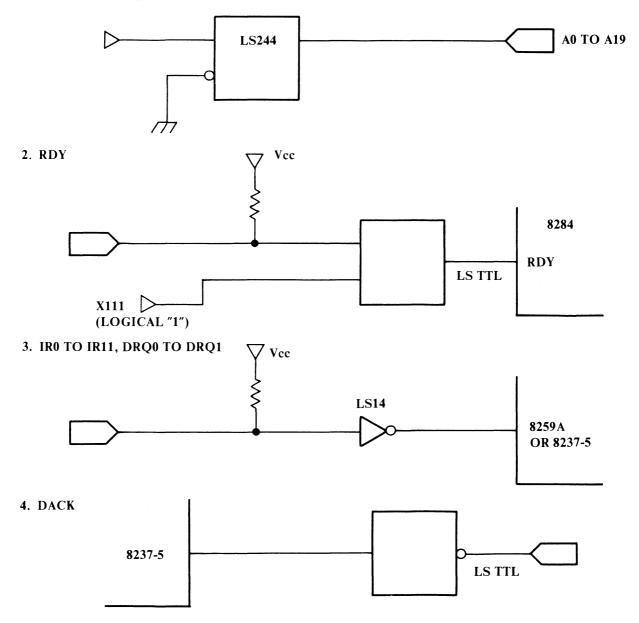
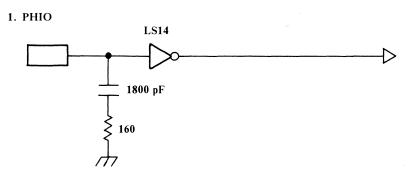
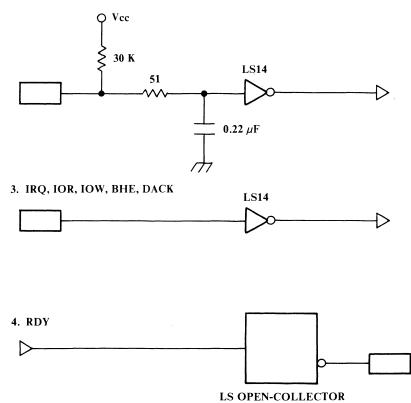


Figure 2-8 Processor Interface Circuits

Processor PCB



2. IRST



5. IR0 TO IR11, DRQ0 TO DRQ1 (LS TTL)

Figure 2-9 Device Interface Circuits

2.2 MICROPROCESSOR

The functional heart of the Processor PCB is the NEC μ PD8086 Microprocessor, an NEC-manufactured device physically and logically interchangeable with the Intel 8086.

The 8086 is a high-performance 16-bit CPU packaged in a single 40-pin Dual In-line Package (DIP) chip. It has a direct addressing capability to 1 MB of memory on a 20-bit address bus, of which bits 0 through 15 are time-multiplexed for the 16-bit data bus. It is driven at a 4.9152 MHz clock rate and is used in maximum operating mode (using an external 8288 bus controller).

In general, the 8086 processes a program by repeated cycling through four clock steps, T1 through T4:

- T1 fetches an instruction from memory
- T2 reads in any required operand
- T3 executes the instruction
- T4 writes any required result.

In the 8086, two separate processors perform these steps independently and simultaneously: (1) an execution unit that executes instructions, and (2) a bus interface unit that fetches instructions and queues them up for use by the execution unit.

All registers and data paths within the execution unit are 16 bits wide for fast operation. A 16-bit arithmetic-logic unit manages the general registers and instruction operands and maintains status and control flags. The execution unit is a strictly internal device and has no connection to the outside world. All instructions and memory access operations are accomplished by the bus interface unit.

The bus interface unit functions as a good secretary by anticipating the needs of the execution unit and lining up sequential instructions for ready access. These instructions are stored in an internal queue RAM with a capacity of six bytes. The bus interface unit is programmed to keep this RAM filled, fetching two bytes at a time from even addresses and one byte at a time from odd addresses. When the execution unit requests a memory or I/O read or write, the bus interface unit discontinues instruction fetching and responds to the execution unit request. If the instruction executed calls for control transfer to another location, the bus interface unit empties the queue RAM, fetches the instruction from the new location, and feeds it directly to the execution unit. Then the bus interface unit proceeds to refill the queue RAM from sequential instructions from the new location.

The 1,048,576 bytes of available memory space are addressed as if divided into logical segments of up to 64 KB each. The 8086 has direct access to four segments at a time, each of which has a base address carried in one of four segment registers: the Code Segment (CS), Data Segment (DS), Stack Segment (SS), and Extra Segment (ES). The Instruction Pointer (IP) register contains the present offset distance in bytes, which completes the logical address of the next address to be processed. The result of this memory organization is that the 20-bit physical memory address can be defined by a logical address consisting of two 16-bit bytes, the first specifying the base address of the selected segment and the second specifying the relative address within that segment, counting from the base address. To convert a logical address to a physical address, first shift the base address byte 4 bits to the left by multiplying it by sixteen, then add the result to the offset byte.

2.3 DIRECT MEMORY ACCESS

Because it bypasses processor intervention, DMA provides a much faster way of moving data between I/O devices and memory. Supported by the NEC LSI 8237-5 DMA Controller, DMA employs 16 address lines and 4 bits of page addressing, thus enabling it to address one megabyte of memory. Although the DMA is a synchronous device, it can interface with low-speed memory or I/O devices by using the external Ready line.

The four DMA channels are assigned as follows:

Channel 0	CRT
Channel 1	FDD
Channel 2	Reserved for graphic operations option
Channel 3	Future.

See Table 2-2 for a list of instructions and I/O addresses. Figures 2-10, 2-11, and 2-12 show the DMA registers.

INSTRUCTION	READ/ WRITE	I/O Address	7	6	DA 5	ГА В 4	SUS 3	2	1	0
Write Command	W	09	K S	D S			T M		A H	M M
Write Mode	W	1B	M S 1	M S 0	I D	A T	T R 1	T R 0	C S 1	C S 0

 Table 2-2
 DMA Instructions

2-14

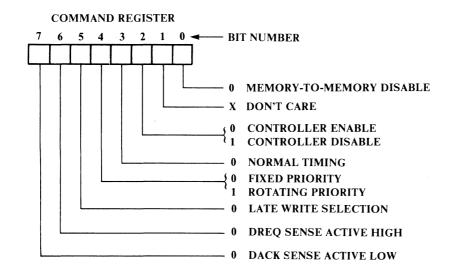
Processor PCB

INSTRUCTION	READ/	I/O			DA	τα Β	SUS			
	WRITE	ADDRESS	7	6	5	4	3	2	1	0
Write RQ Register	W	19	_					R B	C S 1	C S 0
Write Single Mask	W	0B	_		_			M K	C S 1	C S 0
Write All Mask	W	1F	_			_	M B 3	M B 2	M B 1	M B 0
Read Status	R	09	R Q 3	R Q 2	R Q 1	R Q 0	T C 3	T C 2	T C 1	T C 0
CH0 DMA Address	R/W	01			A5 A13				A1 A9	A0 A8
CH0 DMA Count	R/W	11		-	W5 W13					W0 W8
CH1 DMA Address	R/W	03			A5 A13					A0 A8
CH1 DMA Count	R/W	13			W5 W13					W0 W8
CH2 DMA Address	R/W	05			A5 A13					A0 A8
CH2 DMA Count	R/W	15			W5 W13					W0 W8
CH3 DMA Address	R/W	07			A5 A13					A0 A8
CH3 DMA Count	R/W	17			W5 4 W13					W0 W8

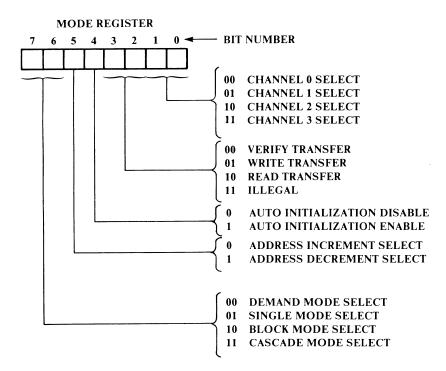
 Table 2-2
 DMA Instructions (cont'd)

INSTRUCTION	READ/	EAD/ I/O					DATA BUS						
	WRITE	ADDRESS	7	6	5	4	3	2	1	0			
CH0 Page Register	W	38	0	0	0	0	A 19	A 18	A 17	A 16			
CH1 Page Register	W	3A	0	0	0	0	A 19	A 18	A 17	A 16			
CH2 Page Register	W	3C	0	0	0	0	A 19	.A 18	A 17	A 16			
CH3 Page Register	W	3E	0	0	0	0	A 19	A 18	A 17	A 16			
Read Temp Register	R	1D	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0			
Master Clear	W	1D											

Table 2-2 DMA Instructions (cont'd)

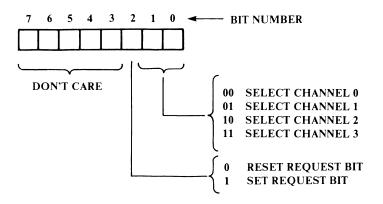






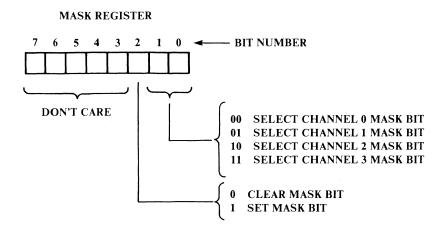


REQUEST REGISTER

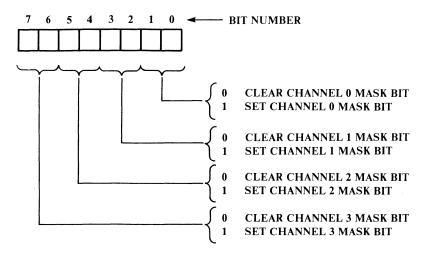


SOFTWARE REQUESTS WILL BE SERVICED ONLY IF THE CHANNEL IS IN BLOCK MODE.

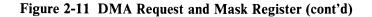
Figure 2-11 DMA Request and Mask Register

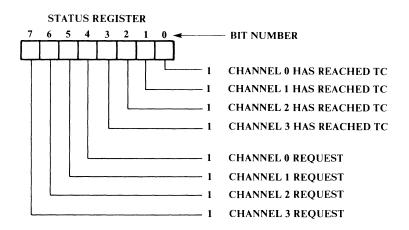


THE INSTRUCTION, WHICH SEPARATELY SETS OR CLEARS THE MASK BITS, IS SIMILAR IN FORM TO THAT USED WITH THE REQUEST REGISTER.



ALL FOUR BITS OF THE MASK REGISTER MAY ALSO BE WRITTEN WITH A SINGLE COMMAND.





THIS INFORMATION INCLUDES WHICH CHANNELS HAVE REACHED A TERMINAL COUNT AND WHICH CHANNELS HAVE A PENDING DMA REQUEST. BITS 0 THROUGH 3 ARE SET EVERY TIME A TC IS REACHED BY THAT CHANNEL OR AN EXTERNAL EOP IS APPLIED. THESE BITS ARE CLEARED UPON RESET AND ON EACH STATUS READ.

Figure 2-12 DMA Status Register

2.4 INTERVAL TIMER

The NEC μ PD8253-5 Programmable Interval Timer has three timer counter outputs: Channel 0 is attached to interrupt-request Channel 3; Channel 1 is sent to the synchronous/asynchronous communications controller on the Controller PCB (see Chapter 3); Channel 2 is not used. Figure 2-13 is a block diagram of the interval timer. Table 2-3 lists the timer commands.

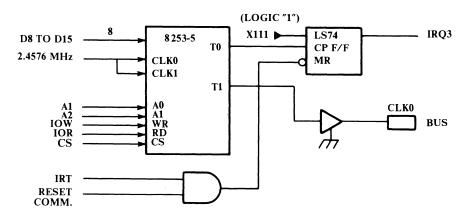


Figure 2-13 Interval Timer Block Diagram

INSTRUCTION	READ/	I/O			Ι	DAT	A BU	JS		
	WRITE	ADDRESS	7	6	5	4	3	2	1	0
Load Counter 0	W	29			C5					C0
			C15	C14	C13	C12	C11	C10	С9	C8
Load Counter 1	W	2B			C5					C0
			C15	C14	C13	C12	C11	C10	С9	C8
			S		R					В
Mode Set	W	2F	C	C 0	L 1		M2	M1	M 0	C
			1	0	1	0				D
Timer Reset	W	46	x	X	X	X	X	T M	X	Х
X: Don't care.	.	ł	1							

 Table 2-3
 Timer Commands

2.5 INTERRUPT CONTROL

This interrupt function is controlled by two 8259 Metal Oxide Semiconductor (MOS) devices; each can handle up to eight vectored priority interrupts, as shown in Figure 2-14. The first 8259 device (master) supports IR0 through IR6, with IR7 cascaded from the second 8259 device (slave), which supports IR7 through IR14. These 15 available interrupt lines are assigned to service specific devices in order of priority. Table 2-4 lists the interrupt lines.

There are two interactions between the processor and the interrupt controller. The first is the acknowledgement process, during which the processor transmits acknowledgement of the interrupt request to the interrupt controller. During the second process, the interrupt controller transmits a byte of data to the processor (see Table 2-4).

Control commands issued by the processor, consisting of Initialization Command Words (ICW) and Operational Command Words (OCW), are summarized in Table 2-5 and shown in Figures 2-15 and 2-16. Table 2-5 also includes poll mode, read interrupt register (IRR), read inservice register (ISR), and interrupt register words that are read into the data bus by the interrupt controller when so commanded.

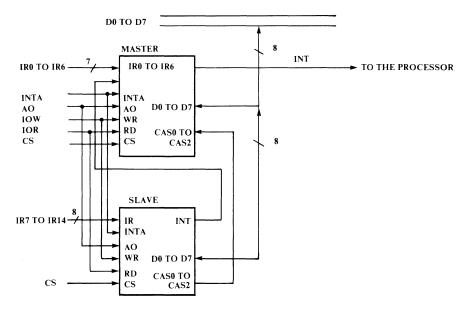


Figure 2-14 Interrupt Control Block Diagram

Table	2-4	Interrupt I	Lines
-------	-----	-------------	-------

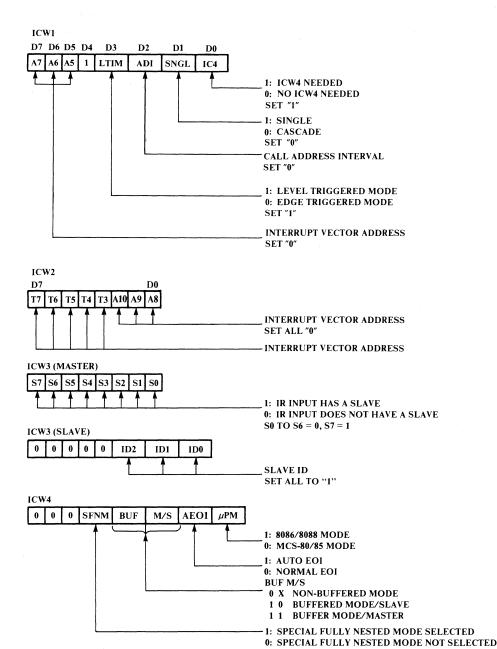
DEVICE	INTERRUPT REQUEST LINE	ASSIGNMENT	INTERRUPT VECTOR BYTE
Master	IR0 IR1 IR2 IR3 IR4 IR5 IR6	Not used Communication Not used Timer Keyboard Not used Not used	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
Slave	IR7 IR8 IR9 IR10 IR11 IR12 IR13 IR14	Printer Not used ORT FDD Not used Not used APU	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

		READ/	I/O	DATA BUS							
DEVICE	INSTRUCTION	WRITE	ADDRESS	7	6	5	4	3	2	1	0
Master	ICW 1	W	20	0	0	0	1	0	0	0	1
	ICW 2	W	22	T7	T6	T5	T4	Т3	0	0	0
	ICW 3	W	22	1	0	0	0	0	0	0	0
	ICW 4	w	22	0	0	0	0	0	0	0	1
	OCW 1	W	22		M6	M5	M4	M3	M2	M1	M0
	OCW 2	W	20	R	S L	E O I	0	0	L2	L1	L0
	OCW 3	W	20	0	E S M	S M M	0	1	Р	P R	R I S
	Poll Mode	R	20	Ι					W2	W1	W0
	Read IRR	R	20		I R 6	I R 5	I R 4	I R 3	I R 2	I R 1	I R 0
	Read ISR	R	20		I S 6	I S 5	I S 4	I S 3	I S 2	I S 1	I S O
	Read Mask	R	22		M6	M5	M-4	M3	M2	M1	M0
Slave	ICW 1	W	28	0	0	0	1	0	0	0	1
	ICW 2	W	2A	T7	T6	Т5	T4	T3	0	0	0
	ICW 3	W	2A	0	0	0	0	0	1	1	1
	ICW 4	W	2A	0	0	0	0	0	0	0	1

 Table 2-5 Interrupt Control Commands Summary

		READ/	I/O				DAT	A BU			
DEVICE	INSTRUCTION	WRITE	ADDRESS	7	6	5	4	3	2	1	0
	OCW 1	W	2A	M14	M13	M12	M11	M 10	M9	M 8	M7
	OCW 2	W	28	R	S L	E O I	0	0	L2	L1	L0
	OCW 3	W	28	0	E S M	S M M	0	1	Р	R R	R I S
	Poll Mode	R	28	Ι				<u></u>	W2	W1	W0
	Read IRR	R	28	IR 14	IR 13	IR 12	IR 11	IR 10	IR 9	IR 8	IR 7
	Read IRR	R	28	IS 14	IS 13	IS 12	IS 11	IS 10	IS 9	IS 8	IS 7
	Read Mask	R	2A	M14	M13	3 M12	M11	M10	M9	M8	M7

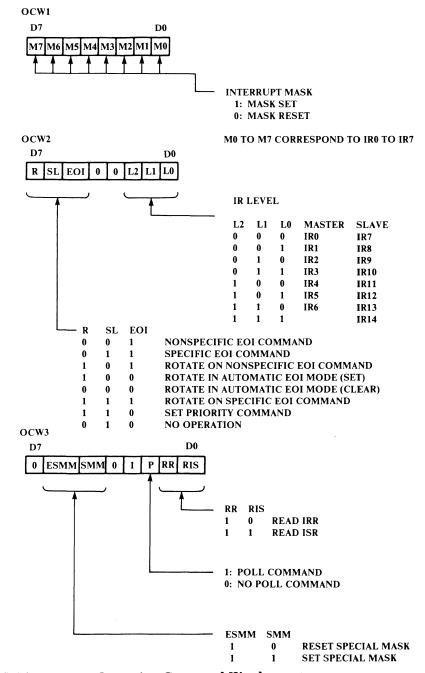
 Table 2-5
 Interrupt Control Commands Summary (cont'd)







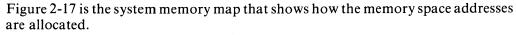
Processor PCB





2-25

2.6 MEMORY



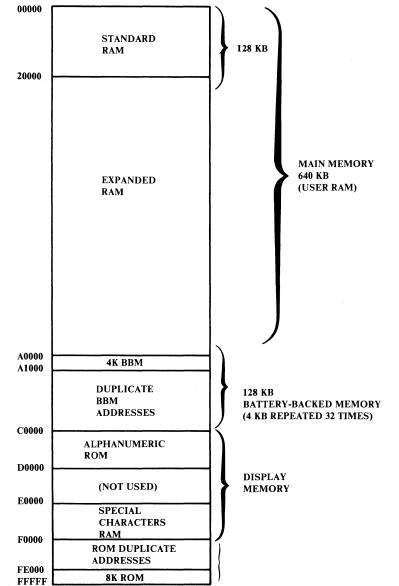


Figure 2-17 System Memory Map

2.6.1 Main Memory

The Processor PCB contains 128 KB (64 Kwords: 16 bits of data, 18 bits wide, with 1 bit parity for each 8 bits) of RAM, organized into eighteen 64K x 1-bit dynamic memory chips. Figure 2-18 is a block diagram of the circuit. The RAM is refreshed during the non-memory-access cycle, and its access time is 200 ns. Parity check is carried out with two additional memory chips. A detected parity error lights the D4 red Light Emitting Diode (LED), located near the top edge of the Processor PCB.

As shown in Figure 2-17, the main memory is expandable to a maximum of 640 KB, of which 256 KB can be supported by the present APC equipment configuration.

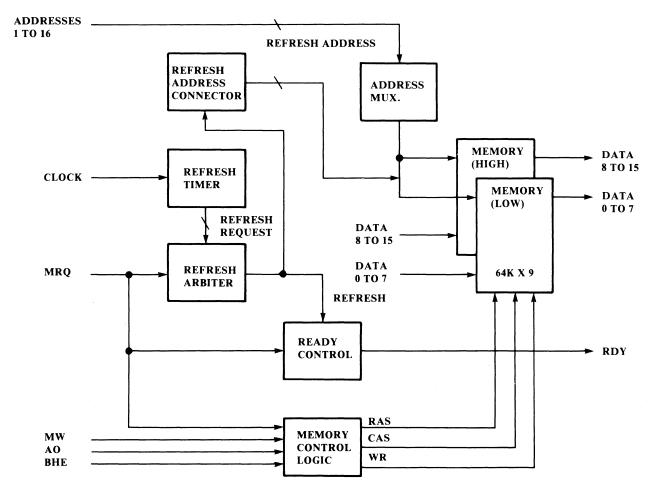


Figure 2-18 Main Memory Block Diagram

2.6.2 Battery-Backed Memory

The BBM is composed of 4K (two 2K X 8-bit chips) of Complementary Metal Oxide Semiconductor (CMOS) static RAM and is addressable from A0000 through C0000 hexadecimal (HEX) in 32 4K visible sections of memory, each section containing the same data. The APC uses partial address decoding of this 128 KB of memory, which results in 4 KB of BBM. The BBM contains system information and is protected from loss for at least two years by the battery that plugs into the Processor PCB.

As shown in Figure 2-19, the BBM read/write operation is identical to that of the main memory except for a BBM write protect circuit that safeguards the BBM from unintentional data manipulation.

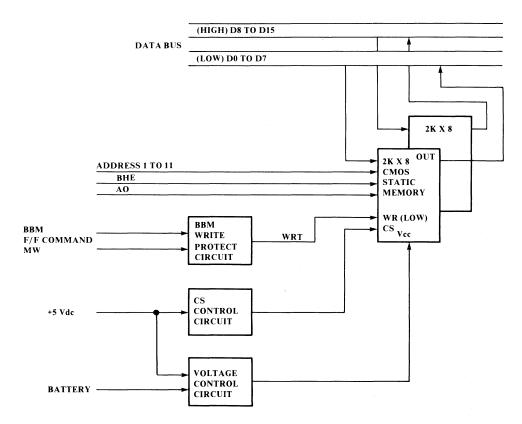


Figure 2-19 Battery-Backed Memory Block Diagram

2-28

The BBM write protect command I/O port address is 59(HEX). A logical "1" on the Least Significant Bit (LSB) position on the data bus enables writing to the BBM; a "0" sets the BBM for write protection.

2.6.3 Read Only Memory

The Processor PCB contains 8K of ROM in two 4K x 8-bit Erasable Programmable Read-Only Memory (EPROM) chips. The ROM has two functions: flexible disk self-testing and bootstrap loading. As shown in Figure 2-17, the ROM occupies the 8K addresses from FE000 through FFFFF and is visible in eight duplicate 8K sections from F0000 through FFFFF. At APC power-on, the 8086 code segment and instruction-pointer registers are set to FFFF(HEX) and 0000(HEX) addresses respectively for loading and auto self-test, instructions for which are resident in the ROM.

2.7 PARALLEL PRINTER CONTROL

This portion of the logic provides an I/O TTL interface with an external paralleldata-bus printer.

As shown in Figures 2-20 and 2-21, the parallel printer control consists of an NEC μ PD8255A Programmable Peripheral Controller that interfaces with connector CN2 through LS244 drivers. A flat-type 26-conductor cable connects the CN2 board connector to a connector at the rear of the main unit that, in turn, goes to the printer. The pin connections are listed in Table 2-6. The interface is adaptable to either an Output Device Adapter (ODA) or Centronics-type printer by setting appropriate jumpers on TM2, TM3, and TM4 on the Processor PCB (see Figure 2-29).

2.7.1 Interface

Table 2-7 lists the interface lines.

2.7.2 Programming Considerations

The 8255A device is operated in the APC as Mode 0 (basic I/O) in the Group A ports (Port A and upper 4 lines of Port C), and Mode 1 (strobed) in the Group B ports (Port B and lower 4 lines of Port C). The eight lines of Port B (PB0 through PB7) carry the strobed data to the printer; I/O control line levels are from Ports A and C.

Programming and execution of the 8255 is accomplished using the instructions described in Tables 2-8 and 2-9. Figures 2-22 and 2-23 show interline timing under various operating conditions.

PRINTER CABLE CONNECTOR PIN NUMBERS

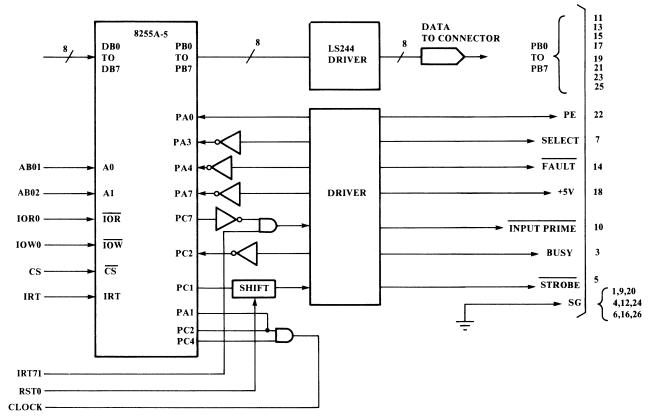


Figure 2-20 Parallel Printer Control Block Diagram

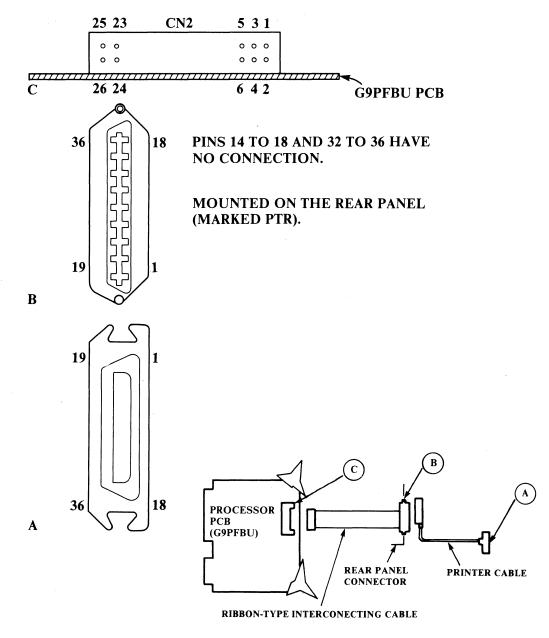
Processor PCB

	PIN NUMBER	PIN NUMBER	PIN NUMBER	REMARKS
SIGNAL	AT A	AT B	AT C	
DATACTO	1	2		
DATA STB	1 2	3 6	2	
DATA 1			16	
DATA 2	3	7	4	
DATA 3	4	8	17	
DATA 4	5	9	5	
DATA 5	6	10	18	
DATA 6	7	11	6	
DATA 7	8	12	19	
DATA 8	9	13	7	
ACK	10	2	14	
Input Busy	11	22	9	
PĚ	12	29	25	
SELECT	13	4	15	
Signal Ground	14	NC	NC	
NC	15	NC	NC	
Signal Ground	16	NC	NC	
Chassis Ground	17	NC	NC	
+5 Vdc	18	27	NC 24	· · ·
Twisted Pair -				
Ground (Pin 1)	19	NC	NC	
Ground (Pin 2)	20	20	8	
Ground (Pin 3)	21	21	21	
Ground (Pin 4)	22	5	3	
Ground (Pin 5)	23	24	10	
Ground (Pin 6)	24	26	11	
Ground (Pin 7)	25	28	12	
Ground (Pin 8)	26	30	13	
Ground (Pin 9)	27	31	26	
Ground (Pin 10)	28	NC		
Ground (Pin 11)	29	NC		
Ground (Pin 31)		NC		
Input Prime	31	23	22	
Fault	32	25	23	
Signal Ground	33	NC	NC	
NC	34	NC	NC	
NC	35	18		1
Input Busy	36	NC	NC	
mput busy	50			
Input busy	50	19	20	No signal

 Table 2-6 Parallel Printer Connectors Pin Assignments

NOTE: NC means No Connection.

Processor PCB





SIGNAL	SOURCE	DESCRIPTION
RMS	АРС	<i>Receive Machine Set.</i> This signal is used with the ODA printer interface only.
BUSY	Printer	 Goes high to indicate that the printer cannot receive data: 1. During data entry 2. During printing operation 3. In offline state 4. During printer error status.
STROBE	APC	Strobe pulse to read data in. The signal level is normally High. Read-in of data is performed at the Low level of this signal.
SG		Twisted-pair return signal ground level.
SELECT	Printer	Goes high to indicate that the printer is in selected state.
ACKNLG	Printer	Acknowledge goes Low to indicate that data has been received and that the printer is ready to accept other data.

Table 2-7 Parallel Printer Interface Signals

	· · · · · · · · · · · · · · · · · · ·	
SIGNAL	SOURCE	DESCRIPTION
INPUT PRIME	APC	Goes Low to initialize the printer.
DATA 1	APC	Data lines from 8255A, PB0 through PB7. High is logic 1; Low is logic 0.
DATA 2	APC	
DATA 3	APC	
DATA 4	APC	
DATA 5	APC	
DATA 6	APC	
DATA 7	APC	
DATA 8	APC	
FAULT	Printer	Goes Low when the printer is in 1. Paper End state 2. Offline state 3. Error state.
+5 V	Printer	Device Control (DCN)
РЕ	Printer	Goes high to indicate that printer is out of paper.

 Table 2-7 Parallel Printer Interface Signals (cont'd)

Processor PCB

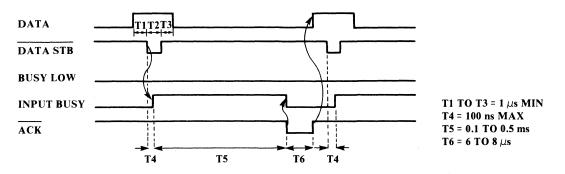
INSTRUCTION	READ/	I/O ADDRESS				ATA				
· · · · · · · · · · · · · · · · · · ·	WRITE		7	6	5	4	3	2	1	0
Write Signal 0	W	6E	1	0	0	1	0	1	0	0
Write Signal 1	W	6E	0	0	0	0	0	1	0	I N T E
Write Signal 2	W	6E	0	0	0	0	0	1	1	R M S
Write Signal 3	W	6E	0	0	0	0	1	0	0	M A S K
Write Signal 4	W	6E	0	0	0	0	1	1	1	I R T
Write Signal 5	W	6C	I P	x	X	M A S K	x	X	X	X
Read Signal	R	68	+ 5 V	0	0	F A U L T	S E L E C T	0	R D R Q	P E
Write Data	W	6A	D A T A 8	D A T A 7	D A T A 6	D A T A 5	D A T A 4	D A T A 3	D A T A 2	D A T A 1

Table 2-8 Parallel Printer Controller Instruction

INSTRUCTION	DESCRIPTION
Write Signal 0	Set the 8255 Mode
Write Signal 1	Interrupt Enable Flag (INTE) 1: Flag On 0: Flag Off
Write Signal 2 (Not used for Centronics I/F)	Receive Machine Set (RMS) 1: RMS On 0: RMS Off
Write Signal 3	Mask Set or Reset 1: Reset 0: Set
Write Signal 4	Input Prime (IP) Set or Reset 1: Reset 0: Set
Write Signal 5	IP and Mask Set or Reset
Read Signal	Read the status of the printer
Write Data	Write data to be printed

 Table 2-9 Parallel Printer Controller Instruction Sequence

RECEIVE DATA





2-36

DATA BUFFER FULL

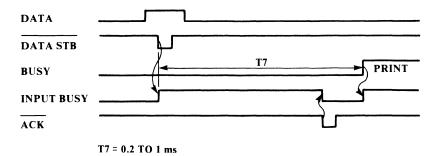
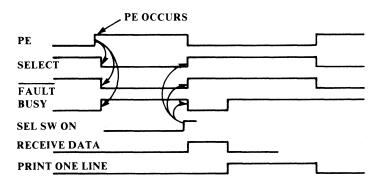


Figure 2-22 Parallel Printer Controller Interface Timing (cont'd)

NO DATA IS IN THE DATA BUFFER



STORED DATA IS IN THE DATA BUFFER

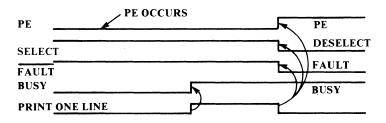


Figure 2-23 Parallel Printer Controller Interface at Paper Out Status

2.8 KEYBOARD

The Keyboard employs capacitance technology and an 8048, 8-bit microprocessor that performs keyboard scanning and coding functions. It contains 109 keys in three major groupings. The central area is a standard typewriter layout. Above the central area are 22 user-definable function keys in a single row. To the right of the central area are 25 keys that consist of a numeric entry pad and a set of cursor/ control keys.

As shown in Figure 2-24, the Keyboard is arranged as a matrix (8 x 16), with 128 possible X/Y coordinate output combinations (only 109 of which are represented by key positions). The 8048 microprocessor, in combination with an LS74159 decoder chip, produces a scan code output function peculiar to each key position and shift/control status. These scan codes are sent to the Processor PCB on an eight-bit scan data bus designated SD1 through SD8.

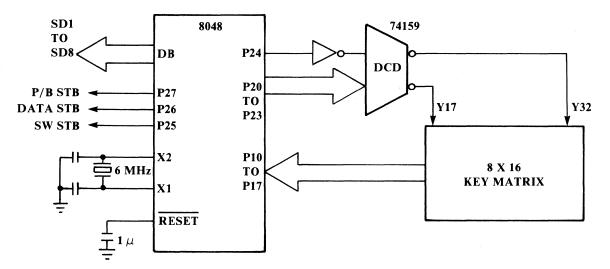


Figure 2-24 Keyboard Block Diagram

Pressing a key produces a strobe that latches the corresponding scan code into a key data register or switch (SW) register located on the Processor PCB and generates an interrupt request. Pressing a switch key (such as FNC or SHIFT) is recorded in an SW register on the Processor PCB, the output of which is combined with the key data register to produce the code output.

The CPU I/O address is hexadecimal 48 for the key data register and 4C for the SW register. The CPU can also read the keyboard status at address 4A.

2.8.1 Keyboard Layout and Scan Codes

The Keyboard layout and designated key position numbers are shown in Figure 2-25. The corresponding scan codes are listed in Table 2-10. The scan codes are usually different than the hex codes for the keys. For hex code information, see Appendix D.

1)	PF1 🗲								— Р	ROGR	AMMA	BLE FU	NCTIO	NKEYS -								>	► PF22	2
FNC	(2)	(3)	(4)	(5)	(6)	(7)	(8) (9)	(10)	(11)	(12)	(13)	(14)	(15)	(16)	(17)	(18)	(19)	(20)	(21)	(22)	(23)]
ESC (24)	! 1 (25)	@ 2 (26)	# 3 (27)	\$ 4 (28)	[%] 5 (29)	¢ 6 (3)	0) & 7 (3	1	8 (32)	9 (33)) 0 (34)	(35)	+ (36)	~ · (37)	BAC SPAC		38)	INS (85)	/ (86)	CLEAR HOME (87)	PRINT (88)	BRE	EAK OP (89)	
	9) (4				R (43)	T (44)	Y (45)	U (46)	I (4) (48)	P (49) ['	(50)]	(51) \ (52) A	(53)		DEL (90)	* (91)	7 (92)	8 (93)	9 (94)	(95)	
CTRL (54)	CAPS LOCK (55)	A (56)	S (57)	D (58)	F (59)	G (6	0) (J (62)	K (63)	L (64)	; ; (65)	,, , , (66		TURN	67)			(96)	4 (97)	5 (98)	6 (99)	+ (100)	
SH	(68)	2			C (71)	v (72)	B (73)	N (74)	M (7:		< (76)	? (77)	? ⁄ (78)		SHIFT (79	,		(101)	(102)	1 (103)	2 (104)	3 (105)	E N T	C
GRP 1	н (80)	GR 2		81)					(SP)				(82)	ALT (83)	HEI	.P (84)			(107)		0 (108)	(109)	E R	

(NUMBERS IN PARENTHESES DESIGNATE KEY POSITION)

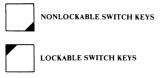


Figure 2-25 Keyboard Layout

Table 2-10 Keyboard Scan Codes

KEY POSITION	SCAN CODE	KEY POSITION	SCAN CODE	KEY POSITION	SCAN CODE
1*	_	38	9C	75	4D
2	80	39	98	76	2C
3	81	40	51	77	2E
4	82	41	57	78	2F
5	83	42	45	,79*	_
6	84	43	52	80*	
7	85	44	54	81*	
8	86	45	59	82	20
				d 79 (SHIFT), 80 to generate a sca	

KEY POSITION	SCAN CODE	KEY POSITION	SCAN CODE	KEY POSITION	SCAN CODE
9	87	46	55	83*	
10	88	47	49	84	9E
11	89	48	4F	85	FB
12	8A	49	50	86	6F
13	8B	50	5B	87	9A
14	8C	51	5D	88	FF
15	8D	52	5C	89	96
16	8E	53	5E	90	FC
17	8F	54*		91	6A
18	90	55*		92	77
19	91	56	41	93	78
20	92	57	53	.94	79
21	93	58	44	95	6D
22	94	59	46	96	F7
23	95	60	47	97	74
24	1B	61	48	98	75
25	31	62	4A	99	76
26	32	63	4B	100	6B
27	33	64	4C	101	FA
28	34	65	3A	102	F9
29	35	66	3B	103	71
30	36	67	97	104	72
31	37	68*		105	73
32	38	69	5A	106	FD
33	39	70	58	107	F8
34	30	71	43	108	70
35	50	72	56	109	6E
36	2D	73	42		
37	40	74	4E		

 Table 2-10 Keyboard Scan Codes (cont'd)

*Positions 1 (FNC), 54 (CTRL), 55 (CAPSLOCK), 68 and 79 (SHIFT), 80 (GRPH 1), 81 (GRPH 2), and 83 (ALT) must be used with another key to generate a scan code.

2.8.2 Interface

The Keyboard connects with a coiled multiconductor cable to the rear of the Main Unit (see Figure 2-26 and Table 2-11). The cable is a shielded 19-wire design that includes power (+5 Vdc), grounds, and twelve signal lines. The cable is permanently attached to the Keyboard.

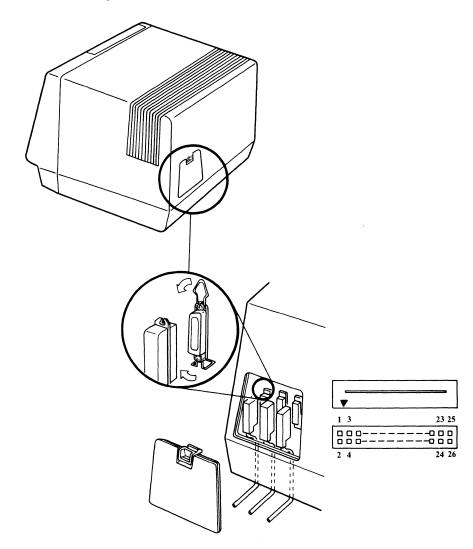


Figure 2-26 Keyboard Interface

PIN	SIGNAL			
1	Not used			
2	Not used			
3 4	Keyboard Data 1			
4	Keyboard Data 2			
5	Keyboard Data 3			
6	Keyboard Data 4			
7	Keyboard Data 5			
8	Keyboard Data 6			
9	Keyboard Data 7			
10	Keyboard Data 8			
.11	Signal Ground			
12	Data Strobe			
13	Signal Ground			
14	Not used			
15	Not used			
16	Switch Strobe			
17	Not used			
18	Not used			
19	Debug			
20	Signal Ground			
21	Signal Ground			
22	Signal Ground			
23	+5 Vdc			
24	+5 Vdc			
25	Not used			
26	Not used			

 Table 2-11 Keyboard Interface Lines

2.9 CALENDAR AND CLOCK GENERATOR

The Calendar and Clock Generator is supported by a CMOS Integrated Circuit (IC) (NEC μ PD1990AC). This IC independently registers the month, day of the month, day of the week, hour, minute, and second, and it can receive or send this information from or to the microprocessor. Because this IC carries out all clock functions, it frees the microprocessor from these duties, increasing the capabilities of the microprocessor in other areas.

2.9.1 Circuit Description

As shown in Figure 2-27, the clock generator is driven by a 32.768 kHz crystal oscillator. Should a power break occur, system battery power prevents calendarand-clock data loss. A 14-pin IC encloses all functions.

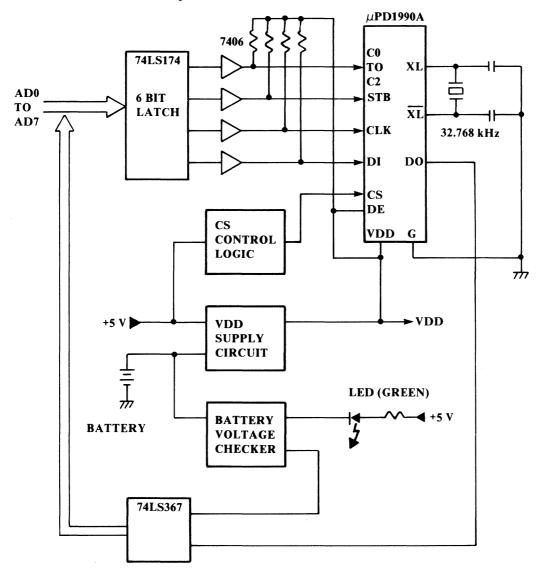


Figure 2-27 Clock/Calendar Block Diagram

2.9.2 Programming Considerations

Input and output of clock/calendar data is available on command as a 40-bit serial word having the following format.

MSB				
4 bits	4 bits	8 bits	8 bits	8 bits
month	day of wk.	date	hour	minute

The write/read instruction format is shown in Table 2-12 and Figure 2-28.

Table 2-12	Clock/	Calendar	Instruction	Format

LSB

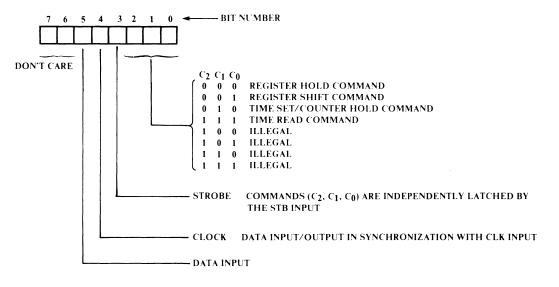
8 bits

second

INSTRUCTION	READ/ WRITE	I/O ADDRESS	7	6		<u>AT A</u> 4	<u>A BU</u> 3	<u>JS</u> 2	1	0	DESCRIPTION
		<u> </u>	, 						/		
Set Register	W	58	0	0	D I	C L K	S T B	C2	Cl	C0	See Figure 2-28 (1)
Read Data	R	58							B A T T	D O	See Figure 2-28 (2)

COMMAND SUMMARY

(1) SET REGISTER



(2) READ DATA

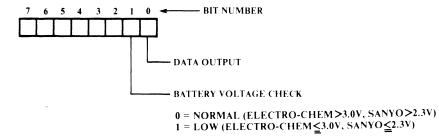
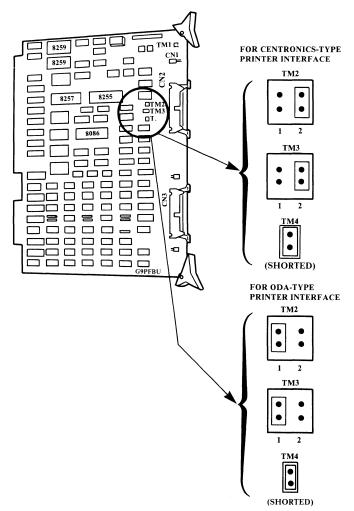


Figure 2-28 Clock/Calendar Format

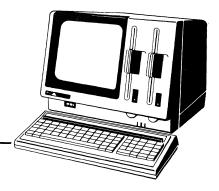
2.10 JUMPER SETTINGS

The Processor PCB has four jumpers (TM1, TM2, TM3, and TM4). TM1 is not related to system functions, but to battery replacement. To prevent harm to the diode when replacing the battery, TM1 must be removed.

To adapt the APC interface for a Centronics-type or ODA printer, set TM2, TM3, and TM4 as instructed in Figure 2-29.







Chapter 3 Controller PCB

The Controller PCB (G9PFCU) is the same size and has the same general physical arrangement as the Processor PCB. Like the Processor PCB, it fits into the Mother Board with a 100-pin card-edge socket. It is normally located in the first slot position (closest to the CRT).

Installed on the Controller PCB are five cable connectors: a communications interface connector, a CRT interface connector, an FDD interface connector, a speaker interface connector, and a volume interface connector (see Figure 3-1).

Figure 3-2 shows the functional relationships between the five principal components that occupy the Controller PCB.

- CRT Display control for the 12-inch monochrome or color display -designed around the μPD7220 graphic display controller
- An 8-inch FDD control, that can read from and drive double-sided doubledensity flexible disks or single-sided single-density disks
- Serial I/O device control, supported by the NEC 8251 A controller, converts serial data to parallel data and parallel data to serial data -- it can do so synchronously or asynchronously, using half- or full-duplex at various baud rates
- Sound control is supported by Large-Scale Integration (LSI) NEC μPD1771-006 and generates signal beeps and programmed melodies
- Arithmetic processing unit, an optional device, that provides high performance fixed-and-floating-point arithmetic operations and floating-point trigonometric operations.

3.1 MOTHER BOARD/CARD CAGE INTERFACE

For a description of this interface, see Section 2.1.

Controller PCB

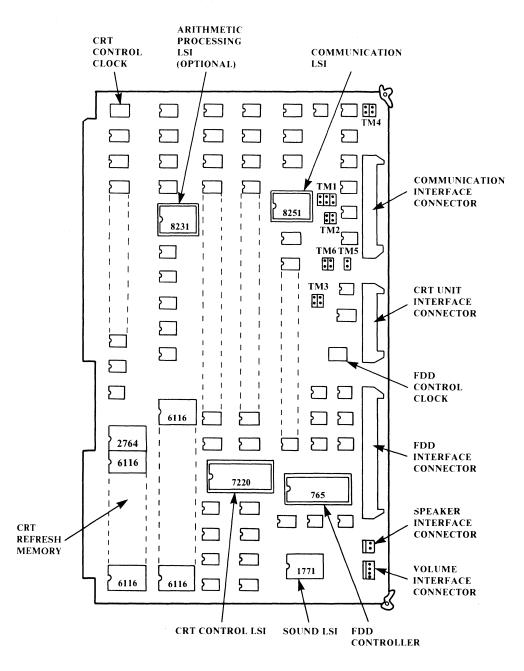


Figure 3-1 Controller PCB

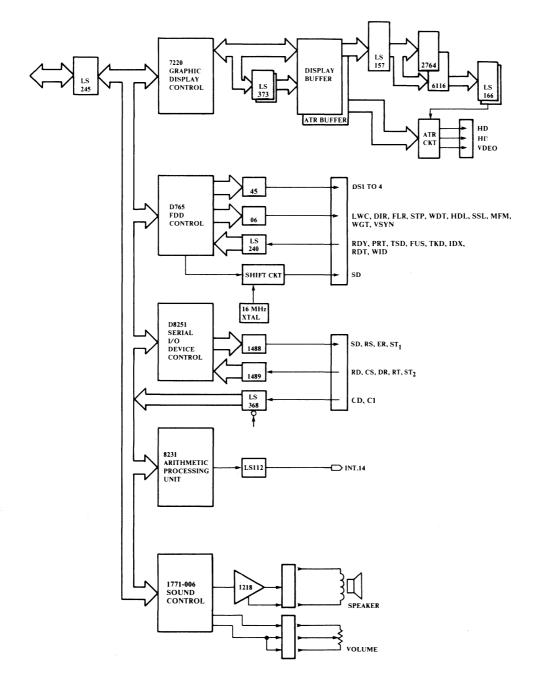


Figure 3-2 Controller PCB Block Diagram

3.2 CRT DISPLAY CONTROL

This adapter connects the microprocessor with a 12-inch monochrome or color display. At the heart of this computer-graphics system is the μ PD7220 Graphic Display Controller (GDC), an intelligent LSI microprocessor that carries out the high-speed and repetitive duties required to generate the raster display and manage the display memory. The GDC duties include

- Generating the basic video raster timing (including sync and blanking signals)
- Video-display-memory modification and data moves
- Calculating display-memory addresses.

Some characteristics of the CRT-control design are

- Display buffer is independent of system memory
- An 80-character by 25-line screen (2000 characters)
- A 26th line reserved for system status information
- Direct drive output
- An 8-dot by 19-dot character box
- A 7-dot by 11-dot character
- 8-dot by 16-dot special programmable characters.

A character generator supplies the video process logic with the information necessary for displaying the characters. Additionally, a special-character generator contains the fonts for user-programmable characters; these are 8 by 16 characters in 8 by 19 character boxes.

In the display-control adapter is a character-code buffer memory that stores character codes or special-character codes (each character has 1 of 256 codes in RAM or 250 codes in ROM, of which 6 in ROM are not assigned) and an attribute-code buffer memory that stores character attributes (each character is associated with one or more of eight attributes). Figure 3-3 shows the functional relationships between the principal components of CRT control.

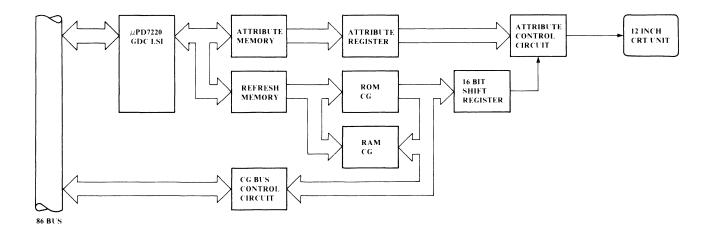


Figure 3-3 CRT Display Control Block Diagram

3.2.1 Display Buffer Memory

There are 2000 positions on the display screen, and each position is associated with 3 bytes (24 bits) of display buffer memory. Two of the three bytes of data indicate the character code or special-character code for an individual display position. A '1' in the character-set bit (Bit 7) indicates that the character comes from the special (or user programmed) character set (see Figure 3-4).

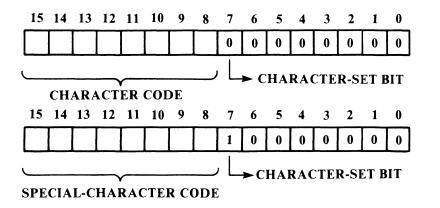


Figure 3-4 Character-Code Representation in the Character Code Buffer Memory

The character code (or special-character code) indicates to the character generator which of the 256 possible characters to display in a given display position. Also associated with each display position is an attribute code, which requires the third byte of data. The attribute code specifies the absence or presence of eight possible character supplements, which are shown in Table 3-1 and Figure 3-5.

ATTRIBUTE	FUNCTION	COMMENT
GR	Green	Must always equal '1' with monochrome display.
BU	Blue	Character is blue.
R∕H	Red∕ highlight	Red color (color display)/high- lighted character (monochrome).
RV	Reverse video	Character and Field Video transposed.
BL	Blinking	
VB	Vertical bar	
OB	Over-bar	
UB	Under-bar	
GR, R/H, and BU all equal '0'	Nullify (secret)	No character displayed.

 Table 3-1
 Attribute Description for Character Attribute Code

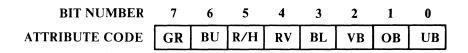


Figure 3-5 Bit Map for Character Attribute Code

Therefore, associated with each display position are a character code (or specialcharacter code) and an attribute code. Both codes are stored in different physical areas of the display buffer memory, which is separate from main memory and accessible to only the GDC. This buffer has four $2K \times 8$ -bit CMOS static RAMs for the character-code memory and two $2K \times 8$ -bit CMOS static RAMs for the attribute-code memory.

The logical arrangement of this buffer is seen as a single 4K x 24-bit storage area, with associated character codes and attribute codes logically concatenated into single 24-bit words. Specifically, for any given display unit, the bit address of its character code is identical to that of its attribute code except for Bit 12. Bit 12 is '0' for the character-code address and '1' for the attribute-code address. For example, character-code address '0000' is associated with attribute-code address '1000' because their addresses are identical except for Bit 12. Figure 3-6 is a memory map that shows the organization of the display buffer memory. Notice that Bit 12 determines whether an address accesses a character code (Bit 12=0) or a character attribute code (Bit 12=1).

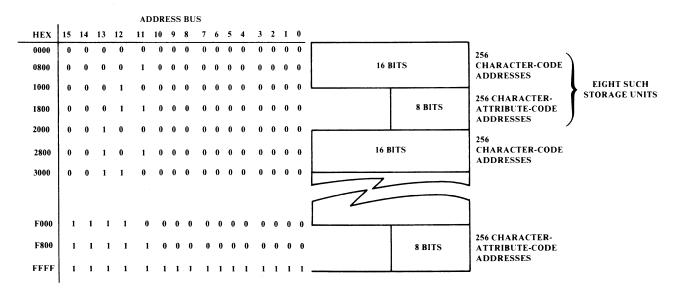


Figure 3-6 Display Buffer Memory Map

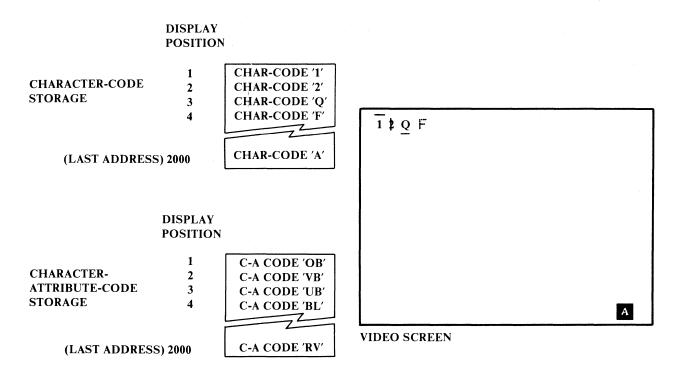


Figure 3-7 Relationship Between Character Code, Character-Attribute Code, Display Position, and Video Screen

3.2.2 Programming Considerations

The GDC has four registers, all of which can be accessed directly or indirectly by the 8086 processor: status register, First-In First-Out (FIFO), command register, and data register. The I/O addresses, functions, and bit maps are summarized in Table 3-2.

The status register is an 8-bit read-only register. Its I/O address is 80 (HEX). Using the 8086 I/O In command, the status register can be read at any time.

Figure 3-8 is a bit map of the GDC status register. Table 3-3 describes the contents of the status register.

I/O	READ/				BIT					
ADDRESS	WRITE	7	6	5	4	3	2	1	0	INSTRUCTION
 40	Read	L P	H B	V S	D M A	D W	F E	F F	D R	Read Status Register
40	Write	Р 7	Р 6	Р 5	Р 4	Р 3		Р 1	Р 0	Write Parameter Register
42	Read	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	Read Data Register
42	Write	C 7	C 6	C 5	C 4	C 3	C 2	C 1	C 0	Write Command Register
46	Write								C R T	Reset Interrupt Request

 Table 3-2
 GDC I/O-Address and Bit Map

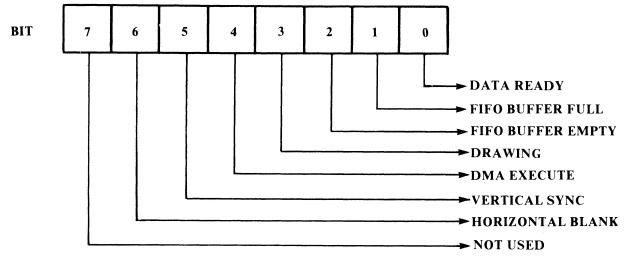


Figure 3-8 GDC Status Register Bit Map

BIT	DESCRIPTION
0	When this flag is a '1', it indicates that a byte is available to be read by the system microprocessor. This bit must be tested before each read operation. It drops to a '0' while the data is transferred from the FIFO into the microprocessor interface data register.
1	A'1' at this flag indicates a full FIFO in the GDC. A '0' ensures that there is room for at least one byte. This flag needs to be checked before each write into the GDC.
2	This bit and the FIFO-Full flag coordinate system microprocessor accesses with the GDC FIFO. When the bit is '1', the Empty flag ensures that the commands and parameters previously sent to the GDC have been processed.
3	While the GDC is drawing a graphics figure, this status bit is a '1'.
4	This bit is a 'l' during DMA data transfers.
5	Vertical retrace sync occurs while this flag is a '1'. The vertical sync flag coordinates display format modifying commands to the blanked interval surrounding vertical sync. This eliminates display disturbances.
6	A '1' value for this flag signifies that horizontal retrace blanking is currently underway.
7	Not used.

Table 3-3 Contents of the GDC Status Register

The FIFO is an internal buffer of the GDC that stores microprocessor commands. Access to the FIFO is coordinated through flags in the status register. The command processor fetches command bytes from the FIFO and interprets them. The command bytes are decoded and succeeding parameters are distributed to their proper destinations within the GDC. The command processor yields to the bus interface when both access the FIFO simultaneously. The Parameter RAM stores parameters that are used repetitively during the display and drawing processes.

Table 3-4 defines the GDC abbreviations and symbols. Table 3-5 lists and describes the GDC commands. Table 3-6 lists the command constants. The APC uses the GDC in Character Mode only.

SYMBOL	NAME	DESCRIPTION			
A0 TO A15	Address 0 to Address 15	Controls display position of cursor.			
BLD	Blinking Disable	Cursor blinks (BLD = 0) or does not blink (BLD = 1).			
BL	Blinking Rate	Controls frequency of blinking.			
CF1	Cursor Finish	Controls at which line the cursor finishes.			
CHR	Character Mode	Character Mode (CHR) and Graphic Mode (G) define the display modes as follows:			
		CHRGMode00Character Mode 010Character Mode 101Not Used			
CIR	Circle	Indicates that a circle is being drawn if $CIR = 1$.			
CSR	Display Cursor	Controls presence (CSR = 1) or absence (CSR = 0) of the cursor.			
CST	Cursor Start	Controls at which line the cursor starts.			
C/R	Character Per Row	Defines horizontal display period.			

Table 3-4GDC Symbols

SYMBOL	NAME	DESCRIPTION		
DE	Display Enable	Controls display start ($DE = 1$) or display stop ($DE = 0$).		
DIR	Direction	Controls drawing direction.		
D	Dynamic RAM	D = 1 implies display buffer consists of dynamic RAM; otherwise ($D = 0$) consists of static RAM.		
F	Flashless Mode	Controls for flashless drawing $(F = 1)$ or flashing drawing $(F = 0)$.		
G	Graphic Mode	Not used; see CHR.		
НВР	Horizontal Back Porch	Defines the amount of left horizontal blanking time.		
HFP	Horizontal Front Porch	Defines the amount of right horizontal blanking time.		
HOS	Horizontal Sync	Horizontal sync occurs when $HOS = 1$.		
I	Interlace	Display is interlaced $(I = 1)$ or not inter- laced $(I = 0)$.		
LIN	Line	LIN = 1 indicates that line is being drawn.		
L/F	Lines Per Frame	Defines the number of lines in the vertical display period.		
L/R	Lines Per Row	L/R defines the number of lines in each row.		
М	Master	M = 0 indicates GDC is in multi (slave)- mode; $M = 1$ indicates single (master)- mode. The APC only uses master mode.		

 Table 3-4
 GDC Symbols (cont'd)

SYMBOL	NAME	DESCRIPTION
MOD	Modify	Controls data that is accessed by CODEW command or CODER command.
RAD	RAM Address	RAD defines the RAM address that stores the scroll address.
REC	Rectangle	REC = 1 indicates that a rectangle is being drawn.
S	Shrink	Affects line center $(S = 1)$.
SL0 to SL9	Scroll Line	Controls scroll-line count.
SLA	Slant	Controls slant of text or drawing.
VBP	Vertical Back Porch	Defines the amount of upper vertical blanking time.
VES	Vertical Sync	Vertical sync occurs when $VES = 1$.
VFP	Vertical Front Porch	Defines the amount of lower vertical blanking time.

Table 3-4 GDC Symbols (cont'd)

DATA BUS DATAMETERREMARKSD7D6D5D4D3D2D1D0REMARKSC0000111DE oSets parameters for synchronization of signals.P100C/RF1DGSP2 $-C/R$ HS $-C/R$ Sets parameters for synchronization of signals.P3 $-VSL$ $-C/R$ HSSets parameters for synchronization of signals.P4 $-HFP$ $-VSL$ $-C/R$ HSSets parameters for synchronization of signals.P60 0 C/R HBP $-VSL$ Sets parameters for signals.P60 0 $-VSL$ $-VFP$ $-VSL$ $-VSL$ Sets parameters for signals.P60 0 $-VSL$ $-VFP$ $-VSL$ $-VSL$ Sets parameters for signals.P60 0 $-VSL$ $-VFP$ $-VSL$ $-VSL$ $-VSL$ $-VSL$ P7 $-VFP$ $-VFP$ $-VFP$ $-VFP$ $-VFP$ $-VFP$ $-VFP$ $-VFP$ $-VFP$ P8 $-VSEP$ $-VFP$ C00000000000 $-VFP$			T
PARAMETER D7 D6 D5 D4 D3 D2 D1 D0 REMARKS C 0 0 0 0 1 1 1 DE Sets parameters for synchronization of signals. P1 0 0 C/R F 1 D G S P3 VSL C/R HB	COMMAND/	DATA BUS	
C000111DEsynchronization of signals.P100CHRFIDGSP3 \leftarrow VSLHS \leftarrow VSLHS \leftarrow Signals.P3 \leftarrow VSLHS \leftarrow VSLSignals.Signals.P4 \leftarrow HFP \leftarrow VSL \leftarrow VSL \leftarrow VSL \leftarrow VSLP500 \leftarrow VFP \leftarrow VSL \leftarrow VSLP600 \leftarrow VFP \leftarrow VSLSelects master or slave video synchronization mode.P8 \leftarrow VBP \leftarrow L/F \leftarrow VSLSelects master or slave video synchronization mode.C0111IC00000C00000DISP START C00011C000110C000110C000110C000110C000110C000110C000110C000110C000110C000110C01001	PARAMETER		REMARKS
P1 P2 P300CHRFIDGSP3 P4 \leftarrow VSL \leftarrow HS \leftarrow HS \leftarrow HS \leftarrow Signals.P4 P5 P6 \leftarrow VSL \leftarrow HS \leftarrow VSH \leftarrow VSH \leftarrow VSHP5 P6 0 \leftarrow UF \leftarrow L/F \leftarrow VSH \leftarrow VSHP6 P7 P7 \leftarrow VBP \leftarrow L/F \leftarrow Selects master or slave video synchronization mode.C 0 1 1 0 1 1 C 0 0 0 0 0 0 C 0 0 0 0 0 0 C 0 0 0 0 0 0 C 0 1 1 0 1 1 C 0 0 0 1 1 0 C 0 0 0 1 1 0 DISP START C 0 0 0 1 1 C 0 0 0 1 1 0 DISP STOP C 0 0 0 1 1 C 0 0 0 1 1 0 C 0 1 0 0 1 0 C 0 1 0 0 1 0 C 0 0 0 1 1 0 C 0 0 0 1 0 0 C 0 0 0 1 0 0 <td></td> <td>SYNC SET</td> <td>Sets parameters for</td>		SYNC SET	Sets parameters for
P2 P3 C/R C/R C/R C/R C/R P3 P4 VSL HS HS VSH O O VSH O P5 P6 P7 P7 P8 C O O VFP VFP VFP VFP P7 P8 C O I/F L/F $Selects$ master or slave video synchronization mode.C O I/F I/F I/F $Selects$ master or slave video synchronization mode.C O O O O O O O O C O O O O O O O O O C O C O C O C O C O C O C O C O O O O O O O	C	0 0 0 0 1 1 1 DE	
P3 P4 \leftarrow VSLHS \leftarrow HFPP5 P600 \leftarrow HBP \lor VFPP7 P8 \leftarrow VBP L/F C011011MC011011MC0000000C0000000C0000000C011011C000110DISP START C00011C000110DISP START C00011C000110DISP STOP C00011C010011C010011C010011C010011C010011PCSR W Sets the position of the cursor in display memory.		0 0 CHR F I D G S	signals.
P4 P5 \leftarrow HFP 0 \vee VSH \rightarrow VFP \rightarrow \downarrow L/FSelects master or slave video synchronization mode.C011011MC011011MC0000000C0000000C0000000C011011C0001101C0001101C0001101C0001100C0001100C0001100C0100110P	P2		
P5 P6 P7 P80 0 $-L/F$ HBP $-VBP$ Selects master or slave video synchronization mode.C011011MC011011MC0000000C0000000C0000000C011011C000110C000110C000110C000110C000110C000110C000110C010011P-ZR-ZW-Stops the display scanning process.C010011P1A7A6A5A4A3A2A1A0010011C01001C010011C010010C010011 <td></td> <td>←VSL───HS ───</td> <td></td>		←VSL───HS ───	
P7 P8 L/F L/F Selects master or slave video synchronization mode.C011011MC00000000C00000000C00000000C0110111C0110111C0001101C0001101C0001101C0001100C0001100C0001100C0100110P $\frac{ZOOM W}{-ZR - ZW - ZW ZW $		←HFP>VSH>	
P7 P8 L/F L/F Selects master or slave video synchronization mode.C011011MC00000000C00000000C00000000C0110111C0110111C0001101C0001101C0001101C0001100C0001100C0001100P $\frac{ZOOM W}{-ZR - ZW - ZWStops the displayscanning process.Secifies zoom coefficients for the displayand graphics-character writing.C0100110P1A7A6A5A4A3A2A1A0$		$0 \qquad 0 \longleftarrow HBP \longrightarrow$	
P8 \checkmark VBP $L/F \rightarrow$ C011011MC011011MC0000000C0000000C0110111C0110111C0000111C0001101C0001101C0001101C0001100C0001100C0001100P $\frac{ZOOM W}{-ZR - ZW -$		$0 \qquad 0 \longleftarrow VFP \longrightarrow$	
C011011MSelects master or slave video synchronization mode.C00000000000C000000000000C01101011MSelects master or slave video synchronization mode.C00000000000C0110111MSelects master or slave video synchronization mode.C0110000000C0110111MSelects master or slave video synchronization mode.C011010111C0001101C0001100C0001100P0100110C0100110P1A7A6A5A4A3A2A1A0		<l f►<="" td=""><td></td></l>	
C0110111Mvideo synchronization mode.C00000000000C01100000000C011010111Mvideo synchronization mode.C00000000000C0110111Mvideo synchronization mode.C01101011Mvideo synchronization mode.C01101011Mvideo synchronization mode.C01101011MResets the GDC to its idle state and specifies video-display format.C0110111MStarts the display scanning process.C00001100110P0100110011P1A7A6A5A4A3A2A1A0Memory.	P8	\leftarrow VBP \longrightarrow L/F \rightarrow	
C0110111Mvideo synchronization mode.C00000000000C01100000000C011010111Mvideo synchronization mode.C00000000000C0110111Mvideo synchronization mode.C01101011Mvideo synchronization mode.C01101011Mvideo synchronization mode.C01101011MResets the GDC to its idle state and specifies video-display format.C0110111MStarts the display scanning process.C00001100110P0100110011P1A7A6A5A4A3A2A1A0Memory.			
C000000000C0000000000C011010111C00001111C00001111C00001101C0001101C0001100C0001100C0100110P $\mathcal{C}R$ $\mathcal{C}R$ $\mathcal{C}RW$ Specifies zoom coefficients for the display and graphics-character writing.C0100101P1A7A6A5A4A3A2A1A0			
C000000000C011010111C01101011C00001101C00001101C00001101C0001100C0001100C0001100P $\frac{ZOOM W}{4ZR}$ $\frac{ZOOM W}{2W}$ Specifies zoom coefficients for the display and graphics-character writing.C010011P $\frac{CSR W}{47}$ $\frac{CSR W}{47}$ Sets the position of the cursor in display memory.	C	0 1 1 0 1 1 1 M	
C000000000C01101011Starts the display scanning process.C000011011C00001101C00001101C00001100C00001100C01001100C01001100P \mathcal{ZR} $\mathcal{ZOOM W}$ Stops the display scanning process.C010011O100110P \mathcal{ZR} \mathcal{ZR} \mathcal{ZW} \mathcal{ZW} Stops the display and graphics- character writing.C01001001P1A7A6A5A4A3A2A1A0			mode.
C000000000C01101011Starts the display scanning process.C000011011C00001101C00001101C00001100C00001100C01001100C01001100P \mathcal{ZR} $\mathcal{ZOOM W}$ Stops the display scanning process.C010011O100110P \mathcal{ZR} \mathcal{ZR} \mathcal{ZW} \mathcal{ZW} Stops the display and graphics- character writing.C01001001P1A7A6A5A4A3A2A1A0		DECET	
CDISP START 0Starts the display format.C011011C0001101C0001101C0001101C0001100C0001100C0100110P $\overbrace{-ZR}^{-}$ $\overbrace{-ZW}^{-}$ $\overbrace{-ZW}^{-}$ Stops the display scanning process.C0100110P $\overbrace{-ZR}^{-}$ $\overbrace{-ZW}^{-}$ $\overbrace{-ZW}^{-}$ Specifies zoom coefficients for the display and graphics-character writing.C0100101P1A7A6A5A4A3A2A1A0	C		
C01101011Starts the display scanning process.C000011011C00001101C00001101C00001100C00001100P $\frac{ZOOM W}{-ZR - ZW -$	C		
C01101011scanning process.C000011011C00001101C00001100C00001100C01001100C01001100P $\frac{ZR}{4}$ $\frac{ZOOM}{2}$ $\frac{ZOOM}{2}$ Specifies zoom coefficients for the display and graphics-character writing.C01001001P $\frac{CSR}{4}$ $\frac{CSR}{4}$ $\frac{CSR}{4}$ $Sets the position of the cursor in display memory.P1A7A6A5A4A3A2A1A0memory.$			video-display format.
C01101011scanning process.C000011011C00001101C00001100C00001100C01001100C01001100P $\frac{ZR}{4}$ $\frac{ZOOM}{2}$ $\frac{ZOOM}{4}$ Specifies zoom coefficients for the display and graphics-character writing.C01001001P $\frac{CSR}{4}$ $\frac{CSR}{4}$ $\frac{CSR}{4}$ $Sets the position of the cursor in display and graphics-character writing.P1A7A6A5A4A3A2A1A0memory.$		DISDSTADT	Starts the display
CDISP START 001C00011DISP STOP 00011C00011C00011O10011C01001P \checkmark ZR \checkmark ZWSpecifies zoom coefficients for the display and graphics-character writing.C01001P \checkmark ZRCSR W A7Sets the position of the cursor in display memory.	C		
C0001101C00001101C00001100C01001100P $\mathcal{Z}R$ $\mathcal{Z}R$ $\mathcal{Z}W$ $\mathcal{Z}W$ Specifies zoom coefficients for the display and graphics-character writing.C01001001P1A7A6A5A4A3A2A1A0	C		scanning process.
C0001101C00001101C00001100C01001100P $\mathcal{Z}R$ $\mathcal{Z}R$ $\mathcal{Z}W$ $\mathcal{Z}W$ Specifies zoom coefficients for the display and graphics-character writing.C01001001P1A7A6A5A4A3A2A1A0		DISP START	
CDISP STOP 0Stops the display scanning process.C0001100C01001100P \checkmark ZR \checkmark ZRZW \checkmark Specifies zoom coefficients for the display and graphics- character writing.C0100110P1A7A6A5A4A3A2A1A0	С		
C0001100C01001100P \checkmark ZR \checkmark ZW \checkmark Specifies zoom coefficients for the display and graphics-character writing.C0100100C0100101P1A7A6A5A4A3A2A1A0			
C0001100scanning process.C01001100Specifies zoom coefficients for the display and graphics-character writing.P \sim ZR \sim ZRZW \sim CSR WSets the position of the cursor in display and graphics-character writing.C01001001P1A7A6A5A4A3A2A1A0		DISP STOP	Stops the display
C0100110P \checkmark ZR \checkmark ZW \checkmark ZWSpecifies zoom coefficients for the display and graphics-character writing.C0100101P1A7A6A5A4A3A2A1A0	С	0 0 0 0 1 1 0 0	
C0100110cients for the display and graphics- character writing.P \checkmark ZR \checkmark ZW \checkmark cients for the display and graphics- character writing.C0100101P1A7A6A5A4A3A2A1A0			
C0100110cients for the display and graphics- character writing.P \checkmark ZR \checkmark ZW \checkmark ZW \sim cients for the display and graphics- character writing.C010010P1A7A6A5A4A3A2A1A0		ZOOM W	Specifies zoom coeffi-
P \leftarrow ZRZWand graphics- character writing.CSR WSets the position of the cursor in display P1Sets the position of the cursor in display memory.		0 1 0 0 0 1 1 0	
CCSR WSets the position of the cursor in displayP1A7A6A5A4A3A2A1A0memory.	Р	$\checkmark ZR \longrightarrow \checkmark ZW \longrightarrow$	and graphics-
C 0 1 0 1 0 1 the cursor in display P1 A7 A6 A5 A4 A3 A2 A1 A0 memory.			
C 0 1 0 1 0 1 the cursor in display P1 A7 A6 A5 A4 A3 A2 A1 A0 memory.			
P1 A7 A6 A5 A4 A3 A2 A1 A0 memory.			
P2 A15 A14 A13 A12 A11 A10 A9 A8			memory.
	P2	A15 A14 A13 A12 A11 A10 A9 A8	

Table 3-5 GDC Commands

ſ		
COMMAND/	DATA BUS	
PARAMETER	D7 D6 D5 D4 D3 D2 D1 D0	REMARKS
C P1 P2 P3	$CSR DISP$ $0 1 0 0 1 0 1 1$ $CSR 0 0 \longleftarrow L/R \longrightarrow BL \square BL BL$	Specifies the height of the cursor and the character row.
C P1 P2 P3 P4 P5 P6 P7 P8	SCROLL W 0 1 1 — RA A7 A6 A5 A4 A3 A2 A1 A0 A15 A14 A13 A12 A11 A10 A9 A8 SL3 SL2 SL1 SL0 0 0 0 0 0 IM SL9 SL8 SL7 SL6 SL5 SL4 A7 A6 A5 A4 A3 A2 A1 A0 0 IM SL9 SL8 SL7 SL6 SL5 SL4 A7 A6 A5 A4 A3 A2 A1 A0 A15 A14 A13 A12 A11 A10 A9 A8 SL3 SL2 SL1 SL0 0 0 0 0 0 0 IM SL9 SL8 SL7 SL6 SL5 SL4	Specifies parameters for scroll: defines the starting addresses and lengths of the display areas and specifies the eight bytes for the graphics character.
C P1 P2	CODEW 0 0 1 0 0 ● MOD → C7 C6 C5 C4 C3 C2 C1 C0 C15 C14 C13 C12 C11 C10 C9 C8	Writes the character- code data into the display memory.
C Pl	LOW BYTE CODEW 0 0 1 1 0 0 ← MOD→ C7 C6 C5 C4 C3 C2 C1 C0	Writes the low-order byte of the character-code data into the display memory.
C P1	HIGH BYTE CODEW 0 0 1 1 1 0 ←MOD→ C15 C14 C13 C12 C11 C10 C9 C8	Writes the high-order byte of the character code data into the display memory.

 Table 3-5
 GDC Commands (cont'd)

	· ·								
COMMAND/				ATA B					
PARAMETER	D7	D6	D5	D4	D3	D2	D1	D0	REMARKS
C P1	0 P7	1 P6	0 P5	PITC 0 P4	CH W 0 P3	1 P2	1 P1	1 P0	Specifies the width of the X dimension of the display memory.
				MAS	SK W				Sets the mask
С	0	1	0	0	1	0	1	0	register contents.
P1	MA7	MA6	MA5	MA4	MA3	MA2	MAI	MA0	
P2	MA15	MA14	MA13	MA12	MA11	MA10	MA9	MA8	
					CT W				Vector parameters
С	0	1	0	0	1	1	0	0	set: specifies the
P1	SL	R	С	Т	L	-	-DIR-		parameters for the
P2	DC7	DC6	DC5	DC4	DC3	DC2		DC0	drawing processor.
P3			DC13				DC9	DC8	
P4	D7	D6	D5	D4	D3	D2	DI	D0	
P5			D13	D12	D11	D10	D9	D8	
P6	D27	D26	D25	D24	D23	D22	D21	D20	
P7			D213	D212	D211	D210	D29	D28	
P8	D17	D16	D15	D14	D13	D12	D11	D10	
P9			D113	D112	D111	D110	D19	D18	
P10	DM7	DM6	DM5	DM4	DM3	DM2	DM1	DM0	
P11		/	DM13	DM12	DM11	DM10	DM9	DM8	
С	1	0	v 1	VORD	CODE 0	CR 0 -	← M0	DD≁	Reads the character-code data from the display
С	1	0	LO' 1	W BYT 1	E COI 0	DER 0	← M(D►	Reads the low- order byte of the character-code data from the display
									memory.

 Table 3-5
 GDC Commands (cont'd)

r.

COMMAND/			DATA BUS	
PARAMETER	D7	D6	D5 D4 D3 D2 D1 D0	REMARKS
С	1	0	HIGH BYTE CODER 1 1 1 0 ← MOD→	Reads the high- order byte of the character-code data from the display memory.
С	1	1	CSR R 1 0 0 0 0 0	Reads the display position of the cursor
С	0	0	WORD DREQW 1 0 0 1 \leftarrow MOD \succ	Requests a DMA write transfer for the entire word.
С	0	0	LOW BYTE DREQW 1 1 0 1 ← MOD →	Requests a DMA write transfer for the low-order byte only.
С	0	0	HIGH BYTE DREQW 1 1 1 1 ← MOD→	Requests a DMA write transfer for the high-order byte only.
С	1	0	WORD DREQR 1 0 0 1 \leftarrow MOD \rightarrow	Requests a DMA read transfer for the entire word.
С	1	0	LOW BYTE DREQR 1 1 0 1 ≪ MOD→	Requests a DMA read transfer for the low-order byte only.
С	1	0	HIGH BYTE DREQR 1 1 1 1 ← MOD→	Requests a DMA read transfer for the high-order byte only.

 Table 3-5
 GDC Commands (cont'd)

COMMAND/ PARAMETER	SETTING VALUE (HEX)	REMARKS
С	SYNCSET	Character display mode '0': no
P1	10	interlace, flashless drawing, static
P2	4E	RAM, 80 characters per row
P3	52	, i
P4	0E	
P5	06	
P6	13	
P7	EE	
P8	45	
С	Master/slave	Master versus slave video synchronization
C P1	ZOOM W 00	Zooming disabled
C P1 P2 P3	CSR DISP 12 C1 8B	Blinking block cursor
C P1	PITCH W 50	80 characters per row
C P1 P2	MASK W FF FF	

 Table 3-6
 GDC Command Constants

3.3 CRT DISPLAY UNIT

The CRT Display unit consists of a chassis-mounted circuit, a 12-inch monochrome or color CRT Display, Controller PCB, and internal power unit.

The monochrome or color display units connect to the Controller PCB (see Figures 3-9 and 3-10).

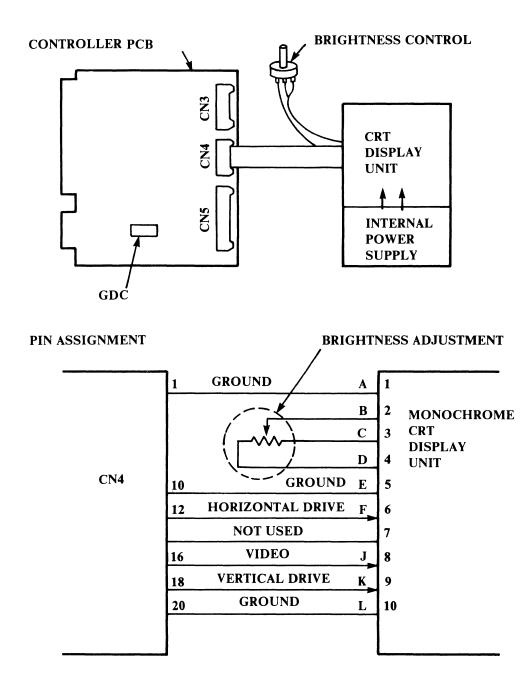
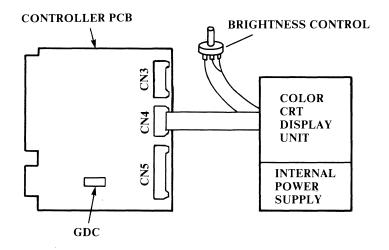


Figure 3-9 Monochrome-CRT Display Interface



PIN ASSIGNMENT

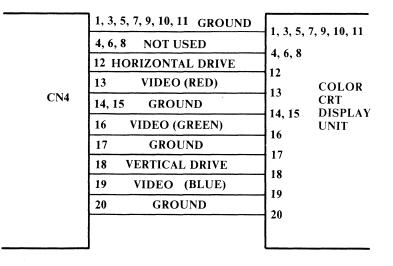


Figure 3-10 Color-CRT Display Interface

Another internal cable, the power supply cable, carries 115 Vac power from the system power supply to the internal power supply of the CRT Display. This internal power unit provides the CRT Display with +12 Vdc.

The following items are the principal operating characteristics of the monochrome CRT Display.

- *Display control*. A brightness control knob is available to the operator on the front of the unit.
- Monochrome Display screen. The Monochrome CRT Display employs a yellow-green, long-persistence phosphor (P39) and has a reduced-glare surface. The display format is 80 characters wide by 25 lines high plus one status line. Each standard character consists of a 7 (width)-by-11 (height) dot matrix. Special characters can be as large as 8-by-16 dots. The screen is composed of 475 lines of vertical resolution.
- Color Display screen. The Color Display has an 8-color, high-resolution, reduced-glare screen.
- *Horizontal drive*. This positive level, TTL compatible frequency is 22.727 kHz. The minimum pulse width is $3 \mu s$.
- Vertical drive. This frequency is 41.5 Hz and is negative level/TTL compatible.
- *Video signal*. The video signal is positive level with a 50-ns minimum pulse width.
- CRT Display interface.

3.4 FLEXIBLE DISK DRIVE CONTROLLER

The APC has space and power for two 8-inch FDDs. The drives are soft-sectored and two-sided, with 77 cylinders (0 to 76). They use Modified Frequency Modulation (MFM) coded in 256 byte sectors (except index track), giving an unformatted capacity of about 1.2 MB per drive. They have a track access time of 5 ms.

The 8-inch Flexible Disk Drive Controller (FDC) on the Controller PCB attaches to the FDD with an internal flat cable, which is daisy-chained if there are two FDDs.

The FDC is designed for double-density MFM-coded drives, uses write precompensation, and employs the NEC μ PD765. The FDC uses DMA for record-data transfers. An interrupt level indicates completed operation or a status condition that requires processor attention.

Figure 3-11 is a functional block diagram of the FDC. This controller contains two registers that can be accessed by the main processor: a status register and a data register. The 8-bit main status register contains the status information of the FDC and can be accessed at any time. This register facilitates the transfer of data between the processor and FDC. It can be read only. Table 3-7 summarizes the bit functions of the main status register.

The 8-bit data register (which actually consists of several registers in a stack with only one register presented to the data bus at a time) stores data, commands, parameters, and FDD status information. Data bytes are written into the data register to program the FDC and are read out of it to obtain results after a command.

The FDC can perform 15 different commands. Each command is initiated by a multibyte transfer from the processor, and the result after execution of the command can also be a multibyte transfer back to the processor. Because of this multibyte interchange of information between the FDC and the processor, each command can be considered in three phases.

- *Command Phase* The FDC receives all information required to perform a particular operation from the processor.
- *Execution Phase* The FDC performs the operation.
- *Result Phase* Status and other housekeeping information are made available to the processor.

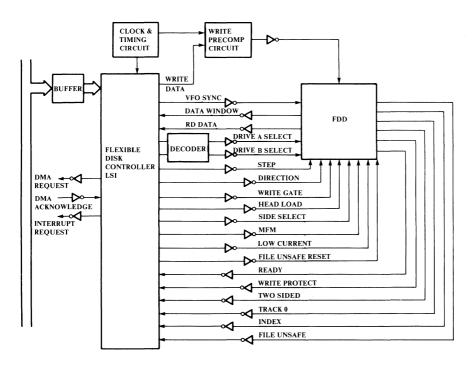


Figure 3-11 FDC Block Diagram

BIT NUMBER	NAME	SYMBOL	DESCRIPTION
DB0	FDD A Busy	DAB	FDD A is in the Seek Mode.
DB1	FDD B Busy	DBB	FDD B is in the Seek Mode.
DB2	FDD C Busy	DCB	Not used.
DB3	FDD D Busy	DDB	Not used.
DB4	FDC Busy	СВ	A read or write command is in process.
DB5	Non-DMA Mode	NDM	The FDC is in the Non-DMA Mode.
DB6	Data Input/ Output	DIO	Indicates direction of data transfer between the FDC and the proces- sor. $DIO = '1'$ indicates transfer is from FDC data register to the processor; $DIO = '0'$ indicates transfer is from processor to FDC data register.
DB7	Request for Master	RQM	Indicates Data Register is ready to send or receive data to or from the processor. Both bits DIO and RQM should be used to perform the handshaking functions of "ready" and "direction" to the processor.

Table 3-7 Bit Description of the FDC Main Status Register

Figure 3-12 is a timing diagram that defines the timing of this three-phase command process.

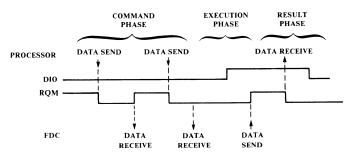


Figure 3-12 FDC Timing Diagram

3.4.1 Programming Considerations

Table 3-8 defines the symbols used in the FDC command summary given in Table 3-9. Tables 3-10, 3-11, 3-12 and 3-13 define the bit functions of the command status registers. Table 3-14 lists the I/O addresses and functions of the FDC registers.

SYMBOL	NAME	DESCRIPTION
A0	Address Line 0	Controls the selection of the Main Status Register (A0=0) or Data Register (A0=1).
С	Cylinder Number	Specifies the selected cylinder number.
D	Data	Specifies the data pattern that is going to be written into a sector.
D7 to D0	Data Bus	8-bit Data Bus, where D7 is the most significant bit, and D0 is the least significant bit.
DTL	Data Length	When N is defined as 00, DTL is the data length that users are going to read out or write into the sector.
ЕОТ	End of Track	Indicates the final sector number on a cylinder.

 Table 3-8
 FDC Symbols

SYMBOL	NAME	DESCRIPTION
GPL	Gap Length	Specifies length of Gap 3 (spacing between sectors excluding VCO Sync. Field).
н	Head Address	Specifies the head number 0 or 1, as specified in the ID field.
HD	Head	Specifies the selected head number 0 or 1. ($H = HD$ in all command words.)
HLT	Head Load Time	Indicates the head load time in the FDD (2 to 256 ms in 2-ms increments).
HUT	Head Unload Time	Indicates the head unload time after a read or write operation has occurred (0 to 240 ms in 16-ms increments).
MF	FM or MFM Mode	If MF is Low, FM Mode is selected; if High, MFM Mode is selected only if MFM is implemented.
МТ	Multi-Track	If MT is High, a multitrack operation is to be performed. (A cylinder under both HD0 and HD1 is read or written.)
Ν	Number	Specifies the number of data bytes writ- ten in a sector.
NCN	New Cylinder Number	New cylinder number, which is going to be reached as a result of the Seek opera- tion. Desired position of head.
ND	Non-DMA Mode	Signals that operation is Non-DMA Mode.
PCN	Present Cylinder Number	Designates cylinder number at the completion of Sense Interrupt Status Command, indicating the position of the head at present time.

Table 3-8 FDC Symbols (cont'd)

SYMBOL	NAME	DESCRIPTION
R	Record	Specifies the sector number, which is read or written.
R/W	Read/Write	Specifies the Read (R) or Write (W) signal.
SC	Sector	Indicates the number of sectors per cylinder.
SK	Skip	Specifies the Skip Deleted Data Address Mark.
SRT	Step Rate Time	Specifies the Stepping Rate for the FDD (1 to 16 ms in 1-ms increments).
ST 0 ST 1 ST 2 ST 3	Status 0 Status 1 Status 2 Status 3	Specifies which of four registers will store the status information after a command has been executed. This information is available during the result phase after command execution. These registers should not be confused with the main status register (selected by $A0 = 0$). ST 0 to 3 can be read only after a command has been executed. They contain information relevant to that particular command.
STP	Scan Test	During a Scan operation, if $STP = 1$, the data in contiguous sectors is compared byte by byte with data sent from the processor (or DMA). If $STP = 2$, then alternate sectors are read and compared.
US0, US1	Unit Select	Specifies the selected drive number.

Table 3-8 FDC Symbols (cont'd)

	READ/				DA	ΓΑ Β	US			
PHASE	WRITE	D7	D6	D5	D4			Dl	D0	REMARKS
Command	W W W W W W	MT X	MF X	SK X	(D DA 0 X C H R N EOT GPL DTL	ATA 1 HD	l USI	0 US0	Command Codes Sector ID information prior to Command execution
Execution										Data transfer between the FDD and main system
Result	R R R R R R				1	ST0 ST1 ST2 C H R N				Status information after Command execution Sector ID information after Command execution
Command	W W W W W W W	MT			0 X H	LETE 1 X C H R N EOT GPL DTL	D DA l HD	TA 0 US1	0 US0	Command Codes Sector ID information prior to Command execution
Execution										Data transfer between the FDD and main system
Result	R R R R R R				:	ST0 ST1 ST2 C H R N				Status information after command execution Sector ID information after command execution
$X = Don^3$	t care.									

Table 3-9 FDC Commands

	READ/				DATA				
PHASE	WRITE	D7	D6	D5	DATA D4 D		D1	D0	REMARKS
Command	* * * * * * * * * * * * *	MT X	MF X	0 X	WRITE I 0 0 X X C H R N EOT GPI DTI	1 HD	0 US1	l USO	Command Codes Sector ID information to command execution
Execution									Data transfer between the main system and FDD
Result	R R R R R R				ST0 ST1 ST2 C H R N				Status information after command execution Sector ID information after command execution
Command	W W W W W W W W	MT X	MF X	VRIT 0 X	E DELET 0 1 X X C H R N EOT GPL DTI	0 HD	ATA 0 US1	l USO	Command Codes Sector ID information prior to command execution
Execution									Data transfer between FDD and main system
Result X = Don't	R R R R R R				ST0 ST1 ST2 C H R N				Status ID information after command execution Sector ID information after command execution

Table 3-9 FD	C Command	s (cont'd)
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	READ/				DA	TA BI	JS			
PHASE	WRITE	D7	D6	D5	D4	D3	D2	D1	D0	REMARKS
Command	W W W W W W W	0 X	MF X	R SK X	0 X	A TR 0 X C H R N EOT GPL DTL	ACK 0 HD	l USI	0 US0	Command Codes Sector ID information prior to command execution
Execution										Data transfer between the FDD and main system. FDD reads all of cylinders contents from index hole to EOT.
Result	R R R R R R R					ST0 ST1 ST2 C H R N				Status information after command execution Sector ID information after command execution
Command	w w	0 X	MF X	0 X	RE 0 X	AD II 1 X	D 0 HD	l US1	0 US0	Command Codes
Execution										The first correct ID information on the cylinder is stored in data register
Result	R R R R R R R					ST0 ST1 ST2 C H R N				Status information after command execution Sector ID information during execution phase
X = Don't	care.									

Table 3-9 FDC Commands ((cont'd)	
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PHASE	READ/ WRITE	D7	D6	D5	DAT D4		US D2	D1	D0	DEMARKS
гпазе	WRITE	D/	D0	05	D4	D3	D2		D0	REMARKS
Command	W W W W W	0 X	MF X	F0 0 X	0 X		RACK 1 HD	0 US1	0 US0	Command Codes Bytes/Sector Sector/Track Gap 3 filler byte
Execution										FDC formats an entire cylinder
Result	R R R				:	STO ST1 ST2				Status information after command execution
	R R R R					C H R N				In this case, the ID information has no meaning
Command	W W W W W W W	MT X	MF X	SK X	(EQU 0 X C H R N EOT GPL STP	JAL 0 HD	0 US1	1 US0	Command Codes Sector ID information prior to command execution
Execution										Data compared between the FDD and main system
Result	R R R R R R R				5	ST0 ST1 ST2 C H R N				Status information after command execution Sector ID information
X = Don't	care.									

 Table 3-9
 FDC Commands (cont'd)

	READ/				DA	ΓΑ ΒΙ	US			
PHASE	WRITE	D7	D6	D5	D4	D3	D2	D1	D0	REMARKS
				SCAN	N LOY	W OR	EQU	AL		
Command	W	MT	MF	SK	1	1		0	1	Command Codes
	W W	X	Х	Х	Х	X C	HD	USI	US0	Santian ID information
	W					Н				Section ID information prior to command
	W					R				execution
	W W				1	N EOT				
	W					GPL				
	W					STP				
Execution										Data compared between the FDD and main system
Result	R R R					STO ST1 ST2				Status information after command execution
	R					C				Sector ID information
	R					H				after command
	R R					R N		•		execution
Command	w	МТ	MF	SCAN SK	HIG	н Он 1	R EQU	AL 0	1	Command Codes
	W	X	X	X	x	Х	HD	USI	US0	
	W W					C H				Sector ID information prior to command
	w					R				execution
	W					N				
	W W					EOT GPL				
	w					STP				
Execution										Data compared between the FDD and main system
Result	R R					STO ST1				Status information after command execution
	R R					ST1				command execution
	R					С				Sector ID information
	R R					H R				after command execution
	R					к N				execution
X = Don'	t care.	•								

Table 3-9	FDC	Commands	(cont'd)
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·			
PHASE	READ/ WRITE	DATA BUS D7 D6 D5 D4 D3 D2 D1 D0	REMARKS
Command Execution No Result	W W	RECALIBRATE 0 0 0 1 1 1 X X X X 0 US1 US0	Command Codes Head retracted to track 0
Phase Command Result	W R R	SENSE INTERRUPT STATUS 0 0 0 0 1 0 0 0 ST0 PCN	Command Code Status information about the FDD at the end of seek operation
Command No Result Phase	W W W	SPECIFY 0 0 0 0 1 1 SRT SRT HUT HUT HUT HLT ND ND	Command Codes
Command Result	W W R	SENSE DRIVE STATUS 0 0 0 0 0 1 0 0 X X X X X HD US1 US0 ST3	Command Codes Status information about FDD
Command Execution	W W W	SEEK 0 0 0 0 1 1 1 1 X X X X X HD US1 US0 NCN	Command Codes Head is positioned over proper cylinder on
No Result Phase Command	W	INVALID Invalid Codes	diskette Invalid command codes (NoOp - FDC goes into
$\frac{\text{Result}}{X = \text{Don}}$	R 't care.	ST0	standby state) ST0 = 80

Table 3-9 FDC Commands (cont'd)

Table 3-10	FDC Status	Register 0
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NUMBER	BIT NAME	SYMBOL	DESCRIPTION
D7 D6	Interrupt Code	IC	D7 = 0 and $D6 = 0Normal termination (NT) ofcommand. Command was completedand properly executed.D7 = 0$ and $D6 = 1Abnormal termination (AT) ofcommand. Execution of commandwas started, but not successfullycompleted.D7 = 1$ and $D6 = 0Invalid command issue (IC). Com-mand which was issued was neverstarted.D7 = 1$ and $D6 = 1Abnormal termination because dur-ing command execution the readysignal from FDD changedstate.$
D5	Seek End	SE	When the FDC completes the Seek command, this flag is set to 1 (High).
D4	Equipment Check	EC	If a fault signal is received from the FDD, or if the track 0 signal fails to occur after 77 step pulses (recalibrate command), then this flag is set.
D3	Not Ready	NR	When the FDD is in the not-ready state and a read or write command is issued, this flag is set. If a read or write command is issued to side 1 of a single sided drive, then this flag is set.
D2	Head Address	HD	This flag is used to indicate the state of the head at interrupt
D1 D0	Unit Select 1 Unit Select 0	US 1 US 0	These flags are used to indicate a Drive Unit number at interrupt.

NUMBER	BIT NAME	SYMBOL	DESCRIPTION
D7	End of Cylinder	EN	When the FDC tries to access a sector beyond the final sector of a cylinder, this flag is set.
D6	_		Not used. This bit is always 0 (Low).
D5	Data Error	DE	When the FDC detects a CRC error in either the ID field or the data field, this flag is set.
D4	Over Run	OR	If the FDC is not serviced by the main systems during data transfers within a certain time interval, this flag is set.
D3			Not used. This bit is always 0 (Low).
D2	No Data	ND	During execution of a Read Data, Write Deleted Data, or Scan com- mand, if the FDC cannot find the sector specified in the ID register, this flag is set. During execution of the Read ID command, if the FDC cannot read the ID field without an error, then this flag is set. During the execution of the Read-a- Cylinder command, if the starting sector cannot be found, then this flag is set.
D1	Not Writable	NW	During Execution of a Write Data, Write Deleted Data, or Format a Cylinder command, if the FDC detects a write protect signal from the FDD, then this flag is set.
D0	Missing Address Mark	МА	If the FDC cannot detect the ID Address Mark, this flag is set. Also at the same time, the MD Flag of Status Register 2 is set.

 Table 3-11
 FDC Status Register 1

NUMBER	BIT NAME	SYMBOL	DESCRIPTION
D7	_		Not Used. This bit is always 0 (Low).
D6	Control Mark	СМ	During execution of the Read Data or Scan command, if the FDC encounters a sector that contains a Deleted Data Address Mark, this flag is set.
D5	Data Error in Data Field	DD	If the FDC detects a CRC error in the data, then this flag is set.
D4	Wrong Cylinder	WC	This bit is related with the ND bit, and when the contents of C on the medium are different from that stored in the ID Register, this flag is set.
D3	Scan Equal Hit	SH	During execution of the Scan command, if the condition of "equal" is satisfied, this flag is set.
D2	Scan Not Satisfied	SN	During execution of the Scan command, if the FDC cannot find a sector on the cylinder that meets the condition, then this flag is set.
DI	Bad Cylinder	BC	This bit is related with the ND bit, and when the contents of C on the medium are different from that stored in the ID Register and the content of C is FF, then this flag is set.
D0	Missing Address Mark in Data Field	MD	When data is read from the medium, if the FDC cannot find a Data Address Mark or Deleted Data Address Mark, then this flag is set.

Table 3-12 FDC Status Register 2

NUMBER	BIT NAME	SYMBOL	DESCRIPTION
D7	Fault	FT	Indicates the status of the Fault signal from the FDD.
D6	Write Protected	WP	Indicates the status of the Write Protected signal from the FDD.
D5	Ready	RY	Indicates the status of the Ready signal from the FDD.
D4	Track 0	Т0	Indicates the status of the Track 0 signal from the FDD.
D3	Two Side	TS	Indicates the status of the Two Side signal from the FDD.
D2	Head Address	HD	Indicates the status of Side Select signal to the FDD.
D1	Unit Select 1	US 1	Indicates the status of the Unit Select 1 signal to the FDD.
D0	Unit Select 0	US 0	Indicates the status of the Unit Select 0 signal to the FDD.

 Table 3-13
 FDC Status Register 3

Table 3-14 FDC Register I/O Addresses and Functions

I/O ADDRESS	READ/ WRITE	FUNCTION
50	Read	Read-Status Register
52	Read	Read-Data Register
52	Write	Write-Data Register

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3.4.2 Drive A and B Interface

All signals are TTL compatible, and all outputs are driven by open-collector gates. The drives provide termination networks; each input is terminated with a 150-ohm resistor. The output signals are described in Table 3-15, the input signals are described in Table 3-16.

SIGNAL	DRIVER	DESCRIPTION
Drive Select A and B	7445	When the line associated with a drive is not active, these two lines are used by Drives A and B to degate all drivers to the adapter and all receivers from the attachment.
Step	7406	The selected drive moves the read/write head one cylinder in or out (according to the direction-line signal) for each pulse present on this line.
Direction	7406	For each recognized pulse of the step line, the read/write head moves one cylinder toward the spindle if this line is active, and away from the spin- dle if this line is inactive.
Write Data	7406	For each inactive-to-active transition of this line (while Write Enable is active), the selected drive causes a flux change to be stored on the disk.
Write Gate	7406	Unless this line is active, the drive disables the write current for the head.
Head Load	7406	While this line is active, the drive loads the read/ write head.
Side Select	7406	The read/write head selects which side of the flexible disk to read/write. 0 = head 0 1 = head 1
M/FM	7406	This signal selects the Code-Reading Mode, FM or MFM. 0 = FM Mode 1 = MFM Mode

Table 3-15 Output Signals

SIGNAL	DRIVER	DESCRIPTION
VFO Sync	7406	This signal enables or disables the VFO Circuit Mode. 0 = enable 1 = disable
Low Current	7406	This line relays head-position information to the drive.
File-Unsafe Reset	7406	This line resets a drive if it is in fault status.

	Table 3-15	Output	Signals	(cont'd)
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Table 3-16 Input Signals

SIGNAL	DESCRIPTION
Index	The selected drive supplies one pulse per disk revolution on this line.
Write Protect	The selected drive activates this line when a write pro- tected diskette is mounted in the drive.
Track 0	The selected drive activates this line when the read/write head is over Track 0.
Read Data	The selected drive supplies a pulse on this line for each flux change encountered on the disk; it relays data from the flexible disk.
Ready	This line becomes active when the selected drive is ready.
Dual Side	When a dual-sided disk is mounted on the drive, this line becomes active.
File Unsafe	If the drive is in a fault state, the selected drive activates this line.
Data Window	The selected drive combines read data with clock data, which allows the FDC to discriminate data from read data.

3.5 FDD UNIT

The 8-inch FDD is a two-sided, double-density unit that can read from and write to one-sided and single-density flexible disks as well. The FDD can read and record digital data using either FM or MFM. Signal transfer is in the VFO Mode.

The FDD unit attaches to the FDC with the signal cable and the flexible disk interface connector, which is located on the Controller PCB (see Figure 3-1). A power cable connects each FDD unit to the APC power supply.

To enable disk reading, insert a disk, and close the front latch; this causes the drive hub to clamp the disk and turn it at 360 rpm. When an index sensor detects the index hole, it activates a signal. The stepper motor positions the read/write heads over the desired tracks for reading.

3.5.1 Specifications

The FDD specifications are listed in Table 3-17.

CHARACTERISTIC	SPECIFICATION
Transfer Rate FM MFM	31.25 KB/sec 62.5 KB/sec
Disk Speed	360 rpm
Seek Time	5 ms track to track
Seek Settling Time	15 ms
Head-Load Time	50 ms
Tracks Per Inch	48
Maximum Bits Per Inch FM MFM	3.408 6.816
Recording Mode	FM or MFM

CHARACTERISTIC	SPECIFICATION
Dimensions Height Width Depth Weight	8.55 in. (217.2 mm) 2.28 in. (58.0 mm) 12.73 in. (323.0 mm) 7.7 lb (3.5 lb)
Operating Temperature Range	50 to 113° F (10 to 45° C)
Relative Humidity Tolerance Range	20 to 80%
Power	+24 Vdc ±10% 0.75 A (starting) 0.90 A (average) +5 Vdc ±5% 0.8 A -5 Vdc ±5% 0.07A
Power Consumption	28 W (maximum)
Error Rate Recoverable Non-Recoverable Seeks	1 per 10 ⁹ 1 per 10 ¹² 1 per 10 ⁶

 Table 3-17 FDD Specifications (cont'd)

3.5.2 Interface

Figure 3-13 shows the signal connector interface and pin assignments; Figure 3-14 illustrates the power connector interface and pin assignments.

3.5.3 Terminations and Jumper Settings

The location and installation of the termination resistor modules are shown in Figure 3-15, and the jumper location and jumper setting are shown in Figure 3-16.

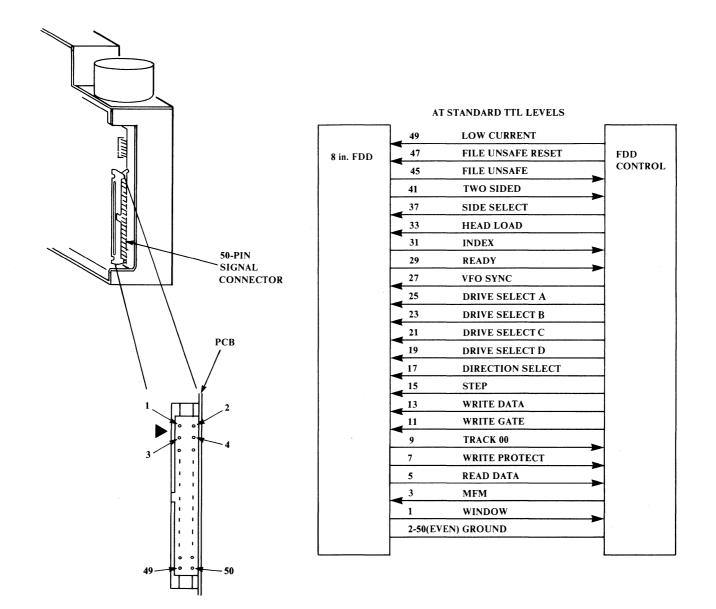


Figure 3-13 FDD Signal Connector Interface and Pin Assignments

3-41

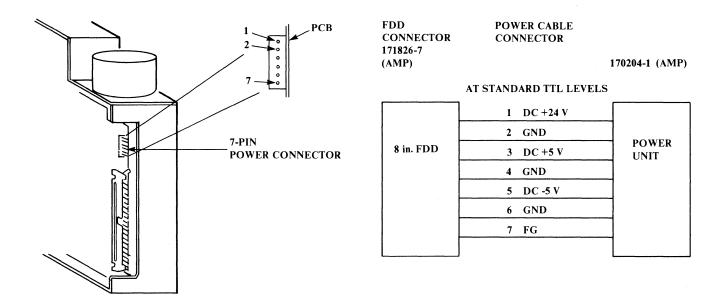
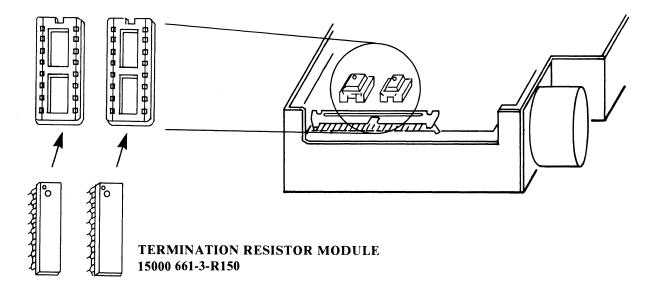


Figure 3-14 FDD Power Connector Interface and Pin Assignments





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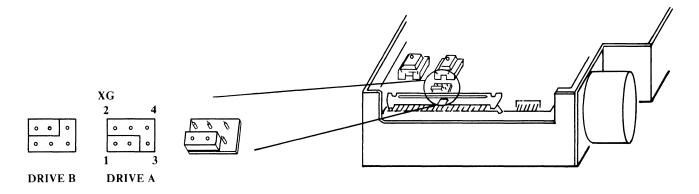


Figure 3-16 FDD Jumper, Location and Proper Setting

3.6 SERIAL I/O COMMUNICATIONS CONTROLLER

Supported by the 8251A USART controller, this communications interface circuit is programmed by the CPU to operate using synchronous, asynchronous, or business-machine serial-data-transmission techniques. Basically, the serial I/O device converts parallel data of the microprocessor into serial data and vice versa and generates appropriate supervisory lines to interface with a modem or other external peripheral devices.

3.6.1 Specifications

Table 3-18 lists the specifications for the Serial I/O Communications Controller.

3.6.2 Circuit Description

A functional block diagram of the serial I/O device is shown in Figure 3-17. Table 3-19 lists the serial I/O commands.

3.6.3 Interface

The serial I/O connects to the APC rear panel with a 26-pin cable connector, designated CN3 on the Controller PCB. The other end of the 26-pin cable connects to a 36-pin D-type connector similar to the printer connector. Table 3-20 lists and Figure 3-18 shows the pin assignments of all the cables. Table 3-21 explains the interface signals.

3.6.4 Programming Considerations

Operation of the 8251A processor is programmed by two 8-bit control words:

- A mode instruction word, which is the first word written into the 8251A after reset
- A command instruction word, which defines the operation to be performed.

Characteristics	Specifications
Processor	NEC 8251A
Channel	1
Transmission Mode	Half-Duplex or Full-Duplex
Synchronization	Synchronous or Asynchronous
Interface	EIA RS-232C
Line Speed	
Asynchronous Mode	50 to 19.2K Baud
Synchronous Mode	50 to 19.2K Baud
Business Machine	1200 Baud

Table 3-18 Serial I/O Communications Controller Specifications

Controller PCB

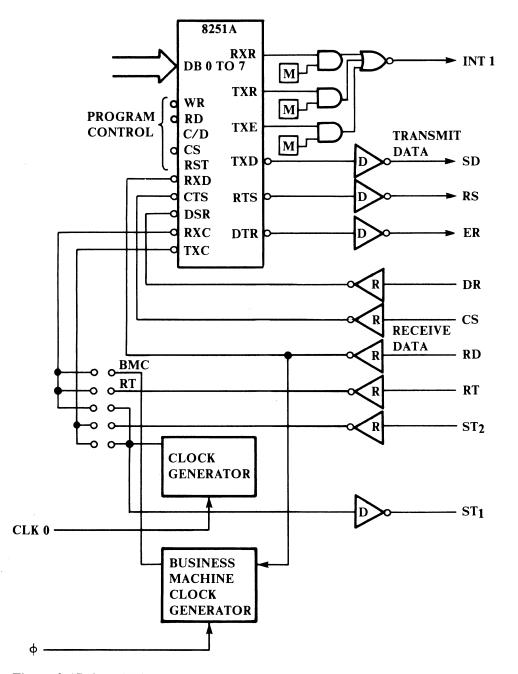


Figure 3-17 Serial I/O Communications Controller Block Diagram

	I/O	READ/	DATA BUS
COMMAND	ADDRESS	WRITE	7 6 5 4 3 2 1 0
Read Data	30	R	RRRRRRRRDDDDDDDD76543210
Write Data	30	W	S S S S S S S S D D D D D D D D D 7 6 5 4 3 2 1 0
Read Status	32	R	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
Write Mode (A)	32	W	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
Write Mode (S)	32	W	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
Write Command	32	W	E I R R S R E T H R S S B E R E T R N N
Write Mask	34	W	T _x R _x T _x E R R
Read Signal	34	R	C C C S I D
Write Signal	36	W	T D C

Table 3-19 Serial I/O Commands

.

SIGNAL	PIN NUMBER AT A	PIN NUMBER AT B	PIN NUMBER AT C	REMARKS
BIGITIL				KEMAKKS
Frame Ground	1	1	1	
SD	2 3	2 3	3	
RD	3	3	5	
RS CS	4 5	4 5	7 9	
DR	5	6	11	
Signal Ground	0 7	7	13	
CD CD	8	8	15	
	9	9	17	No signal
	10	10	19	
	11	11	21	
	12	12	23	
	13 14	13	25 2	
		19		
ST2	15	20	4	-
	16	21	6	No signal
RT	17	22	8	
	18	23	10	
	19	24	12	No signal
ER	20	25	14	
	21	26	16	
	22	27	18	No signal
	23	28	20	
ST1	24	29	22	
	25	30	24	No signal

Table 3-20 Serial I/O Connectors Pin Assignments

SIGNAL	SOURCE	DESCRIPTION
SG		Signal ground
SD	Controller	Send data
RD	Modem	Receive data
RS	Controller	Request to send
CS	Modem	Clear to send
DR	Modem	Data set ready
SG		
ST2(TxC)	Modem	Transmit Clock
RT	Modem	Receive Clock
ER	Controller	Data Terminal Ready
ST1(RxC)	Controller	Transmit Clock

Table 3-21 Serial I/O Device Interface Connector Pin Descriptions

The processor can also read a status word from the 8251A, or write sync characters (in the Synchronous Mode), or specify that the data bus is to be read from or written to and transmitted to or received from (respectively) the modem. Instruction to the 8251A is determined by the levels on IC Pins 10, 11, 12, 13 and 21 (see Table 3-22).

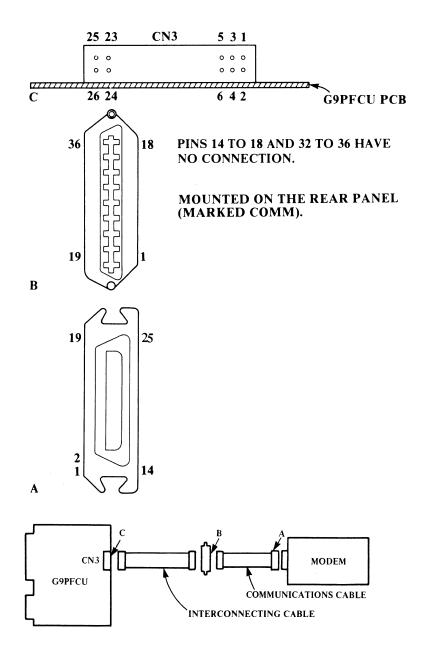


Figure 3-18 Communications Controller Cable Connections

[]	· · · · · · · · · · · · · · · · · · ·	
SYMBOL	NAME	DESCRIPTION
WR	WRITE	A Low on this line indicates that data on the bus is to be written into the 8251A (APC IOW line).
ĊŚ	CHIP SELECT	A Low on this line selects the 8251A, enabling read or write operations. This line must be Low for the 8251A to respond to or affect the data bus (APC S10 line).
C∕D	<u>CONT</u> ROL/ DATA	A High on this line specifies that a control word is being written in or that a status word read out. A Low means that data is being written in or read out (APC AB line).
RD	READ	A Low on this line indicates that the data or a status word is being read from the 8251A (APC IOR line).
RST	RESET	A High on this line places the 8251A in an idle mode, wait- ing for a new set of control words (APC RST line).

 Table 3-22
 8251A Instructions

3.6.4.1 ASYNCHRONOUS OPERATING MODE

The mode instruction word for asynchronous operation is shown in Figure 3-19. The format of the command instructions word is shown in Figure 3-20. Figure 3-21 shows the setup of jumper settings and the resulting circuit. Table 3-23 shows how the Baud rate is set.

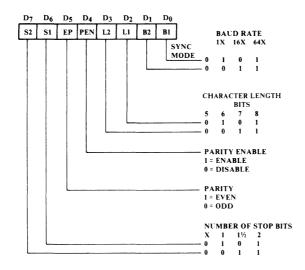


Figure 3-19 Asynchronous Mode Instruction Word

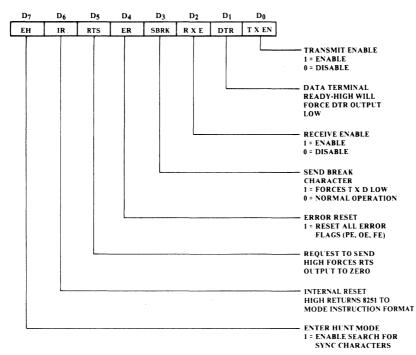
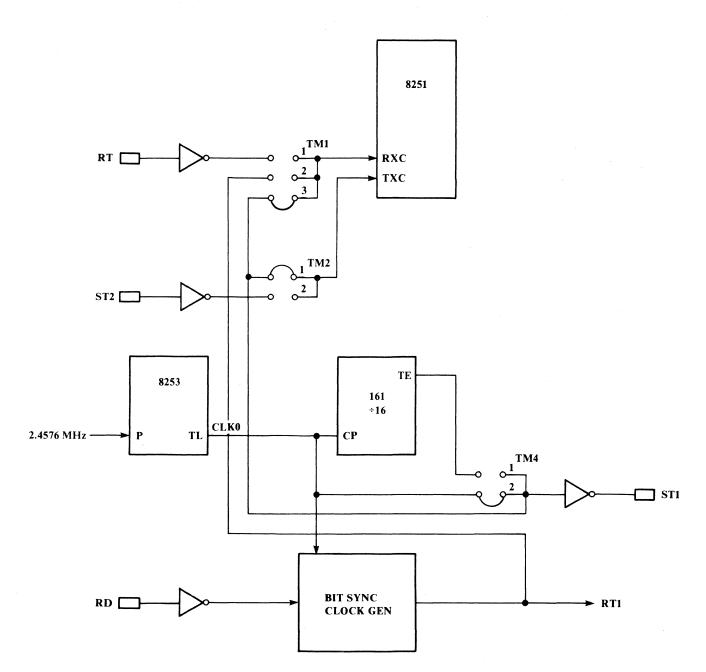


Figure 3-20 Command Instruction Word Format





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		COUNT REGISTER HIGH								COUNT REGISTER LOW					
BAUD RATE	COUNT RATE*	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1 0					
19.2K	8	0	0	0	0	0	0	0	0	0 0 0 0 1 0 0 0					
9600	16	0	0	0	0	0	0	0	0	0 0 0 1 0 0 0 0					
4800	32	0	0	0	0	0	0	0	0	0 0 1 0 0 0 0 0					
2400	64	0	0	0	0	0	0	0	0	0 1 0 0 0 0 0 0					
1200	128	0	0	0	0	0	0	0	0	10000000					
600	256	0	0	0	0	0	0	0	1	0 0 0 0 0 0 0 0					
300	512	0	0	0	0	0	0	1	0	0 0 0 0 0 0 0 0					
200	768	0	0	0	0	0	0	1	1	0 0 0 0 0 0 0 0					
135															
100	1536	0	0	0	0	0	1	1	0	0 0 0 0 0 0 0 0					
75	2048	0	0	0	0	1	0	0	0	0 0 0 0 0 0 0 0					
50	3072	0	0	0	0	1	1	0	0	0 0 0 0 0 0 0 0					
*Count Rate = 2	2457600/(R	xC o	r T	xC)	x 16	6 (H	z)								

Table 3-23 Communications Controller, Baud Rate Coding During Asynchronous Operation

3.6.4.2 SYNCHRONOUS OPERATING MODE

The mode instruction word for synchronous operation is shown by Figure 3-22. Figures 3-23 and 3-24 show the circuits for synchronous operation using external (Modem) and interval clocks, respectively. Table 3-24 lists the Baud rate setting codes in synchronous operation.

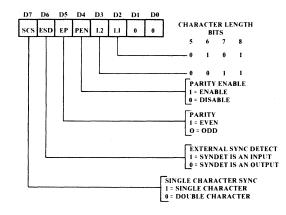
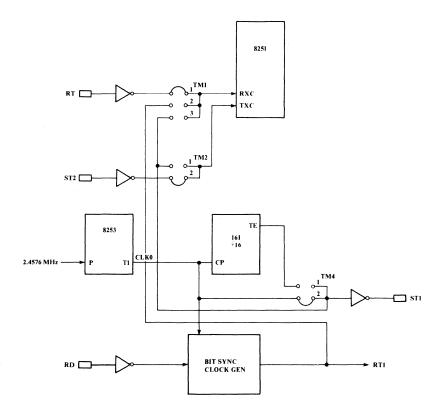
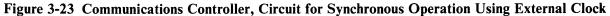
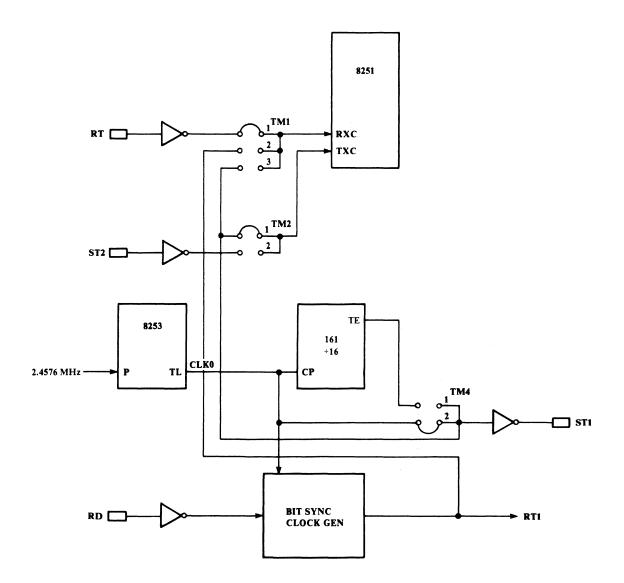
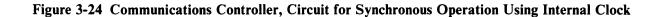


Figure 3-22 Synchronous Mode Instruction Word







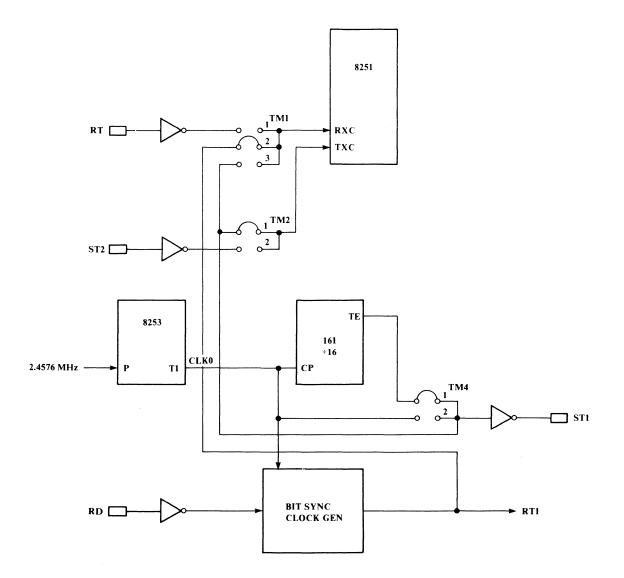


	COUNT	COUNT REGISTER HIGH								COUNT REGISTER LOW						
BAUD RATE	COUNT RATE*	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1 0						
19.2K	128	0	0	0	0	0	0	0	0	10000000						
9600	256	0	0	0	0	0	0	0	1	0 0 0 0 0 0 0 0						
4800	512	0	0	0	0	0	0	1	0	00000010						
2400	1024	0	0	0	0	0	1	0	0	00000000						
1200	2048	0	0	0	0	1	0	0	0	0 0 0 0 0 0 0 0						
600	4096	0	0	0	1	0	0	0	0	0 0 0 0 0 0 0 0						
300	8192	0	0	1	0	0	0	0	0	0 0 0 0 0 0 0 0						
200	12288	0	0	1	1	0	0	0	0	0 0 0 0 0 0 0 0						
100	18204	0	1	0	0	0	1	1	1	0 0 0 1 1 1 0 0						
75	24756	0	1	1	0	0	0	0	0	10110100						
*Count Rate = 2	457600/Ba	ud (Hz)			۰.										

Table 3-24 Communications Controller, Baud Rate Coding During Synchronous Operation

3.6.4.3 BUSINESS MACHINE OPERATING MODE

Figure 3-25 shows the circuit and Table 3-25 lists the Baud rate setting codes when operation with business-machine timing.





Controller PCB

		COUNT REGISTER HIGH							COUNT REGISTER LOW	
BAUD RATE	RATE	15	14	13	12	11	10	9	8	7 6 5 4 3 2 1 0
19.2K	8	0	0	0	0	0	0	0	0	0 0 0 0 1 0 0 0
9600	16	0	0	0	0	0	0	0	0	00010000
4800	32	0	0	0	0	0	0	0	0	00100000
2400	64	0	0	0	0	0	0	0	0	0 1 0 0 0 0 0 0
1200	128	0	0	0	0	0	0	0	0	10000000
600	256	0	0	0	0	0	0	0	1	00000000
300	512	0	0	0	0	0	0	1	0	0 0 0 0 0 0 0 0
200	768	0	0	0	0	0	0	1	1	0 0 0 0 0 0 0 0
135	1138	0	0	0	0	0	1	0	0	0 1 1 1 0 0 1 0
100	1536	0	0	0	0	0	1	1	0	00000000
75	2048	0	0	0	0	1	0	0	0	0 0 0 0 0 0 0 0
50	3072	0	0	0	0	1	1	0	0	00000000

Table 3-25 Communications Controller, Baud Rate Coding During Operations with Business Machine Clocking

Controller PCB

3.6.5 Status Word Format

The status word format is shown by Figure 3-26.

_	D7	D6	D5	D4	D3	D2	D1	D0
	DSR	SYNDET	FE	OE	PE	TXE	TXRDY	RXRDY
-		1		1			1	
					SAN	1E DEFIN	ITIONS A	S I/O PINS
				PA	RITY ER	ROR		
				1			PARITY	ERROR IS
				1				IT OPERATION
					8251. RE			
					DMMAND			
				•	ERRUN I			
								PU DOES
								FORE THE
					EXT ONE I	~		
					RESET BY			
					STRUCTI			
					51 OPERA	- , -		UN
				CF	IARACTE	R IS LOS	1.	
			L		AMING E	•		,
					FLAG SE			
								D OF EVERY
					IARACTE			
					ERATION			
				BI	Г OF THE	COMMA	ND INSTE	RUCTION.

Figure 3-26 Communications Controller, Status Word Format

3.7 SOUND CONTROL

The sound control system is supported by the NEC μ PD1771C-006, which drives a loudspeaker through a ¹/₄-Watt audio amplifier. This LSI generates audio signals and programmable music. Through music programming, the sound control system can generate tones ranging over two octaves in frequency, at specified note lengths, intensities, and tempos.

A functional block diagram of the sound control system is shown in Figure 3-27. The sound system speaker is mounted near the front of the main unit. An operator's volume control is also provided.

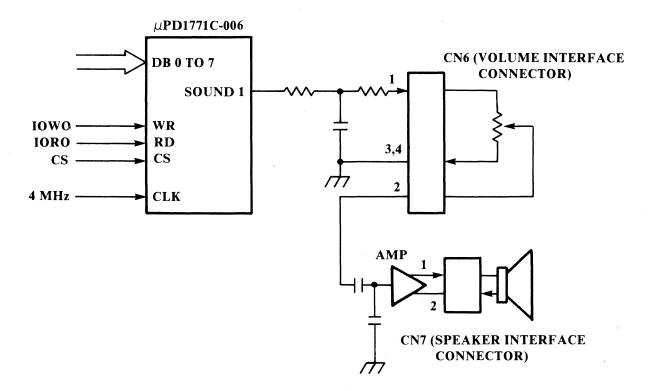


Figure 3-27 Sound Control Block Diagram

3.7.1 Interface

Figure 3-28 shows the sound control interface with the Controller PCB, and Table 3-26 describes the pin assignments.

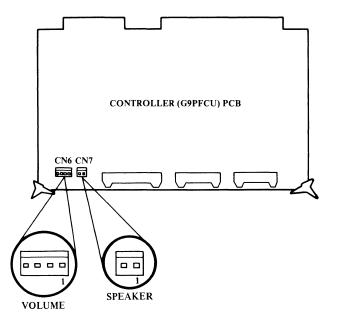




 Table 3-26
 Sound Interface Pin Assignments

CONNECTOR	PIN	SIGNAL
CN6 (Volume	1	Volume In
Interface)	2	Volume Out
	3	Ground
	4	Ground
CN7	1	SP+
(Speaker Interface)	2	SP-

3.7.2 Programming Considerations

Tables 3-27, 3-28 and 3-29 give format and command information for sound-programming users.

Table 3-27 Sound Programming Read/V	Write Format
-------------------------------------	--------------

	READ/	I/O	DATA BUS											
INSTRUCTION	WRITE	ADDRESS	7	6	5	4	3	2	1	0				
Write Command	W	60	0	FS	C5	C4	C3	C2	C1	C0				
Read Status	R	60	S7	S 6	S5	S4	S3	S2	S1	S0				
$\begin{array}{ c c c c c c c c c c c c c c c c c c c$	Control and information:	(1) command Scale comma if HEX value is lue is 00, only t	unds 5 80,	all t	he v	vrite								

 Table 3-28
 Sound Control Commands

FIRS	T COMMAND	SECOND CO	MMAND
	DATA BUS		DATA BUS
COMMAND	7 6 5 4 3 2 1 0	MUSIC EXPRESSION	7 6 5 4 3 2 1 0
Music Notes	00110001	Volume Illegal	0 1 0 0 0 0 0 0
Beep Notes		Piano	0 1 0 0 0 0 0 1
20 ms	001110XX	Medium	0 1 0 0 0 0 1 0
6 minutes	001111XX	Forte	01000011
710 Hz	00111X00		
1202 Hz	00111X01	Tempo Slow (1.0 sec)	0 1 0 1 0 0 0 0
2038 Hz	0 0 1 1 1 X 1 0	Moderately Slow (0.87 sec)	0 1 0 1 0 0 0 1

3-62

FIRS	Г COMMAND	SECOND CO	MMAND
	DATA BUS		DATA BUS
COMMAND	7 6 5 4 3 2 1 0	MUSIC EXPRESSION	7 6 5 4 3 2 1 0
3906 Hz	0 0 1 1 1 X 1 1	Moderately Fast (0.56 sec)	0 1 0 1 0 0 1 0
		Fast (0.38 sec)	0 1 0 1 0 0 1 1
		Sharp Attack (Bell-like)
		Illegal	0 1 1 0 0 0 0 0
		Piano	0 1 1 0 0 0 0 1
		Medium	0 1 1 0 0 0 1 0
		Forte	0 1 1 0 0 0 1 1
		Soft Attack (Pia	ano-like)
		Illegal	0 1 1 1 0 0 0 0
		Piano	0 1 1 1 0 0 0 1
		Medium	0 1 1 1 0 0 1 0
L		Forte	0 1 1 1 0 0 1 1

Table 3-28 Sound Control Commands (cont'd)

Table 3-29	Sound S	cale Commands	5

FIRST COM	MAND (NOTE TONE)	SECOND COMMAND	(NOTE DURATION)
COMMAND	DATA BUS 7 6 5 4 3 2 1 0	COMMAND	DATA BUS 7 6 5 4 3 2 1 0
Illegal C	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 1	Moderately emphatic rhythm	0 1 0 0 X X X X
C# D D#	0 0 0 0 0 0 1 0 0 0 0 0 0 1 1 0 0 0 0 0	Emphatic rhythm Note without point	0 1 0 1 X X X X 0 1 0 X 0 X X X 0 1 0 X 1 X X X
E F	0 0 0 0 0 1 0 1 0 0 0 0 0 1 1 0 1 0 0 0 0	Note with point (Except thirty-second note	
F# G G#	0 0 0 0 1 1 1 0 0 0 0 1 0 0 0 0 0 0 0 1 0 0 0 0 0 0 0 1 0 0 1	Whole note (o) Half note (o) Quarter note (o) Eighth note (o)	0 1 0 X X 0 0 0 0 1 0 X X 0 0 1 0 1 0 X X 0 1 0 0 1 0 X X 0 1 1

ſ			(
FIRST COM	MAND (NOTE TONE)	SECOND COMMAND	(NOTE DURATION)
	DATA BUS		DATA BUS
COMMAND	7 6 5 4 3 2 1 0	COMMAND	7 6 5 4 3 2 1 0
A A#	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Sixteenth note (0 1 0 X X 1 0 0
В	0 0 0 0 1 1 0 0	Thirty-second note (0 1 0 X X 1 0 1
С	0 0 0 0 1 1 0 1	Illegal	0 1 0 X X 1 1 0
C#	0 0 0 0 1 1 1 0	Illegal	0 1 0 X X 1 1 1
D	0 0 0 0 1 1 1 1		
D#	0 0 0 1 0 0 0 0		
Е	0 0 0 1 0 0 0 1		
F	0 0 0 1 0 0 1 0		
F#	0 0 0 1 0 0 1 1		
G	0 0 0 1 0 1 0 0		
G#	0 0 0 1 0 1 0 1		
А	0 0 0 1 0 1 1 0		
A#	0 0 0 1 0 1 1 1		
В	0 0 0 1 1 0 0 0		
С	0 0 0 1 1 0 0 1		
C#	0 0 0 1 1 0 1 0		
D	0 0 0 1 1 0 1 1		
D#	0 0 0 1 1 1 0 0		
Ε	0 0 0 1 1 1 0 1		
	0 0 0 1 1 1 1 0		
Illegal	Through	an a	
	00101111		
Rest	0 0 1 1 0 0 0 0		
Illegal	0 0 1 1 0 0 0 1 Through 0 0 1 1 1 1 1 1		

Table 3-29 Sound Scale Commands (cont'd)

3.8 JUMPER SETTINGS

Figure 3-29 shows the Controller PCB jumper settings, which adapt the system to various communications situations and to either monochrome or color display.

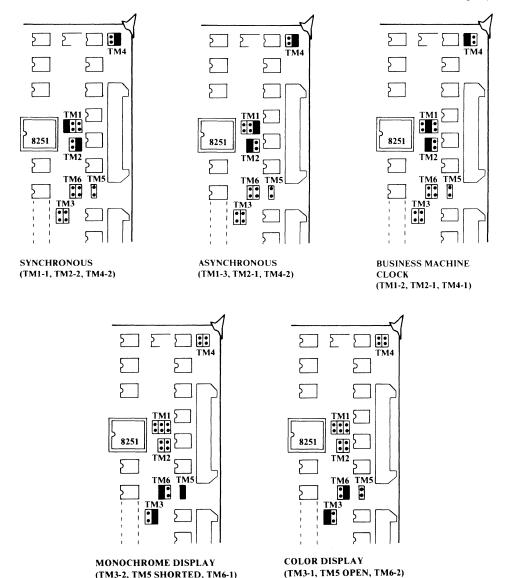
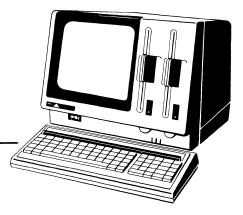


Figure 3-29 Controller PCB Jumper Settings

(TM3-2, TM5 SHORTED, TM6-1)



Chapter 4 Power Supply

The dc power supply is a 100 W, 5-voltage level, switching regulator providing the following dc outputs. The power supply also provides a noise-filtered switched 115 V, 60 Hz output at 1.2 A, and a single-pole, single-throw power control switch output for external power On/Off control.

- +5 Vdc \pm 5% @ 9 A
- -5 Vdc \pm 5% @ 0.3 A
- +12 Vdc \pm 5% @ 0.3 A
- -12 Vdc \pm 5% @ 0.25 A
- +24 Vdc \pm 10% @ 1.8 A

The power supply furnishes all required power to APC components in the Keyboard and terminal cabinet and is located in a removable chassis module under the CRT Display. The power On/Off Switch is an integral part of the power supply.

All dc outputs are regulated and have overcurrent and overvoltage protection. Ripple voltage does not exceed 50 mV at any dc output except the 24 V output, where the ripple voltage does not exceed 100 mV. Spike noise voltage is less than 250 mV on any output. If an overload or overvoltage condition exists on any of the dc outputs, the unit automatically shuts down until the condition is corrected and the power is recycled off and on. The power supply is designed for continuous operation at 100 W of dc output and 130 W of ac output. The ac output is 2.5 A maximum at 104 to 132 V, 60 ± 0.5 Hz and is fused for 5.0 A.

The APC power supply incorporates a POF circuit that enables remote On/Off switching of both ac and dc outputs. The POF character is 5B and its address is AD08.

A functional block diagram of the power supply is shown by Figure 4-1, which also shows additional specifications of the POF feature.

The input and output cable connections to and from the power supply are shown in Figure 4-2 and listed in Table 4-1.

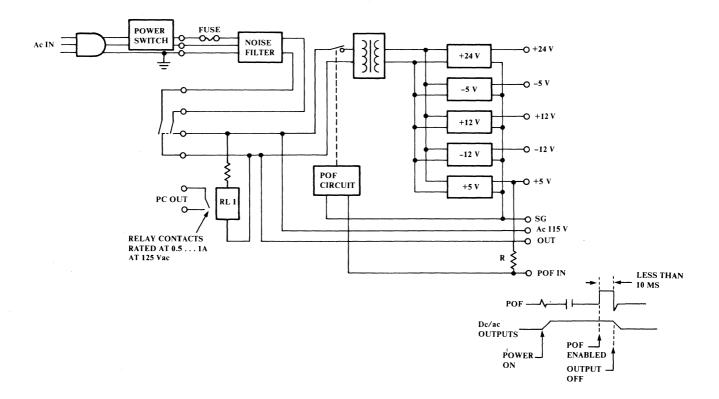


Figure 4-1 System Power Supply Block Diagram

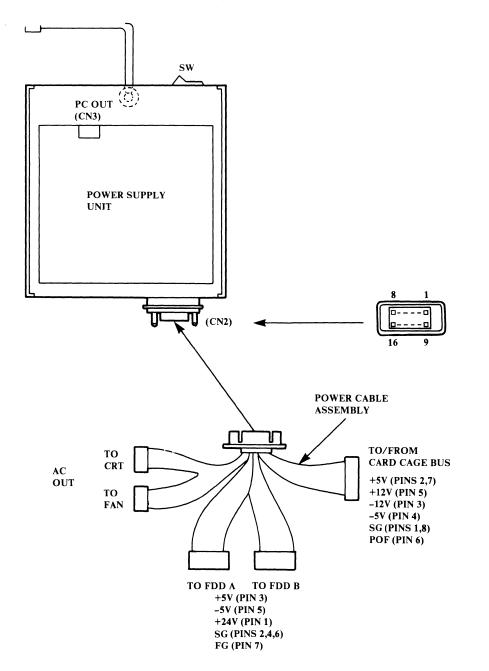
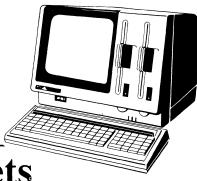


Figure 4-2 Power Supply Interconnection Diagram

CN2 PIN NUMBER	DESCRIPTION	CN2 PIN NUMBER	DESCRIPTION
1	115 Vac	9	115 Vac
2	Ground	10	Ground
3	+12 Vdc	11	-12 Vdc
4	-5 Vdc	12	-5 Vdc
5	POF	13	+24 Vdc
6	+5 Vdc	14	Ground
7	+5 Vdc	15	+5 Vdc
8	Ground	16	Ground

Table 4-1 Power Supply Pin Command Assignments





Integrated Circuit Data Sheets

16-BIT MICROPROCESSOR*

- FEATURES Can Directly Address 1 Megabyte of Memory
 - Fourteen 16-Bit Registers with Symmetrical Operations
 - Bit, Byte, Word, and Block Operations
 - 8- and 16-Bit Signed and Unsigned Arithmetic Operations in Binary or Decimal
 - Multiply and Divide Instructions
 - 24 Operand Addressing Modes
 - Assembly Language Compatible with the µPD8080/8085
 - Complete Family of Components for Design Flexibility

PIN CONFIGURATION	GND	# PD8086 СРU	40 VCC 39 AD15 38 A16/S3 37 A17/S4 36 A18/S5 35 A19/S6 34 BHE/S7 33 MN/MX 32 RD 31 HOLD 30 HLDA 29 WR 28 M/IO 27 DT/R 28 TEST	(RQ/GT0) (RQ/GT1) (LOCK) (S2) (S1) (S0) (QS0) (QS1)
	NMI 🗖 17	,		(QS1)
	INTR 🗖 18	1	23 🗖 TEST	
	CLK 🗖 19)	22 🏳 READY	
)	21 RESET	

*Preliminary

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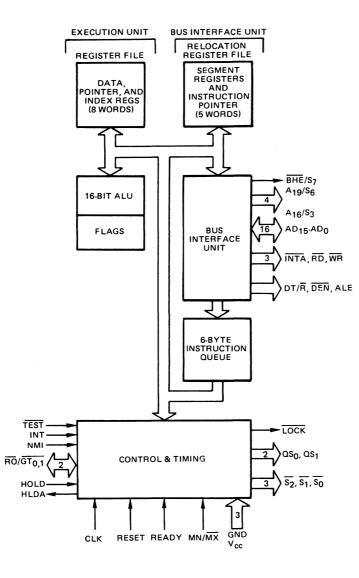
NOTE: These manufacturer's specifications are provided for reference. The APC may not use some of the functions described here.

DESCRIPTION The μ PD8086 is a 16-bit microprocessor that has both 8-bit and 16-bit attributes. It has a 16-bit wide physical path to memory for high performance. Its architecture allows higher throughput than the 5 MHz μ PD8085A-2.

PIN IDENTIFICATION

NO.	SYMBOL	NAME	FUNCTION			
2-16, 39	AD0-AD15	Address/Data Bus	Multiplexed address (T ₁) and data (T ₂ , T ₃ , T _W , T ₄) bus. 8-bit peripherals tied to the lower B bits, use A0 to condition chip select functions. These lines are tri-state during interrupt acknowledge and hold states.			
17	NMI	Non-Maskable Interrupt	This is an edge triggered input causing a type 2 interru look-up table is used by the processor for vectoring information.			
18	INTR	Interrupt Request	A level triggered input sampled on the last clock cycle of each instruction. Vectoring is via an interrupt look-up table. INTR can mask in software by resetting the interrupt enable bit.			
19	CLK	Clock	The clock input is a 1/3 duty cycle input basic timing for the processor and bus controller.			
21	RESET	Reset	This active high signal must be high for 4 clock cycles. When it returns low, the processor restarts execution.			
22	READY	Ready	An acknowledgement from memory or 1/O that data will be transferred. Synchronization is done by the μPD8284 clock generator.			
23	TEST	Test	This input is examined by the "WAIT" instruction, and if low, execution continues. Otherwise the processor waits in an "Idle" state. Synchronized by the processor on the leading edge of CLK.			
24	INTA	Interrupt Acknowledge	This is a read strobe for reading vectoring information. During T_2 , T_3 , and T_W of each interrupt acknowledge cycle it is low.			
25	ALE	Address Latch Enable	This is used in conjunction with the μ PD8282/8283 latches to latch the address, during T1 of any bus cycle.			
26	DEN	Data Enable	This is the output enable for the µPD8282/8287 transceivers. It is active low during each memory and I/O access and INTA cycles.			
27	DT/R	Data Transmit/Receive	Used to control the direction of data flow through the transceivers.			
28	M/IO	Memory/IO Status	This is used to separate memory access from I/O access.			
29	WR	Write	Depending on the state of the $M/\overline{10}$ line, the processor is either writing to I/O or memory.			
30	HLDA	Hold Acknowledge	A response to the HOLD input, causing the processor to tri-state the local bus. The bus return active one cycle after HOLD goes back low.			
31	HOLD	Hold	When another device requests the local bus, driving HOLD high, will cause the $\mu PD8086$ to issue a HLDA.			
32	RD	Read	Depending on the state of the M/IO line, the processor is reading from either memory or I/O.			
33	MN/MX	Minimum/Maximum	This input is to tell the processor which mode it is to be used in. This effects some of the pin descriptions.			
34	BHE/S7	Bus/High Enable	This is used in conjunction with the most significant half of the data bus. Peripheral devices on this half of the bus use BHE to condition chip select functions.			
35-38	A16-A19	Most Significant Address Bits	The four most significant address bits for memory opera- tions. Low during I/O operations.			
26, 27, 28 34-38	s ₀₋ s ₇	Status Outputs	These are the status outputs from the processor. They are used by the μ PD8288 to generate bus control signals.			
24, 25	QS1, QS0	Que Status	Used to track the internal µPD8086 instruction que.			
29	LOCK	Lock	This output is set by the "LOCK" instruction to prevent other system bus masters from gaining control.			
30, 31	RO/GT	Request/Grant	Other local bus masters can force the processor to rebase the local bus at the end of the current bus cycle.			

BLOCK DIAGRAM



A1-3

Operating Temperature	
Storage Temperature	
Voltage on Any Pin with Respect to Ground1.0 to +7V	
Power Dissipation	

ABSOLUTE MAXIMUM RATINGS*

 $T_a = 25^{\circ}C$

*COMMENT: Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Ta =	0°C to	₀ 70°C	VCC =	= 5V	± 10%
------	--------	--------	-------	------	-------

		LI	MITS		TEST
PARAMETER	SYMBOL	MIN	MAX	UNITS	CONDITIONS
Input Low Voltage	۷IL	-0.5	+0.8	v	
Input High Voltage	VIH	2.0	VCC + 0.5	v	
Output Low Voltage	VOL		0.45	v	I _{OL} = 2.5 mA
Output High Voltage	Voн	2.4		v	I _{OH} = -400 μA
Power Supply Current μPD8086/ μPD8086-2	ICC		340 350	mA mA	T _a = 25°C
Input Leakage Current	ILI		±10	μA	$0V < V_{IN} < V_{CC}$
Output Leakage Current	^I LO		±10	μA	0.45V ≤ V _{OUT} ≤ V _{CC}
Clock Input Low Voltage	VCL	-0.5	+0.6	v	
Clock Input High Voltage	∨сн.	3.9	VCC + 1.0	v	
Capacitance of Input Buffer (All input except AD ₀ –AD ₁₅ , RQ/GT)	CIN		15	pF	fc = 1 MHz
Capacitance of I/O Buffer AD0-AD15, RQ/GT)	CIO		15	рF	fc = 1 MHz

DC CHARACTERISTICS

AC CHARACTERISTICS

μ PD8086: T_a = 0°C to 70°C; V_{CC} = 5V ± 10%

MINIMUM COMPLEXITY SYSTEM

		μPD6086		µPD8086-2 (Preliminary)			TEST
PARAMETER	SYMBOL	MIN	MAX	MIN	MAX	UNITS	CONDITIONS
CLK Cycle Period - µPD8086	TCLCL	200	500	125	500	ns	
CLK Low Time	TCLCH	(2/3 TCLCL) -15		(2/3 TCLCL)-15		ns	
CLK High Time	TCHCL	(1/3 TCLCL) +2		(1/3 TCLCL) +2		ns	
CLK Rise Time	TCH1CH2		10		10	ns	From 1.0V to 3.5
CLK Fall Time	TCL2CL1		10		10	ns	From 3.5V to 1.0
Data in Setup Time	TDVCL	30		20		ns	
Data In Hold Time	TCLDX	10		10		ns	
RDY Setup Time into µPD8284 ① ②	TRIVCL	35		35		ns	
RDY Hold Time into µPD8284	TCLR1X	0		0		ns	
READY Setup Time into #PD8086	TRYHCH	(2/3 TCLCL) -15		(2/3 TCLCL) - 15		ns	
READY Hold Time into #PD8086	TCHRYX	30		20		ns	
READY Inactive to CLK	TRYLCL	-8		-8		ns	
HOLD Setup Time	тнусн	35		20		ns	
INTR, NMI, TEST Setup Time	TINVCH	30		15		ns	
Input Rise Time	TILIH		20			ns	From 0.8V to 2.0V
Input Fall Time	ТІНІС		12			ns	From 2.0V to 0.8V

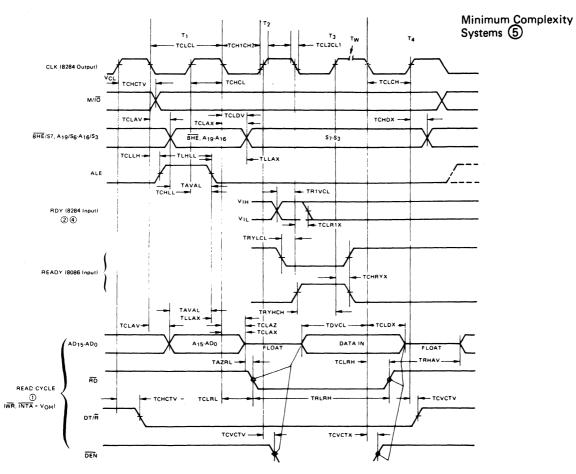
TIMING RESPONSES

		TIN	AING RE				
PARAMETER		μ PD8086		µPD8086-2 (Preliminary)			TEST
	SYMBOL	MIN	MAX	MIN	MAX	UNITS	CONDITIONS
Address Valid Delay	TCLAV	10	110	10	60		
Address Hold Time	TCLAX	10		10		ns	
Address Float Delay	TCLAZ	TCLAX	80	TCLAX	50	ns	
ALE Width	TLHLL	TCLCH-20	1	TCLCH-10		ns	
ALE Active Delay	TCLLH		80		50	ns	1
ALE Inactive Delay	TCHLL		85		55	ns	
Address Hold Time to ALE Inactive	TLLAX	TCHCL-10	1	TCHCL-10		ns	
Data Valid Delay	TCLDV	10	110	10	60	ns	CL = 20-100 pF for
Data Hold Time	тснох	10	1	10		ns	all µPD8086 Output
Data Hold Time After WR	TWHDX	TCLCH-30	1	TCLCH-30	1	ns	(In addition to µPD8086 self-load)
Control Active Delay 1	тсусту	10	110	10	70	nş	
Control Active Delay 2	TCHCTV	10	110	10	60	ns	
Control Active Delay	тсустх	10	110	10	70	ns	
Address Float to READ Active	TAZRL	0		0		ns	
RD Active Delay	TCLRL	10	165	10	100	ns	
RD Inactive Delay	TCLRH	10	150	10	80	ns	
RD Inective to Next Address Active	TRHAV	TCLCL-45		TCLCL-40		ns	
HLDA Valid Delay	TCLHAV	10	160	10	100	ns	
RD Width	TRLRH	2TCLCL-75		2TCLCL-50		ns	
WR Width	TWLWH	2TCLCL-60		2TCLCL-40		ns	
Address Valid to ALE Low	TAVAL	TCLCH-60		TCLCH-40		ns	
Output Rise Time	TOLOH		20			ns	From 0.8V to 2.0V
Output Fall Time	TOHOL		12			ns	From 2.0V to 0.8V

NOTES: (1) Signal at µPD8284 shown for reference only.

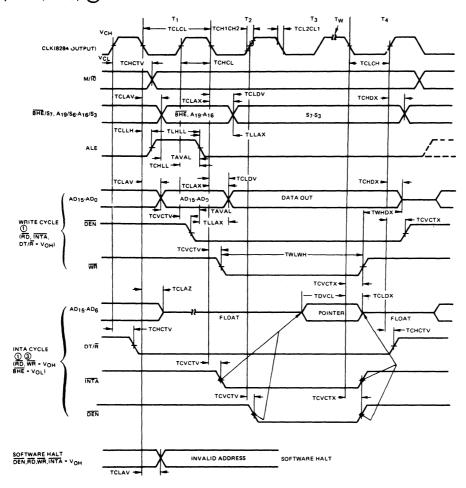
Setup requirement for asynchronous signal only to guarantee recognition at next CLK.
 Appiles only to T2 state. (8 ns into T3)

TIMING WAVEFORMS



TIMING WAVEFORMS

Minimum Complexity Systems (Con't.) (5)



NOTES: (1) All signals switch between VOH and VOL unless otherwise specified.

- (2) RDY is sampled near the end of T₂, T₃, T_W to determine if T_W machines states are to be inserted.
- ③ Two INTA cycles run back-to-back. The µPD8086 local ADDR/Data Bus is floating during both INTA cycles. Control signals shown for second INTA cycle.
- (4) Signals at µPD8284 are shown for reference only.
- (5) All timing measurements are made at 1.5V unless otherwise noted.

TIMING WITH #PB8288 BUS CONTROLLER

TIMAINIC	0.00	 45.617

	TIMING REQUIREMENTS						
	μ PD8086		µPD8086-2 (Preliminary)			TEST	
PARAMETER	SYMBOL	MIN	MAX	MIN	MAX	UNITS	CONDITIONS
CLK Cycle Period - µPD8086	TCLCL	200	500	125	500	ns	
CLK Low Time	TCLCH	(2/3 TCLCL) -15		(2/3 TCLCL) -15		ns	
CLK High Time	TCHCL	(1/3 TCLCL) +2		(1/3 TCLCL) +2		ns	
CLK Rise Time	TCH1CH2		10		10	ns	From 1.0V to 3.5V
CLN Fall Time	TCL2CL1		10		10	ns	From 3.5V to 1.0V
Data in Setup Time	TDVCL	30		20		ns	
Data in Hold Time	TCLDX	10		10		ns	
RDY Setup Time into µPD8284	TRIVCL	35		35		ns	
RDY Hold Time into #PD8284	TCLR1X	0		0		ns	
READY Setup Time into µPD8086	TRYHCH	(2/3 TCLCL) -15		(2/3 TCLCL) -15		ns	
READY Hold Time into #PD8086	TCHRYX	30		20		ns	
READY inactive to CLK	TRYLCL	-8		-8		ns	
Setup Time for Recognition (INTR, NMI, TEST) ②	TINVCH	30		15		ns	
RQ/GT Setup Time	TGVCH	30		15		ns	
RQ Hold Time into #PD8086	тсндх	40		30		ns	
Input Rise Time	тіцін		20			ns	From 0.8V to 2.0V
Input Fall Time	TIHIL		12			ns	From 2.0V to 0.8V

MAXIMUM MODE SYSTEM

With µPB8288 Bus Controller

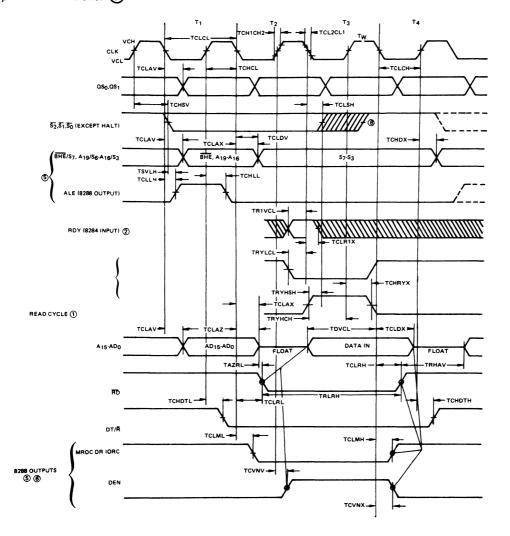
TIMING R	ESPONSES
----------	----------

	TIMING RESPONSES							
PARAMETER	µPD8086		µPD8086-2 (Preliminary)					
	SYMBOL	MIN	MAX	MIN	MAX	UNITS	TEST CONDITIONS	
Command Active Delay (See Note 1.)	TCLML	10	35	10	35	ns		
Command Inactive Delay (See Note 1)	TCLMH	10	35	10	35	ns		
READY Active to Status Passive (See Note 3)	TRYHSH		110		65	ns		
Status Active Delay	TCHSV	10	110	10	60	ns		
Status Inactive Delay	TCLSH	10	130	10	70	ns		
Address Valid Delay	TCLAV	10	110	10	60	ns		
Address Hold Time	TCLAX	10		10		ns		
Address Float Delay	TCLAZ	TCLAX	80	TCLAX	50	ns		
Status Valid to ALE High (See Note 1)	TSVLH		15		15	ns]	
Status Valid to MCE High (See Note 1)	тотисн		15		15	ns		
CLK Low to ALE Valid (See Note 1)	TCLLH		15		15	ns		
CLK Low to MCE High (See Note 1)	TCLMCH		15		15	ns		
ALE Inactive Delay (See Note 1)	TCHLL		15		15	ns	CL = 20-100 pF fo	
MCE Inactive Delay (See Note 1)	TCLMCL		15		15	ns	all µPD8086 Outpu	
Data Valid Delay	TCLDV	10	110	10	60	ns	(In addition to µPD8086 self-load)	
Data Hold Time	тснох	10		10		ns		
Control Active Delay (See Note 1)	TCVNV	5	45	5	45	ns		
Control Inactive Delay (See Note 1)	TCVNX	10	45	10	45	ns		
Address Float to Read Active	TAZRL	0		0		ns		
RD Active Delay	TCLRL	10	165	10	100	ns		
RD Inactive Delay	TCLRH	10	150	10	80	ns		
RD Inactive to Next Address Active	TRHAV	TCLCL-45		TCLCL-40		ns		
Direction Control Active Delay (See Note 1)	TCHDTL		50		50	ns		
Direction Control Inactive Delay (See Note 1)	тснотн		30		30	ns		
GT Active Delay	TCLGL	0	85	0	50	ns		
GT Inactive Delay	TCLGH	0	85	0	50	ns		
RD Width	TRLRH	2TCLCL-50		2TCLCL-50		ns		
Output Rise Time	TOLOH		20			ns	From 0.8V to 2.0V	
Output Fall Time	TOHOL		12			ns	From 2.0V to 0.8V	

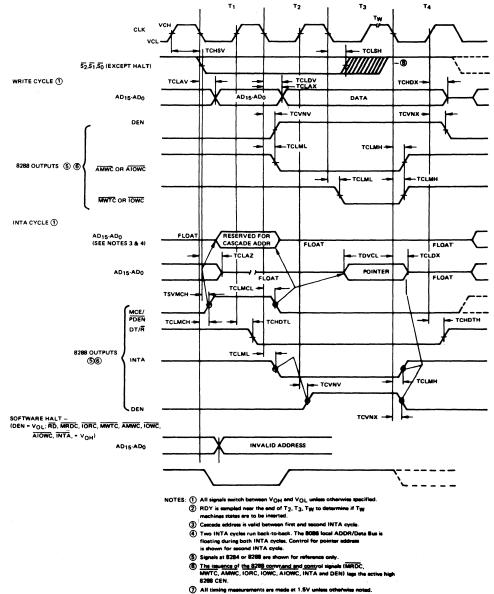
NOTES: ① Signal at µP88284 or µP88288 shown for reference only. ② Setup requirement for asynchronous signal only to guarantee recognition at next CLK. ③ Applies only to T3 and wait states. ④ Applies only to T3 state @ ns into T3).

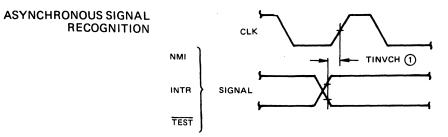
TIMING WAVEFORMS

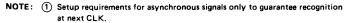
Maximum Mode System Using µPB8288 Controller (7)

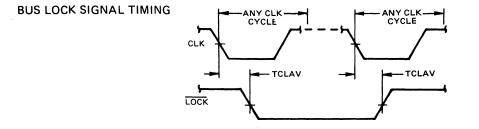


TIMING WAVEFORMS Maximum Mode System Using µPB8288 Controller (Con't.) 7

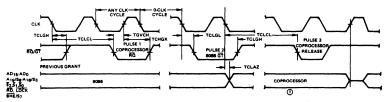


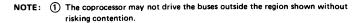






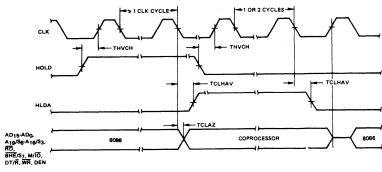




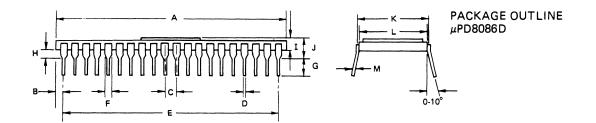


*for Maximum Mode only

HOLD/HOLD ACKNOWLEDGE TIMING*



*for Minimum Mode only



Cerdip

ITEM	MILLIMETERS	INCHES
А	51.5 MAX	2.03 MAX
В	1.62 MAX	0.06 MAX
С	2.54 ± 0.1	0.1 ± 0.004
D	0.5 ± 0.1	0.02 ± 0.004
E	48.26 ± 0.1	1.9 ± 0.004
F	1.02 MIN	0.04 MIN
G	3.2 MIN	0.13 MIN
н	1.0 MIN	0.04 MIN
I	3.5 MAX	0.14 MAX
J	4.5 MAX	0.18 MAX
к	15.24 TYP	0.6 TYP
L	14.93 TYP	0.59 TYP
м	0.25 ± 0.05	0.01 ± 0.0019

A1-12

PROGRAMMABLE COMMUNICATION INTERFACES

DESCRIPTION

The µPD8251 and µPD8251A Universal Synchronous/Asynchronous Receiver/ Transmitters (USARTs) are designed for microcomputer systems data communications. The USART is used as a peripheral and is programmed by the 8080A or other processor to communicate in commonly used serial data transmission techniques including IBM Bi-Sync. The USART receives serial data streams and converts them into parallel data characters for the processor. While receiving serial data, the USART will also accept data characters from the processor in parallel format, convert them to serial format and transmit. The USART will signal the processor when it has completely received or transmitted a character and requires service. Complete USART status including data format errors and control signals such as TxE and SYNDET, is available to the processor at any time.

- FEATURES Asynchronous or Synchronous Operation
 - Asynchronous:

Five 8-Bit Characters Clock Rate - 1, 16 or 64 x Baud Rate Break Character Generation Select 1, 1-1/2, or 2 Stop Bits False Start Bit Detector Automatic Break Detect and Handling (µPD8251A)

- Synchronous:
 - Five 8-Bit Characters Internal or External Character Synchronization Automatic Sync Insertion
 - Single or Double Sync Characters
- Baud Rate (1X Mode) DC to 56K Baud (µPD8251)
 - DC to 64K Baud (µPD8251A)
- Full Duplex, Double Buffered Transmitter and Receiver
- Parity, Overrun and Framing Flags
- Fully Compatible with 8080A/8085/µPD780 (Z80TM)
- All Inputs and Outputs are TTL Compatible
- Single +5 Volt Supply, ± 10% (8251A) ± 5% (8251)
- Separate Device Receive and Transmit TTL Clocks
- 28 Pin Plastic DIP Package
- N-Channel MOS Technology

PIN CONFIGURATION

			PIN NAMES
\sim	28 01	D7-D0	Data Bus (8 bits)
		C/Ď	Control or Data is to be Written or Read
	27 D D0	ŘĎ	Read Data Command
	26 h Vcc	WA	Write Data or Control Command
		टड	Chip Enable
	25 🔲 🖥 🛪 C	CLK	Clock Pulse (TTL)
	24 h 575	RESET	Reset
		TxC	Transmitter Clock (TTL)
uPD	23 🗍 RTS	T×D	Transmitter Data
		RxC	Receiver Clock (TTL)
	22 H Dan	RxD	Receiver Data
8251A	21 BESET	RxRDY	Receiver Ready (has character for 8080)
		TxRDY	Transmitter Ready (ready for char. from 8080)
			Data Set Ready
		DTR	Data Terminal Ready
		SYNDET	Sync Detect
	18 🔲 T×E	SYNDET/B	O Sync Detect/Break Detect
	h crs	RTS	Request to Send Date
	· · · ·		Clear to Send Data
			Transmitter Empty
		BD (µPD8251A) VCC	+5 Volt Supply
		GND	Ground
	μPD 8251/ 8251A	26 V _{CC} 25 R _X C 24 DTR 24 DTR 23 RTS 8251/ 22 DSR 8251A 21 RESET 20 CLK 19 T _X D 18 T _X E 17 CTS SYNDET	27 D0 RD 27 D0 RD 26 Vcc RR 25 RxC CLK 24 DTR TcC 23 RTS TcC 8251/ 22 DSR RxC 20 CLK Rsc RxD 8251/ 22 DSR RxD 20 CLK DSR RxD 19 TxD STR SYNDET 18 TxE SYNDET (µPD8251) Tris 16 SYNDET (µPD8251) Tris TxE 16 TRPDY Vcc Vcc

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DIN NAMES

NOTE: These manufacturer's specifications are provided for reference. The APC may not use some of the functions described here.

The μ PD8251 and μ PD8251A Universal Synchronous/Asynchronous Receiver/ Transmitters are designed specifically for 8080 microcomputer systems but work with most 8-bit processors. Operation of the μ PD8251 and μ PD8251A, like other I/O devices in the 8080 family, are programmed by system software for maximum flexibility.

In the receive mode, the μ PD8251 or μ PD8251A converts incoming serial format data into parallel data and makes certain format checks. In the transmit mode, it formats parallel data into serial form. The device also supplies or removes characters or bits that are unique to the communication format in use. By performing conversion and formatting services automatically, the USART appears to the processor as a simple or "transparent" input or output of byte-oriented parallel data.

The μ PD8251A is an advanced design of the industry standard 8251 USART. It operates with a wide range of microprocessors, including the 8080, 8085, and μ PD780 (Z80TM). The additional features and enhancements of the μ PD8251A over the μ PD8251 are listed below.

- The data paths are double-buffered with separate I/O registers for control, status, Data In and Data Out. This feature simplifies control programming and minimizes processor overhead.
- 2. The Receiver detects and handles "break" automatically in asynchronous operations, which relieves the processor of this task.
- The Receiver is prevented from starting when in "break" state by a refined Rx initialization. This also prevents a disconnected USART from causing unwanted interrupts.
- When a transmission is concluded the TxD line will always return to the marking state unless SBRK is programmed.
- 5. The Tx Disable command is prevented from halting transmission by the Tx Enable Logic enhancement, until all data previously written has been transmitted. The same logic also prevents the transmitter from turning off in the middle of a word.
- Internal Sync Detect is disabled when External Sync Detect is programmed. An External Sync Detect Status is provided through a flip-flop which clears itself upon a status read.
- 7. The possibility of a false sync detect is minimized by:
 - ensuring that if a double sync character is programmed, the characters be contiguously detected.
 - clearing the Rx register to all Logic 1s (VOH) whenever the Enter Hunt command is issued in Sync mode.
- 8. The \overline{RD} and \overline{WR} do not affect the internal operation of the device as long as the μ PD8251A is not selected.
- The μPD8251A Status can be read at any time, however, the status update will be inhibited during status read.
- The µPD8251A has enhanced AC and DC characteristics and is free from extraneous glitches, providing higher speed and improved operating margins.
- 11. Baud rate from DC to 64K.

FUNCTIONAL DESCRIPTION

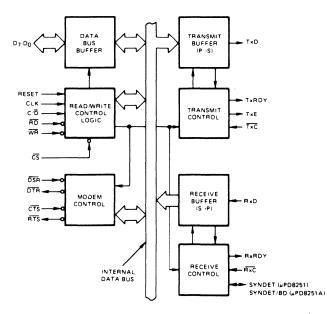
μPD8251A FEATURES AND ENHANCEMENTS

BASIC OPERATION

C/D	RD	WR	CS	
0	0	1	0	µPD8251/µPD8251A → Data Bus
0	1	0	0	Data Bus → µPD8251/µPD8251A
1	0	1	0	Status → Data Bus
1	1	0	0	Data Bus → Control
X	X	X	1	Data Bus → 3-State
X	1	1	0	Data Dus - S.State

TM: Z80 is a registered trademark of Zilog, Inc.

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

М	Operating Temperature	- 0° C to +70°C
S*	Storage Temperature	-65°C to +150°C
	Ali Output Voltages	
	All Input Voltages	
	Supply Voltages	

$T_a = 25^{\circ}C$

*COMMENT: Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

 $T_a = 0^{\circ}$ C to 70° C; V_{CC} = 5.0V ± 10% for 8251A and ± 5% for 8251; GND = 0V.

			LIMITS					
			PD82	51	#PD	8251A		
PARAMETER	SYMBOL	MIN	ŤΥΡ	MAX	MIN	MAX	UNIT	TEST CONDITIONS
Input Low Voltage	VIL	-0.5		0.8	0.5	0.8	v	
Input High Voltage	⊻ін	2.0	[Vcc	2.2	Vcc	V	
	Va			0.45		0.45	v	µPD8251: I _{OL} = 1.7 mA
Output Low Voltage	VOL			0.45		0.45	Ň	µPD8251A: IOL = 2.2 mA
Output High Voltage	Vau	2.4			2.4		v	μPD8251: IOH = -100 μA
Output High Voltage	∨он	2.4			2.4		ľ	μPD8251A: I _{OH} = -400 μA
Data Bus Leakage	1			-50		-10		V _{OUT} = 0.45V
Data bus Leakage	'DL			10		10	μA	VOUT = VCC
Input Load Current	11			10		10	μA	At 5.5V
Power Supply Current			45			100		µPD8251A: All Outputs =
rower supply current	'cc		45	80		100	mA	Logic 1

 $T_a = 25^{\circ}C; V_{CC} = GND = 0V$

			LIMITS			TEST
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	CONDITIONS
Input Capacitance	CIN			10	pF	fc = 1 MHz
1/O Capacitance	C _{1/O}			20	pF	Unmeasured pins returned to GND

CAPACITANCE

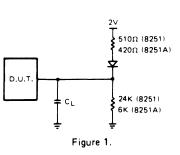
DC CHARACTERISTICS

A2-4

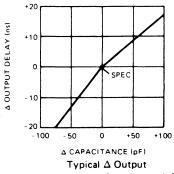
AC CHARACTERISTICS

Ta = 0°C to 70°C. VCC = 5.0V ± 10% for 8251A; GND = 0V. VCC = 5.0V ± 5% for 8251

	1	T	LIM	ITS			T	
		PD8251 µPD8215A			8215A	1	TEST CONDITIONS	
PARAMETER	SYMBOL	MIN MAX MIN		MAX	UNIT			
		RE	AD	_			r	
Address Stable before READ, (CS, C/D)	'AR	50		50		ns		
Address Hold Time for READ, (CS, CD)	^t RA	5		50		<u>∩s</u>		
READ Pulse Width	^t RR	430		250		ns		
Data Delay from READ	1RD		350		250	ns	μPD8251 CL 100 μF μPD8251A CL 150 μF	
READ to Data Floating	1DF	25	200	10	100	ns	PD8251 CL 100 pF	
	•	WR	TE					
Address Stable before WRITE	[†] AW	20		50		ns		
Address Hold Time for WRITE	'WA	20		50		^ \$		
WRITE Pulse Width	'ww	400		250				
Data Set Up Time for WRITE	1DW	200		150		ns		
Data Hold Time for WRITE	1WD	40		30		ns		
Recovery Time Between WRITES 2	IRV	6		6		10.4		
		OTHER	L					
Ciock Period 3	1CY	0 4 2 0	1 35	0 3 2	1 35	ъs	· · · · · · · · · · · · · · · · · · ·	
Clock Pulse Width High	10W	220	0 71CY	140	1CY 90			
Cock Puise Width Low	low			90		~ 5		
Clock Rise and Fail Time	TR IF	0	50	5	20	25		
TxD Delay from Falling Edge of TxC	*TC1		1		1	<u>ب</u>		
Rx Data Set-Up T-me to Sampling Pulse	I'SR x	2		2		ي د س	µPD8251 CL + 100 pF	
Rix Data Hold Time to Sampling Pulse	1HRx	2		2		ي د س		
Transmitter Input Clock Frequency	17.	•				<u> </u>		
1X Baud Rate		DC	56		64			
16X Baud Rate 64X Baud Rate		DC	520		310	к H z		
Transmitter Inpu: Clock Pulse Width	÷	DC	520		615	к H Z		
1 X Baud Rate	TPW	12		12		101		
16X and 64X Baud Rate				i		1 <u>CY</u>		
Transmitter Input Clock Pulse Delay	1TPD							
1 X Baud Rate 16 X and 64 X Baud Rate		15		15		1CY		
Receiver Input Clock Frequency	+	3		3		1C Y		
1X Baud Rate	18x	DC	56		64	k H2		
16X Baud Rate		DC	520		310	k Hz		
64X Baud Rate		DC	520		615	k H2		
Receiver Input Clock Pulse Width 1X Baud Rate	1RPW	12						
16X and 64X Baud Rate		1		12		1 <u>CY</u>		
Receiver Input Clock Pulse Delay	IRPD						•	
1 X Baud Rate		15		15		<u>'CY</u>		
16X and 64X Baud Rate		3		3		1C Y		
TxRDY Delay from Center of Data Bit	1 T x		16		8	'C Y	PD8251 CL 50 pF	
RxRDY Delay from Center of Data B-1	'RX		20		24	.+C.Y		
Internal SYNDET Delay from Center of Data Bit	'IS		25		24	1C Y		
External SYNDET Set Up Time before Failing Edge of RxC	'ES	16		16		۲CY		
TxEMPTY Delay from Center of Data Bit	1T×E		16		20	1C Y	PD8251 CL 50 DF	
Control Delay from Rising Edge of WRITE (TxE, DTR, RTS)	'wc		16		8	1C Y	-	
Control to READ Set Up Time (DSR. CTS)	1CR	16		20		1CY		







Delay Versus Δ Capacitance (pF)

Notes ① AC timings measured at VOH = 20. VOL = 0.8 and with load circuit of Figure 1. ② This recovery time is for initialization only, when MODE SYNC1, SYNC2 COMMAND and first DATA BYTES are written into the USART Subsequent writing of both COMMAND and DATA are only allowed when TXRDY + 1.

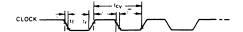
written into the USART is substrated writing to control commute the USART is updated writing to control commute the USART is updated by the the following limitations with respect to CLK. For 1X Build Rate ($T_{\rm T}$ or ($R_{\rm T} \le 1.130$ (cy)) For 16X and 64X Baud Rate ($T_{\rm X}$ or ($R_{\rm X} \le 1/(4.5)$ cy))

Reset Pulse Width = 6 tCy minimum '

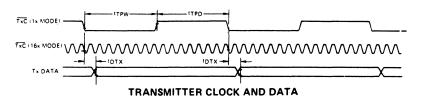
S TIXRDYCCR -2TCY + To + TR + 200ns

(TRXRDYCLR -2TCY + To + TR + 170ns

TIMING WAVEFORMS

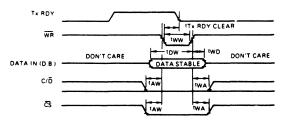


SYSTEM CLOCK INPUT

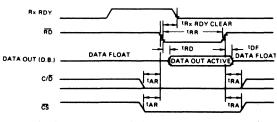


Rx BAUD COUNTER STARTS HERE) R DATA -DATA BIT START BIT DATA BIT IRPO RxC (1x MODE) FRIODS 16 R×C PERIODS (16× MODE) REC (16 MODE) 3 101 3 tev INT SAMPLING PULSE _ t - 'HRX ISRX

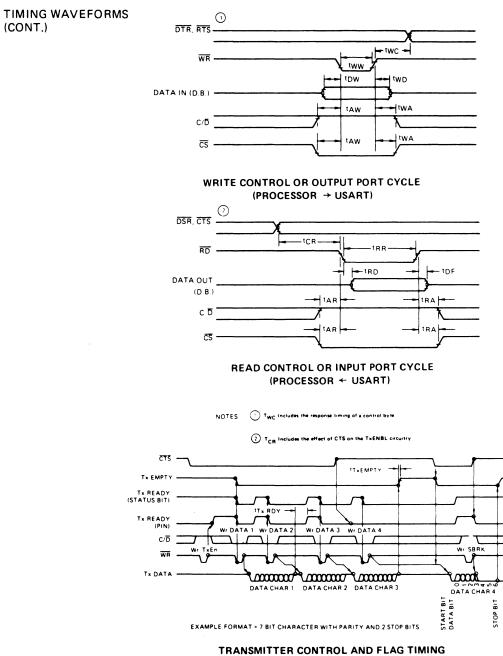
RECEIVER CLOCK AND DATA



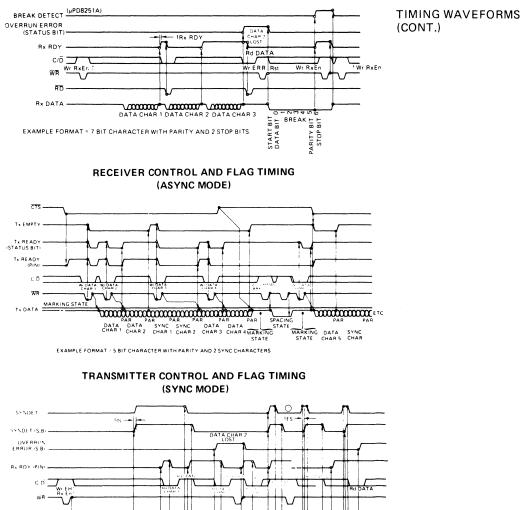
WRITE DATA CYCLE (PROCESSOR → USART)

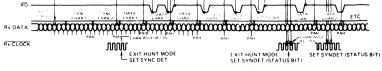


READ DATA CYCLE (PROCESSOR + USART)



(ASYNC MODE)





RECEIVER CONTROL AND FLAG TIMING (SYNC MODE)

Notes: ① Internal sync, 2 sync characters, 5 bits, with parity. ② External sync, 5 bits, with parity.

PIN IDENTIFICATION

	P	IN	[
NO.	SYMBOL	NAME	FUNCTION
1, 2, 27, 28 5 – 8	D ₇ – D ₀	Data Bus Buffer	An 8-bit, 3-state bi-directional buffer used to interface the USART to the processor data bus. Data is transmitted or received by the buffer in response to input/output or Read/ Write instructions from the processor. The Data Bus Buffer also transfers Control words, Command words, and Status.
26	∨cc	VCC Supply Voltage	+5 volt supply
4	GND	Ground	Ground
	Read/Write	e Control Logic	This logic block accepts inputs from the pro- cessor Control Bus and generates control signals for overall USART operation. The Mode Instruction and Command Instruction registers that store the control formats for device func- tional definition are located in the Read Write Control Logic
21	RESET	Reset	A "one" on this input forces the USART into the "Idle" mode where it will remain until reinitial ized with a new set of control words. Minimum RESET pulse width is 6 tCy.
20	CLK	Clock Pulse	The CLK input provides for internal device tim- ing and is usually connected to the Phase 2 iTTL1 output of the uPB8224 Clock Generator. External inputs and outputs are not referenced to CLK, but the CLK frequency must be at least 30 times the Receiver or Transmitter clocks in the synchronous mode and 4.5 times for the asynchronous mode
10	WR	Write Data	A "zero" on this input instructs the USART to accept the data or control world which the processor is writing out on the data bus
13	RD	Read Data	A "zero" on this input instructs the USART to place the data or status information onto the Data Bus for the processor to read
12	C/Đ	Control-Data	The Control Data input, in conjunction with the WR and RD inputs, informs the USART to accept or provide either a data character, control word or status information via the Data Bus. 0 - Data, 1 - Control
11	<u>CS</u>	Chip Select	A "zero" on this input enables the USART to read from or write to the processor.
	Mode	m Control	The µPD8251 and µPD8251A have a set of control inputs and outputs which may be used to simplify the interface to a Modem.
22	DSR	Data Set Ready	The Data Set Ready input can be tested by the processor via Status information. The DSR input is normally used to test Modem Data Set Ready condition.
24	DTR	Data Terminal Ready	The Data Terminal Ready output can be con- trolled via the Command word. The DTR output is normally used to drive Modem Data Terminal Ready or Rate Select lines.
23	RTS	Request to Send	The Request to Send output can be controlled via the Command word. The \overline{RTS} output is normally used to drive the Modem Request to Send line.
17	CTS	Clear to Send	A "zero" on the Clear to Send input enables the USART to transmit serial data if the TxEN bit in the Command Instruction register is enabled (one)

The Transmit Buffer receives parallel data from the Data Bus Buffer via the internal data bus, converts parallel to serial data, inserts the necessary characters or bits needed for the programmed communication format and outputs composite serial data on the TxD pin.

TRANSMIT BUFFER

		PIN	EUNICEION
NO.	SYMBOL	NAME	FUNCTION
		it Control Logic	The Transmit Control Logic accepts and outputs all external and internal signals necessary for serial data transmission.
15	TXRDY	Transmitter Ready	Transmitter Ready signals the processor that the transmitter is ready to accept a data character. TxRDY can be used as an interrupt or may be tested through the Status information for polled operation. Loading a character from the processor automatically resets TXRDY, on the leading edge.
18	Τ×Ε	Transmitter Empty	The Transmitter Empty output signals the processor that the USART has no further char- acters to transmit. TxE is automatically reset upon receiving a data character from the pro- cessor. In half-duplex, TxE can be used to signal end of a transmission and request the processor to "turn the line around." The TxEn bit in the command instruction does not effect TxE. In the Synchronous mode, a "one" on this out- put indicates that a Sync character or charac- ters are about to be automatically transmitted as "fillers" because the next data character has not been loaded.
9	TxC	Transmitter Clock	The Transmitter Clock controls the serial charac- ter transmission rate. In the Asynchronous mode, the TxC frequency is a multiple of the actual Baud Rate. Two bits of the Mode Instruc- tion select the multiple to be 1x, 16x, or 64x the Baud Rate. In the Synchronous mode, the TxC frequency is automatically selected to equal the actual Baud Rate. Note that for both Synchronous and Asynchro- nous modes, serial data is shifted out of the USART by the falling edge of TxC.
19	TxD	Transmitter Data	The Transmit Control Logic outputs the composite serial data stream on this pin,

ADDRESS BUS A₀ CONTROL BUS 02 10 R I'O W RESET (TTL) DATA BUS 8 C/D cs D7 - D0 RD WR RESET CLK µPD8251/8251A

PIN IDENTIFICATION (CONT.)

μPD8251 AND μPD8251A INTERFACE TO 8080 STANDARD SYSTEM BUS

RECEIVE BUFFER

The Receive Buffer accepts serial data input at the \overline{RxD} pin and converts the data from serial to parallel format. Bits or characters required for the specific communication technique in use are checked and then an eight-bit "assembled" character is readied for the processor. For communication techniques which require less than eight bits, the μ PD8251 and μ PD8251A set the extra bits to "zero."

PIN IDENTIFICATION			PIN	T
(CONT.)	NO.	SYMBOL	NAME	FUNCTION
		Receiver C	iontrol Logic	This block manages all activities related to incoming data.
	14	R×RDY	Receiver Ready	The Receiver Ready output indicates that the Receiver Buffer is ready with an "assembled" character for input to the processor. For Polled operation, the processor can check RxRDY using a Status Read or RxRDY can be connected to the processor interrupt structure Note that reading the character to the processor automatically resets RxRDY.
	25	R ×C	Receiver Clock	The Receiver Clock determines the rate at which the incoming character is received. In the Asyn- chronous mode, the RxC frequency may be 1.16 or 64 times the actual Baud Rate but in the Syn- chronous mode the RxC frequency must equal the Baud Rate. Two bits in the mode instruction select Asynchronous at 1x, 16x or 64x or Syn- chronous operation at 1x the Baud Rate. Unlike TxC, data is sampled by the μ PD8251 and μ PD8251A on the rising edge of RxC ()
	3	R×D	Receiver Data	A composite serial data stream is received by the Receiver Control Logic on this pin
	16	SYNDET (µPD8251)	Sync Detect	The SYNC Detect pin is only used in the Synchronous mode. The "PD8251 may te pro- grammed through the Mode Instruction to operate in either the internal or external Sync mode and SYNDET then functions as an output or input respectively. In the internal Sync mode, the SYNDET output will go to a "one" when the "PD8251 has located the SYNC character in the Receive mode. If double SYNC character (his sync Operation has been pro- grammed, SYNDET will go to "one" in the middle of the last bit of the second SYNC character (his sync Operation has been pro- grammed, SYNDET will go to "one" in the middle of the last bit of the second SYNC character to "zero" upon a Status Read or RESET. In the external SYNC mode, a "zero" to "one" transition on the SYNDET input swill dual character on the next failing edge of RxC. The length of the SYNDET input should be at least one RxC period, but may be removed once the "PD8251 is in SYNC.
	16	SYNDET BD (µPD8251A)	Sync Detect Break Detect	The SYNDET/BD pin is used in both Synchro- nous and Asynchronous modes, When in SYNC mode the features for the SYNDET pin described above apply. When in Asynchro- nous mode, the Break Detect output will go high which all zero word of the programmed length is received. This word consists of: start bit, data bit, parity bit and one stop bit. Reset only occurs when Rx data returns to a logic one state or upon chip reset. The state of Break Detect can be read as a status bit.

Note: 1 Since the µPD8251 and µPD8251A will frequently be handling both the reception and transmission for a given link, the Receive and Transmit Baud Rates will be same. RxC and TxC then require the same frequency and may be tied together and connected to a single clock source or Baud Rate Generator.

Examples

If the Baud Rate equals 110 (Async) If the Baud Rate equals 300:

RxC or TxC equals 110 Hz (1x) RxC or TxC equals 1.76 KHz (16x) RxC or TxC equals 7.04 KHz (64x) RxC or TxC equals 300 Hz (1x) A or S

RxC or TxC equals 4800 Hz (16x) A only RxC or TxC equals 19.2 KHz (64x) A only

A set of control words must be sent to the μ PD8251 and μ PD8251A to define the desired mode and communications format. The control words will specify the BAUD rate factor (1x, 16x, 64x), character length (5 to 8), number of STOP bits (1, 1-1/2, 2) Asynchronous or Synchronous mode, SYNDET (IN or OUT), parity, etc.

After receiving the control words, the μ PD8251 and μ PD8251A are ready to communicate. TxRDY is raised to signal the processor that the USART is ready to receive a character for transmission. When the processor writes a character to the USART, TxRDY is automatically reset.

Concurrently, the μ PD8251 and μ PD8251A may receive serial data; and after receiving an entire character, the RxRDY output is raised to indicate a completed character is ready for the processor. The processor fetch will automatically reset RxRDY.

Note: The μPD8251 and μPD8251A may provide faulty RxRDY for the first read after power-on or for the first read after receive is re-enabled by a command instruction (RxE). A dummy read is recommended to clear faulty RxRDY. But this is not the case for the first read after hardware or software reset after the device operation has once been established.

The μ PD8251 and μ PD8251A cannot transmit until the TxEN (Transmitter Enable) bit has been set by a Command Instruction and until the $\overline{\text{CTS}}$ (Clear to Send) input is a "zero". TxD is held in the "marking" state after Reset awaiting new control words.

The USART must be loaded with a group of two to four control words provided by the processor before data reception and transmission can begin. A RESET (internal or external) must immediately proceed the control words which are used to program the complete operational description of the communications interface. If an external RESET is not available, three successive 00 Hex or two successive 80 Hex command instructions ($C/\overline{D} = 1$) followed by a software reset command instruction (40 Hex) can be used to initialize the μ PD8251 and μ PD8251A.

There are two control word formats:

- 1. Mode Instruction
- 2. Command Instruction

This control word specifies the general characteristics of the interface regarding the Synchronous or Asynchronous mode, BAUD rate factor, character length, parity, and number of stop bits. Once the Mode Instruction has been received, SYNC characters or Command Instructions may be inserted depending on the Mode Instruction content.

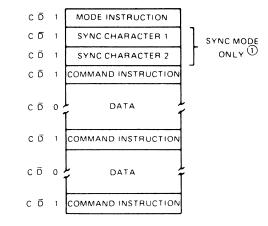
MODE INSTRUCTION

USART PROGRAMMING

OPERATIONAL DESCRIPTION

COMMAND INSTRUCTION This control word will be interpreted as a SYNC character definition if immediately preceded by a Mode Instruction which specified a Synchronous format. After the SYNC character(s) are specified or after an Asynchronous Mode Instruction, all subsequent control words will be interpreted as an update to the Command Instruction. Command Instruction updates may occur at any time during the data block. To modify the Mode Instruction, a bit may be set in the Command Instruction which causes an internal Reset which allows a new Mode Instruction to be accepted.

TYPICAL DATA BLOCK



NOTE (1) The second SYNC character is skipped if MODE instruction has programmed the µPD8251 and µPD8251A to single character Internal SYNC Mode. Both SYNC characters are skipped if MODE instruction has programmed the µPD8251 and µPD8251A to ASYNC mode

MODE INSTRUCTION DEFINITION

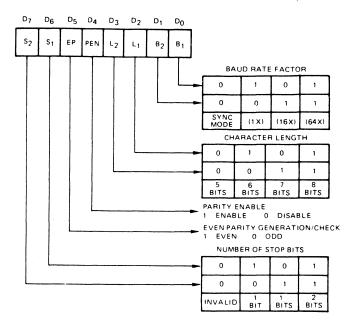
The μ PD8251 and μ PD8251A can operate in either Asynchronous or Synchronous communication modes. Understanding how the Mode Instruction controls the functional operation of the USART is easiest when the device is considered to be two separate components (one asynchronous and the other synchronous) which share the same support circuits and package. Although the format definition can be changed at will or "on the fly," the two modes will be explained separately for clarity.

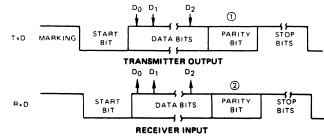
ASYNCHRONOUS TRANSMISSION

When a data character is written into the μ PD8251 and μ PD8251A, the USART automatically adds a START bit (low level or "space") and the number of STOP bits (high level or "mark") specified by the Mode Instruction. If Parity has been enabled, an odd or even Parity bit is inserted just before the STOP bit(s), as specified by the Mode Instruction. Then, depending on CTS and TxEN, the character may be transmitted as a serial data stream at the TxD output. Data is shifted out by the falling edge of TxC at TxC, TxC/16 or TxC/64, as defined by the Mode Instruction.

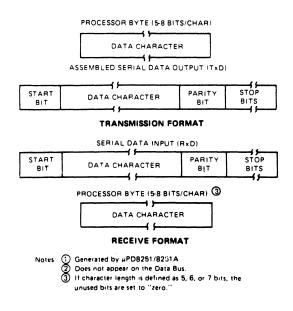
If no data characters have been loaded into the μ PD8251 and μ PD8251A, or if all available characters have been transmitted, the TxD output remains "high" (marking) in preparation for sending the START bit of the next character provided by the processor. TxD may be forced to send a BREAK (continuously low) by setting the correct bit in the Command Instruction.

The RxD input line is normally held "high" (marking) by the transmitting device. A falling edge at RxD signals the possible beginning of a START bit and a new character. The START bit is checked by testing for a "low" at its nominal center as specified by the BAUD RATE. If a "low" is detected again, it is considered valid, and the bit assembling counter starts counting. The bit counter locates the approximate center of the data, parity (if specified), and STOP bits. The parity error flag (PE) is set, if a parity error occurs. Input bits are sampled at the RxD pin with the rising edge of \overline{RxC} . If a high is not detected for the STOP bit, which normally signals the end of an input character, a framing error (FE) will be set. After a valid STOP bit, the input character is loaded into the parallel Data Bus Buffer of the μ PD8251 and μ PD8251A and the RxRDY signal is raised to indicate to the processor that a character is ready to be fetched. If the processor has failed to fetch the previous character, the new character replaces the old and the overrun flag (OE) is set. All the error flags can be reset by setting a bit in the Command Instruction. Error flag conditions will not stop subsequent USART operation.





ASYNCHRONOUS RECEIVE



SYNCHRONOUS TRANSMISSION

As in Asynchronous transmission, the TxD output remains "high" (marking) until the μ PD8251 and μ PD8251A receive the first character (usually a SYNC character) from the processor. After a Command Instruction has set TxEN and after Clear to Send (CTS) goes low, the first character is serially transmitted. Data is shifted out on the falling edge of TxC and the same rate as TxC.

Once transmission has started, Synchronous Mode format requires that the serial data stream at TxD continue at the TxC rate or SYNC will be lost. If a data character is not provided by the processor before the μ PD8251 and μ PD8251A Transmit. Buffer becomes empty, the SYNC character(s) loaded directly following the Mode Instruction will be automatically inserted in the TxD data stream. The SYNC character(s) are inserted to fill the line and maintain synchronization until new data characters are available for transmission. If the μ PD8251 and μ PD8251A become empty, and must send the SYNC character(s), the TxEMPTY output is raised to signal the processor that the Transmitter Buffer is empty and SYNC characters are being transmitted. TxEMPTY is automatically reset by the next character from the processor.

SYNCHRONOUS RECEIVE

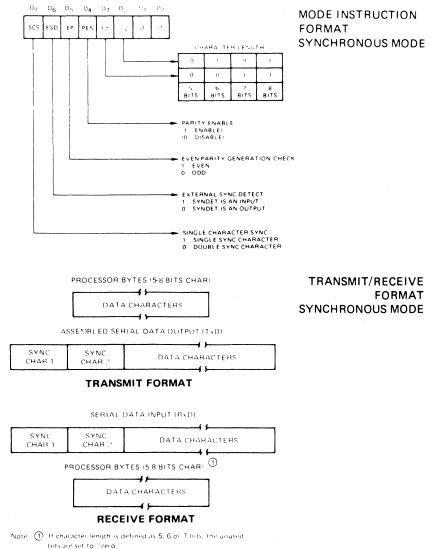
In Synchronous Receive, character synchronization can be either external or internal. If the internal SYNC mode has been selected, and the Enter HUNT (EH) bit has been set by a Command Instruction, the receiver goes into the HUNT mode.

Incoming data on the RxD input is sampled on the rising edge of \overline{RxC} , and the Receive Buffer is compared with the first SYNC character after each bit has been loaded until a match is found. If two SYNC characters have been programmed, the next received character is also compared. When the SYNC character(s) programmed have been detected, the μ PD8251 and μ PD8251A leave the HUNT mode and are in character synchronization. At this time, the SYNDET (output) is set high. SYNDET is automatically reset by a STATUS READ.

If external SYNC has been specified in the Mode Instruction, a "one" applied to the SYNDET (input) for at least one \overline{RxC} cycle will synchronize the USART.

Parity and Overrun Errors are treated the same in the Synchronous as in the Asynchronous Mode. If not in HUNT, parity will continue to be checked even if the receiver is not enabled. Framing errors do not apply in the Synchronous format.

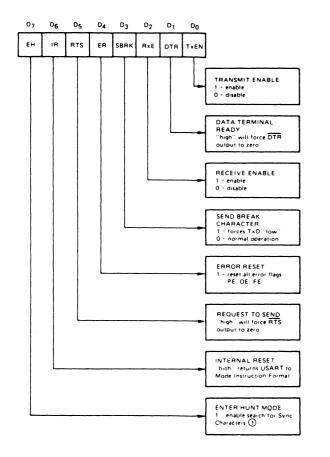
The processor may command the receiver to enter the HUNT mode with a Command Instruction which sets Enter HUNT (EH) if synchronization is lost.



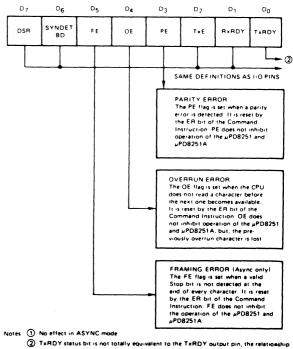
COMMAND INSTRUCTION After the functional definition of the µPD8251 and µPD8251A has been specified by

FORMAT	the Mode Instruction and the SYNC character(s) have been entered (if in SYNC mode), the USART is ready to receive Command Instructions and begin communication. A Command Instruction is used to control the specific operation of the format selected by the Mode Instruction. Enable Transmit, Enable Receive, Error Reset and Modem Controls are controlled by the Command Instruction. After the Mode Instruction and the SYNC character(s) (as needed) are loaded, all subsequent "control writes" ($C/\overline{D} = 1$) will load or overwrite the Command Instruction register. A Reset operation (internal via CMD IR or external via the RESET input) will cause the μ PD8251 and μ PD8251A to interpret the next "control write", which must immediately follow the reset, as a Mode Instruction.
STATUS READ FORMAT	It is frequently necessary for the processor to examine the status of an active interface device to determine if errors have occurred or if there are other conditions which require a response from the processor. The μ PD8251 and μ PD8251A have features which allow the processor to read the device status at any time. A data fetch is issued by the processor while holding the C/ \overline{D} input "high" to obtain device Status Information. Many of the bits in the status register are copies of external pins. This dual status arrangement allows the μ PD8251 and μ PD8251A to be used in both Polled and interrupt driven environments. Status update can have a maximum delay of 16 clock periods in the μ PD8251 and 28 clock periods in the μ PD8251A.
PARITY ERROR	When a parity error is detected, the PE flag is set. It is cleared by setting the ER bit in a subsequent Command Instruction. PE being set does not inhibit USART operation.
OVERRUN ERROR	If the processor fails to read a data character before the one following is available, the OE flag is set. It is cleared by setting the ER bit in a subsequent Command Instruction. Although OE being set does not inhibit USART operation, the previously received character is overwritten and lost.
FRAMING ERROR $^{\textcircled{1}}$	If a valid STOP bit is not detected at the end of a character, the FE flag is set. It is cleared by setting the ER bit in a subsequent Command Instruction. FE being set does not inhibit USART operation.
	Note: ① ASYNC mode only.

COMMAND INSTRUCTION FORMAT



STATUS READ FORMAT

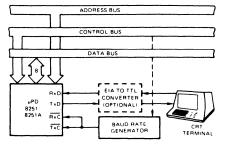


is as follows:

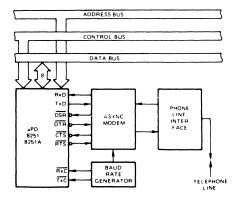
TxRDY status bit = DB Buffer Empty

TxRDY (pin 15) = DB Buffer Empty + CTS + TxEn

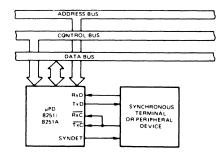
APPLICATION OF THE µPD8251 AND µPD8251A



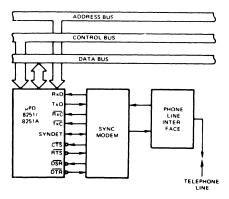
ASYNCHRONOUS SERIAL INTERFACE TO CRT TERMINAL, DC to 9600 BAUD



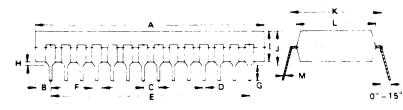
ASYNCHRONOUS INTERFACE TO TELEPHONE LINES



SYNCHRONOUS INTERFACE TO TERMINAL OR PERIPHERAL DEVICE



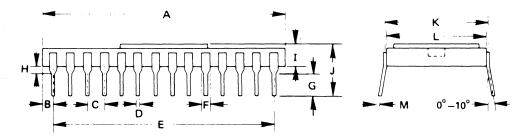
SYNCHRONOUS INTERFACE TO TELEPHONE LINES



PACKAGE OUTLINES µPD8251C µPD8251AC

Plastic

ITEM	MILLIMETERS	INCHES
A	38 0 MAX	1 496 MAX
в	2 49	0 098
с	2 54	0 10
D	05-01	0 02 + 0 004
E	33 0 2	13
F	15	0 059
G	2 54 MIN	0.10 MIN
н	0.5 MIN	0 02 MIN
I	5 22 MAX	0 205 MAX
J	5 72 MAX	0 225 MAX
ĸ	15 24	06
L	13 2	0 52
м	0 25 ° 0 10 0 05	0 01 0 004



μPD8251D μPD8251AD

Ceramic

ITEM	MILLIMETERS	INCHES				
Α	36.2 MAX.	1.43 MAX.				
В	1.59 MAX.	0.06 MAX.				
С	2.54 ± 0.1	0.1 ± 0.004				
D	0.46 ± 0.01	0.02 ± 0.004				
E	33.02 ± 0.1	1.3 ± 0.004 0.04 MIN.				
F	1.02 MIN.					
G	3.2 MIN.	0.13 MIN.				
н	1.0 MIN.	0.04 MIN.				
I	3.5 MAX.	0.14 MAX.				
J	4.5 MAX.	0.18 MAX.				
ĸ	15.24 TYP.	0.6 TYP.				
L	14.93 TYP.	0.59 TYP.				
м	0.25 ± 0.05	0.01 ± 0.002				

SINGLE/DOUBLE DENSITY FLOPPY DISK CONTROLLER

DESCRIPTION

The μ PD765 is an LSI Floppy Disk Controller (FDC) Chip, which contains the circuitry and control functions for interfacing a processor to 4 Floppy Disk Drives. It is capable of supporting either IBM 3740 single density format (FM), or IBM System 34 Double Density format (MFM) including double sided recording. The μ PD765 provides control signals which simplify the design of an external phase locked loop, and write precompensation circuitry. The FDC simplifies and handles most of the burdens associated with implementing a Floppy Disk Interface.

Hand shaking signals are provided in the μ PD765 which make DMA operation easy to incorporate with the aid of an external DMA Controller chip, such as the μ PD8257. The FDC will operate in either DMA or Non-DMA mode. In the Non-DMA mode, the FDC generates interrupts to the processor every time a data byte is available. In the DMA mode, the processor need only load the command into the FDC and all data transfers occur under control of the μ PD765 and DMA controller.

There are 15 separate commands which the μ PD765 will execute. Each of these commands require multiple 8-bit bytes to fully specify the operation which the processor wishes the FDC to perform. The following commands are available:

Read Data	Scan High or Equal	Write Deleted Data
Read ID	Scan Low or Equal	Seek
Read Deleted Data	Specify	Recalibrate (Restore to Track 0)
Read a Track	Write Data	Sense Interrupt Status
Scan Equal	Format a Track	Sense Drive Status

FEATURES Address mark detection circuitry is internal to the FDC which simplifies the phase locked loop and read electronics. The track stepping rate, head load time, and head unload time may be programmed by the user. The µPD765 offers many additional features such as multiple sector transfers in both read and write with a single command, and full IBM compatibility in both single and double density modes.

- IBM Compatible in Both Single and Double Density Recording Formats
- Programmable Data Record Lengths: 128, 256, 512, or 1024 Bytes/Sector
- Multi-Sector and Multi-Track Transfer Capability
- Drive Up to 4 Floppy Disks
- Data Scan Capability Will Scan a Single Sector or an Entire Cylinder's Worth of Data Fields, Comparing on a Byte by Byte Basis, Data in the Processor's Memory with Data Read from the Diskette
- Data Transfers in DMA or Non-DMA Mode
- Parallel Seek Operations on Up to Four Drives
- Compatible with Most Microprocessors Including 8080A, 8085A, μPD780 (Z80TM)
- Single Phase 8 MHz Clock
- Single +5 Volt Power Supply
- Available in 40 Pin Plastic Dual-in-Line Package

RESET	1	~~~~	40 □ Vcc
	2		39 🛱 🕅 🕅 39 🛱
	3		
cs 🗆	4		37 🛱 F 🖬 / STP
A0 [5		36 HDL
	6		35 🗖 RDY
	7		34 🔁 WP/TS
	8		
DB3 C	9	μPD	32 D PS0
D84 🗖	10	765A	31 🕁 PS1
D85 🗖	11		30 🗖 WDA
ове 🗹	12		29 🗖 US0
	13		28 🗖 US1
DRO	14		27 рно
DACK	15		26 🗋 MFM
тс	16		25 WE
	17		24 🗖 VCO
	18		23 RD
CLK [19		22 RDW
GND	20		21 wck

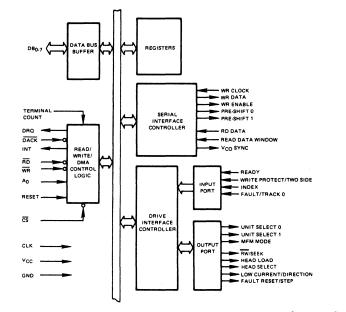
PIN CONFIGURATION

TM:Z80 is a registered trademark of Zilog, Inc.

Reprinted through courtesy of NEC Electronics, U.S.A., Inc.

NOTE: These manufacturer's specifications are provided for reference. The APC may not use some of the functions described here.

BLOCK DIAGRAM



Operating Temperature	10°C to +70°C
Storage Temperature	-55°C to +150°C
All Output Voitages	-0.5 to +7 Volt
All Input Voltages	-0.5 to +7 Volt
Supply Voltage V _{CC}	-0.5 to +7 Volt
Power Dissipation	1 Watt

C ABSOLUTE MAXIMUM C RATINGS*

*COMMENT: Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

 $T_a = 25^{\circ}C$

$T_a = -10^{\circ}C$ to $+70^{\circ}C$; $V_{CC} = +5V \pm 5\%$ unless otherwise specified.

PARAMETER	6Y44001		LIMIT	'S		TEST
PARAMETER	SYMBOL	MIN TYP		MAX	UNIT	CONDITIONS
Input Low Voltage	VIL	-0.5		0.8	V	
Input High Voltage	VIH	2.0		V _{CC} + 0.5	V	
Output Low Voltage	VOL			0.45	V	IOL = 2.0 mA
Output High Voltage	∨он	2.4		Vcc	V	IOH = -200 µA
Input Low Voltage (CLK + WR Clock)	VIL(Φ)	-0.5		0.65	v	
Input High Voltage (CLK + WR Clock)	VIH(Φ)	2.4		VCC + 0.5	v	
V _{CC} Supply Current	1cc			150	mA	
Input Load Current	1.1			10	μA	VIN = VCC
(All Input Pins)				-10	μA	VIN = OV
High Level Output Leakage Current	LOH			10	μA	VOUT = VCC
Low Level Output Leakage Current	LOL			-10	μA	VOUT = +0.45V

DC CHARACTERISTICS

Note: 1 Typical values for $T_a = 25^{\circ}C$ and nominal supply voltage.

PIN IDENTIFICATION

		PIN	INPUT/	CONNECTION	FUNCTION				
NO.	O. SYMBOL NAME		OUTPUT	TO	r unu (lun				
1	RST	Reset	Input	Processor	Places FDC in idle stats. Resets output lines to FDD to "0" (low). Does not effect SRT, HUT or HLT in Specify command. If RDY pin is held high during Reset, FDC will generate interrupt 1.35 ms later. To clear this interrupt use Sense Interrupt Status command.				
2	RD	Read	Input (1)	Processor	Control signal for transfer of data from FDC to Data Bus; when "0" (low).				
3	WR	Write	Input()	Processor	Control signal for transfer of data to FDC via Data Bus, when "0" (low).				
4	CS	Chip Select	Input	Processor	IC selected when "0" (low), allowing RD and WR to be enabled.				
5	A0	Deta/Status Reg Select	Input	Processor	Selects Data Reg (Ag=1) or Status Reg (Ag=0) contents of the FDC to be sent to Data Bus.				
6-13	D80-D87	Deta Bus	Input(1) Output	Processor	Bi-Directional 8-Bit Data Bus.				
14	DRQ	Data DMA Request	Output	DMA	DMA Request is being made by FDC when DRQ="1".				
15	DACK	DMA Acknowledge	Input	DMA	DMA cycle is active when "0" (low) and Controller is performing DMA transfer.				
16	тс	Terminal Count	Input	DMA	Indicates the termination of a DMA trans- fer when "1" (high). It terminates data transfer during Read/Write/Scan command in DMA or interrupt mode.				
17	IDX	Index	Input	FDD	Indicates the beginning of a disk track.				
18	INT	Interrupt	Output	Processor	Interrupt Request Generated by FDC.				
19	CLK	Clock	Input		Single Phase 8 MHz Squarewave Clock.				
20	GND	Ground			D.C. Power Return.				
21	WCK	Write Clock	Input		Write data rate to FDD. FM = 500 kHz, MFM = 1 MHz, with a pulse width of 250 ns for both FM and MFM.				
22	RDW	Read Date Window	Input	Phase Lock Loop.	Generated by PLL, and used to sample data from FDD.				
23	RDD	Reed Data	Input	FDD	Reed data from FDD, containing clock and data bits.				
24	vco	VCO Sync	Output	Phase Lock Loop	Inhibits VCO in PLL when "0" (low), enables VCO when "1."				
25	WE	Write Enable	Output	FDD	Enables write data into FDD.				
26	MFM	MFM Mode	Output	Phase Lock Loop	MFM mode when "1," FM mode when "0."				
27	HD	Head Select	Output	FDD	Heed 1 selected when "1" (high), Heed 0 selected when "0" (low).				
28,29	US1,US0	Unit Select	Output	FDD	FDD Unit Selected.				
30	WDA	Write Date	Output	FDD	Seriel clock and data bits to FDD.				
31,32	PS1,PS0	Precompensation (pre-shift)	Output	FDD	Write precompensation status during MFM mode. Determines early, late, and normal times.				
33	FLT/TR0	Feult/Track 0	Input	FDD	Senses FDD fault condition, in Read/ Write mode; and Track 0 condition in Seek mode.				
34	WP/TS	Write Protect/ Two-Side	Input	FDD	Senses Write Protect status in Read/Write mode; end Two Side Medie in Seek mode.				
36	RDY	Ready	Input	FDD	indicates FDD is ready to send or receive data.				
36	HDL	Heed Loed	Output	FDD	Command which causes read/write head in FDD to contect disketts.				
37	FR/STP	Fit Reset/Step	Output	FDD	Resets fault F.F. In FDD in Read/Write mode, contains step pulses to move head to another cylinder in Seek mode.				
38	LCT/DIR	Low Current/ Direction	Output	FDD	Lowers Write current on Inner tracks in Read/Write mode, determines direction- head will step in Stek mode. A fault reset pulse is issued at the beginning of each Read or Write command prior to the occurrence of the Head Load signal.				
39	TW/SEEK	Read Write/SEEK	Output	FDD	When "1" (high) Seek mode selected and when "0" (low) Read/Write mode selected.				
40	Vcc	+6V			DC Power.				

Note: 1 Disabled when CS = 1.

 $T_a = -10^{\circ}$ C to +70°C; $V_{CC} = +5V \pm 5\%$ unless otherwise specified.

LIMITS TEST PARAMETER SYMBO UNIT CONDITIONS MIN TYP(1) MAX **Clock Period** ΦCY 120 125 500 ns Clock Active (High, Low) Φ0 40 ns Clock Rise Time Φr 20 ns Clock Fall Time Φf 20 ns A0, CS, DACK Set Up Time to RD ↓ TAR ٥ ns A0, CS, DACK Hold Time from RD 1 TRA 0 ns RD Width 250 TRR ns Data Access Time from RD ↓ TRD 200 ns $C_1 = 100 \, \text{pf}$ CL = 100 pF DB to Float Delay Time from RD 1 20 100 TDF ns A0, CS, DACK Set Up Time to WR + TAW 0 ns A0, CS, DACK Hold Time to WR 1 0 ns TWA WR Width 250 Tww ns TDW Data Set Up Time to WR † 150 ns Data Hold Time from WR 1 TWD 5 ns INT Delay Time from RD 1 TBL 500 ns INT Delay Time from WR 1 Twi 500 ns DRQ Cycle Time TMCY 13 μs DRQ Delay Time from DACK ↓ TAM 200 ns TC Width TTC 1 ΦCY **Reset Width** TRST 14 ΦCY 2 or 4(2) MFM = 0WCK Cycle Time TCY μs MFM = 1 1 or 2 250 350 WCK Active Time (High) тο 80 ns WCK Rise Time T_r 20 ns 20 WCK Fall Time Tf ns Pre-Shift Delay Time from WCK 1 20 100 ТСР ns WDA Delay Time from WCK 1 ТСD 20 100 ns **RDD Active Time (High)** 40 TRDD ns 2.0 MFM = 0Window Cycle Time TWCY μs MFM = 1 1.0 TRDW 15 Window Hold Time to/from RDD ns TWRD US0 1 Hold Time to RW/SEEK 1 TUS 12 μs SEEK/RW Hold Time to LOW CURRENT/ ШS TSD 7 DIRECTION 1 LOW CURRENT/DIRECTION Hold Time to TDST 1.0 μs FAULT RESET/STEP 1 8 MHz Clock US0.1 Hold Time from FAULT тѕт∪ μs 5.0 Period RESET/STEP 1 STEP Active Time (High) TSTP 6.0 7.0 μs 0 3 33 STEP Cycle Time тsс μs FAULT RESET Active Time (High) 8.0 10 TFR μs Write Data Width TWDD T0-50 ns US0,1 Hold Time After SEEK TSU 15 μs 8 MHz Clock Seek Hold Time from DIR TDS 30 μs Period **DIR Hold Time after STEP** TSTD 24 μs Index Pulse Width TIDX 10 ΦCY RD + Delay from DRQ TMR 800 ns 8 MHz Clock WR + Delay from DRQ 250 TMW ns Period WE or RD Response Time from DRQ 1 TMRW 12 μs

AC CHARACTERISTICS

Notes: (1) Typical values for $T_a = 25^{\circ}C$ and nominal supply voltage.

The former value of 2 and 1 are applied to Standard Floppy, and the latter value of 4 and 2 are applied to Mini-floppy.

③ Under Software Control. The range is from 1 ms to 16 ms at 8 MHz Clock Period, and 2 to 32 ms at 4 MHz Clock Period.

④ For mini-floppy applications, Φ_{CY} must be 4 mHz.

CAPACITANCE

 $T_a = 25^{\circ}C; f_c = 1 MHz; V_{CC} = 0V$

	0)/11001		LIMIT	s		TEST	
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	CONDITIONS	
Clock Input Capacitance	CIN(Φ)			20	pF	All Pins Except	
Input Capacitance	CIN			10	pF	Pin Under Test Tied to AC	
Output Capacitance	солт			20	рF	Ground	

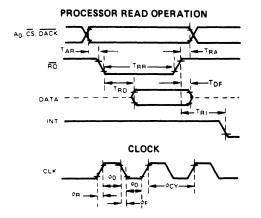
AC TEST CONDITION



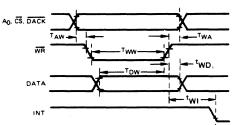
AC TESTING

Inputs are driven at 2.4V for a logic "1" and 0.45V for a logic "0." Timing measurements are made at 2.0V for a logic "1" and 0.8V for a logic "0." Clocks are driven at 3.0V for a logic "1" and 0.3V for a logic "0." Timing measurements are made at 2.4V for a logic "1" and 0.65V for a logic "0."

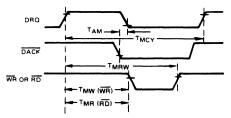
TIMING WAVEFORMS

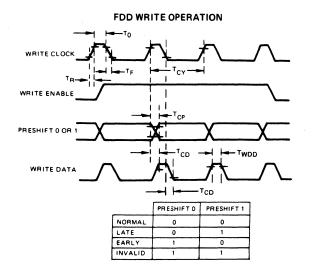


PROCESSOR WRITE OPERATION



DMA OPERATION





SEEK OPERATION

I tsu

tSC

Ltstu_

STD

STABLE

TERMINAL COUNT

RESET

ттс

- TRST

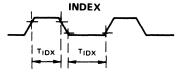
тс

RESET

TIMING WAVEFORMS (CONT.)







FDD READ OPERATION READ DATA -TRDD TRDW -TWRD READ DATA WINDOW Note: Either polarity data window is valid. TWCY

US_{0, 1}

RW/SEEK

DIRECTION

STEP

tus-

^tDST

-l'sol-

tSTP-

INTERNAL REGISTERS The µPD765 contains two registers which may be accessed by the main system processor; a Status Register and a Data Register. The 8-bit Main Status Register contains the status information of the FDC, and may be accessed at any time. The 8-bit Data Register (actually consists of several registers in a stack with only one register presented to the data bus at a time), which stores data, commands, parameters, and FDD status information. Data bytes are read out of, or written into, the Data Register in order to program or obtain the results after a particular command. The Status Register may only be read and is used to facilitate the transfer of data between the processor and µPD765.

The relationship between the Status/Data registers and the signals $\overline{RD}, \overline{WR},$ and A_0 is shown below.

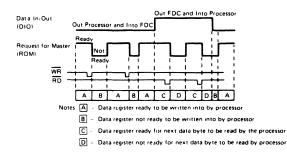
A0	Ao RD WR		FUNCTION
0	0	1	Read Main Status Register
0	1	0	Illegal
0	0	0	Illegal
1	0	0	Illegal
1	0	1	Read from Data Register
1	1	0	Write into Data Register

INTERNAL REGISTERS (CONT.)

The bits in the Main Status Register are defined as follows:

BIT NUMBER	NAME	SYMBOL	DESCRIPTION
DB ₀	FDD 0 Busy	D ₀ B	FDD number 0 is in the Seek mode. If any of the bits is set FDC will not accept read or write command.
DB1	FDD 1 Busy	D ₁ B	FDD number 1 is in the Seek mode. If any of the bits is set FDC will not accept read or write command.
DB2	FDD 2 Busy	D ₂ B	FDD number 2 is in the Seek mode. If any of the bits is set FDC will not accept read or write command.
DB3	FDD 3 Busy	D ₃ B	FDD number 3 is in the Seek mode. If any of the bits is set FDC will not accept read or write command.
DB4	FDC Busy	CB	A read or write command is in process. FDC will not accept any other command.
DB5	Execution Mode	EXM	This bit is set only during execution phase in non-DMA mode. When DB5 goes low, execution phase has ended, and result phase was started. It operates only during NON-DMA mode of operation.
DB6	Data Input/Output	DIO	Indicates direction of data transfer between FDC and Data Register. If DIO = "1" then transfer is from Data Register to the Processor. If DIO = "0", then transfer is from the Processor to Data Register.
DB7	Request for Master	RQM	Indicates Data Register is ready to send or receive data to or from the Processor. Both bits DIO and RQM should be used to perform the hand-shaking functions of "ready" and "direction" to the processor.

The DIO and RQM bits in the Status Register indicate when Data is ready and in which direction data will be transferred on the Data Bus. The max time between the last RD or WR during command or result phase and DIO and RQM getting set or reset is 12 µs. For this reason every time Main Status Register is read the CPU should wait 12 µs. The max time from the trailing edge cf the last RD in the result phase to when DB4 (FDC Bury) goes low is 12 µs.



COMMAND SEQUENCE

The μ PD765 is capable of performing 15 different commands. Each command is initiated by a multi-byte transfer from the processor, and the result after execution of the command may also be a multi-byte transfer back to the processor. Because of this multi-byte interchange of information between the μ PD765 and the processor, it is convenient to consider each command as consisting of three phases:

Command Phase:	The FDC receives all information required to perform a particular operation from the processor.
Execution Phase:	The FDC performs the operation it was instructed to do.
Result Phase:	After completion of the operation, status and other housekeeping information are made available to the processor.

INSTRUCTION SET

				D	ATA	BUS	5									D	AT	A BU	IS			1
PHASE	R/W	D ₇ D	6 D	5 D	4 [3	D2	D1	D ₀	REMARKS	PHASE	R/W	D7	D ₆	De	; D	4	D3	D2	D1	D ₀	REMARKS
	SCAN LOW OR EQUAL							RECALIBRATE														
Command	w	мт м							1	Command Codes	'Command	w	0	0	0	(0	0	1	1	1	Command Codes
	w	x >	< x)	K (x	HD	US1	US0			w	x	х	x	х	<	х	с	US1	US0	1
	w				- c-					Sector ID information prior	Execution											Head retracted to Track 0
	w									Command execution	'				SE	NSE	E IN	TER	RUP	T ST	ATUS	
	w				N	 -					Command	w	0	0	0	C)	1	0	0	0	Command Codes
	w				- GPI						Result	в	_				st	o				Status information at the end
	w				- STP	·					Tiesu II	R										of seek-operation about the FDC
Execution										Data-compared between the								SPE	CIFY	'		
										FDD and main-system	Command	w	0	0	0	0)	0	0	1	1	Command Codes
Result	R				- st	0				Status information after		w								- HU		
	R									Command execution		W		H								L
	R				- c					Sector ID information after	Command		0			-			-		s 0	
	R				—н					Command execution	Command	w		-	0	-		0		-	-	Command Codes
	R				N							w	х	~	~		•		HU	051	US0	
				SCA	ANH	IGH	OR	EQUA	NL.		Result	R				_	ST	-				Status information about FDD
Command	w	MT N	IF SI	ĸ	1	1	1	0	1	Command Codes								SEE				,
	w	x	ĸ ×	¢ :	x	x	нD	US1	USO		Command	w	0		0			1		1	1	Command Codes
	w									Sector ID information prior		w	~	~				x N		051	US0	
	w									Command execution	Execution	~					- NC	N				
	w																					Head is positioned over proper Cylinder on
	w																					Diskette
	w				- ST	P																
Execution										Data-compared between the									ALID			
CARGIN										FDD and main-system	Command	w			1	nval	lid C	ode	s			Invalid Command Codes (NoOp – FDC goes into
Result	R									Status information after	1 1											Standby State)
	R									Command execution	Result	R					ST	0 —				ST 0 = 80
	R									Sector ID information after												(16)
	R									Command execution												
	R																					
L	L	<u> </u>					-			1												

INSTRUCTION SET ① ② (CONT.)

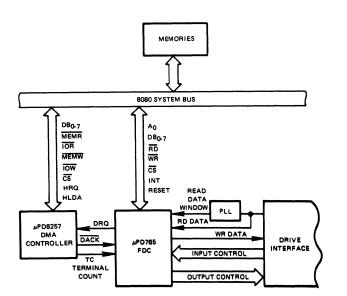
		DATA BUS	······································			DATA BUS	
PHASE	R/W	D7 D6 D5 D4 D3 D2 D1 D0	REMARKS	PHASE	R/W	D7 D6 D5 D4 D3 D2 D1 D0	REMARKS
		READ DATA				READ A TRACK	
Command	w	MT MF SK 0 0 1 1 0	Command Codes	Command	w	0 MF SK 0 0 0 1 0	Command Codes
	w	X X X X X HD US1 US0			w	X X X X X HD US1 US0	
	w	C	Sector ID information prior		w	C	Sector ID information prior
	w	H	to Command execution. The		w		to Command execution
J	w	R	4 bytes are commanded against		w		
	w	N	header on Floppy Disk.		w	N	
	w	EOT			w	EOT	
1.1	w l	OTL			l ŵ		
		512				DIE	
Execution			Data-transfer between the	Execution			Data-transfer between the
			FDD and main-system				FDD and main-system, FDC
Result	R	ST 0	Status information after				reads all data fields from index hole to EOT
	R	ST 1	Command execution			1	
	R	ST 2		Result	R	ST 0	Status information after
	R	C	Sector ID information after		R	ST 1	Command execution
	8		Command execution		R		Sector ID information after
	B	N			8		Command execution
		READ DELETED DATA			B		Command exception
Command					R	N	
Command	w	MT MF SK 0 1 1 0 0	Command Codes			BEAD ID	
	w	X X X X X HD US1 US0		Command	w	0 MF 0 0 1 0 1 0	Commands
	w	C	Sector ID information prior		w.	X X X X X HD US1 US0	
	w		to Command execution. The				
	w		4 bytes are commanded against header on Floppy Disk.	Execution			The first correct ID informatic
	w	EOT	header on r loppy black.				on the Cylinder is stored in
	w	GPL					Data Register
	w	DTL		Result	R		Status information after
Execution					B	ST 1	Command execution
Execution			Data-transfer between the FDD and main-system		R	ST 2	
			P DD and main-system		R	c	Sector ID information read
Result	R	ST 0	Status information after		R	H	during Execution Phase from
	F.	ST 1	Command execution		R	A	Floppy Disk
	R	ST 2			н	N N	
	R	C	Sector ID information after			FORMAT A TRACK	
	R		Command execution	Command	w	0 MF 0 0 1 1 0 1	Command Codes
	B	N			w	X X X X X HD US1 US0	
					w	N	Bytes/Sector
· · · · · · · · · · · · · · · · · · ·		WRITE DATA			w	SC	Sectors/Track
Command	w	MT MF 0 0 0 1 0 1	Command Codes		w	GPL	Gap 3
	w	X X X X X HD US1 US0			w	D	Filler Byte
	w	c	Sector ID information prior	Execution			FDC formats an entire track
	w	H	to Command execution. The				
	*		4 bytes are commanded against	Result	R	ST 0	Status information after
		EQT	header on Floppy Disk.		R		Command execution
	w				R	ST 2 C	
	ŵ	DTL			B		In this case, the ID information has no meaning
	1				R		has no meaning
Execution			Data-transfer between the		R	N	
[1		main-system and FDD			SCAN EQUAL	
Result	R	ST 0	Status information after	0	W		
	R		Command execution	Command		MT MF SK 1 0 0 0 1	Command Codes
	R	ST 2			~	X X X X X HD US1 US0	
	R		Sector ID information after		w	C	Sector ID information prior
	R R		Command execution		w	н	to Command execution
	R				w		
		WRITE DELETED DATA			w	EOT	
					w	GPL	
Command	w	MT MF 0 0 1 0 0 1	Command Codes		w	STP	
	w	X X X X X HD US1 US0					_
	w	c	Sector ID information prior	Execution			Data-compared between the
	w	+-	to Command execution. The				FOD and main-system
	w		4 bytes are commanded against	Result	R	ST 0	Status information after
	w w		header on Floppy Disk.		R	ST 1	Command execution
	~	EOT			R	ST 2	
		DTL			R	C	Sector ID information after
		0.0			R	н	Command execution
Execution			Data-transfer between the		R		
	ļ		FDD and main-system		н	N	
Result	R	ST 0	Status information after				
nesult i	R	\$T 0	Status information after Command execution				
	R	ST 1	Commence execution				
		C 1					
	R	C	Sector ID information after Command execution				
	R						
	R R	н					

Note: ① Symbols used in this table are described at the end of this section.

A₀ should equal binary 1 for all operations.
 X = Don't care, usually made to equal binary 0.

SYMBOL	NAME	DESCRIPTION		
A ₀	Address Line 0	A_0 controls selection of Main Status Register (A_0 = 0) or Data Register (A_0 = 1)		
С	Cylinder Number	C stands for the current/selected Cylinder (track) number 0 through 76 of the medium.		
D	Data	D stands for the data pattern which is going to be written into a Sector.		
D7-D0	Data Bus	8-bit Data Bus, where D7 stands for a most significant bit, and D0 stands for a least significant bit.		
DTL	Data Length	When N is defined as 00, DTL stands for the data length which users are going to read out or write into the Sector.		
EOT	End of Track	EOT stands for the final Sector number on a Cylinder. During Read or Write operation FDC will stop date transfer after a sector # equal to EOT.		
GPL	Gap Length	GPL stands for the length of Gap 3, During Read/Write commands this value determines the number of bytes that VCOs will stay low after two CRC bytes. During Format command it determines the size of Gap 3.		
н	Head Address	H stands for head number 0 or 1, as specified in ID field.		
HD	Head	HD stands for a selected head number 0 or 1 and controls the polarity of pin 27. (H = HD in all command words.)		
HLT	Head Load Time	HLT stands for the head load time in the FDD (2 to 254 ms in 2 ms increments).		
нот	Head Unload Time	HUT stands for the head unload time after a read or write opera- tion has occurred (16 to 240 ms in 16 ms increments).		
MF	FM or MFM Mode	If MF is low, FM mode is selected, and if it is high, MFM mode is selected.		
мт	Multi-Track	If MT is high, a multi-track operation is to be performed. If MT = after finishing Read/Write operation on side 0 FDC will auto- matically start searching for sector 1 on side 1.		

COMMAND SYMBOL DESCRIPTION



SYSTEM CONFIGURATION

COMMAND SYMBOL DESCRIPTION (CONT.)

SYMBOL	NAME	DESCRIPTION		
N	Number	N stands for the number of data bytes written in a Sector.		
NCN	New Cylinder Number	NCN stands for a new Cylinder number, which is going to be reached as a result of the Seek operation. Desired position of Head.		
ND	Non-DMA Mode	ND stands for operation in the Non-DMA Mode.		
PCN	Present Cylinder Number	PCN stands for the Cylinder number at the com- pletion of SENSE INTERRUPT STATUS Command. Position of Head at present time.		
R	Record	R stands for the Sector number, which will be read or written.		
R/W	Read/Write	R/W stands for either Read (R) or Write (W) signal.		
sc	Sector	SC indicates the number of Sectors per Cylinder.		
SK	Skip	SK stands for Skip Deleted Data Address Mark.		
SRT	Step Rate Time	SRT stands for the Stepping Rate for the FDD. (1 to 16 ms in 1 ms increments.) Stepping Rate applies to all drives, (F = 1 ms, E = 2 ms, etc.).		
ST 0 ST 1 ST 2 ST 3	Status O Status 1 Status 2 Status 3	ST 0-3 stand for one of four registers which store the status information after a command has been executed. This information is available during the result phase after command execution. These registers should not be con- fused with the main status register (selected by $A_0 = 0$). ST 0-3 may be read only after a com- mand has been executed and contain information relevant to that particular command.		
STP		During a Scan operation, if STP = 1, the data in contiguous sectors is compared byte by byte with data sent from the processor (or DMA); and if STP = 2, then alternate sectors are read and compared.		
US0, US1	Unit Select	US stands for a selected drive number 0 or 1.		

PROCESSOR INTERFACE

During Command or Result Phases the Main Status Register (described earlier) must be read by the processor before each byte of information is written into or read from the Data Register. After each byte of data read or written to Data Register, CPU should wait tor 12 μ s before reading MSR. Bits D6 and D7 in the Main Status Register must be in a 0 and 1 state, respectively, before each byte of the command word may be written into the μ PD765. Many of the commands require multiple bytes, and as a result the Main Status Register must be read prior to each byte transfer to the μ PD765. On the other hand, during the Result Phase, D6 and D7 in the Main Status Register. Note, this reading of the Main Status Register before each byte from the Data Register. Note, this reading of the Main Status Register before each byte transfer to the μ PD765 is required in only the Command and Result Phases, and NOT during the Execution Phase.

During the Execution Phase, the Main Status Register need not be read. If the μ PD765 is in the NON-DMA Mode, then the receipt of each data byte (if μ PD765 is reading data from FDD) is indicated by an Interrupt signal on pin 18 (INT = 1). The generation of a Read signal ($\overline{RD} = 0$) or Write signal ($\overline{WR} = 0$) will reset the Interrupt as well as output the Data onto the Data Bus. If the processor cannot handle Interrupts fast enough (every 13 μ s) for MFM and 27 μ s for FM mode, then it may poll the Main Status Register and then bit D7 (RQM) functions just like the Interrupt signal. If a Write Command is in process then the WR signal performs the reset to the Interrupt signal.

If the μ PD765 is in the DMA Mode, no Interrupts are generated during the Execution Phase. The μ PD765 generates DRQ's (DMA Requests) when each byte of data is available. The DMA Controller responds to this request with both a DACK = 0 (DMA Acknowledge) and a \overline{RD} = 0 (Read signal). When the DMA Acknowledge signal goes low (DACK = 0) then the DMA Request is reset (DRQ = 0). If a Write Command has been programmed then a WR signal will appear instead of RD. After the Execution Phase has been completed (Terminal Count has occurred) or EOT sector was read/ written, then an Interrupt will occur (INT = 1). This signifies the beginning of the Result Phase. When the first byte of data is read during the Result Phase, the Interrupt is automatically reset (INT = 0).

It is important to note that during the Result Phase all bytes shown in the Command Table must be read. The Read Data Command, for example has seven bytes of data in the Result Phase. All seven bytes must be read in order to successfully complete the Read Data Command. The μ PD765 will not accept a new command until all seven bytes have been read. Other commands may require fewer bytes to be read during the Result Phase.

The μ PD765 contains five Status Registers. The Main Status Register mentioned above may be read by the processor at any time. The other four Status Registers (ST0, ST1, ST2, and ST3) are only available during the Result Phase, and may be read only after completing a command. The particular command which has been executed determines how many of the Status Registers will be read.

The bytes of data which are sent to the μ PD765 to form the Command Phase, and are read out of the μ PD765 in the Result Phase, must occur in the order shown in the Command Table. That is, the Command Code must be sent first and the other bytes sent in the prescribed sequence. No foreshortening of the Command or Result Phases are allowed. After the last byte of data in the Command Phase is sent to the μ PD765, the Execution Phase automatically starts. In a similar fashion, when the last byte of data is read out in the Result Phase, the command is automatically ended and the μ PD765 is ready for a new command.

After the Specify command has been sent to the μ PD765, the Unit Select line US0 and US1 will automatically go into a polling mode. In between commands (and between step pulses in the SEEK command) the μ PD765 polls all four FDD's looking for a change in the Ready line from any of the drives. If the Ready line changes state (usually due to a door opening or closing) then the μ PD765 will generate an interrupt. When Status Register 0 (ST0) is read (after Sense interrupt Status is issued), Not Ready (NR) will be indicated. The polling of the Ready line by the μ PD765 occurs continuously between commands, thus notifying the processor which drives are on or off line. Each drive is polled every 1,024 ms except during the Read/Write commands.

READ DATA

A set of nine (9) byte words are required to place the FDC into the Read Data Mode. After the Read Data command has been issued the FDC loads the head (if it is in the unloaded state), waits the specified head settling time (defined in the Specify Command), and begins reading ID Address Marks and ID fields. When the current sector number ("R") stored in the ID Register (IDR) compares with the sector number read off the diskette, then the FDC outputs data (from the data field) byte-to-byte to the main system via the data bus.

After completion of the read operation from the current sector, the Sector Number is incremented by one, and the data from the next sector is read and output on the data bus. This continuous read function is called a "Multi-Sector Read Operation." The Read Data Command <u>may be</u> terminated by the receipt of a Terminal Count signal. TC should be issued at the same time that the <u>DACK</u> for the last byte of data is sent. Upon receipt of this signal, the FDC stops outputting data to the processor, but will continue to read data from the current sector, check CRC (Cyclic Redundancy Count) bytes, and then at the end of the sector terminate the Read Data Command.

The amount of data which can be handled with a single command to the FDC depends upon MT (multitrack), MF (MFM/FM), and N (Number of Bytes/Sector). Table 1 below shows the Transfer Capacity.

FUNCTIONAL DESCRIPTION OF COMMANDS

POLLING FEATURE OF THE μPD765

Multi-Track MFM/FM Bytes/S MT MF N		Bytes/Sector N	Maximum Transfer Capacity (Bytes/Sector) (Number of Sectors)	Final Sector Read from Diskette	
0	0	00	(128) (26) = 3,328	26 at Side 0	
0	1	01	(256) (26) = 6,656	or 26 at Side 1	
1	0	00	(128) (52) = 6,656	26 at Side 1	
1	1	01	(256) (52) = 13,312		
0	0	01	(256) (15) = 3,840	15 at Side 0	
0	1	02	(512) (15) = 7,680	or 15 at Side 1	
1	0	01	(256) (30) = 7,680	15 at Side 1	
1	1	02	(512) (30) = 15,360		
0	0	02	(512) (8) = 4,096	8 at Side 0	
0	1	03	(1024) (8) = 8,192	or 8 at Side 1	
1	0	02	(512) (16) = 8,192	8 at Side 1	
1	1	03	(1024) (16) = 16,384		

Table 1. Transfer Capacity

The "multi-track" function (MT) allows the FDC to read data from both sides of the diskette. For a particular cylinder, data will be transferred starting at Sector 1, Side 0 and completing at Sector L, Side 1 (Sector L = last sector on the side). Note, this function pertains to only one cylinder (the same track) on each side of the diskette.

When N = 0, then DTL defines the data length which the FDC must treat as a sector. If DTL is smaller than the actual data length in a Sector, the data beyond DTL in the Sector, is not sent to the Data Bus. The FDC reads (internally) the complete Sector performing the CRC check, and depending upon the manner of command termination, may perform a Multi-Sector Read Operation. When N is non-zero, then DTL has no meaning and should be set to FF Hexidecimal.

At the completion of the Read Data Command, the head is not unloaded until after Head Unload Time Interval (specified in the Specify Command) has elapsed. If the processor issues another command before the head unloads then the head settling time may be saved between subsequent reads. This time out is particularly valuable when a diskette is copied from one drive to another.

If the FDC detects the Index Hole twice without finding the right sector, (indicated in "R"), then the FDC sets the ND (No Data) flag in Status Register 1 to a 1 (high), and terminates the Read Data Command. (Status Register 0 also has bits 7 and 6 set to 0 and 1 respectively.)

After reading the ID and Data Fields in each sector, the FDC checks the CRC bytes. If a read error is detected (incorrect CRC in ID field), the FDC sets the DE (Data Error) flag in Status Register 1 to a 1 (high), and if a CRC error occurs in the Data Field the FDC also sets the DD (Data Error in Data Field) flag in Status Register 2 to a 1 (high), and terminates the Read Data Command. (Status Register 0 also has bits 7 and 6 set to 0 and 1 respectively.)

If the FDC reads a Deleted Data Address Mark off the diskette, and the SK bit (bit D5 in the first Command Word) is not set (SK = 0), then the FDC sets the CM (Control Mark) flag in Status Register 2 to a 1 (high), and terminates the Read Data Command, after reading all the data in the Sector. If SK = 1, the FDC skips the sector with the Deleted Data Address Mark and reads the next sector. The CRC bits in the deleted data field are not checked when SK = 1.

During disk data transfers between the FDC and the processor, via the data bus, the FDC must be serviced by the processor every $27 \,\mu s$ in the FM Mode, and every $13 \,\mu s$ in the MFM Mode, or the FDC sets the OR (Over Run) flag in Status Register 1 to a 1 (high), and terminates the Read Data Command.

If the processor terminates a read (or write) operation in the FDC, then the ID Information in the Result Phase is dependent upon the state of the MT bit and EOT byte. Table 2 shows the values for C, H, R, and N, when the processor terminates the Command.

мт		E la secontra de la seconda de	ID Information at Result Phase			
	HD	Final Sector Transferred to Processor	С	н	R	N
0	0	Less than EOT	NC	NC	R + 1	NC
	0	Equal to EOT	C + 1	NC	R = 01	NC
	1	Less than EOT	NC	NC	R + 1	NC
	1	Equal to EOT	C + 1	NC	R = 01	NC
1	0	Less than EOT	NC	NC	R + 1	NC
	0	Equal to EOT	NC	LSB	R = 01	NC
	1	Less than EOT	NC	NC	R + 1	NC
	1	Equal to EOT	C + 1	LSB	R = 01	NC

FUNCTIONAL DESCRIPTION OF COMMANDS (CONT.)

Notes: 1 NC (No Change): The same value as the one at the beginning of command execution.

2 LSB (Least Significant Bit): The least significant bit of H is complemented.

WRITE DATA

A set of nine (9) bytes are required to set the FDC into the Write Data mode. After the Write Data command has been issued the FDC loads the head (if it is in the unloaded state), waits the specified Head Settling Time (defined in the Specify Command), and begins reading ID Fields. When all four bytes loaded during the command (C, H, R, N) match the four bytes of the ID field from the diskette, the FDC takes data from the processor byte-by-byte via the data bus, and outputs it to the FDD.

After writing data into the current sector, the Sector Number stored in "R" is incremented by one, and the next data field is written into. The FDC continues this "Multi-Sector Write Operation" until the issuance of a Terminal Count signal. If a Terminal Count signal is sent to the FDC it continues writing into the current sector to complete the data field. If the Terminal Count signal is received while a data field is being written then the remainder of the data field is filled with 00 (zeros).

The FDC reads the ID field of each sector and checks the CRC bytes. If the FDC detects a read error (incorrect CRC) in one of the ID Fields, it sets the DE (Data Error) riag of Status Register 1 to a 1 (high), and terminates the Write Data Command. (Status Register 0 also has bits 7 and 6 set to 0 and 1 respectively.)

The Write Command operates in much the same manner as the Read Command. The following items are the same, and one should refer to the Read Data Command for details:

- Transfer Capacity
- Head Unload Time Interval
- EN (End of Cylinder) Flag
- ID Information when the processor terminates command (see Table 2)

ND (No Data) Flag

• Definition of DTL when N = 0 and when N \neq 0

In the Write Data mode, data transfers between the processor and FDC, via the Data Bus, must occur every 27 µs in the FM mode, and every 13 µs in the MFM mode. If the time interval between data transfers is longer than this then the FDC sets the OR (Over Run) flag in Status Register 1 to a 1 (high), and terminates the Write Data Command. (Status Register 0 also has bit 7 and 6 set to 0 and 1 respectively.)

WRITE DELETED DATA

This command is the same as the Write Data Command except a Deleted Data Address Mark is written at the beginning of the Data Field instead of the normal Data Address Mark.

READ DELETED DATA

This command is the same as the Read Data Command except that when the FDC detects a Data Address Mark at the beginning of a Data Field (and SK = 0 (low), it will read all the data in the sector and set the CM flag in Status Register 2 to a 1 (high), and then terminate the command. If SK = 1, then the FDC skips the sector with the Data Address Mark and reads the next sector.

READ & TRACK

This command is similar to READ DATA Command except that this is a continuous READ operation where the entire data field from each of the sectors are read. Immediately after encountering the INDEX HOLE, the FDC starts reading all data fields on the track, as continuous blocks of data. If the FDC finds an error in the ID or DATA CRC check bytes, it continues to read data from the track. The FDC compares the ID information read from each sector with the value stored in the IDR, and sets the ND flag of Status Register 1 to a 1 (high) if there is no comparison. Multi-track or skip operations are not allowed with this command.

FUNCTIONAL DESCRIPTION OF COMMANDS (CONT.)

This command terminates when number of sectors read is equal to EOT. If the FDC does not find an ID Address Mark on the diskette after it encounters the INDEX HOLE for the second time, then it sets the MA (missing address mark) flag in Status Register 1 to a 1 (high), and terminates the command. (Status Register 0 has bits 7 and 6 set to 0 and 1 respectively.)

READ ID

The READ ID Command is used to give the present position of the recording head. The FDC stores the values from the first ID Field it is able to read. If no proper ID Address Mark is found on the diskette, before the INDEX HOLE is encountered for the second time then the MA (Missing Address Mark) flag in Status Register 1 is set to a 1 (high), and if no data is found then the ND (No Data) flag is also set in Status Register 1 to a 1 (high). The command is then terminated with Bits 7 and 6 in Status Register 0 set to 0 and 1 respectively. During this command there is no data transfer between FDC and the CPU except during the result phase.

FORMAT A TRACK

The Format Command allows an entire track to be formatted. After the INDEX HOLE is detected, Data is written on the Diskette; Gaps, Address Marks, ID Fields and Data Fields, all per the IBM System 34 (Double Density) or System 3740 (Single Density) Format are recorded. The particular format which will be written is controlled by the values programmed into N (number of bytes/sector), SC (sectors/cylinder), GPL (Gap Length), and D (Data Pattern) which are supplied by the processor during the Command Phase. The Data Field is filled with the Byte of data stored in D. The ID Field for each sector is supplied by the processor that is, four data requests per sector are made by the FDC for C (Cylinder Number), H (Head Number), R (Sector Number) and N (Number of Bytes/Sector). This allows the diskette to be formatted with non-sequential sector numbers, if desired.

The processor must send new values for C, H, R, and N to the μ PD765 for each sector on the track. If FDC is set for DMA mode, it will issue 4 DMA requests per sector. If it is set for interrupt mode, it will issue four interrupts per sector and the processor must supply C, H, R and N load for each sector. The contents of the R register is incremented by one after each sector is formatted, thus, the R register contains a value of R when it is read during the Result Phase. This incrementing and formatting continues for the whole track until the FDC encounters the INDEX HOLE for the second time; whereupon it terminates the command.

If a FAULT signal is received from the FDD at the end of a write operation, then the FDC sets the EC flag of Status Register 0 to a 1 (high), and terminates the command after setting bits 7 and 6 of Status Register 0 to 0 and 1 respectively. Also the loss of a READY signal at the beginning of a command execution phase causes bits 7 and 6 of Status Register 0 to be set to 0 and 1 respectively.

Table 3 shows the relationship between N, SC, and GPL for various sector sizes:

8" STANDARD FLOPPY

5%" MINI FLOPPY

FORMAT	SECTOR SIZE	N	SC	GPL ()	GPL 2	SECTOR SIZE	N	SC	GPL ①	GPL (2)
	128 bytes/Sector	00	1A	07	1B	128 bytes/Sector	00	12	07	09
FM Mode	256	01	0F	0E	2A	128	00	10	10	19
	512	02	08	1B	3A	256	01	08	18	30
	1024 bytes/Sector	03	04	47	8A	512	02	04	46	87
	2048	04	02	C8	FF	1024	03	02	C8	FF
	4096	05	01	C8	FF	2048	04	01	C8	FF
	256	01	1A	OE	36	256	01	12	0A	0C
	512	02	0F	1B	54	256	01	10	20	32
	1024	03	08	35	74	512	02	08	2A	50
MFM Mode	2048	04	04	99	FF	1024	03	04	80	FO
	4096	05	02	C8	FF	2048	04	02	C8	FF
	8192	06	01	C8	FF	4096	05	01	C8	FF

Table 3

Note: (1) Suggested values of GPL in Read or Write Commands to avoid splice point between data field and ID field of contiguous sections.

② Suggested values of GPL in format command.

③ In MFM mode FDC can not perform a read/write/format operation with 128 bytes/sector. (N = 00)

(4) All the values are hexidecimal.

SCAN COMMANDS

The SCAN Commands allow data which is being read from the diskette to be compared against data which is being supplied from the main system. The FDC compares the data on a byte-by-byte basis, and looks for a sector of data which meets the conditions of $D_{FDD} = D_{Processor}$. $D_{FDD} \leq D_{Processor}$, or $D_{FDD} \geq D_{Processor}$. The hexidicemial byte of FF either from memory or from FDD can be used as a mask byte because it always meet the condition of the compare. Ones complement arithmetic is used for comparison (FF = largest number, 00 = smallest number). After a whole sector of data is compared, if the conditions are not met, the sector number is incremental (R + STP \rightarrow R), and the scan operation is continued. The scan operation continues until one of the following conditions occur; the conditions for scan are met (equal, low, or high), the last sector on the track is reached (ECT), or the terminal count signal is received.

If the conditions for scan are met then the FDC sets the SH (Scan Hit) flag of Status Register 2 to a 1 (high), and terminates the Scan Command. If the conditions for scan are not met between the starting sector (as specified by R) and the last sector on the cylinder (EOT), then the FDC sets the SN (Scan Not Satisfied) flag of Status Register 2 to a 1 (high), and terminates the Scan Command. The receipt of a TERMINAL COUNT signal from the Processor or DMA Controller during the scan operation will cause the FDC to complete the comparison of the particular byte which is in process, and then to terminate the command. Table 4 shows the status of bits SH and SN under various conditions of SCAN.

COMMAND	STATUS R	EGISTER 2	COMMENTS		
COMMAND	BIT 2 = SN	BIT 3 = SH	CONNIVIENTS		
Scan Equal	0	1	DFDD = DProcessor		
	1	0	DFDD ≠ DProcessor		
Scan Low or Equal	0	1	DFDD = DProcessor		
	0	0	DFDD < DProcessor		
	1	0	DFDD > DProcessor		
Scan High or Equal	0	1	DFDD = Dprocessor		
	0	0	DFDD > Dprocessor		
	1	0	DFDD < Dprocessor		

Table 4

If the FDC encounters a Deleted Data Address Mark on one of the sectors (and SK = 0), then it regards the sector as the last sector on the cylinder, sets CM (Control Mark) flag of Status Register 2 to a 1 (high) and terminates the command. If SK = 1, the FDC skips the sector with the Deleted Address Mark, and reads the next sector. In the second case (SK = 1), the FDC sets the CM (Control Mark) flag of Status Register 2 to a 1 (high) in order to show that a Deleted Sector had been encountered.

When either the STP (contiguous sectors = 01, or alternate sectors = 02 sectors are read) or the MT (Multi-Track) are programmed, it is necessary to remember that the last sector on the track must be read. For example, if STP = 02, MT = 0, the sectors are numbered sequentially 1 through 26, and we start the Scan Command at sector 21; the following will happen. Sectors 21, 23, and 25 will be read, then the next sector (26) will be skipped and the Index Hole will be encountered before the EOT value of 26 can be read. This will result in an abnormal termination of the command. If the EOT had been set at 25 or the scanning started at sector 20, then the Scan Command would be completed in a normal manner.

During the Scan Command data is supplied by either the processor or DMA Controller for comparison against the data read from the diskette. In order to avoid having the OR (Over Run) flag set in Status Register 1, it is necessary to have the data available in less than 27 μ s (FM Mode) or 13 μ s (MFM Mode). If an Overrun occurs the FDC ends the command with bits 7 and 6 of Status Pegister 0 set to 0 and 1, respectively.

SEEK

The read/write head within the FDD is moved from cylinder to cylinder under control of the Seek Command, FDC has four independent Present Cylinder Registers for each drive, They are clear only after Recalibrate command. The FDC compares the PCN (Present Cylinder Number) which is the current head

FUNCTIONAL DESCRIPTION OF COMMANDS (CONT.)

FUNCTIONAL DESCRIPTION OF COMMANDS (CONT.)

position with the NCN (New Cylinder Number), and if there is a difference performs the following operation

PCN < NCN: Direction signal to FDD set to a 1 (high), and Step Pulses are issued. (Step In.) PCN > NCN: Direction signal to FDD set to a 0 (low), and Step Pulses are issued. (Step Out.)

The rate at which Step Pulses are issued is controlled by SRT (Stepping Rate Time) in the SPECIFY Command. After each Step Pulse is issued NCN is compared against PCN, and when NCN = PCN, then the SE (Seek End) flag is set in Status Register 0 to a 1 (high), and the command is terminated. At this point FDC interrupt goes high. Bits DB0-DB3 in Main Status Register are set during seek operation and are cleared by Sense Interrupt Status command.

During the Command Phase of the Seek operation the FDC is in the FDC BUSY state, but during the Execution Phase it is in the NON BUSY state, While the FDC is in the NON BUSY state, another Seek Command may be issued, and in this manner parallel seek operations may be done on up to 4 Drives at once. No other command could be issued for as long as FDC is in process of sending Step Pulses to any drive.

If an FDD is in a NOT READY state at the beginning of the command execution phase or during the seek operation, then the NR (NOT READY) flag is set in Status Register 0 to a 1 (high), and the command is terminated after bits 7 and 6 of Status Register 0 are set to 0 and 1 respectively.

If the time to write 3 bytes of seek command exceeds 150 µs, the timing between first two Step Pulses may be shorter than set in the Specify command by as much as 1 ms.

RECALIBRATE

The function of this command is to retract the read/write head within the FDD to the Track 0 position. The FDC clears the contents of the PCN counter, and checks the status of the Track 0 signal from the FDD. As long as the Track 0 signal is low, the Direction signal remains 0 (low) and Step Pulses are issued. When the Track 0 signal goes high, the SE (SEEK END) flag in Status Register 0 is set to a 1 (high) and the command is terminated. If the Track 0 signal is still low after 77 Step Pulse have been issued, the FDC sets the SE (SEEK END) and EC (EQUIPMENT CHECK) flags of Status Register 0 to both 1s (highs), and terminates the command after bits 7 and 6 of Status Register 0 is set to 0 and 1 respectively.

The ability to do overlap RECALIBRATE Commands to multiple FDDs and the loss of the READY signal, as described in the SEEK Command, also applies to the RECALIBRATE Command.

g. Write Deleted Data Command

h. Scan Commands

SENSE INTERRUPT STATUS

An Interrupt signal is generated by the FDC for one of the following reasons:

1. Upon entering the Result Phase of:

- a Read Data Command e. Write Data Command f. Format a Cylinder Command
- b. Read a Track Command
- c. Read ID Command
- d. Read Deleted Data Command
- 2. Ready Line of FDD changes state
- 3. End of Seek or Recalibrate Command
- 4. During Execution Phase in the NON-DMA Mode

Interrupts caused by reasons 1 and 4 above occur during normal command operations and are easily discernible by the processor. During an execution phase in NON-DMA Mode, DB5 in Main Status Register is high. Upon entering Result Phase this bit gets clear. Reason 1 and 4 does not require Sense Interrupt Status command. The interrupt is cleared by reading/writing data to FDC. Interrupts caused by reasons 2 and 3 above may be uniquely identified with the aid of the Sense Interrupt Status Command. This command when issued resets the interrupt signal and via bits 5, 6, and 7 of Status Register 0 identifies the cause of the interrupt.

SEEK END	INTERRU	PT CODE	CAUSE
BIT 5	BIT 6 BIT 7		CAUSE
0	1	1	Ready Line changed state, either polarity
1	0	0	Normal Termination of Seek or Recalibrate Command
1	1 0		Abnormal Termination of Seek or Recalibrate Command

Table 5

Neither the Seek or Recalibrate Command have a Result Phase. Therefore, it is mandatory to use the Sense Interrupt Status Command after these commands to effectively terminate them and to provide verification of where the head is positioned (PCN).

Issuing Sense Interrupt Status Command without interrupt pending is treated as an invalid command.

SPECIFY

The Specify Command sets the initial values for each of the three internal timers. The HUT (Head Unload Time) defines the time from the end of the Execution Phase of one of the Read/Write Commands to the head unload state. This timer is programmable from 16 to 240 ms in increments of 16 ms (01 = 16 ms, 02 = 32 ms... OF = 240 ms). The SRT (Step Rate Time) defines the time interval between adjacent step pulses. This timer is programmable from 1 to 16 ms in increments of 1 ms (F = 1 ms, E = 2 ms, D = 3 ms, etc.). The HLT (Head Load Time) defines the time between when the Head Load signal goes high and when the Read/Write operation starts. This timer is programmable from 2 to 254 ms in increments of 2 ms (01 = 2 ms, 02 = 4 ms, 03 = 6 ms... 7F = 254 ms).

The time intervals mentioned above are a direct function of the clock (CLK on pin 19). Times indicated above are for an 8 MHz clock, if the clock was reduced to 4 MHz (mini-floppy application) then all time intervals are increased by a factor of 2.

The choice of DMA or NON-DMA operation is made by the ND (NON-DMA) bit. When this bit is high (ND = 1) the NON-DMA mode is selected, and when ND = 0 the DMA mode is selected.

SENSE DRIVE STATUS

This command may be used by the processor whenever it wishes to obtain the status of the FDDs. Status Register 3 contains the Drive Status information stored internally in FDC registers.

INVALID

If an invalid command is sent to the FDC (a command not defined above), then the FDC will terminate the command after bits 7 and 6 of Status Register 0 are set to 1 and 0 respectively. No interrupt is generated by the μ PD765 during this condition. Bit 6 and bit 7 (DIO and RQM) in the Main Status Register are both high ("1") indicating to the processor that the μ PD765 is in the Result Phase and the contents of Status Register 0 (STO) must be read. When the processor reads Status Register 0 it will find a 80 hex indicating an invalid command was received.

A Sense Interrupt Status Command must be sent after a Seek or Recalibrate Interrupt, otherwise the FDC will consider the next command to be an Invalid Command.

In some applications the user may wish to use this command as a No-Op command, to place the FDC in a standby or no operation state.

STATUS REGISTER IDENTIFICATION

	BIT DESCRIPTION						
NO.	NAME	SYMBOL	DEGONIFTION				
STATUS REGISTER 0							
D7			D7 = 0 and D ₆ = 0				
	Interrupt	IC	Normal Termination of Command, (NT). Com-				
	Code		mand was completed and properly executed.				
D6			D7 = 0 and D ₆ = 1				
			Abnormal Termination of Command, (AT).				
			Execution of Command was started, but was no				
			successfully completed.				
			$D_7 = 1$ and $D_6 = 0$				
			Invalid Command issue, (IC). Command which				
			was issued was never started.				
			$D_7 = 1$ and $D_6 = 1$ Abnormal Termination because during command				
			execution the ready signal from FDD changed				
			state.				
D ₅	Seek End	SE	When the FDC completes the SEEK Command,				
- 5		02	this flag is set to 1 (high).				
D4	Equipment	EC	If a fault Signal is received from the FDD, or if				
	Check		the Track 0 Signal fails to occur after 77 Step				
			Pulses (Recalibrate Command) then this flag is				
			set.				
D ₃	Not Ready	NR	When the FDD is in the not-ready state and a				
			read or write command is issued, this flag is set.				
			If a read or write command is issued to Side 1 of				
			a single sided drive, then this flag is set.				
D2	Head	HD	This flag is used to indicate the state of the head				
	Address		at Interrupt.				
<u>D1</u>	Unit Select 1	US 1	These flags are used to indicate a Drive Unit.				
D ₀	Unit Select 0	'US 0	Number at Interrupt.				
		STA	TUS REGISTER 1				
D7	End of	EN	When the FDC tries to access a Sector beyond				
	Cylinder		the final Sector of a Cylinder, this flag is set.				
D6			Not used. This bit is always 0 (low).				
D5	Data Error	DE	When the FDC detects a CRC error in either the				
			ID field or the data field, this flag is set.				
D ₄	Over Run	OR	If the FDC is not serviced by the main-systems				
			during data transfers, within a certain time				
			interval, this flag is set.				
D3			Not used. This bit always 0 (low).				
D2	No Data	ND	During execution of READ DATA, WRITE				
			DELETED DATA or SCAN Command, if the				
			FDC cannot find the Sector specified in the IDR				
			Register, this flag is set.				
			During executing the READ ID Command, if				
			the FDC cannot read the ID field without an				
]		error, then this flag is set.				
			During the execution of the READ A Cylinder				
			Command, if the starting sector cannot be				
	1		found, then this flag is set.				

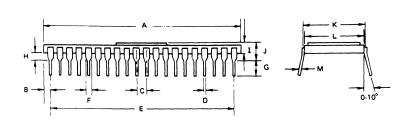
	BIT		
NO.	NAME	SYMBOL	DESCRIPTION
			S REGISTER 1 (CONT.)
	Not	NW	During execution of WRITE DATA, WRITE
D1	Writable		DELETED DATA or Format A Cylinder Com-
	WIILBUIC		mand, if the FDC detects a write protect signal
			from the FDD, then this flag is set.
Do	Missing	MA	If the FDC cannot detect the ID Address Mark
0	Address		after encountering the index hole twice, then
	Mark		this flag is set.
			If the FDC cannot detect the Data Address Mark
			or Deleted Data Address Mark, this flag is set.
			Also at the same time, the MD (Missing Address
			Mark in Data Field) of Status Register 2 is set.
		ST	ATUS REGISTER 2
D7			Not used. This bit is always 0 (low).
D ₆	Control	CM	During executing the READ DATA or SCAN
	Mark		Command, if the FDC encounters a Sector which
-			contains a Deleted Data Address Mark, this
			flag is set.
D5	Data Error in	DD	If the FDC detects a CRC error in the data field
	Data Field		then this flag is set.
D4	Wrong	WC	This bit is related with the ND bit, and when the
	Cylinder		contents of C on the medium is different from
		011	that stored in the IDR, this flag is set.
D3	Scan Equal Hit	SH	During execution, the SCAN Command, if the condition of "equal" is satisfied, this flag is set.
De	Scan Not	SN	During executing the SCAN Command, if the
D2	Satisfied	311	FDC cannot find a Sector on the cylinder which
	Jatisfied		meets the condition, then this flag is set.
D1	Bad	BC	This bit is related with the ND bit, and when the
	Cylinder		content of C on the medium is different from
			that stored in the IDR and the content of C is
			FF, then this flag is set.
Do	Missing	MD	When data is read from the medium, if the FDC
	Address Mark		cannot find a Data Address Mark or Deleted
	in Data Field		Data Address Mark, then this flag is set.
		ST/	ATUS REGISTER 3
D7	Fault	FT	This bit is used to indicate the status of the
			Fault signal from the FDD.
D6 (Write	WP	This bit is used to indicate the status of the
	Protected		Write Protected signal from the FDD.
D5	Ready	RY	This bit is used to indicate the status of the
			Ready signal from the FDD.
D4	Track 0	т0	This bit is used to indicate the status of the
-	T	TC	Track 0 signal from the FDD.
D3	Two Side	TS	This bit is used to indicate the status of the Two Side signal from the FDD.
		HD	
D ₂	Head Address	ΠU	This bit is used to indicate the status of Side Select signal to the FDD.
	Unit Select 1	US 1	This bit is used to indicate the status of the Unit
D1	Unit Select 1	031	Select 1 signal to the FDD.
	Unit Select 0	US 0	This bit is used to indicate the status of the Unit
D ₀	Onit Select 0	030	Select 0 signal to the FDD.
L			Contre signal to the PDD.

STATUS REGISTER IDENTIFICATION (CONT.)

It is suggested that you utilize the following applications notes:

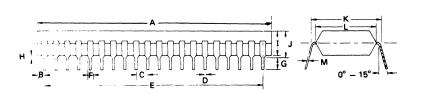
- ① #8 for an example of an actual interface, as well as a "theoretical" data separator.
- 2 #10 for a well documented example of a working phase lock loop.

PACKAGE OUTLINE µPD765AD



	Ceramic						
ITEM	MILLIMETERS	INCHES					
А	51.5 MAX	2.03 MAX					
В	1.62 MAX	0.06 MAX					
С	2.54 ± 0.1	0.1 ± 0.004					
D	0.5 ± 0.1	0.02 ± 0.004					
E	48.26 ± 0.1	1.9 ± 0.004					
F	1.02 MIN	0.04 MIN					
G	3.2 MIN	0.13 MIN					
н	1.0 MIN	0.04 MIN					
I	3.5 MAX	0.14 MAX					
J	4.5 MAX	0.18 MAX					
ĸ	15.24 TYP	0.6 TYP					
L	14.93 TYP	0.59 TYP					
M	0.25 ± 0.05	0.01 ± 0.0019					

PACKAGE OUTLINE µPD765AC



	Plastic							
ITEM	MILLIMETERS	INCHES						
A	51.5 MAX	2.028 MAX						
В	1.62	0.064						
С	2.54 ± 0.1	0.10 ± 0.004						
D	0.5 ± 0.1	0.019 ± 0.004						
E	48.26	1.9						
F	1.2 MIN	0.047 MIN						
G	2.54 MIN	0.10 MIN						
н	0.5 MIN	0.019 MIN						
I	5.22 MAX	0.206 MAX						
J	5.72 MAX	0.225 MAX						
к	15.24	0.600						
L	13.2	0.520						
м	0.25 + 0.1 0.25 0.05	0.010 ⁺ 0.004 0.002						

PRELIMINARY GRAPHICS DISPLAY CONTROLLER

Description

The µPD7220 Graphics Display Controller (GDC) is an intelligent microprocessor peripheral designed to be the heart of a high-performance raster-scan computer graphics and character display system. Positioned between the video display memory and the microprocessor bus, the GDC performs the tasks needed to generate the raster display and manage the display memory. Processor software overhead is minimized by the GDC's sophisticated instruction set, graphics figure drawing, and DMA transfer capabilities. The display memory supported by the GDC can be configured in any number of formats and sizes up to 256K 16-bit words. The display can be zoomed and panned, while partitioned screen areas can be independently scrolled. With its light pen input and multiple controller capability, the GDČ is ideal for advanced computer graphics applications.

Features

- ☐ Microprocessor Interface DMA transfers with 8257- or 8237-type controllers FIFO Command Buffering
- Display Memory Interface
 Up to 256K words of 16 bits
 - Read-Modify-Write (RMW) Display Memory cycles in under 800ns
- Dynamic RAM reresh cycles for nonaccessed memory
- Light Pen Input
- External video synchronization mode
- Graphics Mode:
 - Four megabit, bit-mapped display memory
- Character Mode:
 - 8K character code and attributes display memory
- Mixed Graphics and Characters Mode 64K if all characters 1 megapixel if all graphics
- Graphics Capabilities:
- Figure drawing of lines, arc/circles, rectangles, and graphics character in 800ns per pixel Display 1024-by-1024 pixels with 4 planes of color or grayscale.
- Two independently scrollable areas
- Character Capabilities: Auto cursor advance Four independently scrollable areas Programmable cursor height Characters per row: up to 256 Character rows per screen: up to 100
- Video Display Format
 Zoom magnification factors of 1 to 16
 Panning
 Command-settable video raster parameters
- Technology
 Single +5 volt, NMOS, 40-pin DIP
- DMA Capability:
 Bytes or word transfers
 4 clock periods per byte transferred

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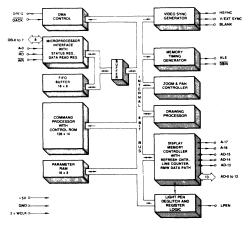
NOTE: These manufacturer's specifications are provided for reference. The APC may not use some of the functions described here.

System Considerations

The GDC is designed to work with a general purpose microprocessor to implement a high-performance computer graphics system. Through the division of labor established by the GDC's design, each of the system components is used to the maximum extent through sixlevel hierarchy of simultaneous tasks. At the lowest level, the GDC generates the basic video raster timing, including sync and blanking signals. Partitioned areas on the screen and zooming are also accomplished at this level. At the next level, video display memory is modified during the figure drawing operations and data moves. Third, display memory addresses are calculated pixel by pixel as drawing progresses. Outside the GDC at the next level, preliminary calculations are done to prepare drawing parameters. At the fifth level, the picture must be represented as a list of graphics figures drawable by the GDC. Finally, this representation must be manipulated, stored, and communicated. By handling the first three levels, the GDC takes care of the high-speed and repetitive tasks required to implement a graphics system.

GDC Components

The GDC block diagram illustrates how these tasks are accomplished.



Microprocessor Bus Interface

Control of the GDC by the system microprocessor is achieved through an 8-bit bidirectional interface. The status register is readable at any time. Access to the FIFO buffer is coordinated through flags in the status register and operates independently of the various internal GDC operations, due to the separate data bus connecting the interface and the FIFO buffer.

Command Processor

The contents of the FIFO are interpreted by the command processor. The command bytes are decoded, and the succeeding parameters are distributed to their proper destina-

tions within the GDC. The command processor yields to the bus interface when both access the FIFO simultaneously.

DMA Control

The DMA control circuitry in the GDC coordinates transfers over the microprocessor interface when using an external DMA controller. The DMA Request and Acknowledge handshake lines directly interface with a μ PD8257 or μ PD8237 DMA controller, so that display data can be moved between the microprocessor memory and the display memory.

Parameter RAM

The 16-byte RAM stores parameters that are used repetitively during the display and drawing processes. In character mode, this RAM holds four sets of partitioned display area parameters; in graphics mode, the drawing pattern and graphics character take the place of two of the sets of parameters.

Video Sync Generator

Based on the clock input, the sync logic generates the raster timing signals for almost any interlaced, non-interlaced, or "repeat field" interlaced video format. The generator is programmed during the idle period following a reset. In video sync slave mode, it coordinates timing between multiple GDCs.

Memory Timing Generator

The memory timing circuitry provides two memory cycle types: a two-clock period refresh cycle and the readmodify-write (RMW) cycle which takes four clock periods. The memory control signals needed to drive the display memory devices are easily generated from the GDC's ALE and DBIN outputs.

Zoom & Pan Controller

Based on the programmable zoom display factor and the display area entries in the parameter RAM, the zoom and pan controller determines when to advance to the next memory address for display refresh and when to go on to the next display area. A horizontal zoom is produced by slowing down the display refresh rate while maintaining the video sync rates. Vertical zoom is accomplished by repeatedly accessing each line a number of times equal to the horizontal repeat. Once the line count for a display area is exhausted, the controller accesses the starting address and line count of the next display area from the parameter RAM. The system microprocessor, by modifying a display area starting address, can pan in any direction, independent of the other display areas.

Drawing Processor

The drawing processor contains the logic necessary to calculate the addresses and positions of the pixels of the various graphics figures. Given a starting point and the appropriate drawing parameters, the drawing processor needs no further assistance to complete the figure drawing.

Display Memory Controller

The display memory controller's tasks are numerous. Its primary purpose is to multiplex the address and data information in and out of the display memory. It also contains the 16-bit logic unit used to modify the display memory contents during RMW cycles, the character mode line counter, and the refresh counter for dynamic RAMs. The memory controller apportions the video field time between the various types of cycles.

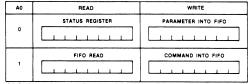
Light Pen Deglitcher

Only if two rising edges on the light pen input occur at the same point during successive video fields are the pulses

accepted as a valid light pen detection. A status bit indicates to the system microprocessor that the light pen register contains a valid address.

Programmer's View of GDC

The GDC occupies two addresses on the system microprocessor bus through which the GDC's status register and FIFO are accessed. Commands and parameters are written into the GDC's FIFO and are differentiated based on address bit A0. The status register or the FIFO can be read as selected by the address line.



GDC Microprocessor Bus Interface Registers

Commands to the GDC take the form of a command byte followed by a series of parameter bytes as needed for specifying the details of the command. The command processor decodes the commands, unpacts the parameters, loads them into the appropriate registers within the GDC, and initiates the required operations.

The commands available in the GDC can be organized into five categories as described in the following section.

GDC Command Summary

Video Control Commands

VIGEO CONTION CO	ininanus ·
1. RESET:	Resets the GDC to its idle state.
2. SYNC:	Specifies the video display format.
3. VSYNC:	Selects master or slave video syn-
	chronization mode.
4. CCHAR:	Specifies the cursor and character
	row heights.
Display Control C	Commands
1. START:	Ends Idle mode and unblanks the
	display.
2. BCTRL:	Controls the blanking and unblanking
	of the display.
3. ZOOM:	Specifies zoom factors for the display
	and graphics characters writing.
4. CURS:	Sets the position of the cursor in
	display memory.
	Defines starting addresses and longths

 5. PRAM: Defines starting addresses and lengths of the display areas and specifies the eight bytes for the graphics character.
 6. PITCH: Specifies the width of the X dimension of display memory.

Drawing Control Commands

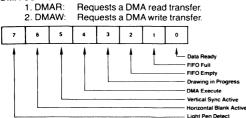
1. WDAT:	Writes data words or bytes into display
	memory.

- 2. MASK: Sets the mask register contents.
- 3. FIGS: Specifies the parameters for the drawing processor.
- 4. FIGD: Draws the figure as specified above.
 - 5. GCHRD: Draws the graphics character into display memory.

Data Read Commands

- 1. RDAT: Reads data words or bytes from display memory.
- 2. CURD: Reads the cursor position.
- 3. LPRD: Reads the light pen address.

DMA Control Commands



Status Register (SR) Status Register Flags

SR-7: Light Pen Detect

When this bit is set to 1, the light pen address (LAD) register contains a deglitched value that the system microprocessor may read. This flag is reset after the 3-byte LAD is moved into the FIFO in response to the light pen read command.

SR-6: Horizontal Blanking Active

A 1 value for this flag signifies that horizontal retrace blanking is currently underway.

SR-5: Vertical Sync

Vertical retrace sync occurs while this flag is a 1. The vertical sync flag coordinates display format modifying commands to the blanked interval surrounding vertical sync. This eliminates display disturbances.

SR-4: DMA Execute

This bit is a 1 during DMA data transfers.

SR-3: Drawing in Progress

While the GDC is drawing a graphics figure, this status bit is a 1.

SR-2: FIFO Empty

This bit and the FIFO Full flag coordinate system microprocessor accesses with the GDC FIFO. When it is 1, the Empty flag ensures that all the commands and parameters previously sent to the GDC have been processed.

SR-1: FIFO Full

A 1 at this flag indicates a full FIFO in the GDC. A 0 ensures that there is room for at least one byte. This flag needs to be checked before each write into the GDC.

SR-0: Data Ready

When this flag is a 1, it indicates that a byte is available to be read by the system microprocessor. This bit must be tested before each read operation. It drops to a 0 while the data is transferred from the FIFO into the microprocessor interface data register.

FIFO Operation & Command Protocol

The first-in, first-out buffer (FIFO) in the GDC handles the command dialogue with the system microprocessor. This flow of information uses a half-duplex technique, in which the single 16-location FIFO is used for both directions of data movement, one direction at a time. The FIFO's direction is controlled by the system microprocessor through the GDC's command set. The microprocessor coordinates these transfers by checking the appropriate status register bits.

The command protocol used by the GDC requires the differentiation of the first byte of a command sequence from the succeeding bytes. This first byte contains the operation code and the remaining bytes carry parameters. Writing into the GDC causes the FIFO to store a flag value alongside the data byte to signify whether the byte was written into the command or the parameter address. The command processor in the GDC tests this bit as it interprets the entries in the FIFO.

The receipt of a command byte by the command processor marks the end of any previous operation. The number of parameter bytes supplied with a command is cut short by the receipt of the next command byte. A read operation from the GDC to the microprocessor can be terminated at any time by the next command.

The FIFO changes direction under the control of the system microprocessor. Commands written into the GDC always put the FIFO into write mode if it wasn't in it already. If it was in read mode, any read data in the FIFO at the time of the turnaround is lost. Commands which require a GDC response, such as RDAT, CURD and LPRD, put the FIFO into read mode after the command is interpreted by the GDC's command processor. Any commands and parameters behind the read-evoking command are discarded when the FIFO direction is reversed.

Read-Modify-Write Cycle

Data transfers between the GDC and the display memory are accomplished using a read-modify-write (RMW) memory cycle. The four clock period timing of the RMW cycle is used to: 1) output the address, 2) read data from the memory, 3) modify the data, and 4) write the modified data back into the initially selected memory address. This type of memory cycle is used for all interactions with display memory including DMA transfers, except for the two clock period display and RAM refresh cycles.

The operations performed during the modify portion of the RMW cycle merit additional explanation. The circuitry in the GDC uses three main elements: the Pattern register, the Mask register, and the 16-bit Logic Unit. The Pattern register holds the data pattern to be moved into memory. It is loaded by the WDAT command or, during drawing, from the parameter RAM. The Mask register contents determine which bits of the read data will be modified. Based on the contents of these registers, the Logic Unit performs the selected operations of REPLACE, COMPLEMENT, SET, or CLEAR on the data read from display memory.

The Pattern register contents are ANDed with the Mask register contents to enable the actual modification of the memory read data, on a bit-by-bit basis. For graphics drawing, one bit at a time from the Pattern register is combined with the Mask. When ANDed with the bit set to a 1 in the Mask register, the proper single pixel is modified by the Logic Unit. For the next pixel in the figure, the next bit in the Pattern register is selected and the Mask register bit is moved to identify the pixel's location within the word. The Execution word address pointer register, EAD, is also adjusted as required to address the word containing the next pixel.

In character mode, all of the bits in the Pattern register are used in parallel to form the respective bits of the modify data word. Since the bits of the character code word are used in parallel, unlike the one-bit-at-a-time graphics drawing process, this facility allows any or all of the bits in a memory word to be modified in one RMW memory cycle. The Mask register must be loaded with 1s in the positions where modification is to be permitted. The Mask register can be loaded in either of two ways. In graphics mode, the CURS command contains a four-bit dAD field to specify the dot address. The command processor converts this parameter into the one-of-16 format used in the Mask register for figure drawing. A full 16 bits can be loaded into the Mask register using the MASK command. In addition to the character mode use mentioned above. the 16-bit MASK load is convenient in graphics mode when all of the pixels of a word are to be set to the same value.

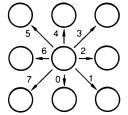
The Logic Unit combines the data read from display memory, the Pattern Register, and the Mask register to generate the data to be written back into display memory. Any one of four operations can be selected: REPLACE, COMPLE-MENT, CLEAR or SET. In each case, if the respective Mask bit is 0, that particular bit of the read data is returned to memory unmodified. If the Mask bit is 1, the modification is enabled. With the REPLACE operation, the modify data simply takes the place of the read data for modification enabled bits. For the other three operations, a 0 in the modify data allows the read data bit to be returned to memory. A 1 value causes the specified operation to be performed in the bit positions with set Mask bits.

Figure Drawing

The GDC draws graphics figures at the rate of one pixel per read-modify-write (RMW) display memory cycle. These cycles take four clock periods to complete. At a clock frequency of 5MHz, this is equal to 800ns. During the RMW cycle the GDC simultaneously calculates the address and position of the next pixel to be drawn.

The graphics figure drawing process depends on the display memory addressing structure. Groups of 16 horizontally adjacent pixels form the 16-bit words which are handled by the GDC. Display memory is organized as a linearly addressed space of these words. Addressing of individual pixels is handled by the GDC's internal RMW logic.

During the drawing process, the GDC finds the next pixel of the figure which is one of the eight nearest neighbors of the last pixel drawn. The GDC assigns each of these eight directions a number from 0 to 7, starting with straight down and proceeding counterclockwise.



Drawing Directions

Figure drawing requires the proper manipulation of the address and the pixel bit position according to the drawing direction to determine the next pixel of the figure. To move to the word above or below the current one, it is necessary to subtract or add the number of words per line in display memory. This parameter is called the pitch. To move to the word to either side, the Execute word address cursor, EAD, must be incremented or decremented as the dot address pointer bit reaches the LSB or the MSB of the Mask register. To move to a pixel within the same word, it is necessary to rotate the dot address pointer register to the right or left.

The table below summarizes these operations for each direction

Whole word drawing is useful for filling areas in memory with a single value. By setting the Mask register to all 1s with the MASK command, both the LSB and MSB of the

DIR	OPERATIONS TO ADDRESS THE NEXT PIXEL	
000	EAD · P → EAD	
001	EAD · P → EAD	
	$dAD (MSB) = 1 EAD + 1 \rightarrow EAD dAD \rightarrow LR$	
010	$dAD (MSB)$ 1 $EAD - 1 \rightarrow EAD dAD \rightarrow LR$	
011	EAD P→EAD	
	$dAD (MSB) = 1 = EAD + 1 \rightarrow EAD = dAD \rightarrow LR$	
100	EAD P→EAD	
101	EAD P→EAD	
	$dAD(LSB)$ 1 EAD 1 \rightarrow EAD $dAD \rightarrow$ RR	
110	$dAD(LSB) = 1 = EAD = 1 \rightarrow EAD = dAD \rightarrow RR$	
111	EAD · P → EAD	
	$dAD(LSB) = 1 EAD + 1 \rightarrow EAD dAD \rightarrow RR$	

Where P. Poor UR. Left Rotate RR. Right R. tate EAC: Execute Whird Address UAC: Child Address Itured In the Mask Register

dAD will always be 1, so that the EAD value will be incremented or decremented for each cycle regardless of direction. One RMW cycle will be able to effect all 16 bits of the word for any drawing type. One bit in the Pattern register is used per RMW cycle to write all the bits of the word to the same value. The next Pattern bit is used for the word, etc.

For the various figures, the effect of the initial direction upon the resulting drawing is shown below:

DIR	LINE	ARC	CHARACTER	SLANT CHAR	RECTANGLE	[DMA
000		Ĭ, '	tent	innin.	+ ') 1 _		NJ
001	•••••••••	•	.rrrit.	1381	$\hat{\mathbb{C}}$		M
010	••••••	· •	-rer- cult	میں مرجع	[]]		Z
011		ŕ.	13/201		Q.		4
100	*	. 1		nulut			
101	Min	,	Null.	1000,	\bigcirc		M
110	The lot			Ë	[]		Z
111	ß	۲ `	1177	1000	\Diamond		Ż

Note that during line drawing, the angle of the line may be anywhere within the shaded octant defined by the DIR value. Arc drawing starts in the direction initially specified by the DIR value and veers into an arc as drawing proceeds. An arc may be up to 45 degrees in length. DMA transfers are done on word boundaries only, and follow the arrows indicated in the table to find successive word addresses. The slanted paths for DMA transfers indicate the GDC changing both the X and Y components of the word address when moving to the next word. It does not follow a 45 degree diagonal path by pixels.

Drawing Parameters

In preparation for graphics figure drawing, the GDC's Drawing Processor needs the figure type, direction and drawing parameters, the starting pixel address, and the pattern from the microprocessor. Once these are in place within the GDC, the Figure Draw command, FIGD, initiates the drawing operation. From that point on, the system microprocessor is not involved in the drawing process. The GDC Drawing Processor coordinates the RMW circuitry and address registers to draw the specified figure pixel by pixel.

The algorithms used by the processor for figure drawing are designed to optimize its drawing speed. To this end, the specific details about the figure to be drawn are reduced by the microprocessor to a form conducive to high-speed address calculations within the GDC. In this way the repetitive, pixel-by-pixel calculations can be done quickly. thereby minimizing the overall figure drawing time. The table below summarizes the parameters.

DRAWING TYPE	DC	D	D2	D1	DM
Initial Value*	0	8	8	-1	-1
Line	ΔI	2 ΔD - ΔI	2(ΔD - Δi)	2 AD	-
Arc**	r sin Ot	r-1	2(r-1)	-1	rsin θi
Rectangle	3	A-1	B-1	-1	A-1
Area Fill	B -1	A	A	-	_
Graphic Character***	B1	A	A		
Read & Write Data	W-1	-		-	
DMAW	D-1	C-1		-	-
DMAR	D-1	C-1	(C-1)/2+		

* initial values for the various parameters are loaded during the handling of the FIGS op code byte

Circles are drawn with 8 arcs, each of which span 45°, so that sin $0 = 1/\sqrt{2}$ and nθ = 0.

*** Graphic characters are a special case of bit-map area filling in which B and A \leq 8 If A = 8 there is no need to load D and D2.

Where: -1 = all ONES value.

All numbers are shown in base 10 for convenience. The GDC accepts base 2 numbers (2s complement notation where appropriate)

- - No parameter bytes sent to GDC for this parameter

- $\Delta I =$ The larger at Δx or Δy .
- ΔD = The smaller at Δx or Δy .
- r = Radius at curvature, in pixels.
- ♦ = Angle from major axis to end at the arc. ♦ ≤ 45°. θ = Angle from major axis to start at the arc. $\theta \le 45^{\circ}$.
- t = Round up to the next higher integer
- + = Round down to the next lower integer
- A = Number of pixels in the initially specified direction. B - Number of pixels in the direction at right angles to the initially specified direc-
- W = Number of words to be accessed.
- C = Number of bytes to be transferred in the initially specified direction. (Two bytes per word if word transfer mode is selected).
- D = Number of words to be accessed in the direction at right angles to the initially specified direction.
- DC = Drawing count parameter which is one less than the number of RMW cycles to be execu
- DM = Dots masked from drawing during arc drawing.
- + Needed only for word reads

Graphics Character Drawing

Graphics characters can be drawn into display memory pixel-by-pixel. The up to 8-by-8 character is loaded into the GDC's parameter RAM by the system microprocessor. Consequently, there are no limitations on the character set used. By varying the drawing parameters and drawing direction, numerous drawing options are available. In area fill applications, a character can be written into display memory as many times as desired without reloading the parameter RAM.

Once the parameter RAM has been loaded with up to eight graphics character bytes by the appropriate PRAM command, the GCHRD command can be used

to draw the bytes into display memory starting at the cursor. The zoom magnification factor for writing, set by the zoom command, controls the size of the character written into the display memory in integer multiples of 1 through 16. The bit values in the PRAM are repeated horizontally and vertically the number of times specified by the zoom factor.

The movement of these PRAM bytes to the display memory is controlled by the parameters of the FIGS command. Based on the specified height and width of the area to be drawn, the parameter RAM is scanned to fill the required area.

For an 8-by-8 graphics character, the first pixel drawn uses the LSB of RA-15, the second pixel uses bit 1 of RA-15, and so on, until the MSB of RA-15 is reached. The GDC jumps to the corresponding bit in RA-14 to continue the drawing. The progression then advances toward the LSB of RA-14. This snaking sequence is continued for the other 6 PRAM bytes. This progression matches the sequence of display memory addresses calculated by the drawing processor as shown above. If the area is narrower than 8 pixels wide, the snaking will advance to the next PRAM byte before the MSB is reached. If the area is less than 8 lines high, fewer bytes in the parameter RAM will be scanned. If the area is larger than 8 by 8, the GDC will repeat the contents of the parameter RAM in two dimensions, as required to fill the area with the 8-by-8 mozaic. (Fractions of the 8-by-8 pattern will be used to fill areas which are not multiples of 8 by 8.)

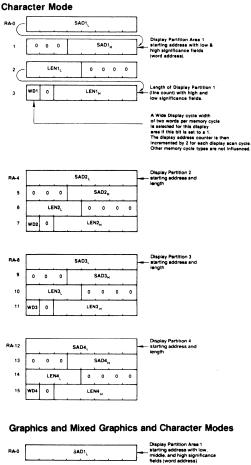
Parameter RAM Contents: RAM Address RA 0 to 15

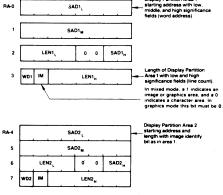
The parameters stored in the parameter RAM, PRAM, are available for the GDC to refer to repeatedly during figure drawing and raster-scanning. In each mode of operation the values in the PRAM are interpreted by the GDC in a predetermined fashion. The host microprocessor must load the appropriate parameters into the proper PRAM locations. PRAM loading command allows the host to write into any location of the PRAM and transfer as many bytes as desired. In this way any stored parameter byte or bytes may be changed without influencing the other bytes.

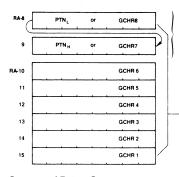
The PRAM stores two types of information. For specifying the details of the display area partitions, blocks of four bytes are used. The four parameters stored in each block include the starting address in display memory of each display area, and its length. In addition, there are two mode bits for each area which specify whether the area is a bit-mapped graphics area or a coded character area, and whether a 16-bit or a 32-bit wide display cycle is to be used for that area.

The other use for the PRAM contents is to supply the pattern for figure drawing when in a bit-mapped graphics area or mode. In these situations, PRAM bytes 8 through 16 are reserved for this patterning information. For line, arc, and rectangle drawing (linear figures) locations 8 and 9 are loaded into the Pattern Register to allow the GDC to draw dotted, dashed, etc. lines. For area filling and graphics bit-mapped character drawing locations 8 through 15 are referenced for the pattern or character to be drawn.

Details of the bit assignments are shown on the following pages for the various modes of operation.



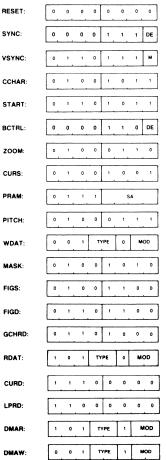




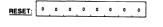
Pattern of 16 bits used for figure drawing to pattern dotted, dashed, etc. lines.

Graphics character bytes to be moved into display memory with graphics character drawing.

Command Bytes Summary



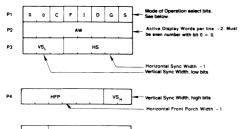
Video Control Commands Reset

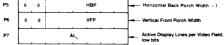


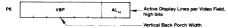
Blank the display, enter Idle mode, and initialize within the GDC: - FIFO - Command Processor - Internal Counters

This command can be executed at any time and does not modify any of the parameters already loaded into the GDC.

If followed by parameter bytes, this command also sets the sync generator parameters as described below. Idle mode is exited with the START command.







In graphics mode, a word is a group of 16 pixels. In character mode, a word is one character code and its attributes, if any.

The number of active words per line must be an even number from 2 to 256.

An all-zero parameter value selects a count equal to 2^n where n = number of bits in the parameter field for vertical parameters.

All horizontal widths are counted in display words. All vertical intervals are counted in lines.

SYNC Generator Period Constraints

Horizontal Back Porch Constraints

- 1. In general:
- $HBP \ge 3$ Display Word Cycles (6 clock cycles). 2. If the IMAGE or WD modes change within one
- video field: HBP ≥ 5 Display Word Cycles (10 clock

cycles).

Horizontal Front Porch Constraints

- 1. If the display ZOOM function is used at other than 1X:
 - HFP ≥ 2 Display Word Cycles (4 clock cycles).
- If the GDC is used in the video sync Slave mode: HFP ≥ 4 Display Word Cycles (8 clock cycles).
- If the Light Pen is used: HFP ≥ 6 Display Word Cycles (12 clock cycles).

Horizontal SYNC Constraints

- 1. If Interlaced display mode is used:
 - HS ≥ 3 Display Word Cycles (6 clock cycles).

Modes of Operation Bits

c	G	Display Mode
0	0	Mixed Graphics & Character
0	1	Graphics Mode
1	0	Character Mode
1	1	Invalid

I	s	Video Framing
0	0	Noninterlaced
0	1	Invalid
1	0	Interlaced Repeat Field for Character Displays
1	1	Interlaced

Repeat Field Framing:	2 Field Sequence with 1/2 line off- set between otherwise identical
	fields.
Interlaced Framing:	2 Field Sequence with 1/2 line off-
	set. Each field displays alternate
	lines.
Noninterlaced Framing:	1 field brings all of the information
	to the screen.

Total scanned lines in interlace mode is odd. The sum of VFP + VS + VBP + AL should equal one less than the desired odd number of lines.

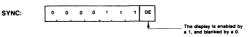
D	Dynamic RAM Refresh Cycles Enable
0	No Refresh — STATIC RAM
1	Refresh — Dynamic RAM

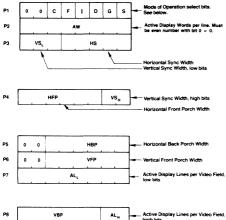
Dynamic RAM refresh is important when high display zoom factors or DMA are used in such a way that not all of the rows in the RAMs are regularly accessed during display raster generation and for otherwise inactive display memory.

F	Drawing Time Window
0	Drawing during active display time and retrace blanking
1	Drawing only during retrace blanking

Access to display memory can be limited to retrace blanking intervals only, so that no disruptions of the image are seen on the screen.

SYNC Format Specify

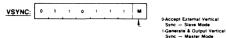






This command also loads parameters into the sync generator. The various parameter fields and bits are identical to those at the RESET command. The GDC is not reset nor does it enter idle mode.

Vertical Sync Mode



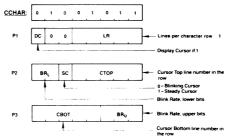
When using two or more GDCs to contribute to one image, one GDC is defined as the master sync generator, and the others operate as its slaves. The VSYNC pins of all GDCs are connected together.

Slave Mode Operation

A few considerations should be observed when synchronizing two or more GDCs to generate overlayed video via the VSYNC INPUT/OUTPUT pin. As mentioned above, the Horizontal Front Porch (HFP) must be 4 or more display cycles wide. This is equivalent to eight or more clock cycles. This gives the slave GDCs time to initialize their internal video sync generators to the proper point in the video field to match the incoming vertical sync pulse (VSYNC). This resetting of the generator occurs just after the end of the incoming VSYNC pulse, during the HFP interval. Enough time during HFP is required to allow the slave GDC to complete the operation before the start of the HSYNC interval.

Once the GDCs are initialized and set up as Master and Slaves, they must be given time to synchronize. It is a good idea to watch the VSYNC status bit of the Master GDC and wait until after one or more VSYNC pulses have been generated before the display process is started. The START command will begin the active display of data and will end the video synchronization process, so be sure there has been at least one VSYNC pulse generated for the Slaves to synchronize to.

Cursor & Character Characteristics



In graphics mode, LR should be set to 0.

The blink rate parameter controls both the cursor and attribute blink rates. The cursor blink-on time = blink-off time = $2 \times BR$ (video frames). The attribute blink rate is always $\frac{1}{2}$ the cursor rate but with a $\frac{3}{4}$ on $\frac{1}{4}$ off duty cycle.

Display Control Commands

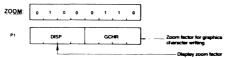
Start Display & End Idle Mode



Display Blanking Control

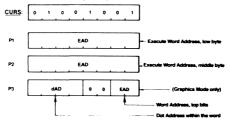


Zoom Factors Specify



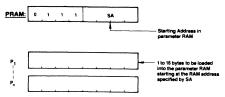
Zoom magnification factors of 1 through 16 are available using codes 0 through 15, respectively.

Cursor Position Specify



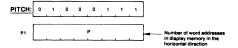
In character mode, the third parameter byte is not needed. The cursor is displayed for the word time in which the display scan address (DAD) equals the cursor address. In graphics mode, the cursor word address specifies the word containing the starting pixel of the drawing; the dot address value specifies the pixel within that word.

Parameter RAM Load



From the starting address, SA, any number of bytes may be loaded into the parameter RAM at incrementing addresses, up to location 15. The sequence of parameter bytes is terminated by the next command byte entered into the FIFO. The parameter RAM stores 16 bytes of information in predefined locations which differ for graphics and character modes. See the parameter RAM discussion for bit assignments.

Pitch Specification

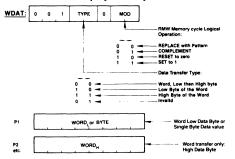


This value is used during drawing by the drawing processor to find the word directly above or below the current word, and during display to find the start of the next line.

The Pitch parameter (width of display memory) is set by two different commands. In addition to the PITCH command, the RESET (or SYNC) command also sets the pitch value. The "active words per line" parameter, which specifies the width of the raster-scan display, also sets the Pitch of the display memory. In situations in which these two values are equal there is no need to execute a PITCH command.

Drawing Control Commands

Write Data into Display Memory



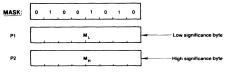
Upon receiving a set of parameters (two bytes for a word transfer, one for a byte transfer), one RMW cycle into Video Memory is done at the address pointed to by the cursor EAD. The EAD pointer is advanced to the next word, according to the previously specified direction. More parameters can then be accepted.

For byte writes, the unspecified byte is treated as all zeros during the RMW memory cycle.

In graphics bit-map situations, only the LSB of the WDAT parameter bytes is used as the pattern in the RMW operations. Therefore it is possible to have only an all ones or all zeros pattern. In coded character applications all the bits of the WDAT parameters are used to establish the drawing pattern.

The WDAT command operates differently from the other commands which initiate RMW cycle activity. It requires parameters to set up the Pattern register while the other commands use the stored values in the parameter RAM. Like all of these commands, the WDAT command must be preceeded by a FIGS command and its parameters. Only the first three parameters need be given following the FIGS opcode, to set up the type of drawing, the DIR direction, and the DC value. The DC parameter + 1 will be the number of RMW cycles done by the GDC with the first set of WDAT parameters. Additional sets of WDAT parameters will see a DC value of 0 which will cause only one RMW cycle to be executed.

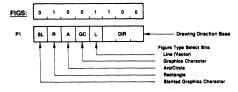
Mask Register Load

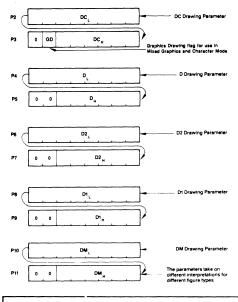


This command sets the value of the 16-bit Mask register of the figure drawing processor. The Mask register controls which bits can be modified in the display memory during a read-modify-write cycle.

The Mask register is loaded both by the MASK command and the third parameter byte of the CURS command. The MASK command accepts two parameter bytes to load a 16-bit value into the Mask register. All 16 bits can be individually one or zero, under program control. The CURS command on the other hand, puts a "1 of 16" pattern into the Mask register based on the value of the Dot Address value, dAD. If normal single-pixel-at-a-time graphics figure drawing is desired, there is no need to do a MASK command at all since the CURS command will set up the proper pattern to address the proper pixels as drawing progresses. For coded character DMA, and screen setting and clearing opertions using the WDAT command, the MASK command should be used after the CURS command if its third parameter byte has been output.

Figure Drawing Parameters Specify





L	Valid	l Fig	ure 1	Гуре	Sele	ect Combinations
	SL	R	<u>A</u>	GC	L	Operation
	0	0	0	0	0	Character Display Mode Drawing, Individual Dot Drawing, DMA, WDAT and RDAT
	0	o	0	0	1	Straight Line Drawing
	0	0	0	1	0	Graphics Character Drawing and Area filling with graphics character pattern
	0	0	1	0	0	Arc and Circle Drawing
	0	1	0	0	0	Rectangle Drawing
	1	0	0	1	0	Slanted graphics character drawing and slanted area filling

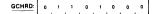
Only these bit combinations assure correct drawing operation.

Figure Draw Start



On execution of this instruction, the GDC loads the parameters from the parameter RAM into the drawing processor and starts the drawing process at the pixel pointed to by the cursor, EAD, and the dot address, dAD.

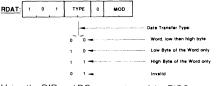
Graphics Character Draw and Area Filling Start



Based on parameters loaded with the FIGS command, this command initiates the drawing of the graphics character or area filling pattern stored in Parameter RAM. Drawing begins at the address in display memory pointed to by the EAD and dAD values.

Data Read Commands

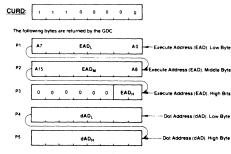
Read Data from Display Memory



Using the DIR and DC parameters of the FIGS command to establish direction and transfer count, multiple RMW cycles can be executed without specification of the cursor address after the initial load (DC = number of words or bytes).

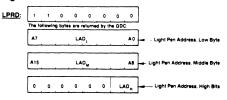
As this instruction begins to execute, the FIFO buffer direction is reversed so that the data read from display memory can pass to the microprocessor. Any commands or parameters in the FIFO at this time will be lost. A command byte sent to the GDC will immediately reverse the buffer direction back to write mode, and all RDAT information not yet read from the FIFO will be lost. MOD should be set to 00 if no modification to video buffer is desired.

Cursor Address Read



The Execute Address, EAD, points to the display memory word containing the pixel to be addressed. The Dot Address, dAD, within the word is represented as a 1-of-16 code for graphics drawing operations.

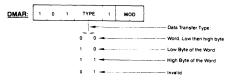
Light Pen Address Read



The light pen address, LAD, corresponds to the display word address, DAD, at which the light pen input signal is detected and deglitched.

The light pen may be used in graphics, character, or mixed modes but only indicates the word address of light pen position.

DMA Read Request



DMA Write Request

DMAW:	0	0	1	TYPE	1	MOD]
						-	RMW Memory Logical Operation
						0 0	REPLACE with Pattern
						0 1	- COMPLEMENT
						1 0	-RESET to Zero
						1 1	- SET to One
				-			Data Transfer Type:
				0 0			Word, Low then high byte
				1 0			Low Byte of the Word
				1 1	-		High Byte of the Word
				0 1	-		Invalid

Absolute Maximum Ratings* (Tentative)

Ambient Temperature under Bias	0 °C to 70 °C
Storage Temperature	- 65 °C to 150 °C
Voltage on any Pin with respect to Ground	-0.5V to +7V
Power Dissipation	1.5 Watt

*COMMENT: Exposing the device to stresses above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational sections of this specification. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC Characteristics

 $t_a = 0$ °C to 70 °C; $V_{CC} = 5V \pm 10\%$; GND = 0V

	Limits					
Parameter	Symbol	Min	Max	Unit	Test Conditions	
Input Low Voltage	VIL	- 0.5	0.8	٧		
Input High Voltage	ViH	2.0	V _{CC} + 0.5	v		
Output Low Voitage	VOL		0.45	v	$I_{OL} = 2.2 \text{ mA}$	
Output High Voltage	VOH	2.4		v	IOH = -400 μA	
Input Low Leak Current	41		- 10	Αμ	$V_1 = 0V$	
Input High Leak Current	1H		+ 10	μA	VI = Vcc	
Output Low Leak Current	IOL		- 10	μA	Vo = 0V	
Output High Leak Current	юн		+ 10	μA	$V_0 = V_{CC}$	
Clock Input Low Voltage	VCL	-0.5	0.6	v	• ••	
Clock Input High Voltage	VCH	3.9	Vcc + 1.0	v		
V _{CC} Supply Current	ICC		270			

Capacitance

 $t_a = 25$ °C; $V_{CC} = GND = 0V$

Parameter	Symbol	Limits Min Max	Unit	Test Conditions	
Input Capacitance	CIN	10	pF		
I/O Capacitance	CVO	20	pF	fc = 1 MHz - V ₁ (unmeasured) = 0V	
Output Capacitance	Сонт	20	pF		
Clock Input Capacitance	C.	20	pF		

AC Characteristics

 $t_A = 0$ °C to 70 °C; $V_{CC} = 5.0V \pm 10\%$; GND = 0V

Read (Cycle	(GDC ↔ CP	U)		
		Lin		Test	
Symbol	Parameter	Min	Max	Unit	Conditions
tAR	Address Setup to RD4	0		ns	
^t RA	Address Hold from RDt	0		ns	
IRR1	PD Pulse Width	tRD1 + 20	80	ns	
IRD1	Data Delay from RDI		80	ns	CL = 50 pF
¹ DF	Data Floating from RDt	0	100	ns	
^t RCY	RD Pulse Cycle	4 ICLK		ns	

Write Cycle (GDC ++ CPU)

		Lii	nits		Test Conditions
Symbol	Parameter	Min	Max	Unit	
taw	Address Setup to WR+	0		ns	
twA	Address Hold from WR1	0		ns	
tww	WR Pulse Width	100		ns	
tDW	Data Setup to WR1	80		ns	
twp	Data Hold from WRt	0		ns	
twcy	WR Pulse Cycle	4 tCLK		ns	

DMA Read Cycle (GDC ↔ CPU)

			Limits		Test
Symbol	Parameter	Min	Max	Unit	Conditions
^t KR	DACK Setup to RD.	0		ns	
^t як	DACK Hold from RDt	0		ns	
tRR2	RD Pulse Width	tRD2 + 20		ns	
tRD2	Data Delay from RDi		1.5 tCLK + 80	ns	C _L = 50 pF
^t REQ	DREQ Delay from 2XCCLK1		120	ns	$C_L = 50 pF$
tak	DREQ Setup to DACK.	0		ns	
^t DK	DACK High Level Width	^t CLK		ns	i tan ina ina ina ina ina ina ina ina ina i
tE	DACK Pulse Cycle	4 tCLK		ns	
^t KQ(R)	DREQ + Delay from DACK+		2 t _{CLK} + 120	ns	C _L = 50 pF

DMA Write Cycle (GDC ↔ CPU)

			Limits	nits	
Symbol	Parameter	Min	Max	Unit	Test Conditions
^t KW	DACK Setup to WR	0		ns	
^t WK	DACK Hold from WRt	0		ns	
^t KQ(R)	DREQ + Delay from DACK+		¹ CLK + 120	ns	CL = 50 pF

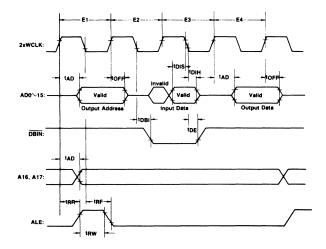
R/M/W Cycle (GDC ↔ Display Memory)

	-,	·	Diopidy mor	,,	
			Limits		Test
Symbol	Parameter	Min	Max	Unit	Conditions
tAD	Address/Data Delay from 2XCCLK†		130	ns	C _L = 50 pl
^t OFF	Address/Data Floating from 2XCCLK†	10	130	ns	CL = 50 pl
tDIS	Input Data Setup to 2XCCLK↓	40		ns	
^t DIH	Input Data Hold from 2XCCLK4	0		ns	
^t DBI	DBIN Delay from 2XCCLK∔		90	ns	C _L = 50 pl
^t RR	ALE† Delay from 2XCCLK†	30	110	ns	$C_L = 50 pF$
^t RF	ALE+ Delay from 2XCCLK+	20	90	ns	C _L = 50 pF
^t RW	ALE Width	1/3 tCLK		ns	$C_L = 50 pf$

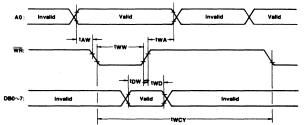
Display	Cycle	(GDC ↔ D	isplay Men	nory)	
-		L	mits		Test
Symbol	Parameter	Min	Max	Unit	Conditions
tvD	Video Signal Delay from 2XCCLK†		120	ns	C _L = 50 pF
Input	Cycle	(GDC ++ I	Display Me	mory)	
		L	imits		Test
Symbol	Parameter	Min	Max	Unit	Conditions
^t PS	Input Signal Setup to 2XCCLK1	20		ns	
^t PW	Input Signal Width	^t CLK		ns	
Clock					
			imits		Test
Symbol	Parameter	Min	Max	Unit	Conditions
^t CR	Clock Rise Time		10	ns	
¹ CF	Clock Fall Time		10	ns	
¹ СН	Clock High Pulse Width	95		ns	
^t CL	Clock Low Pulse Width	95		ns	
1CLK	Clock Cycle	200	2000	ns	

Timing Waveforms

Display Memory RMW Timing

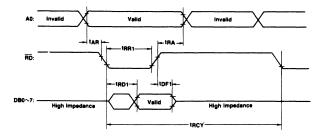


Microprocessor Interface Write Timing

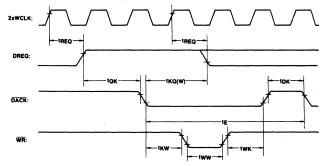


Timing Waveforms (Cont.)

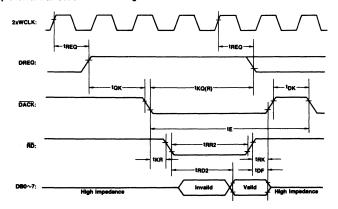
Microprocessor Interface Read Timing



Microprocessor Interface DMA Write Timing

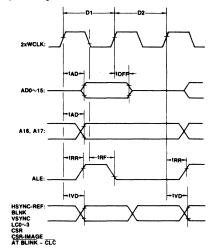


Microprocessor Interface DMA Read Timing

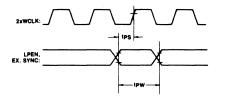


Timing Waveforms (Cont.)

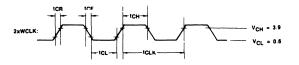
Display Memory Display Cycle Timing



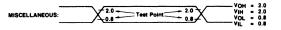
Light Pen and External Sync Input Timing



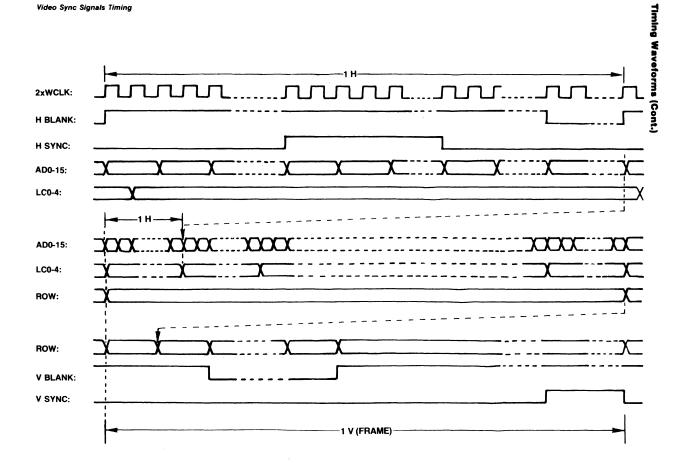
Clock Timing



Test Level (for AC Tests)



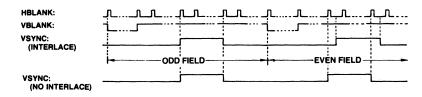
Video Sync Signals Timing



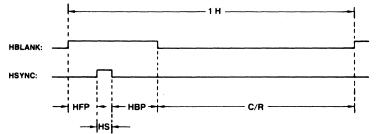
A4-15

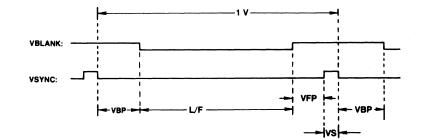
Timing Waveforms (Cont.)

Interlaced Video Timing



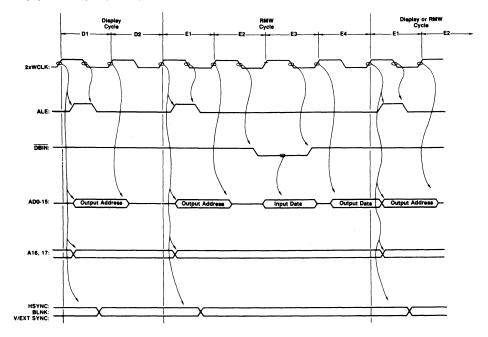
Video Sync Generator Parameters



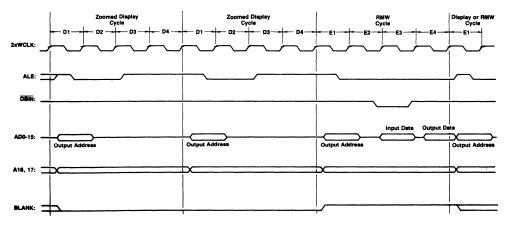


Timing Waveforms (Cont.)

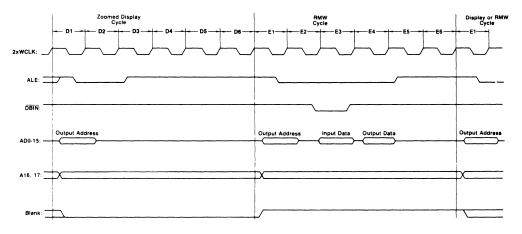
Display and RMW Cycles (1x Zoom)

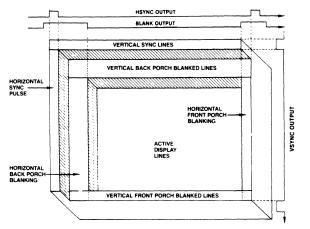


Display and RMW Cycles (2x Zoom)



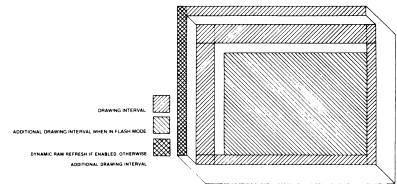
Zoomed Display Operation with RMW Cycle (3x Zoom)



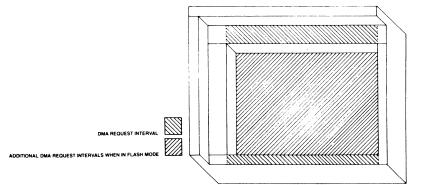


Video Field Timing









Pin Identification

Pin Configuration

	Pin		
No.	Symbol	Direction	Function
1	2xWCLK	IN	Clock Input
2	DBIN	OUT	Display Memory Read input Flag
3	HSYNC	OUT	Horizontal Video Sync Output
4	V/EXT SYNC	IN/OUT	Vertical Video Sync Output or External VSYNC Input
5	BLANK	OUT	CRT Blanking Output
6	ALE (RAS)	OUT	Address Latch Enable Output
7	DRQ	OUT	DMA Request Output
8	DACK	IN	DMA Acknowledge Input
9	RD	IN	Read Strobe input for Microprocessor Interface
10	WR	IN	Write Strobe input for Microprocessor Interface
11	A0	IN	Address Select Input for Microprocessor Interface
12-19	DB0 to 7	IN/OUT	Bidirectional Data Bus to Host Microprocessor
20	GND	-	Ground
21	LPEN	IN	Light Pen Detect Input
22-34	AD0 to 12	IN/OUT	Address and Data Lines to Display Memory
35-37	AD13 to 15	IN/OUT	Utilization Varies with Mode of Operation
38	A16	OUT	Utilization Varies with Mode of Operation
39	A17	OUT	Utilization Varies with Mode of Operation
40	Vcc	-	+5V ± 10%

Character Mode Pin Utilization

Pin			
No.	Name	Direction	Function
35-37	AD13 to 15	OUT	Line Counter Bits 0 to 2 Outputs
38	A16	OUT	Line Counter Bit 3 Output
39	A17	OUT	Cursor Output

Mixed Mode Pin Utilization

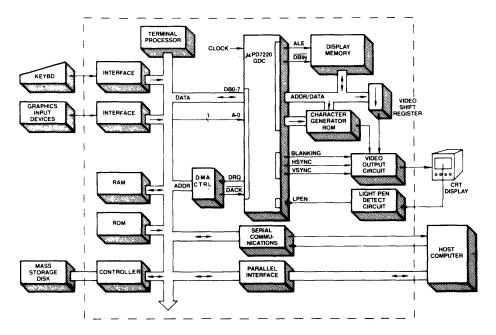
Pin			
No.	Name	Direction	Function
35-37	AD13 to 15	IN/OUT	Address and Data Bits 13 to 15
38	A16	OUT	Attribute Blink and Clear Line Counter* Output
39	A17	OUT	Cursor and Bit-Map Area* Flag Output

 = Output during the HSYNC interval. Use the trailing edge at HSYNC to clock this value into a flop for reference during the rest of the video line.

Graphics Mode Pin Utilization

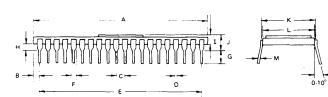
Pin			
No.	Name	Direction	Function
35-37	AD13 to 15	IN/OUT	Address and Data Bits 13 to 15
38	A16	OUT	Address Bit 16 Output
39	A17	OUT	Address Bit 17 Output

Block Diagram of a Graphics Terminal

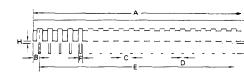


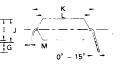
Package Outlines µPD7220D

μ**PD7220C**



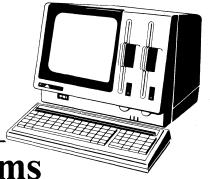
Ceramic				
ITEM	MILLIMETERS	INCHES		
А	51.5 MAX	2.03 MAX		
В	1.62 MAX	0.06 MAX		
С	2.54 0.1	0.1 . 0.004		
D	0.5 · 0.1	0.02 . 0.004		
E	48.26 0.1	1.9 0.004		
F	1.02 MIN	0.04 MIN		
G	3.2 MIN	0.13 MIN		
н	1.0 MIN	0.04 MIN		
1	3.5 MAX	0.14 MAX		
J	4.5 MAX	0.18 MAX		
к	15.24 TYP	0.6 TYP		
L	14.93 TYP	0.59 TYP		
M	0.25 0.05	0.01 + 0.0019		





ITEM	MILLIMETERS	INCHES
А	51 5 MAX	2.028 MAX
В	1 62	0.064
С	254.01	0.10 + 0.004
D	0.5 • 0 1	0.019 + 0.004
E	48.26	19
F	1.2 MIN	0.047 MIN
G	2.54 MIN	0.10 MIN
н	0.5 MIN	0.019 MIN
I	5.22 MAX	0.206 MAX
J	5.72 MAX	0.225 MAX
к	15.24	0.600
L	13.2	0.520
м	0.25 + 0.1 0.05	0.010 + 0.004 0.002

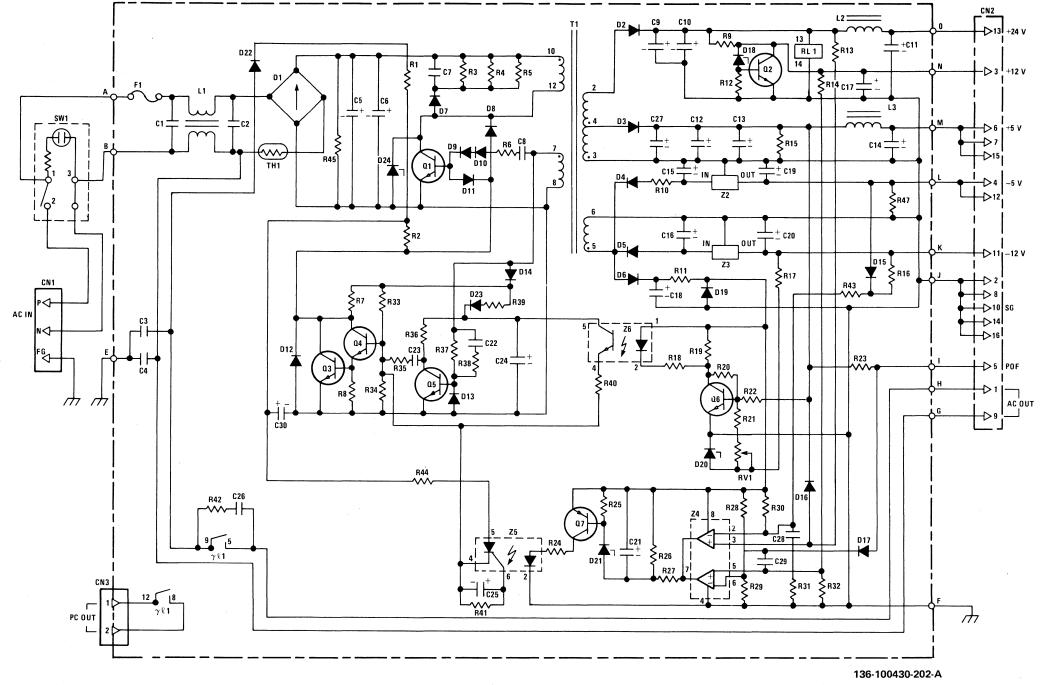
Plastic



Appendix B Logic and Schematic Diagrams

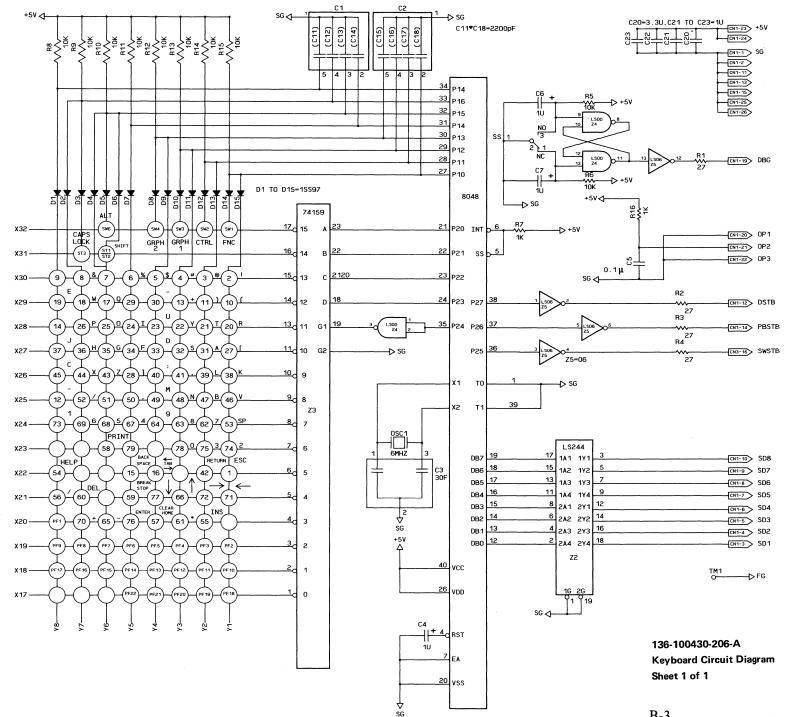
The APC logic and schematic diagrams are arranged in drawing number sequence.



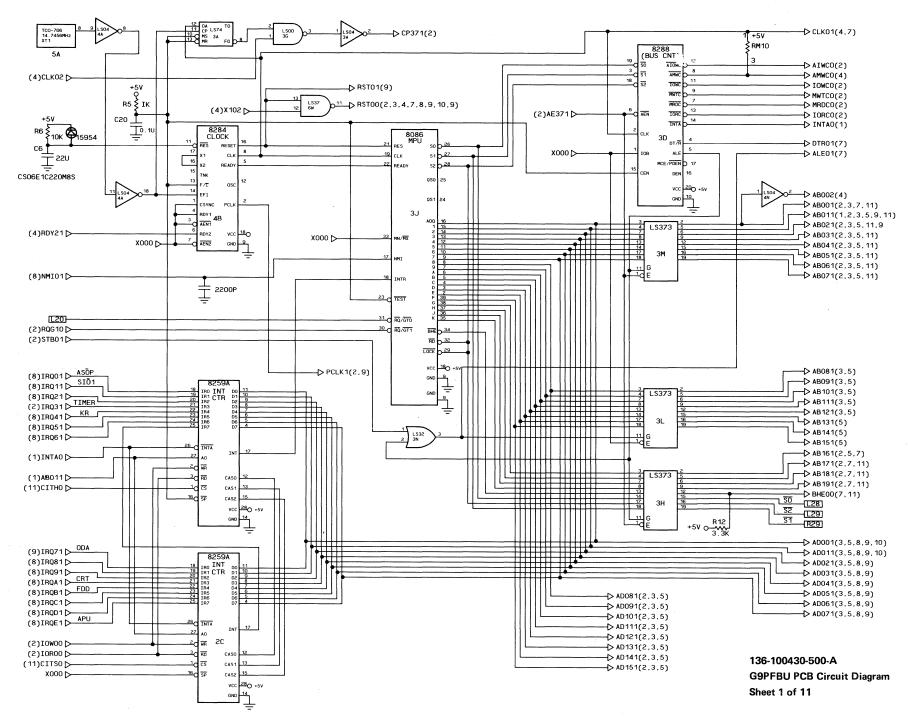


H Type Power Supply Circuit Diagram Sheet 1 of 1



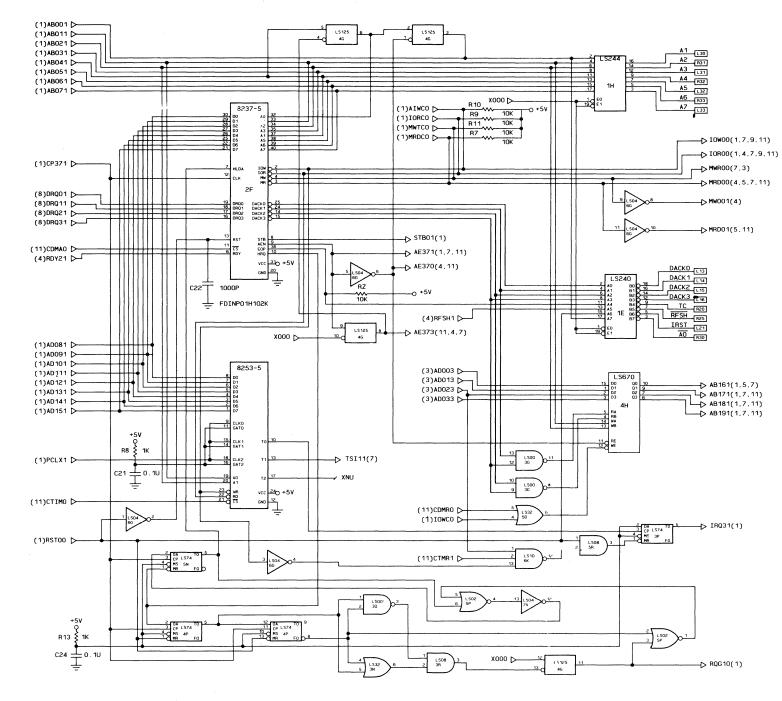






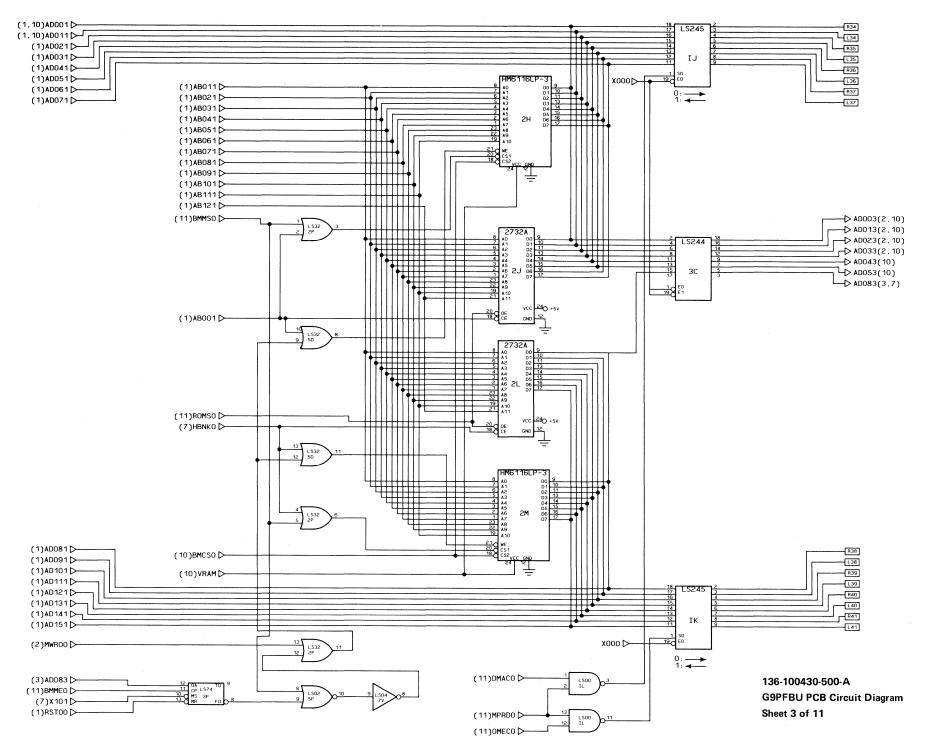
B-4



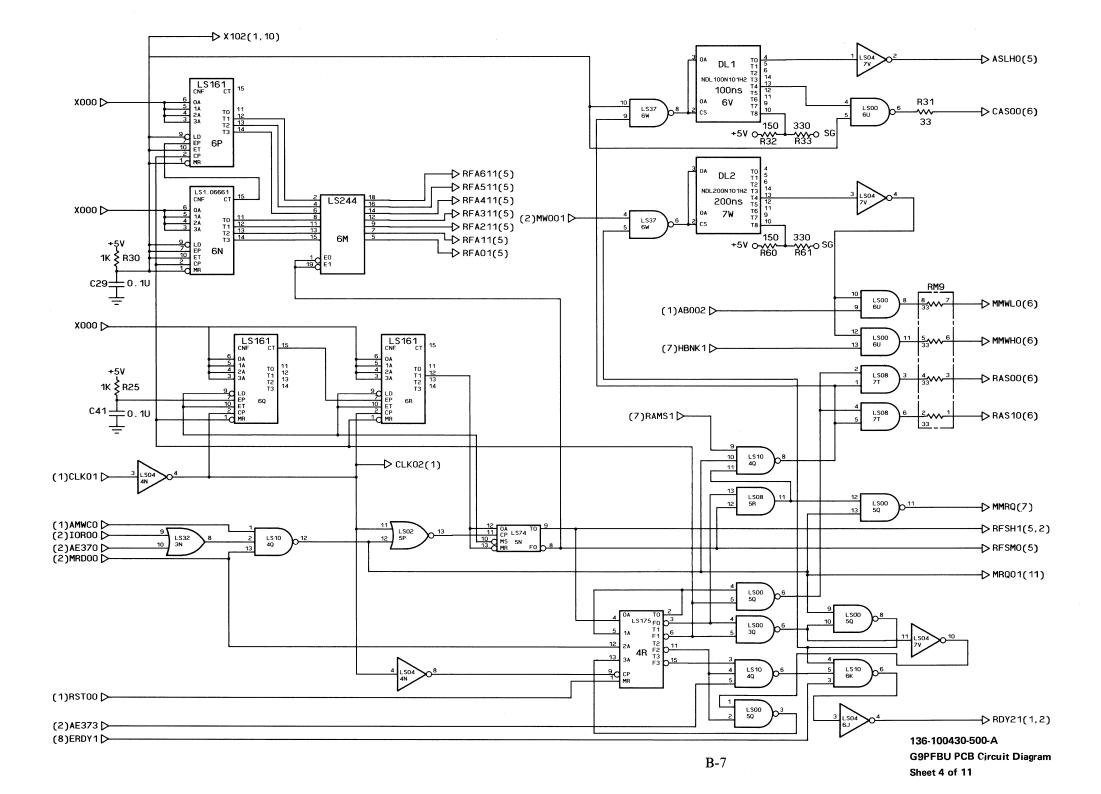


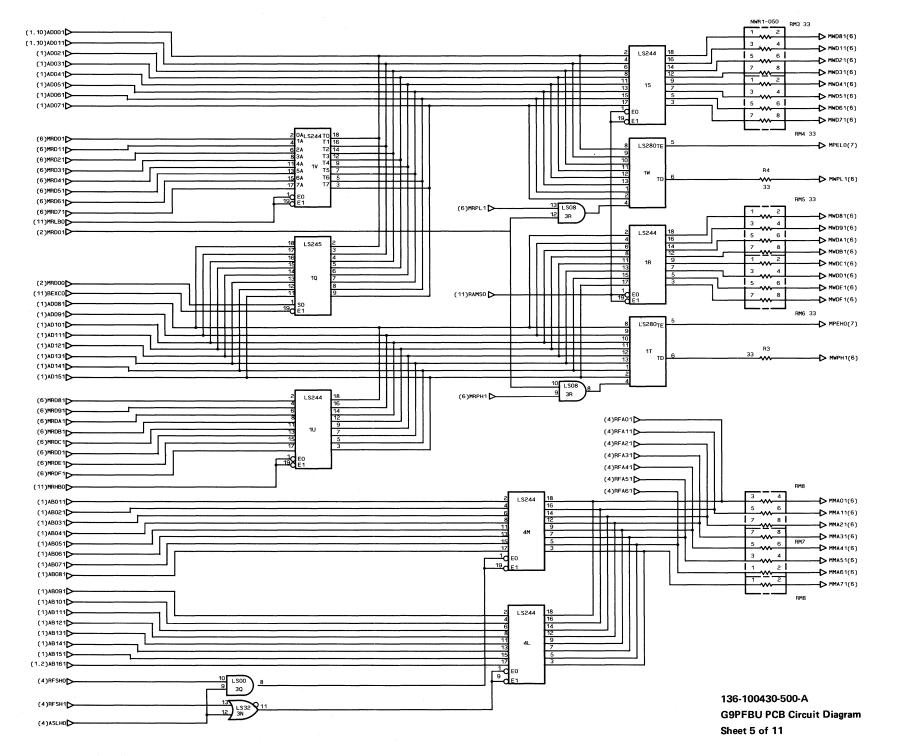
136-100430-500-A G9PFBU PCB Circuit Diagram Sheet 2 of 11

B-5



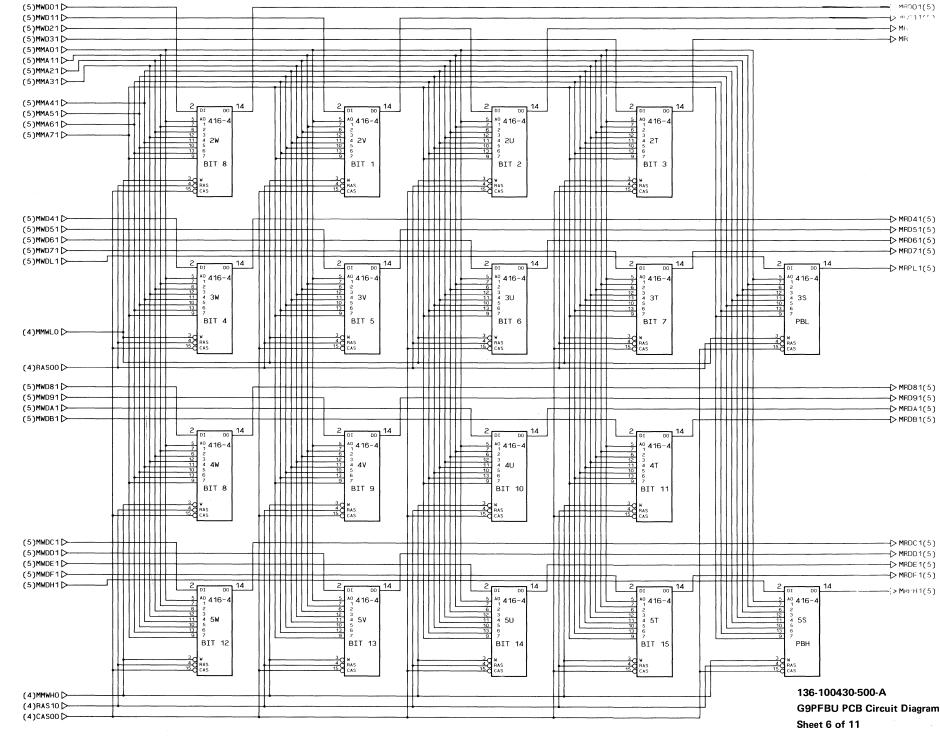






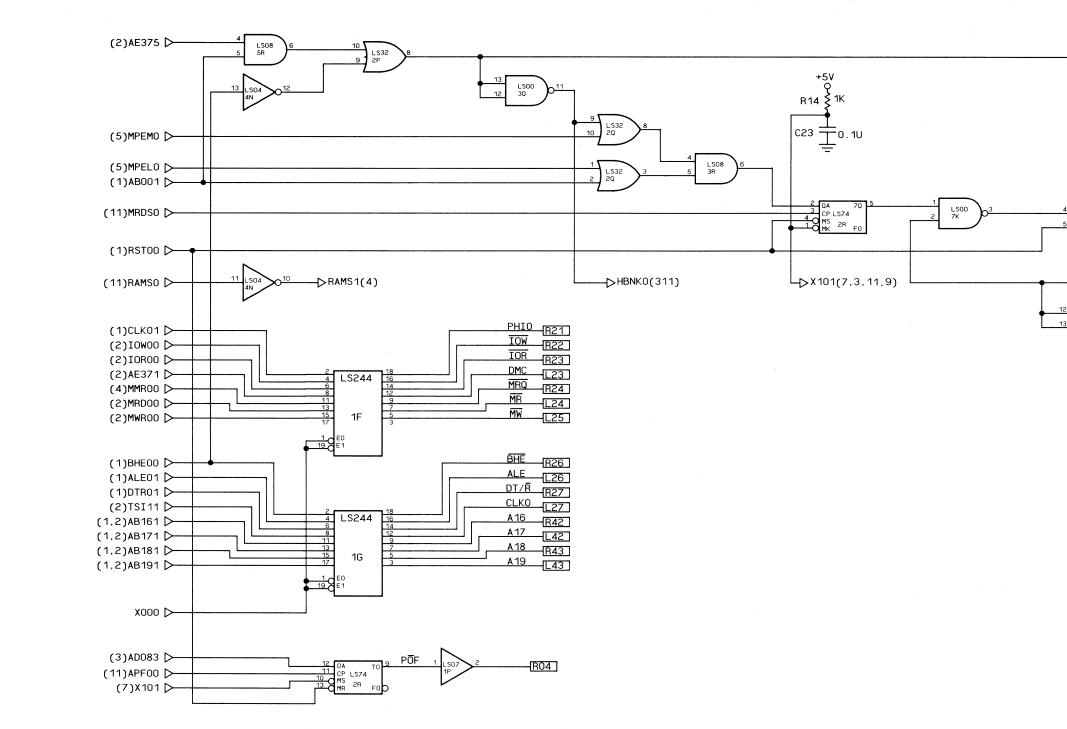
B-8







136-100430-500-A G9PFBU PCB Circuit Diagram Sheet 7 of 11



+5V

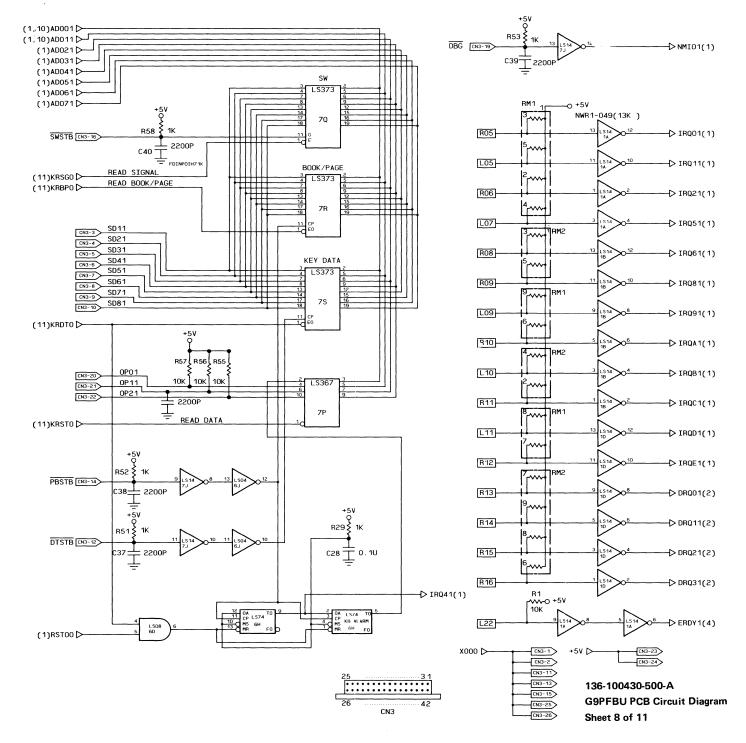
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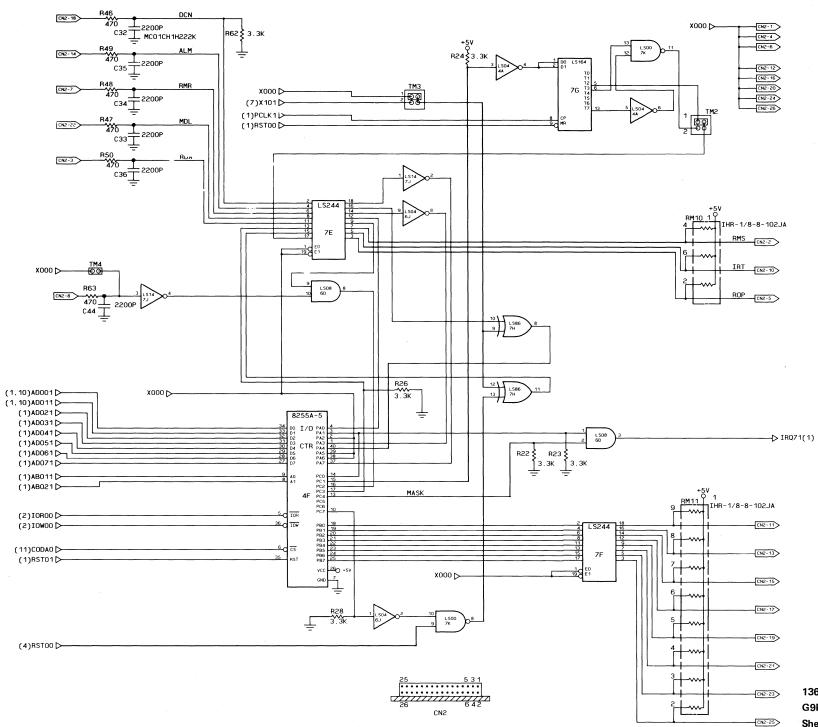
R54 **\$**470

LS00 7K

LSO8 7T

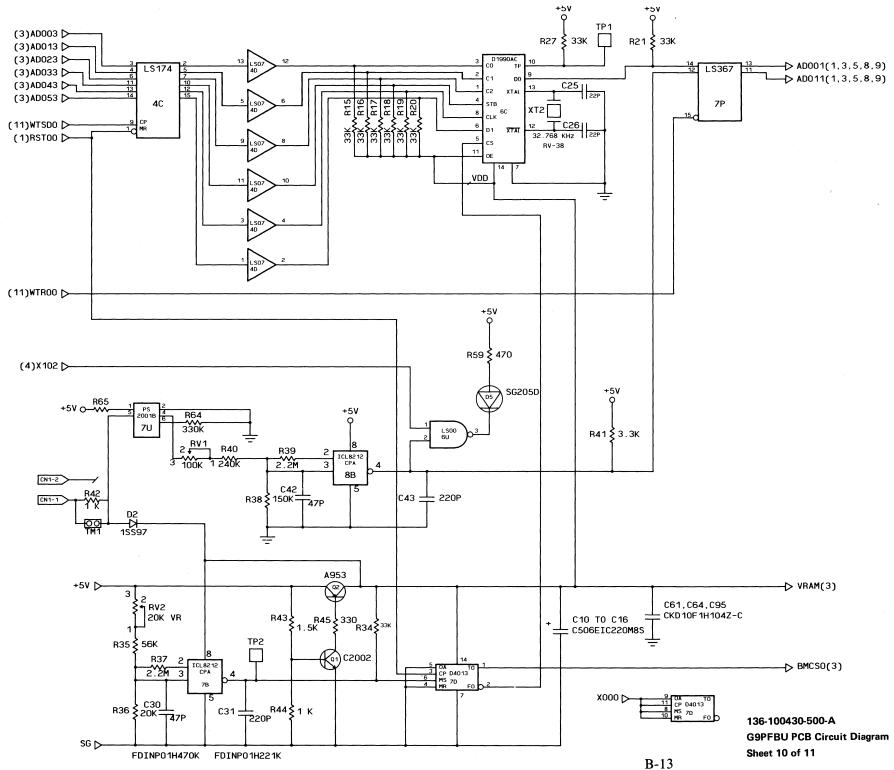
SR505D

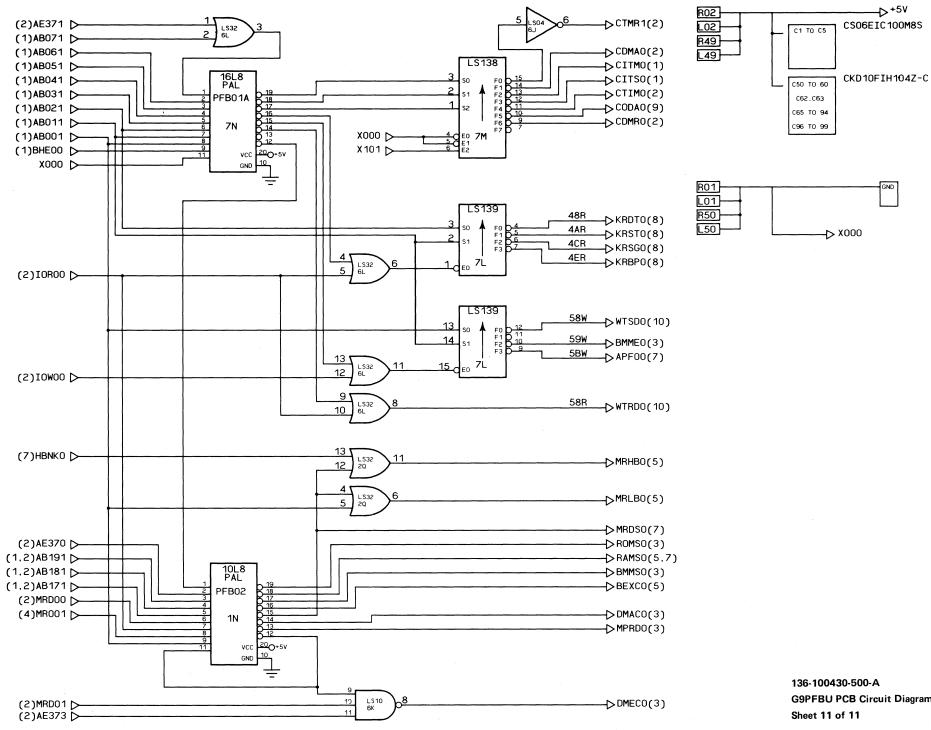




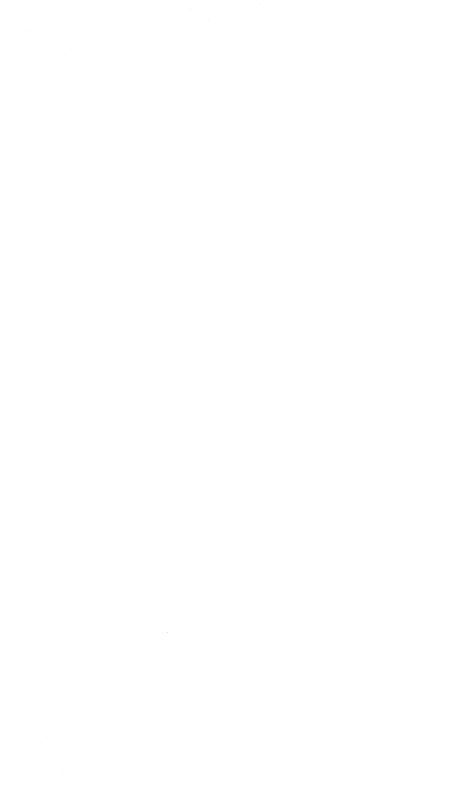
136-100430-500-A G9PFBU PCB Circuit Diagram Sheet 9 of 11

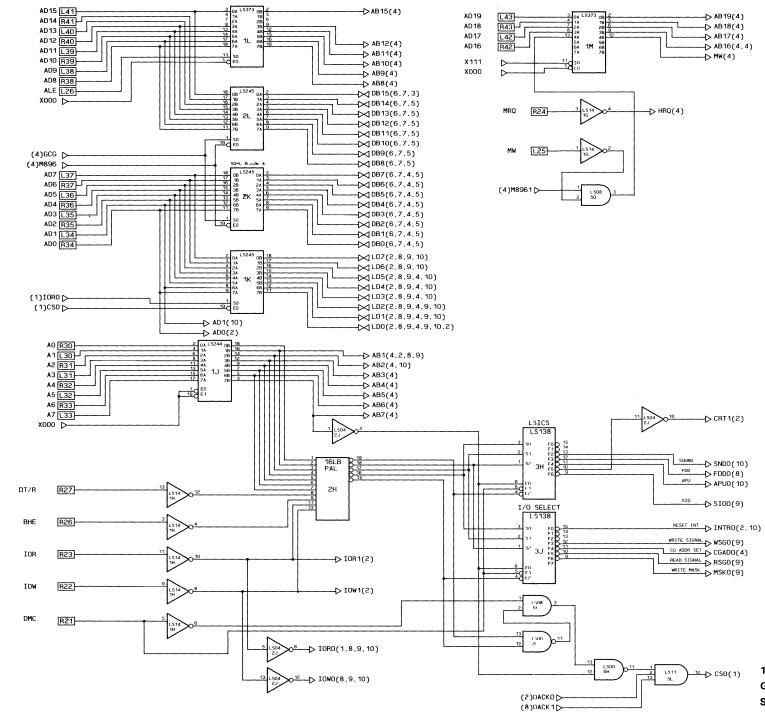






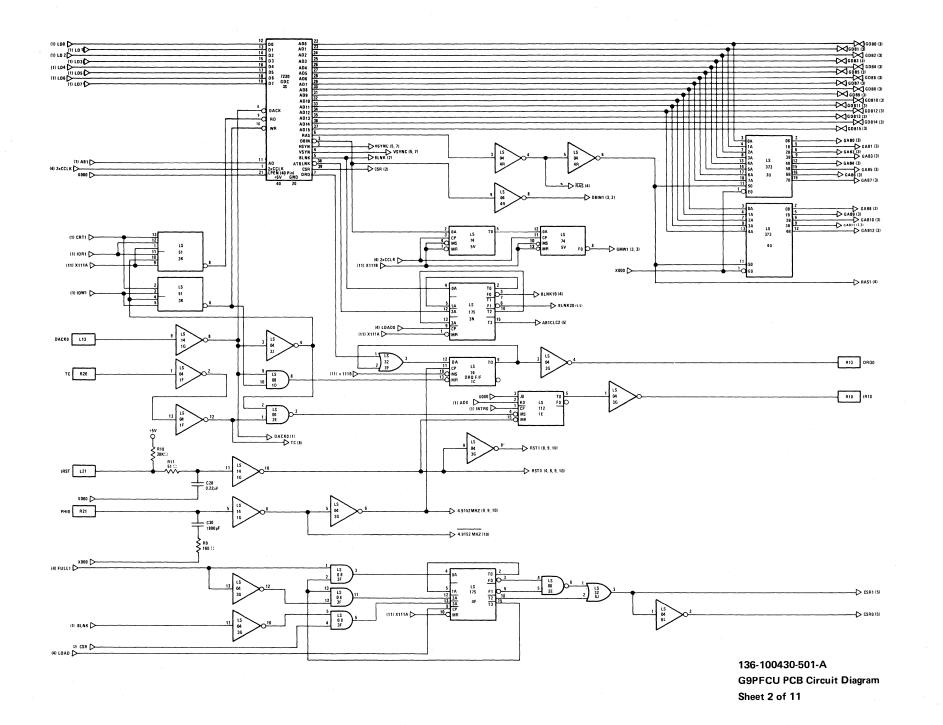
G9PFBU PCB Circuit Diagram



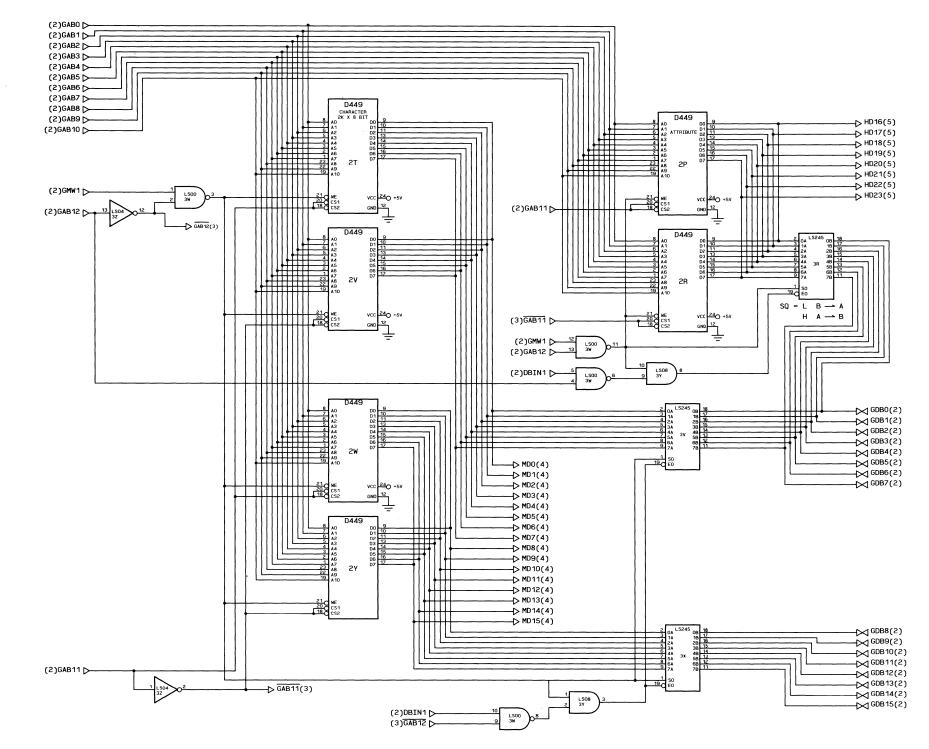


136-100430-501-A **G9PFCU PCB Circuit Diagram** Sheet 1 of 11



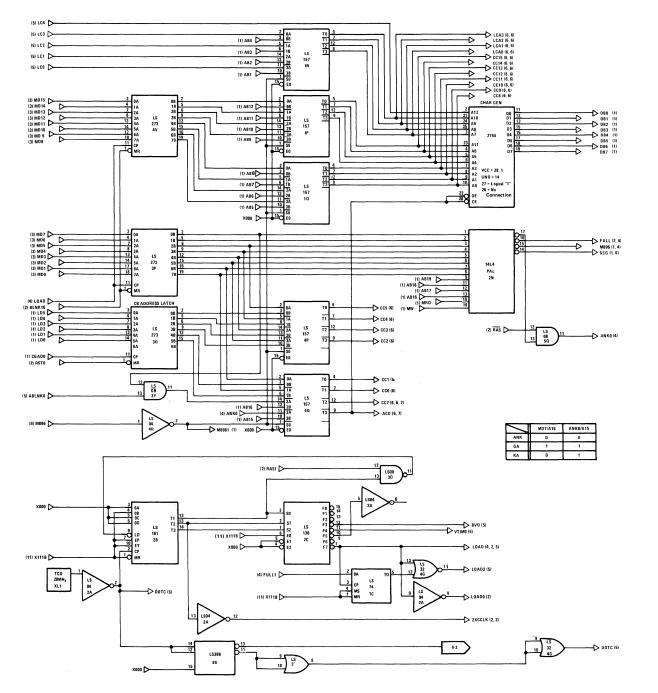






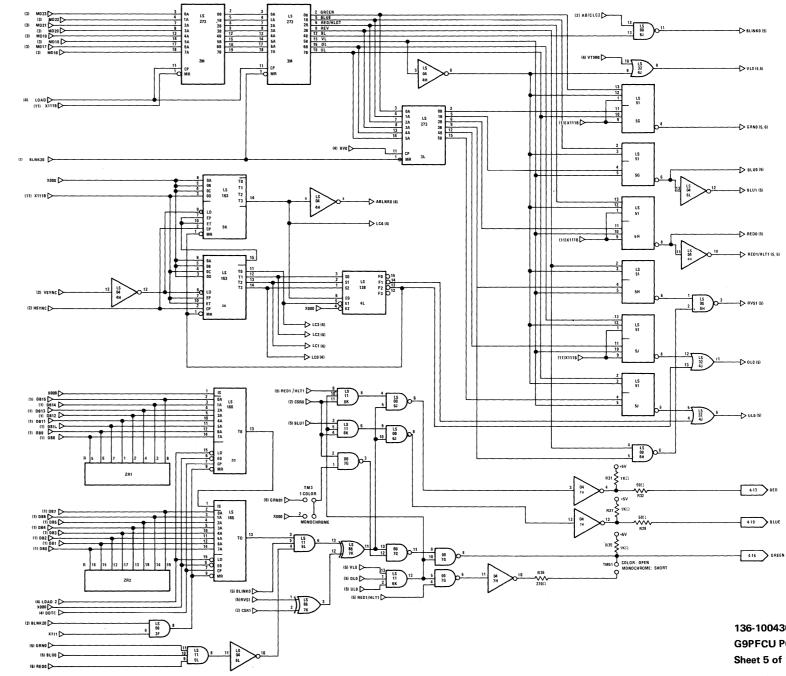
136-100430-501-A

G9PFCU PCB Circuit Diagram Sheet 3 of 11

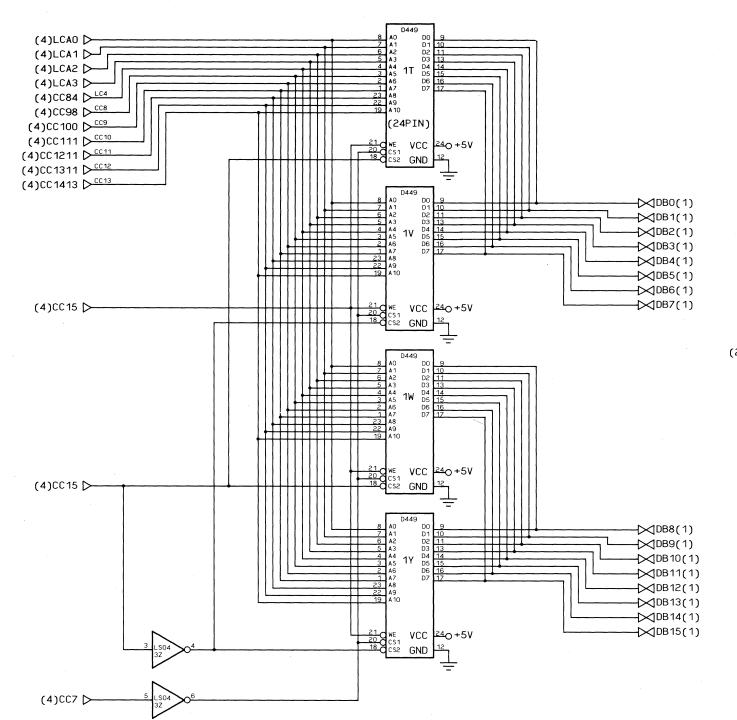


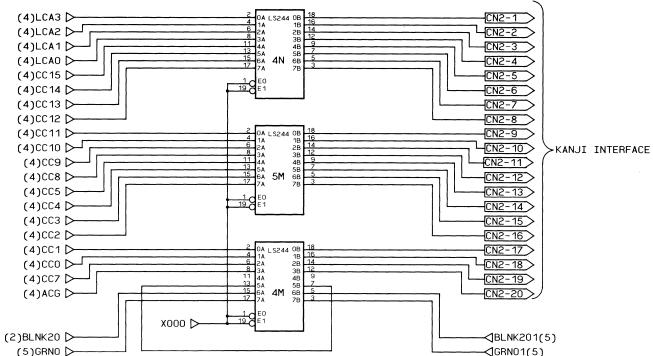
136-100430-501-A G9PFCU PCB Circuit Diagram Sheet 4 of 11





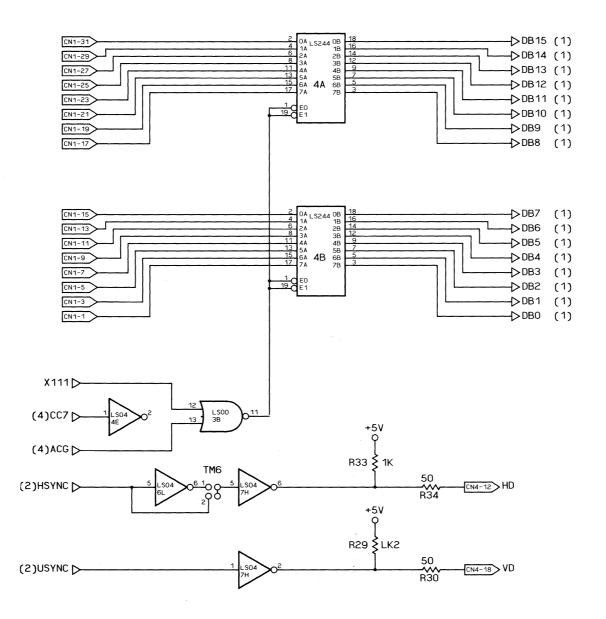
136-100430-501-A G9PFCU PCB Circuit Diagram Sheet 5 of 11



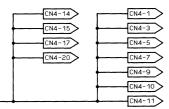


-4GRN01(5)

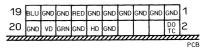
136-100430-501-A G9PFCU PCB Circuit Diagram Sheet 6 of 11



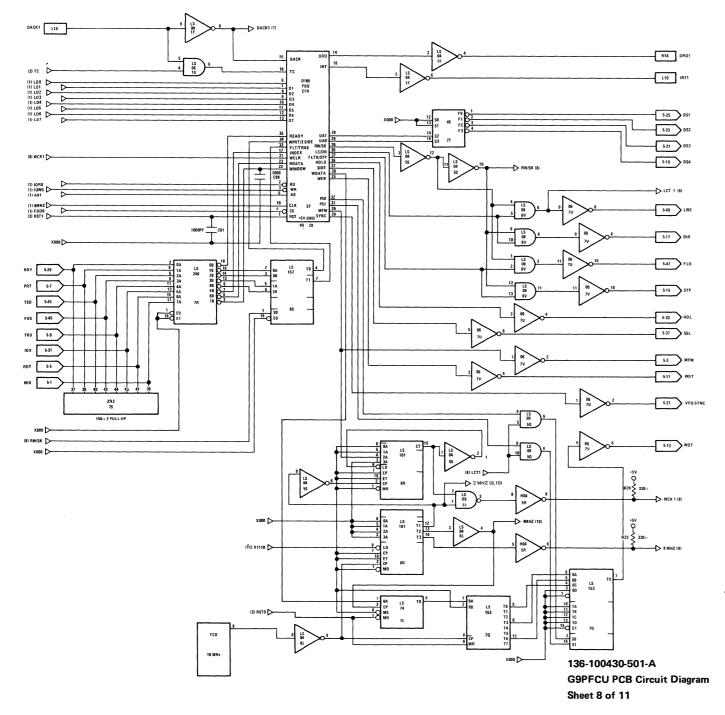
X000 🗁



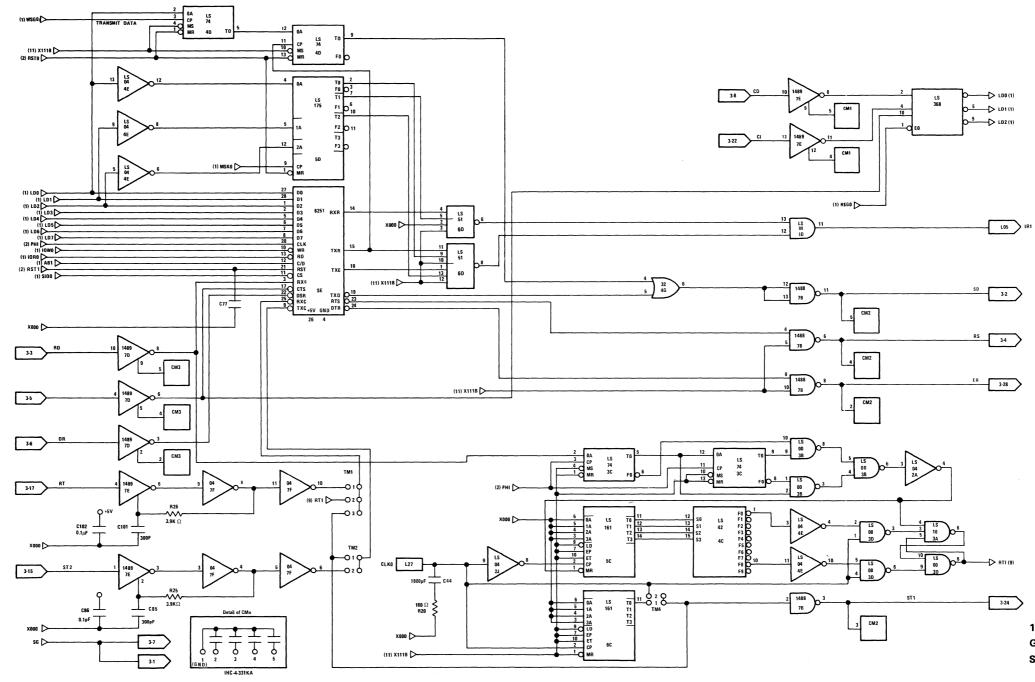
Pin assignment of CRT display unit connector



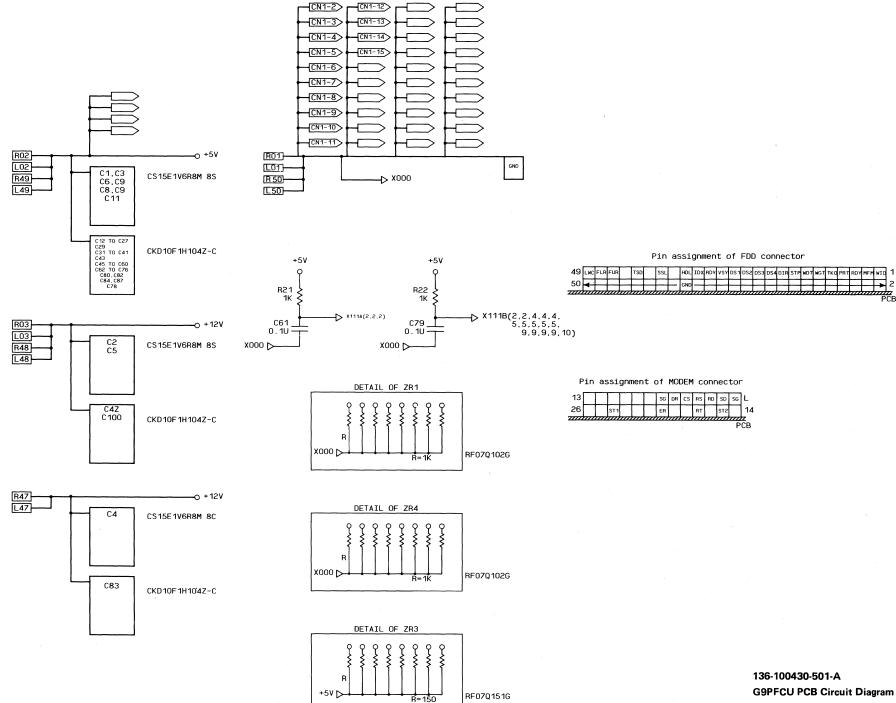
136-100430-501-A G9PFCU PCB Circuit Diagram Sheet 7 of 11





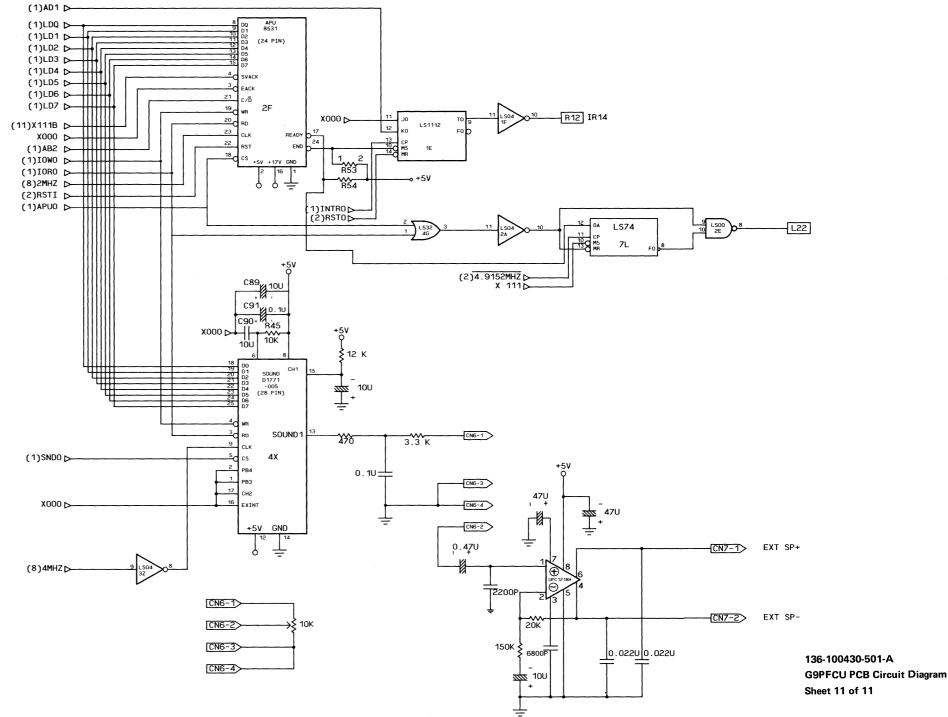


136-100430-501-A G9PFCU PCB Circuit Diagram Sheet 9 of 11

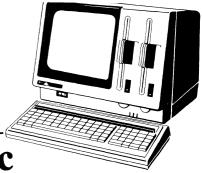


Sheet 10 of 11





Appendix C



Programmable Array Logic Decoding Specifications

There are four Programmable Array Logic (PAL) devices in the APC, two on the Processor PCB and two on the Controller PCB. These devices are identified and listed in Table C-1. Tables C-2 to C-5 describes each PAL device in terms of its inputs and outputs.

STAMPED IDENTIFICATION	MANUFACTURER DATA	PCB LOCATION
PFB01C	MMI PAL 16L8 or Signetics N 82S153F	G9PFBU (Processor PCB) Location 7N
PFB02	MMI PAL 10L8	G9PFBU (Processor PCB) Location 1N
PFC01	MMI PAL 14L4 or Signetics N 82S153F	G9PFCU (Controller PCB) Location 2H
NMS02	MMI PAL 14L4	G9PFCU (Controller PCB) Location 2N

Table C-1 Identification and Location of PAL Devices

IN	IPUT	OUTPUT						
PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME					
1 2 3 4 5 6 7 8 9 11	A7 A6 A5 A4 A3 A2 A1 A0 BHE0 AE371	19 18 17 16 15 14 13 12	B0 B1 B2 KB C0 WAT CDMA0 MBC					
(Ā	7·A6·A5·BHE0·AE371) 7·A6·A5·A4·A3·A2·A1·	A0·AE371)						
(Ā	7• A6• A5• BHE0• AE371) 7• A6• A5• A4• A3• A0• AE3 7• A6• A5• A4• A3• A0• AE3	$(\overline{371}) +$	•BHE0•AE371) +					
(Ā	7·A6·A5·A4·A3·A2·A0· 7·A6·A5·A4·A3·BHE0· (A7·A6·A5·A4·A3·A2·A	AE <u>371)+(A7</u> ·A6·A5·	A4·A3·A0·AE371)					
$\overline{KB} = (\overline{A})$	7·A6·A5·A4·A3·A0·AE	371)						
$\boxed{\overline{C0}} = (\overline{A}) \\ (\overline{A})$	7·A6·A5·A4·A3·A2·A1· 7·A6·A5·A4·A3·A2·BH	$\overline{A0} \cdot \overline{AE371}$) + E0 · $\overline{AE371}$)						
$\overline{WAT} = (\overline{A})$	7·A6·A5·A4·A3·A2·A1·	Ā0·ĀE371)						
	$\overline{7} \cdot \overline{A6} \cdot \overline{A5} \cdot \overline{BHE0} \cdot \overline{AE371})$ $\overline{7} \cdot \overline{A6} \cdot A5 \cdot \overline{A4} \cdot A3 \cdot \overline{BHE0} \cdot \overline{A5} \cdot \overline{A4} \cdot A3 \cdot \overline{BHE0} \cdot \overline{A5} \cdot \overline{A4} \cdot A3 \cdot \overline{A0} \cdot \overline{AE3} \cdot \overline{A5} \cdot \overline{A4} \cdot A3 \cdot \overline{A0} \cdot \overline{AE3} \cdot \overline{A5} \cdot \overline{A4} \cdot A3 \cdot \overline{A0} \cdot \overline{AE3} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{7} \cdot \overline{A6} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{7} \cdot \overline{A6} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{7} \cdot \overline{A6} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{7} \cdot \overline{A6} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{7} \cdot \overline{A6} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{7} \cdot \overline{A6} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{A5} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{A5} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{A5} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{A5} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{A5} \cdot \overline{A5} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{A5} \cdot \overline{A5} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \overline{A5} \cdot \overline$	$\overline{AE371} + (\overline{A7} \cdot A6 \cdot \overline{A4})$ $\overline{371} + (\overline{A7} \cdot A6 \cdot \overline{A5} \cdot A4)$	$(A3 \cdot \overline{A0} \cdot \overline{AE371}) +$					
$\overline{\text{CDMA0}} = (\overline{\text{A}})$	7•A6•A5•BHEO•AE371)						

Table C-2 PFB01C Inputs/Outputs

IN	PUT	OU	TPUT
PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
1 2 3 4 5 6 7 8 9 11	MBCS DMC AB19 AB18 AB17 MRD IOR MRQ AB0 IMM	19 18 17 16 15 14 13 12	ROMS RAMS BMMS BEXC MRBS DMA MPR ITMM
$\overline{RAMS} = (\overline{AB})$ $\overline{BMMS} = (AB)$ $\overline{BEXC} = (\overline{DM})$ $\overline{MRBS} = (\overline{AB})$ $\overline{DMA} = (\overline{DM})$ $\overline{MPR} = (DM)$	9. $AB18. AB17. \overline{MRD}$) 9. $\overline{AB18}. \overline{AB17}$) 9. $\overline{AB18}. \overline{AB17}$) 9. $\overline{AB18}. \overline{AB17}. MRQ$) $\overline{C}. MRQ. AB0$) 9. $\overline{AB18}. \overline{AB17}. \overline{MRD}$) $\overline{C}. \overline{IOR}$) + ($\overline{DMC}. \overline{MRD}$) $\overline{C}. \overline{MBCS}. \overline{IOR}$) + (DMC)	C·MRD·IMM)	

Table C-3 PFB02 Inputs/Outputs

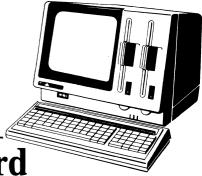
IN	PUT	OUTPUT						
PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME					
1 2 3 4 5 6 7 8 9 11 13	A0 A1 A2 A3 A4 A5 A6 DT/R BHE IOR IOR IOW	LSI B0 B1 B2 IO CS0 CS1						
$(\underline{A6} \cdot \overline{A5})$	$(A4 \cdot \overline{A3} \cdot \overline{A2} \cdot A0) + (A6 \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot A0) + (A6 \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot A0) + (A6 \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot BHE) + (A6 \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot BHE)$	$\overline{A5} \cdot A4 \cdot A3 \cdot A1 \cdot A0) +$	0) +					
$(A6 \cdot A5)$ $(A6 \cdot A5)$	$\begin{array}{c} \cdot \underline{A4} \cdot \overline{\underline{A3}} \cdot \overline{\underline{A2}} \cdot \underline{A0} + (\underline{A6} \cdot \overline{\underline{A4}} \cdot \overline{\underline{A3}} \cdot \overline{\underline{A2}} \cdot \underline{A1} \cdot \underline{A0}) + (\underline{A6} \cdot \overline{\underline{A4}} \cdot \underline{A3} \cdot \underline{A2} \cdot \overline{\underline{A1}} \cdot \underline{A0}) + (\underline{A6} \cdot \overline{\underline{A4}} \cdot \underline{A3} \cdot \underline{A2} \cdot \overline{\underline{A1}} \cdot \underline{A0} \cdot \overline{\underline{DT}} / \underline{A4} \cdot \overline{\underline{A3}} \cdot \underline{A2} \cdot \overline{\underline{A1}} \cdot \underline{A0} \cdot \overline{\underline{DT}} / \underline{A4} \cdot \overline{\underline{A3}} \cdot \overline{\underline{A2}} \cdot \underline{A1} \cdot \underline{A0}) \\ \cdot \overline{\underline{A4}} \cdot \overline{\underline{A3}} \cdot \overline{\underline{A2}} \cdot \underline{A1} \cdot \underline{A0}) \\ \end{array}$	A6•A5•A4•A3•A2•BHI						
$(\overline{A6} \cdot A5)$ $(\overline{A6} \cdot A5)$	$\overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot A0) + (A6 \cdot \overline{A})$ $A4 \cdot \overline{A3} \cdot \overline{A2} \cdot BHE) + (A6 \cdot \overline{A4})$ $A4 \cdot \overline{A3} \cdot A2 \cdot \overline{A1} \cdot A0 \cdot DT/$ $\overline{A4} \cdot \overline{A3} \cdot A2 \cdot A1 \cdot A0 \cdot \overline{DT/}$	$(\overline{A5} \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{BHE})$ R) + (A6 \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A3} \cdot	$+ \frac{1}{A2 \cdot A1 \cdot A0 \cdot DT/R} + \frac{1}{A1 \cdot A0 \cdot DT/R} + \frac{1}{A0 \cdot DT/R} + 1$					
$(A6 \cdot A5)$ $(A6 \cdot A5)$	$\begin{array}{c} \underline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \underline{A0} + (\overline{A6} \cdot A \\ \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \underline{A0} + (\overline{A6} \cdot A \\ \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \overline{A1} \cdot \underline{A0} + (\overline{A6} \cdot A \\ \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \underline{A1} \cdot \underline{A0} \cdot \overline{DT} \\ \overline{A4} \cdot \overline{A3} \cdot \overline{A2} \cdot \underline{A1} \cdot \underline{A0} \end{array}$	<u>A6·Ā5·Ā4·Ā3·Ā2·BHI</u>	E) +					
$(\overline{A6} \cdot \underline{A5})$ $(A6 \cdot \overline{A5})$	•A4•A3•A2•A1•A0•IOW •A4•A3•A2•A1•A0•IOW •A4•A3•A2•A1•A0•IOW •A4•A3•A2•A1•A0•IOW •A4•A3•A2•A1•A0•IOR	$(A6 \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A}) + (A6 \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A}) + (A6 \cdot \overline{A5} \cdot \overline{A4} \cdot \overline{A3} \cdot \overline{A})$	$2 \cdot \overline{A1} \cdot A0 \cdot IOW + 0$					
$\overline{\text{CS0}} = (\text{A6·A5})$ $\overline{\text{CS1}} = (\overline{\text{A6·A5}})$,							
	(T)							

Table C-4 PFC01 Inputs/Outputs

IN	PUT	OUTPUT								
PIN NUMBER	SIGNAL NAME	SIGNAL NAME PIN NUMBER								
1 2 3 4 5 6 7 8 9 11 12 13 18 19	CC7 CC6 CC5 CC4 CC3 CC2 CC1 CC0 M8960 MRQ0 MRQ0 MW0 XNU XNU XNU XNU XNU	17 16 15 14	ANK0 FULL1 BE0 BS0							

Table C-5 NMS02 Inputs/Outputs

Appendix D

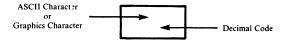


Character Code and Keyboard Information

This appendix gives important character code and keyboard information for the APC. The characters that can be generated and their associated codes are shown in Table D-1. The meanings of the ASCII special characters are given in Table D-2. Table D-3 lists the APC special characters that differ in representation from the ASCII standard, but the generated code is the same. A quick reference quide for easy association of the ASCII special characters and APC special characters is provided in Table D-4. The APC GRPH1 characters are shown in Figure D-1, the GRPH2 characters in Figure D-2.

Table D-1 Code Table

SECOND HEX		FIRST HEX DIGIT														
DIGIT	0	1	2	3	4	5	6	7	8	9	A	В	C	D	E	F
0	NUL 00	DLE 16	SP 32	0 48	@ 64	P 80	96	р 112	128	144	160	00	a 192	¢	224	240
1	SOH 01	DC1 17	! 33	1 49	A 65	Q 81	a 97	q 113	129	145	≥ 161	3 177	V 193	ω 209	225	241
2	STX 02	DC2 18	" 34	2 50	B 66	R 82	b 98	r 114	130	146	162	$ au_{178} au$	Δ	≈ 210	226	242
3	ETX 03	DC3 19	# 35	3 51	C 67	S 83	с 99	s 115	131	147	* 163	4 179	β 195	√ 211	227	243
4	EOT 04	DC4 20	\$ 36	4 52	D 68	T 84	d 100	t 116	132	148	<u>≤</u> 164	5 180	ξ 196	7 212	228	244
5	ENQ 05	NAK 21	% 37	5 53	E 69	U 85	e 101	u 117	133	149	165	6 181	η 197	8 213	229	245
6	ACK 06	SYN 22	& 38	6 54	F 70	V 86	f 102	V 118	134	150	• 166	E 182	θ	9 214	230	246
7	BEL 07	ETB 23	39	7 55	G 71	W 87	g 103	W 119	135	151	167	ρ 183	1 199	l 215	231	247
8	BS 08	CAN 24	(40	8 56	H 72	X 88	h 104	x 120	136	152	1 168 ²	σ 184	+	ф	4 232	248
9	HT 09	EM 25) 41	• 9 57	I 73	Y 89	i 105	y 121	137	153	169	¥	U 201	+ 217	233	J 249
А	LF 10	SUB 26	* 42	: 58	J 74	Z 90	j 106	z 122	138	154	170	Ω 186	π 202	χ_{218}	234	250
В	VT 11	ESC 27	+ 43	; 59	K 75	[91	k 107	{ 123	139	155	171	Г	A	0 219	235	251
С	FF 12	FS 28	, 44	< 60	L 76	92	1 108	1 124	140	156	+	0 188	2 204	0 220	236	252
D	CR 13	GS 29	45	= 61	M 77] 93	m 109	} 125	141	157	173	δ 189		ک 221	237	253
E	SO 14	RS 30	46	> 62	N 78	∧ 94	n 110	126	142	158) 174)	К 190	 206	λ	238	254
F	SI 15	US 31	/ 47	? 63	O 79	95	0 111	DEL 127	143	159	1 175 4	<u>ک</u>	τ 207	μ 223	239	255

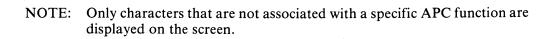


CODE	MEANING						
NUL	Null						
SOH	Start of Heading						
STX	Start Text						
ETX	End Text						
ЕОТ	End of Transmission						
ENQ	Enquiry						
ACK	Acknowledge						
BEL	Bell						
BS	Backspace						
HT	Horizontal Tab						
LF	Line Feed						
VT	Vertical Tab						
FF	Form Feed						
CR	Carriage Return						
SO	Shift Out						
SI	Shift In						
DLE	Data Link Escape						
DC1	Device Control 1						
DC2	Device Control 2						
DC3	Device Control 3						
DC4	Device Control 4						
NAK	Negative Acknowledge						
SYN	Synchronous Idle						
ETB	End Transmission Block						
CAN	Cancel						
EM	End of Medium						
SUB	Substitute						
ESC	Escape						
FS	Form Separator						
GS	Group Separator						
RS	Record Separator						
US	Unit Separator						
SP	Space						
DEL	Delete						
	isplayed on the APC as shown. Some of these codes PC, but the unused codes can still be transmitted for						

 Table D-2
 ASCII Special Characters

Table D-3 APC Special Characters

SECOND HEX DIGIT		H	RST EX GIT
	C)	1
0	0	0	1 6
1		•	17
2		\sum_{2}	18
3	Ц о	נ	19
4	20	2	20
5	0	2	$\underset{21}{\times}$
6	C 0	ĸ	
7	4		
8	1		24
9	0		25
А	<		26
В		L	□□ 27
С		7	1 28
D	4	3	오 29
Е			□ 30
F	1	£]	
APC		->	

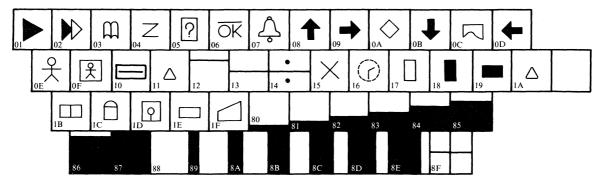


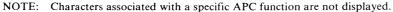
Decimal Code

ASCII	APC
SPECIAL	SPECIAL
CHARACTER	CHARACTER
NUL	
SOH	
STX	\triangleright
ETX	► A
EOT	Z
ENQ	?
ACK	OK
BEL	Δ,
BS	↑
HT	~ ~ ♪ ↓ ↓ ↓ ↓
LF	\diamond
VT	↓
FF	
CR	+
SO	र् ऱ
SI	<u>×</u>
DLE	
DC1	
DC2	
DC3	•
DC4	$\overline{\cdot}$
NAK SYN	÷×⊙□
ETB	
CAN	
EM	
SUB	_
ESC	Ē
FS	
GS	2
RS	
US	\Box
SP	
DEL	

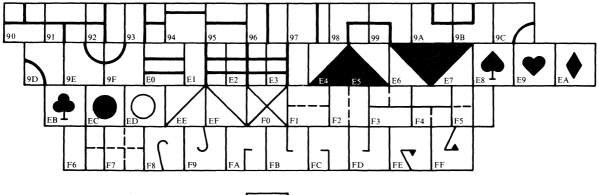
Table D-4 Quick Reference Guide for ASCII Special Character/APC Special Character Association

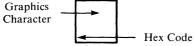
NOTE: Characters associated with a specific APC function are not displayed.





A. UNSHIFTED (SHIFT KEY UP)





B. SHIFTED (SHIFT KEY DOWN)

NOTES: 1 GRPH1 CHARACTERS ARE PRODUCED WHEN THE GRPH1 KEY IS PRESSED.

2 GRAPHICS SYMBOLS ASSOCIATED WITH A SPECIFIC APC FUNCTION ARE NOT DISPLAYED ON THE SCREEN. INSTEAD, THE FUNCTION IS PERFORMED.

3 THE ALPHANUMERIC SYMBOLS ASSOCIATED WITH THE GRAPHIC SYMBOLS ARE THE HEXADECIMAL (HEX) CODES GENERATED BY PRESSING THE KEYS.

Figure D-1 APC GRPH1 Characters

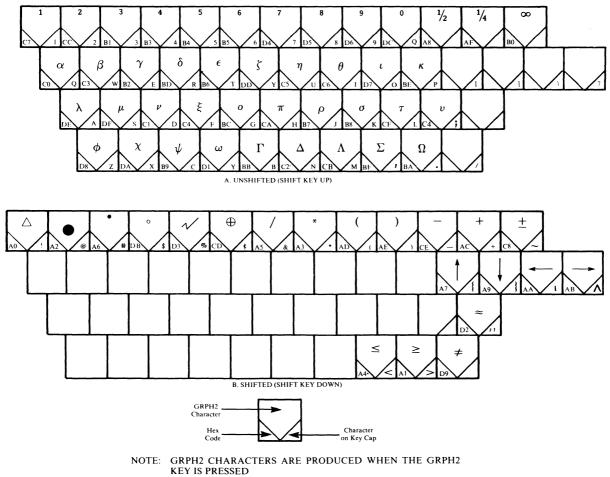


Figure D-2 APC GRPH2 Characters

*) F	Fi 🗲										PROC	GRAM	MABLE	FUNCT	ON KEY	s								► PF22
FNC	(80)	(81)	(82) (83)	(84)	(85) (8	6)	(87)	(88)	(89)	(8A) (8B)	(8C)	(8D)	(8E)	(8F)	(**)	(**)	(**)	(**)	(**)	(**)
ESC (1B)	! 1	@2	# 3	s	4	[%] 5	¢ 6	&	7	8	(9) 0	-	+ =	~	BAC SPAC)8)	INS (1C)	/ (2F)	CLEAR HOME (1E)	PRINT (1D)	BR ST	EAK TOP (1.
TAB	(08) (09)	Q	w	E	R		т	Y	U	1		0	Р	}					DEL (18)	* (2A)	7 (37)	8 (38)	9 (39)	— (2D
CTRL (*)	CAPS LOCK (*)		s		Þ	F	G		н	J	к	L	;	"	RET	URN (0D)			(0B)	4 (34)	5 (35)	6 (36)	+ (2B
Sł	HIFT	(*)	z	x	с		v	в	N	N	1	< ,	> •	/	s	HIFT (*)			(1D)	(0C)	1 (31)	2 (32)	3 (33)	E N
GR 1	ерн (*)		GRPH 2	(*)						(SP)				(20)	ALT	*) HEI	.P (3F)			(0A)		0 (30)	• (2E)	E R

(0D)



NONLOCKABLE SWITCH KEYS

LOCKABLE SWITCH KEYS

NOTES: 1. HEX NUMBERS IN PARENTHESES DESIGNATE HEX CODES.

2. FOR HEX CODES OF STANDARD ALPHANUMERIC CHARACTERS, SEE TABLE D-1.

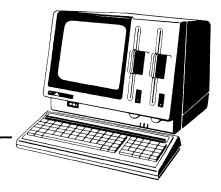
3. KEYS WITH (*) MUST BE USED WITH ANOTHER KEY TO GENERATE A CODE.

4. "SHIFT" OR "CTRL" PLUS "BREAK STOP" GENERATES HEX CODE 03.

5. KEYS WITH (**) (PF17 TO PF22) GENERATE THE SPECIAL CODES SHOWN BELOW.

	PF17	ESCOO
	PF18	ESC O P
	PF19	ESC O Q
	PF20	ESC OR
	PF21	ESC O'S
	PF22	ESC O'T
FNC	PF17	ESC O/U
FNC	PF18	ESC O'V
FNC	PF19	ESC OW
FNC	PF20	ESC O'X
FNC	PF21	ESC OY
FNC	PF22	ESC OZ

Figure D-3 Keyboard Layout Showing Hex Codes For Special Keys



Appendix E I/O Port Addresses and Instructions

The I/O port addresses and instructions for all devices are listed in Tables E-1 to E-21.

Data bus bit descriptions are listed left to right as Bits 7 through 0 for low order bytes and Bits 15 through 8 for high order bytes.

INSTRUCTION	READ/ WRITE	I/O ADDRESS				DAT	A BU	S		
CH0 Address Read	R	01	A7 A15	A6 A14	A5 A13	A4 A12	A3 A11	A2 A10	A1 A9	A0 A8
CH0 Address Write	w	01	A7 A15	A6 A14	A5 A13	A4 A12	A3 A11	A2 A10	A1 A9	A0 A8
CH0 Word Count R.	R	11	W7 W15	W6 W14	W5 W13	W4 W12	W3 W11	W2 W10	W1 W9	W0 W8
CH0 Word Count W.	w	11	W7 W15	W6 W14	W5 W13	W4 W12	W3 W11	W2 W10	W1 W9	W0 W8
CH1 Address Read	R	03	A7 A15	A6 A14	A5 A13	A4 A12	A3 A11	A2 A10	A1 A9	A0 A8
CH1 Address Write	W	03	A7 A15	A6 A14	A5 A13	A4 A12	A3 A11	A2 A10	A1 A9	A0 A8
CH1 Word Count R.	R	13	W7 W15	W6 W14	W5 W13	W4 W12	W3 W11	W2 W10	W1 W9	W0 W8
CH1 Word Count W.	W	13	W7 W15	W6 W14	W5 W13	W4 W12	W3 W11	W2 W10	W1 W9	W0 W8
CH2 Address Read	R	05	A7 A15	A6 A14	A5 A13	A4 A12	A3 A11	A2 A10	A1 A9	A0 A8
CH2 Address Write	W	05	A7 A15	A6 A14	A5 A13	A4 A12	A3 A11	A2 A10	A1 A9	A0 A8
CH2 Word Count R.	R	15	W7 W15	W6 W14	W5 W13	W4 W12	W3 W11	W2 W10	W1 W9	W0 W8
CH2 Word Count W.	W	15	W7 W15	W6 W14	W5 W13	W4 W12	W3 W11	W2 W10	W1 W9	W0 W8
CH3 Address Read	R	07	A7 A15	A6 A14	A5 A13	A4 A12	A3 A11	A2 A10	A1 A9	A0 A8
CH3 Address Write	W	07	A7 A15	A6 A14	A5 A13	A4 A12	A3 A11	A2 A10	A1 A9	A0 A8

Table E-1 I/O Port Address and Instructions for the DMA Controller

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS									
CH3 Word Count	R	17	W7 W15	W6 W14	W5 W13	W4 W12	W3 W11	W2 W10	W1 W9	W0 W8		
CH3 Word Count	W	17	W7 W15	W6 W14	W5 W13	W4 W12	W3 W11	W2 W10	W1 W9	W0 W8		
DMA Status Read	R	09	RQ3	RQ2	RQ1	RQ0	TC3	TC2	TC1	TC0		
DMA Command Write	W	09	KS	DS	WS	PR	ТМ	CE	AH	MM		
Illegal	R	19	_		_							
Write Request Register	W	19						RB	CS1	CS0		
Illegal	R	0B										
Write Single Mask	W	0B				_		MK	CS1	CS0		
Illegal	R	1B										
Write Mode	W	1B	MS1	MS0	ID	AT ,	TR1	TR0	CS1	CS0		
Illegal	R	0D	_									
Clear F/F	W	0D				_				_		
Read Temporary Register	R	1D	D7	D6	D5	D4	D3	D2	DI	D0		
Master Clear	W	1D	_							_		
Illegal	R	0F	_							_		
Illegal	w	0F								_		
Illegal	R	1F	_									
Write All Mask	W	lF					MB3	MB2	MB1	MB0		

Table E-1 I/O Port Address and Instructions for the DMA Controller (cont'd)

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS								
Read IRR/ISR/IRL	R	20	D7	D6	D5	D4	D3	D2	D1	D0	
OCW2	W	20	R	SL	EOI	0	0	L2	LI	L0	
OCW3	W	20	0	ESM	SMM	0	1	Р	PR	RIS	
ICW1	W	20	0	0	0	1	0	0	0	1	
Read Mask R.	R	22		M6	M5	M4	M3	M2	M1	M 0	
OCW1	W	22		M 6	M5	M4	M3	M2	M1	M 0	
ICW2	W	22	T7	T6	T5	T4	T3	0	0	0	
ICW3	W	22	1	0	0	0	0	0	0	0	
ICW4	W	22	0	0	0	0	0	0	0	1	
	R	24									
	W	24									
	R	26									
	W	26									
Read IRR/ISR/IRL	R	28	D7	D6	D5	D4	D3	D2	D1	D0	
OCW2	W	28	R	SL	EOI	0	0	L2	L1	L0	
OCW3	W	28	0	ESM	SMM	0	1	Р	PR	RIS	
ICW1	W	28	0	0	0	1	0	0	0	1	
Read Mask R.	R	2A	M14	M13	M12	M11	M10	M9	M8	M7	
OCW1	W	2A	M14	M13	M12	M11	M10	M9	M8	M7	
ICW2	W	2A	T 7	T6	T5	T4	T3	0	0	0	
ICW3	W	2A	0	0	0	0	0	1	1	1	
ICW4	W	2A	0	0	0	0	0	0	0	1	

Table E-2 I/O Port Addresses and Instructions for the Interrupt Controller

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS									
Read Counter 0	R	29	C7 C15	C6 C14	C5 C13	C4 C12	C3 C11	C2 C10	C1 C9	C0 C8		
Load Counter 0	W	29	C7 C15	C6 C14	C5 C13	C4 C12	C3 C11	C2 C10	C1 C9	C0 C8		
Read Counter 1	R	2B	C7 C15	C6 C14	C5 C13	C4 C12	C3 C11	C2 C10	C1 C9	C0 C8		
Load Counter 1	W	28	C7 C15	C6 C14	C5 C13	C4 C12	C3 C11	C2 C10	C1 C9	C0 C8		
Read Counter 2	R	2D	C7 C15	C6 C14	C5 C13	C4 C12	C3 C11	C2 C10	C1 C9	C0 C8		
Load Counter 2	w	2D	C7 C15	C6 C14	C5 C13	C4 C12	C3 C11	C2 C10	C1 C9	C0 C8		
No Operation	R	2F					—					
Write Mode	W	2F	SC1	SC0	RLI	RL0	M2	M 1	M0	BCD		

.

Table E-3 I/O Port Addresses and Instructions for the Interval Timer

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS									
Read Data	R	30	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0		
Write Data	W	30	SD7	SD6	SD5	SD4	SD3	SD2	SD1	SD0		
Read Status	R	32	DR	SYN	FE	OE	PE	TE	RR	TR		
Write Mode (A)	W	32	S2	S 1	EP	PEN	L2	L1	B2	B1		
Write Mode (S)	W	32	SCS	ESD	EP	PEN	L2	L1	0	0		
Write Command	W	32	EH	IR	RS	RST	SBR	REN	ER	TEN		
Write Mask	W	34	0	0	0	0	0	TXE	RXR	TXR		
Read Signal	R	34	_					CS	CI	CD		
Write Signal	W	36	0	0	0	0	0	0	0	TDC		
	R	36										

 Table E-4 I/O Port Addresses and Instructions for the Serial I/O Communications Controller

 Number 1

 Table E-5 I/O Port Addresses and Instructions for the Serial I/O Communications Controller

 Number 2

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS									
Read Data	R	31	RD8	RD7	RD6	RD5	RD4	RD3	RD2	RD1		
Write Data	W	31	SD8	SD7	SD6	SD5	SD4	SD3	SD2	SD1		
Read Status	R	33	DR	SYN	FE	OE	PE	TE	RRDY	TRDY		
Write Mode (A)	W	33	S2	S 1	EP	PEN	L2	LI	B2	B1		
Write Mode (S)	W	33	SCS	ESD	EP	PEN	L2	L1	B2	B1		
Write Command	W	33	EH	IR	RS	RST	SBR	REN	ER	TEN		
Write Mask	W	35	0	0	0	0	0	TXE	RXR	TXR		
Read Signal	R	35	_				SCA	CS	CI	CD		
Write Signal	W	37	0	0	0	0	0	0	0	TDC		

INSTRUCTION	READ/ WRITE	I/O ADDRESS				DA	ATA BU	ſS		
CH0 Read Address R.	R	38								
CH0 Write Address R.	w	38	0	0	0	0	A19	A18	A17	A16
CH1 Read Address	R	3A								
CH1 Write Address R.	w	3A	0	0	0	0	A19	A18	A17	A16
CH2 Read Address	R	3C								
CH2 Write Address R.	w	3C	0	0	0	0	A19	A18	A17	A16
CH3 Read Address	R	3E								
CH3 Write Address R.	w	3E	0	0	0	0	A19	A18	A17	A16

Table E-6 I/O Port Addresses and Instructions for the DMA Address Registers

Table E-7 I/O Port Addresses and Instructions for the CRT Controller

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS									
Read Status	R	40	LP	HP	VS	DM	A DW	FE	FF	DR		
Write Parameter	W	40	P7	P6	P5	P4	P3	P2	P1	P0		
Read Data	R	42	D7	D6	D5	D4	D3	D2	Dl	D0		
Write Command	W	42	C7	C6	C5	C4	C3	C2	C1	C0		
Reset Intr.	W	46					GDC	TM	APU	CRT		
L												

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS								
Read Status	R	70	LP	HB	VS	DM	A DW	FE	FF	DR	
Write Parameter	W	70	P7	P 6	P5	P4	P3	P2	P1	P0	
Read Data	R	72	D7	D6	D5	D4	D3	D2	D1	D0	
Write Command	W	72	C7	C6	C5	C4	C3	C2	C1	C0	
Graph Enable	w	76			_			_		1/0	

Table E-8 I/O Port Addresses and Instructions for the Graphics Display Controller

NOTE: For Graph Enable, 1 = Release From Blanking Status; 0 = Blanking Always. At power on, Blanking Always is selected.

Table E-9 I/O Port Addresses and Instructions for the Keyboard Controller

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS								
Read Data	R	48	SD8	SD7	SD6	SD5	SD4	SD3	SD2	SD1	
Buzzer Set	W	48	_								
Read Status	R	4A					TP2	TP1	TP0	ALM	
Buzzer Reset	W	4A	_								
Read Signal	R	4C	SW8	SW7	SW6	SW5	SW4	SW3	SW2	SW1	
Read Book/Page	R	4E	B4	B3	B2	B1	P4	Р3	P2	P1	
Read Shift	R	4E	0	0	0	0	SF4	SF3	SF2	SF1	

Table E-10 I/O Port Addresses and Instructions for the FDD Controller

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS							
Read Status	R	50	RQM	DIO	NDM	FCB	F3B	F2B	F1B	F0B
Read Data	R	52	D7	D6	D5	D4	D3	D2	Dl	D0
Write Command	W	52	C7	C6	C5	C4	C3	C2	C1	C0

INSTRUCTION	READ/ WRITE	I/O ADDRESS				DATA BUS			
Read Data	R	58	0		—	— —	—	BAT	TDO
Set Register	W	58		0	DI	Clk stb	C2	Cl	C0

Table E-11 I/O Port Addresses and Instructions for the Clock and Calendar

 Table E-12
 I/O Port Address and Instruction for the BBM Enable

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS
BBM Enable	W	59	ENB

Table E-13 I/O Port Addresses and Instructions for the APU

INSTRUCTION	READ/ WRITE	I/O ADDRESS				DA	ΓΑ Βυ	S		
Read Data	R	5A	D7	D6	D5	D4	D3	D2	D1	D0
Write Data	W	5A	⁻ D7	D6	D5	D4	D3	D2	DI	D0
Read Status	R	5E	В	S	Z	E3	E2	El	E0	CRY
Write Command	W	5E	C7	C6	C5	C4	C3	C2	C1	C0

 Table E-14
 I/O Port Address and Instruction for the Power Off Control

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS
Power Off	W	5B	OFF

INSTRUCTION	READ/ WRITE	I/O ADDRESS			DA	ГА BU	ſS		
Write Command Read Status	W R	60 60	0 S7		C4 S4	C3 S3	C2 S2	C1 S1	C0 S0

Table E-15 I/O Port Addresses and Instructions for the Sound Control

Table E-16 I/O Port Addresses and Instructions for the Timer

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS							
Read Counter 0	R	61	C7 C15	C6 C14	C5 C13	C4 C12	C3 C11	C2 C10	C1 C9	C0 C8
Load Counter 0	W	61	C7 C15	C6 C14	C5 C13	C4 C12	C3 C11	C2 C10	C1 C9	C0 C8
		63 63 65 65								
Write Mode	w	67 67	SC1	SC0	RLI	RL0	M2	M1	М0	BCD

INSTRUCTION	READ/ WRITE	I/O ADDRESS				DAT	A BUS			
Read Signal	R	68	DCN	0	0	ALM	RMR	0	DPQ	MDL
Write Data	W	6A	RD8	RD7	RD6	RD5	RD4	RD3	RD2	RD1
Write Signal 2	W	6C	IRT			MASE	K			
Write Signal 0	W	6E	1	0	0	1	0	1	0	0
Write Signal 1	W	6E	0	0	0	0	0	1	0	INTE
Write Signal 1	W	6E	0	0	0	0	0	1	1	RMS
Write Signal 1	W	6E	0	0	0	0	1	0	0	MASK
Write Signal 1	W	6E	0	0	0	0	1	1	1	IRT

Table E-17 I/O Port Addresses and Instructions for the ODA Controller Number 1

Table E-18 I/O Port Addresses and Instructions for the IDA Controller

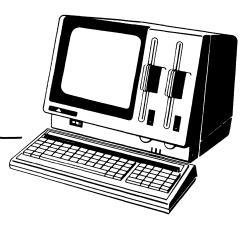
INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS							
Read Signal	R	71	DCN	IP3	IP2	PSM	SMR	IP1	SDRC	Q STT
Read Data	R	73	SD8	SD7	SD6	SD5	SD4	SD3	SD2	SD1
Write Signal 2	w	75	IRT	SDR	SMS	MASK				
Write Signal 0	w	77	1	0	0	1	0	1	1	0
Write Signal 1	W	77	0	0	0	0	0	1	0	INTE
Write Signal 1	w	77	0	0	0	0	1	0	0	MASK
Write Signal 1	w	77	0	0	0	0	1	0	1	SMS
Write Signal 1	w	77	0	0	0	0	1	1	0	SDR
Write Signal 1	w	77	0	0	0	0	1	1	1	IRT
Write Signal 3	w	79								SDA

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS							
Write BUF1	W	80	D7	D6	D5	D4	D3	D2	D1	D0
Read BUF4	R	80	D7	D6	D5	D4	D3	D2	D1	D0
Write BUF2	W	82	D7	D6	D5	D4	D3	D2	D1	D0
Read BUF5	R	82	D7	D6	D5	D4	D3	D2	D1	D0
Write BUF3	W	84	D7	D6	D5	D4	D3	D2	D1	D0
Read BUF6	R	84	D7	D6	D5	D4	D3	D2	D1	D0
Start DMA	W	86					_			-
Set INT1	W	88					_			_
Reset INT2	W	8A						—		-
Reset SDMA INT	W	8C				_				-
Reset RDMA INT	W	8E								-
Read INT	R	90					INT1	INT2	MSDE	MRDE

Table E-19 I/O Port Addresses and Instructions for the Communications Adapter

Table E-20 I/O Port Addresses and Instructions for the ASOP Controller

INSTRUCTION	READ/ WRITE	I/O ADDRESS	DATA BUS								
Low Address Set	W	F0	SA7 SA6 SA5 SA4 SA3 SA2 SA1 SA0								
Mid Address Set	W	F2	SA15 SA14 SA13 SA12 SA11 SA10 SA9 SA8								
High Address Set	W	F4	SA19 SA18 SA17 SA16								
Mask Set	W	F6	MASK								
Read Signal	k	F6	R/W INT								



Appendix F Hardware Specifications

FEATURE

SPECIFICATION

CPU*

Word Length Clock Rate NEC µPD 8086 16 bits 5 MHz

ROM*

RAM Standard Size* Maximum Size 8K (bootstrap and self-test)

64K chips, 200 ns Access Time 128 KB 256 KB

Memory with Battery Backup*

4 K (CMOS) Two-year life Can be protected against accidental writing

I/O Facilities Standard* Printer RS-232C

Optional

Parallel Asynchronous and Synchronous at speeds up to 19,200 bps Software Emulators for all important IBM Workstations and Communications subsystems Second RS-232C Port

Other Standard Features* Music

Pitch Range: 2 + Octaves Number of Tempos: 4 Note Duration: thirty-second to whole Dynamics: piano, medium, forte accent

*Standard Feature, included with Basic Unit

FEATURE

SPECIFICATION

Other Standard Features* (cont.) Alarm

Clock/Calendar Automatic Power Off Lithium Battery

Flexible Disk Drives*

Packaging Size Formatted Capacity (each) Single-Sided, Single-Density 243 KB Double-Sided, Double-Density 1 MB Standard Number of Drives monochróme model - one

Pitch: 4 selectable frequencies Length: 20 ms or continuous Loudness: 3 levels Hardware (with battery backup) Can be initiated locally or remotely Backs up CMOS RAM and Clock/Calendar Two-year life

Integrated (one* or two) 8 in.

Both supported

Maximum Number of Drives two Maximum Disk Capacity **Disk Performance Characteristics Rotation Rate** Head Settle Time Track-track Time **Transfer Rate**

2 MB 360 rpm 50 ms 5 ms 62.5 KB/sec

color model - two

Display Screen*

Size (Diagonal) Lines x Columns Character Set Predefined* User-Definable* Monochrome* Phosphor Type Video Interface Color Virtual Graphic Area Size Real Graphic Window Size

12 in. 25 x 80 plus status line

250 Symbols (8 x 19 matrix) 256 Symbols (all displayable and printable) Green Black Integrated CRT Display 8-color (high res. 640 x 475 pixels) 1,024 x 1,024 pixels 640 x 475 pixels — 8-color

*Standard Feature, included with Basic Unit

FEATURE

SPECIFICATION

Display Screen* (cont.)						
Character Graphics*	Overline, underline, vertical line, highlight, inverse video, blinking, secret					
Line Drawing	Line segment, rectangle, arc, circle					
Keyboard*						
Number of Keys						
(excluded in Programmable						
Function Keys)	86					
Number of Programmable						
Function Keys	22, Dual Mode (effectively, 44)					
Numeric Pad	Standard					
Standard Printer						
Туре	Dot Matrix					
Speed	100 Characters per second					
Controller*	Standard					
Dimensions						
Main Enclosure	19.7 in. (50 cm) wide x 13.8 in. (35 cm)					
	high x					
	monochrome: 18.1 in. (46 cm) deep color: 19.9 in. (50.5 cm) deep.					
Keyboard	19.7 in. (50 cm) wide x 2.4 in. (6 cm) high x					
	9.1 in. (23 cm) deep					

*Standard Feature, included with Basic Unit

Glossary

- A Abbreviation for Ampere.
- **AD0 to AD15** Address and Data lines 0 to 15; bus interface channels. See Chapter 2 for information.
- Address Bus A set of parallel conductors that carry address codes from the microprocessor to memory and I/O devices.

ALE Address Latch Enable.

- **AND** A logic operator having the property that if P is a statement, Q is a statement, R is a statement..., then the AND of P,Q,R...is true if and only if all statements are true, false if any statement is false.
- **ANSI** American National Standards Institute; an organization that develops and publishes industry standards, including terminology and standard codes.

APC Advanced Personal Computer.

- ASCII American Standard Code for Information Interchange; this standard defines character set codes that are used for data interchange between equipment of different manufacturers. This code defines 96 displayed characters (64 without lowercase) and 32 non-displayed controls in terms of 7 bits (plus an eighth bit for parity check).
- Assembler A computer program that prepares a machine-language program from a symbolic language program.

Asynchronous Without relation to a regular time period.

- Asynchronous Communications A method of transmitting data in which the timing of character placement on connecting transmitting lines is not critical. The transmitted characters are preceded by a start bit and followed by one or more stop bits; this designates individual characters and allows the interval between characters to vary.
- Attribute, Character In the APC, one of eight supplements that can accompany a character on the display screen.
- A16 to A19 Address bits 16 to 19; bus interface channels.
- **BASIC** Beginner's All-purpose Symbolic Instruction Code; a common, highlevel, numerical-application-oriented, computer program language that is easily learned.
- **Baud** (1) A unit of signaling speed equal to the number of discrete conditions or signal events per second. For example, one baud equals one-half dot cycle per second in Morse code, one bit per second in a train of binary signals, and one 3-bit value per second in a train of signals each of which can assume one of eight different states. (2) In asynchronous transmission, the baud is a unit of modulation rate that equals the unit intervals.

BBM Battery-Backed Memory.

- BHE Bus High Enable; a bus-interface channel. See Chapter 2.
- **Binary** (1) A condition that can have exactly two values; for example, ON and OFF, 1 and 0. (2) A numbering system that includes the digits zero and one and uses two as its base; that is, the base-2 numbering system.
- **Binary-Coded Decimal (BCD)** Positional notation in which the individual decimal digits are represented by a set of four binary numerals; for example, the number twenty-three is represented by 0010 0011 in binary-coded decimal notation, and by 10111 in binary notation.
- **Bootstrap** A technique or device designed to bring itself into a desired state by means of its own action; for example, a machine routine whose first few instructions are sufficient to bring the rest of itself into the computer from an input device.

- **Buffer** A temporary storage area between devices used to compensate for differences in data flow rates or in the occurrence of events; a storage area that temporarily holds input or output data.
- **Bus** A number of parallel conductors (usually 8 or 16, sometimes 20) used for transmitting data signals or power; for example, address bus, data bus.
- **Byte** A sequence of adjacent binary digits (eight digits in most machines including the APC) operated upon as a unit and usually shorter than a computer word (a word is composed of two bytes in the APC).
- C/D (CONTROL/DATA) An input signal of the NEC 8251A Communications Controller. See Chapter 3.
- **Central Processing Unit (CPU)** (1) A unit of a computer that includes the circuits controlling the interpretation and execution of instructions. (2) In the APC, the NEC μ PD8086 microprocessor.
- **Chip** A tiny piece of semiconductor material on which microscopic electronic components are photoetched to form one or more circuits. After connector leads and a case are added, it is called an integrated circuit.
- **CLKO** Communications Clock; a bus-interface channel. See Chapter 2.
- **COBOL** Common Business Oriented Language; a business data processing language.
- **Clock** (1) The basic source of synchronizing signals in the microcomputer; PHI0 in the APC. (2) In data communications, the clock CLK0 in the APC that controls the timing of signal sending and receiving.
- CMOS Complementary Metal Oxide Semiconductor
- **Code** (1) A system for representing data according to unambiguous rules; e.g. a binary decimal code. (2) Within a given machine or storage location, a system of binary digits given certain arbitrary meanings, used for transmitting information; for example, in the APC, character code, character-attribute code, command code. (3) To change the symbolic representation of data or commands in order to make them conform to such a system.

- **Communications** Refers to communication between computers or between computers and terminals. Information is transmitted with synchronous or asynchronous timing, and in serial-data or parallel-data form.
- **Computer** A data processor capable of high-speed mathematical or logical calculations, able to assemble, store, and otherwise process information derived from coded data in accordance with a predetermined program.
- **CP/M** Control Program For Microprocessors; a registered trademark of Digital Research, an operating system that comprises four subsystems: basic inputoutput system (BIOS), basic disk-operating system (BDOS), console command processor (CCP), and transient program area (TPA). Programs that are created, edited, debugged, assembled, and executed on one CP/M-based configuration run on all CP/M-based configurations. CP/M is thus a standard interface between user programs and system hardware. Among the high-level languages that currently run with CP/M are BASIC, COBOL, FORTRAN, Pascal, APL, and PL/1.
- **CRT** Cathode Ray Tube; a vacuum tube in which electrons are accelerated to and focused upon a fluorescent screen.
- **CRT Display Unit** In the APC, the equipment that receives data and transforms it into visible images on the CRT display screen. Specifically, the unit includes a cathode ray tube, display control, display screen, horizontal driver, and vertical driver.
- CS Code Segment
- **CS (Chip Select)** An input signal of the Intel 8251A Communications Controller. See Chapter 3.
- **DACK0 to DACK3** DMA-request Acknowledgement 0 through 3; bus-interface channels. See Chapter 2.
- **Data** (1) A representation of facts, concepts, or instructions in a formalized manner suitable for communication, interpretation, or processing by humans or automatic means. (2) Any representations such as characters or analog quantities to which meaning is or might be assigned.

- **DIP** Dual In-Line Package; a popular IC packaging container that has two parallel rows (hence dual) of leads, which connect the unit to a circuit board. They are available in a variety of configurations, from 14-pin to 40-pin assemblies.
- **Disk, Flexible** A type of magnetic disk, so named because it is soft and bends easily; also called floppy disk.
- **Disk, Hard** Conventional magnetic disk that is stiffer than a flexible disk, contains more concentrated data, and can be read faster.
- **Disk, Magnetic** A flat circular plate with a magnetic surface on which data can be stored by selective magnetization of portions of the flat surface.
- **Display Position** A unit on the video display screen capable of containing one character; that is, each display unit holds one character box. The APC video display has 25 lines of 80 display positions; and each display position is composed of an 8 x 19 dot matrix.
- **DMA** Direct Memory Access; high-speed data transfer operation in which an I/O channel transfers information directly to or from the memory. Transfers take place with no microprocessor intervention using a "cycle-stealing" method. Also called "data break."
- **DMC** DMA Cycle; a bus-interface channel. See Chapter 2.
- **Double Density** Refers to a type of magnetic disk storage organization in which 256 characters of information are stored on each sector of a track. Compare with single density.
- **DRQ0 to DRQ3** DMA Request 0 to 3, bus interface channels. See Chapter 2.

DS Data Segment

DT/R Data Transmit or Receive; a bus-interface channel. See Chapter 2.

EIA Electronics Industries Association; an electronics trade association that formulates and establishes industry standards. **EPROM** Erasable Programmable Read-Only Memory. Like a PROM, it is a programmable read-only memory, but unlike an ordinary PROM its contents can be erased and rewritten more than once. Like any ROM device, an EPROM retains its contents indefinitely.

FDC Flexible Disk Controller.

FDD Flexible Disk Drive.

FIFO First-In First-Out.

- **Firmware** Refers to microprocessors and other software that have been permanently written into ROM chips; for example, the bootstrap loader is a firmware program.
- **Fixed-Point Arithmetic** Computer calculations in which the computer does not consider the radix point. Compare floating-point arithmetic.
- **Flag** An indicator used to specify the status of a designated condition. A flag is usually one or two bits and can be hardware- or software-implemented.
- **Floating-Point Arithmetic** Arithmetic procedures in which the computer keeps track of the radix point. Compare fixed-point arithmetic.

FM Frequency Modulation.

Full Duplex In communications, pertains to simultaneous two-way independent transmission in both directions; also called duplex. Compare with half duplex.

GDC Graphic Display Controller.

- Half Duplex In communications, pertains to an alternate, one-way-at-a-time independent transmission. Compare with full duplex.
- **Hexadecimal (HEX)** Refers to the number system with 16 as its base. The hexadecimal system uses 16 symbols: 0 to 9, and A to F for the base-10 numbers 10 to 15. One hexadecimal digit can be represented by four bits.
- Hertz (Hz) A unit of frequency equal to one cycle per second.

- **Highlighting** A method used to distinguish or emphasize data on a CRT Display. There are a number of methods: reversing the field, blinking, underlining, changing color, changing light intensity, or some combination of these. The APC features all of these highlighting methods.
- **High-Order Position** In this manual (and in general), the left-most position in a string of digits, characters, or bytes. A high-order position is more significant than a low-order position.
- ICW Initialization Command Word.
- **Impact Printer** A printer that forms characters by physically striking the paper through a ribbon; for example, conventional typewriters print this way.
- **Input/Output (I/O)** Pertaining to a hardware device that can transmit data into or receive data from a computer.
- **Integrated Circuit (IC)** A microunit consisting of interconnected elements, inseparably associated and formed on or within a single substrate to function as an electronic circuit.
- **Intel** A large semiconductor designer, manufacturer, and distributor.
- **Interlace** To assign successive storage location numbers to physically separate storage locations; this reduces access time.
- **Interrupt** (1) A suspension of the normal flow of a process in such a way that the flow can be resumed. (2) A special control signal from an I/O device that diverts the attention of the CPU from the program to a specific address.
- **IOR** I/O Read; a bus-interface channel. See Chapter 2.
- **IOW** I/O Write; a bus-interface channel. See Chapter 2.

IP Instruction Pointer.

IR0 to IR14 Interrupt Request 0 to 14; bus-interface channels. See Chapter 2.

IRR Read Interrupt Register.

IRST Initial Reset; a bus-interface channel. See Chapter 2.

ISR Read Inservice Register.

K Abbreviation for kilo. (1) Prefix meaning 1000. (2) With regard to memory space and addressing, kilo means 1024 (2 to the 10th power); for example 2K equals 2048.

KB Abbreviation for kilobyte; 1024 bytes.

kHz Abbreviation for kilohertz; a unit of frequency equal to 1000 hertz.

LAD Light Pen Address.

Low-Order Position The left-most position in a string of digits, characters, or bytes. A low-order position is less significant than a high-order position.

LSB Least Significant Bit.

- LSI Large Scale Integration; (1) Refers to a component density of 100 or more per chip. (2) A chip with more than 100 components.
- M Abbreviation for mega. (1) Prefix meaning 1,000,000. (2) With regard to memory space and addressing, mega means 1,048,576 (2 to the 20th power); for example, one MB equals one megabyte, 1,048,576 bytes.
- Machine Language Binary-coded language; the only type of language that can be directly used by the machine.
- **Main Unit** In the APC, the Main Unit houses all the microcomputer devices except the Keyboard and Printer. In addition, all interfaces are in or on this unit.
- Matrix Printer A printer that forms characters by printing a pattern of dots.

MB Megabyte; 1,048,576 bytes. The addressing power of the APC.

- **Memory Address** (1) The unique location of a word in memory. (2) In the APC, a 20-bit value that identifies a specific portion of memory.
- **Memory Map** A symbolic representation of memory locations that defines the boundaries of various memory segments.
- **MFM** Modified Frequency Modulation; a magnetic-disk coding system that uses double-density encoding of information.

- MHz Megahertz; a unit of frequency equal to one million hertz.
- **Microprocessor** (1) The principal component of a microcomputer, it is a semiconductor central processing unit. Usually contained on a single chip, which is mounted on a DIP, it includes an arithmetic logic unit, control logic, and control-memory unit. (2) In the APC, the microprocessor is the NEC μ PD8086, which is mounted on a 40-pin DIP.
- **Mnemonic** An abbreviation of two or three letters (abbreviated in a way to aid human memory) that is used instead of terminology.
- **Mode** Refers to various methods of operation; for example, the synchronous versus the asynchronous mode.
- **Modem** MOdulator-DEModulator; a device that modulates signals transmitted over communication facilities. This device enables computers and terminals to communicate over telephone circuits.
- **Monitor** (1) A device that observes and verifies the operation of a data processing system and indicates any significant departure from the norm. (2) Software or hardware that observes, supervises, controls, or verifies the operation of a system. (3) A video display.

MOS Metal Oxide Semiconductor.

- **Mother Board** A circuit board into which various printed circuit boards (PCB) are plugged. In the APC, the Mother Board is inside the card cage and has five PCB slots.
- **MR** Memory Read; a bus-interface channel. See Chapter 2.
- **MRQ** Memory ReQuest, a bus-interface channel. See Chapter 2.
- ms millisecond; one-thousandth of one second, 0.001 second.

MSB Most Significant Bit.

Multiplexer A device capable of combining several low-speed inputs into one high-speed data stream transmitted on a single channel. A demultiplexer subsequently reconverts the single data stream into low-speed inputs for the host computer. Two kinds of multiplexers are time-division multiplexers in which the channel is divided into time slots and frequency-division multiplexers in which the channel is divided into frequency bands.

MW Memory Write; a bus-interface channel. See Chapter 2.

NAND A logical operator that is the negation of AND.

NEC Nippon Electric Company; a large manufacturer of electronics equipment, including semiconductors and microcomputers.

NOR A logical operator that is the negation of OR.

ns nanosecond; one billionth of a second, 0.000000001 second.

NT Normal Termination.

OCW Operational Command Word.

ODA Output Device Adapter.

- **OR** A logic operator having the property that if P is a statement, Q is a statement, R is a statement..., then the OR of P,Q,R...is true if at least one statement is true, false only if all statements are false. Often represented by +, as in P + Q.
- **Output** Pertaining to a device, process, or channel involved in an output process, or to the data or states involved in an output process.
- **Overflow** That portion of the result of an operation that exceeds the capacity of the intended unit of storage.
- **Parallel Data** Method for representing data in which characters are transmitted and received over separate lines, usually simultaneously. Compare serial data.
- **Parameter** In general, a quantity used to specify I/O devices or to designate desired routines.

PCB Printed Circuit Board.

- **Personal Computer** A relatively low-cost computer that is based on tiny microcomputer chips and is therefore portable and personally controllable. Personal computers are often classified as home, hobbyist, professional, business, small business, appliance, and others.
- **PHIO** System Clock; a bus-interface channel. See Chapter 2.

- **POF** Power-Off Control; (1) A bus-interface channel. See Chapter 2. (2) In the APC, a control circuit that shuts off the system power supply by a microprocessor command.
- **Printed Circuit Board** Also called pc board, plate, card, chassis, and in this manual PCB; an insulating board with metallic wiring paths for point-to-point connections, but it can also include metallized connecting surfaces and heat sinks or heat radiators. Printed circuit boards are single-sided, double-sided, or multilayer; all pc boards in the APC are multilayer.
- **Program** A series of instructions or statements, in a form acceptable to a computer, prepared in order to achieve a certain result.
- **Programmable Array Logic (PAL)** TTL Schottky bipolar devices designed to replace standard TTL logic. They are fully programmable to provide a high degree of design flexibility and efficiency. The basic logic implementation is the AND-OR array, where the AND is programmable and the OR fixed. PALs are used to make logic modification quicker and easier than with standard devices.
- **PROM** Programmable Read Only Memory; unprogrammed upon manufacture, can be programmed once and only once. After programming, like ROMs, they retain their contents indefinitely.
- **Protocol** In data communications, a specific set of rules defining the format and content of messages between communicating devices.
- **P39 Phosphor** Used in both the monochrome and color displays of the APC, it is a yellow-green, long-persistence phosphor that provides good luminescence, small dot size, and good focus.
- **RAM** Random Access Memory. See Read/Write Memory.
- **Raster Scan** A technique of graphics CRT displays; it operates by varying the intensity of a beam that periodically scans left-to-right and top-to-bottom. This CRT graphics method is the type used in the APC and conventional home TV; it is the only method that makes full color display possible.
- **RD** READ; an input signal of the NEC 8251A Communications Controller. See Chapter 3.
- **RDY** Ready; a bus-interface channel. See Chapter 2.

- **Read/Write Memory** Also called random access memory or RAM. A type of memory in which each cell can be both sensed at appropriate output terminals and changed in response to electrical input signals.
- **Refreshing** A process of periodically reactivating or restoring information that decays when left idle; for example, the phosphor on a CRT must be refreshed in order to maintain the image, and dynamic memory cells need constant refreshing to maintain their contents.

RFSH Refresh; a bus-interface channel. See Chapter 2.

Register A device capable of storing a specified amount of data such as one word.

rpm Revolutions Per Minute.

ROM Read-Only Memory; memory that can be read but not altered.

- **RS-232C Interface** An interface between a modem and the associated data terminal equipment that is standardized by EIA Standard 232C.
- **RST** RESET; an input signal of the NEC 8251A Communications Controller. See Chapter 3.
- Serial Data Method for representing data in which the data stream is transmitted and received as a single signal by \approx single transmission path. Compare parallel data.
- **Single Density** Refers to a magnetic disk storage technique in which 128 characters of information are stored on each sector of a track. Compare double density.
- **Software** A set of programs, procedures, and possibly associated documentation concerned with the operation of a data processing system.
- **Sound Generator** In general, a computer device that includes a tone-generator and speaker for outputting tones. In the APC, the sound generator is fully programmable and capable of generating user-programmed melodies and various beep signals.
- **Special Character** In the APC, a character that the user can create through the ACGGEN utility program; the programmed character is stored in display RAM (and on disk if desired) and is accesible on command. There is storage allocation for 256 special characters, though an indefinite number can be stored on disk.

SS Stack Segment.

Status Register A register that provides storage for arithmetic and control status flags.

SW Switch.

- **Synchronous** Having a constant time interval between successive bits, characters, or events.
- **Synchronous Communications** A method of transmitting information in which the timing of character placement signifies the division between characters. A data stream of an indefinite number of characters is preceded by one or two sync bits, which indicate where the data stream begins.
- TC Terminal Count; a bus-interface channel. See Chapter 2.

TTL Transistor/Transistor Logic.

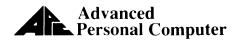
USART Universal Synchronous/Asynchronous Receiver/Transmitter

V Abbreviation for Volt.

VFO Variable Frequency Oscillator.

W Abbreviation for Watt.

- **Word** A group of characters that occupy one storage location and are treated as a single entity, instruction, or quantity. In the APC, two bytes (16 bits) make up a word.
- WR (WRITE) An input signal of the NEC 8251A Communications Controller. See Chapter 3.



USER'S COMMENTS FORM

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